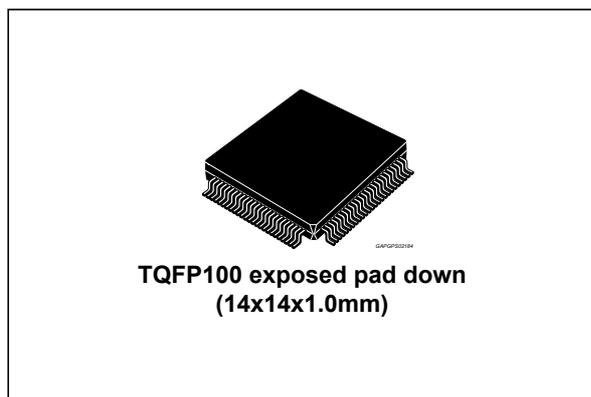


## Automotive advanced airbag IC for mid/high end applications

Datasheet - production data



### Features



- AEC-Q100 qualified
- Boost regulator for energy reserve
  - 1.882 MHz operation,  $I_{load} = 55$  mA max
  - Output voltage user selectable, 23 V/ 33 V  $\pm 5\%$
  - Capacitor value & ESR diagnostics
- Boost regulator for PSI-5 SYNC pulse
  - 1.882 MHz operation,
  - Output voltage, 12 V/14.75 V, user configurable
- Buck regulator for remote sensor
  - 1.882 MHz operation
  - Output voltage, 7.2 V/9 V  $\pm 4\%$ , user configurable
- Buck regulator for micro controller unit
  - 1.882 MHz operation
  - Output voltage user selectable, 3.3 V or 5.0 V  $\pm 3\%$
- Integrated energy reserve crossover switch
  - 3  $\Omega$  - 912 mA max
  - Switch active output indicator
- Battery voltage monitor & shutdown control with Wake-up control
- System voltage diagnostics with integrated ADC
- Squib deployment drivers
  - 8 channel HSD/LSD
  - 25 V max deployment voltage
  - Various deployment profiles
  - Current monitoring
  - $R_{measure}$ , STB, STG & Leakage diagnostics
  - High & low side driver FET tests
- High side safing switch regulator and enable control
- Two channel remote sensor interface
  - PSI-5 satellite sensors
- Three channel GPO, HSD or LSD configurable, with PWM 0-100% control
- Nine channel hall-effect, resistive or switch sensor interface
- User customizable safing logic
- Specific disarm signal for passenger airbag
- Temporal and algorithmic Watchdog timers
- End of life disposal interface
- Temperature sensor
- 32 bit SPI communications
- 5.5 V minimum operating voltage at device battery pin
- Operating temperature, -40 to 95 °C
- Packaging - 100 pin

**Table 1. Device summary**

| Order code | Package | Pacing      |
|------------|---------|-------------|
| L9679P     | TQFP100 | Tray        |
| L9679PTR   |         | Tape & Reel |

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# 1 Description

The L9679P is an advanced airbag system chip solution targeted for mature airbag market and integrated safety markets. This device is family compatible with the L9678 and L9680 devices. Safety system integration is enabled through higher power supply currents and integrated PSI-5 satellite interface.

High frequency power supply design allows further cost reduction by using smaller and less expensive external components. All switching regulators operate at 1.882 MHz while buck converters have integrated synchronous rectifiers.

Additional attention is given to system integrity and diagnostics. The reserve capacitor is electrically isolated from the boost regulator by a 50 mA nominal fixed current source, controlling in-rush an additional capacitor discharge fixed current source is integrated to diagnose the reserve capacitor value and ESR. The same current sources can be used to discharge the capacitor at shutdown.

Thanks to low quiescent current, the device can be directly connected to battery. In this way, the device start-up and shutdown are controlled through the wake-up input function. The power supply and crossover function are controlled automatically through the internal state machine.

The user can select both ECU logic voltage ( $V_{CC}$  at 3.3 V or 5.0 V) and energy reserve output voltage (at either 23 V or 33 V). Deployment voltage is set to a maximum of 25 V for all profiles and can be controlled through external safing switch circuit using the high side safing switch reference enabled through the system SPI interface or the arming logic.

## 2 Absolute maximum ratings

This part may be irreparably damaged if taken outside the specified absolute maximum ratings. Operation above the absolute maximum ratings may also cause a decrease in reliability.

The operating junction temperature range is -40 °C to +150 °C. The maximum junction temperature must not be exceeded except when in deployment and within the deploy power stages. Deployment is possible starting with a junction temperature of 150 °C. A power dissipation calculation has to be performed for the final application limiting the available functionality to a subset of it in order to respect to the power dissipation capability.

**Table 2. Absolute maximum ratings**

| Pin# | Pin name | Pin function                      | Min  | Max           | Unit |
|------|----------|-----------------------------------|------|---------------|------|
| 1    | CS_RS    | Remote SPI interface chip select  | -0.3 | VCC+0.3 ≤ 6.5 | V    |
| 2    | SCLK_RS  | Remote SPI interface clock        | -0.3 | VCC+0.3 ≤ 6.5 | V    |
| 3    | MOSI_RS  | Remote SPI interface data in      | -0.3 | VCC+0.3 ≤ 6.5 | V    |
| 4    | MISO_RS  | Remote SPI interface data out     | -0.3 | VCC+0.3 ≤ 6.5 | V    |
| 5    | RESET    | Reset output                      | -0.3 | VCC+0.3 ≤ 6.5 | V    |
| 6    | MISO_G   | Global SPI interface data out     | -0.3 | VCC+0.3 ≤ 6.5 | V    |
| 7    | MOSI_G   | Global SPI interface data in      | -0.3 | VCC+0.3 ≤ 6.5 | V    |
| 8    | SCLK_G   | Global SPI interface clock        | -0.3 | VCC+0.3 ≤ 6.5 | V    |
| 9    | CS_G     | Global SPI interface chip select  | -0.3 | VCC+0.3 ≤ 6.5 | V    |
| 10   | WDT/TM   | Watchdog disable                  | -0.3 | 20            | V    |
| 11   | SR4      | Squib 4 low-side pin              | -0.3 | 35            | V    |
| 12   | SF4      | Squib 4 high-side pin             | -1.0 | 40            | V    |
| 13   | SS45     | Squib 4 & 5 deployment supply pin | -0.3 | 40            | V    |
| 14   | SF5      | Squib 5 high-side pin             | -1.0 | 40            | V    |
| 15   | SR5      | Squib 5 low-side pin              | -0.3 | 35            | V    |
| 16   | SR0      | Squib 0 low-side pin              | -0.3 | 35            | V    |
| 17   | SF0      | Squib 0 high-side pin             | -1.0 | 40            | V    |
| 18   | SS01     | Squib 0 & 1 deployment supply pin | -0.3 | 40            | V    |
| 19   | SF1      | Squib 1 high-side pin             | -1.0 | 40            | V    |
| 20   | SR1      | Squib 1 low-side pin              | -0.3 | 35            | V    |
| 21   | NC       | Not connected                     |      |               |      |
| 22   | NC       | Not connected                     |      |               |      |
| 23   | NC       | Not connected                     |      |               |      |
| 24   | NC       | Not connected                     |      |               |      |
| 25   | NC       | Not connected                     |      |               |      |
| 26   | DCS8     | DC Sensor interface channel 8     | -2   | 40            | V    |

Table 2. Absolute maximum ratings (continued)

| Pin# | Pin name | Pin function                                | Min  | Max                   | Unit |
|------|----------|---|------|-----------------------|------|
| 27   | DCS7     | DC Sensor interface channel 7               | -2   | 40                    | V    |
| 28   | DCS6     | DC Sensor interface channel 6               | -2   | 40                    | V    |
| 29   | DCS5     | DC Sensor interface channel 5               | -2   | 40                    | V    |
| 30   | DCS4     | DC Sensor interface channel 4               | -2   | 40                    | V    |
| 31   | DCS3     | DC Sensor interface channel 3               | -2   | 40                    | V    |
| 32   | DCS2     | DC Sensor interface channel 2               | -2   | 40                    | V    |
| 33   | DCS1     | DC Sensor interface channel 1               | -2   | 40                    | V    |
| 34   | DCS0     | DC Sensor interface channel 0               | -2   | 40                    | V    |
| 35   | RSU0     | PSI-5/WSS ch. 0 remote sensor output        | -1   | 40                    | V    |
| 36   | RSU1     | PSI-5/WSS ch. 1 remote sensor output        | -1   | 40                    | V    |
| 37   | NC       | Not connected                               |      |                       |      |
| 38   | NC       | Not connected                               |      |                       |      |
| 39   | GPOD0    | GPO driver 0 drain output pin               | -1   | 40                    | V    |
| 40   | GPOS0    | GPO driver 0 source output pin              | -1   | 40                    | V    |
| 41   | GPOS1    | GPO driver 1 source output pin              | -1   | 40                    | V    |
| 42   | GPOD1    | GPO driver 1 drain output pin               | -1   | 40                    | V    |
| 43   | GPOD2    | GPO driver 2 drain output pin               | -1   | 40                    | V    |
| 44   | GPOS2    | GPO driver 2 source output pin              | -1   | 40                    | V    |
| 45   | COVRACT  | External Crossover Switch Driver            | -0.3 | 40                    | V    |
| 46   | ISOK     | ISO9141 bus pin (K-LINE)                    | -18  | 40                    | V    |
| 47   | NC       | Not connected                               |      |                       |      |
| 48   | SATSYNC  | Initiate Satellite Sensor Sync Pulse        | -0.3 | $V_{CC}+0.3 \leq 6.5$ | V    |
| 49   | PSINHB   | Active Low Passenger Airbag Inhibit Control | -0.3 | $V_{CC}+0.3 \leq 6.5$ | V    |
| 50   | GNDSUB1  | Substrate ground / Squib ground             | -0.3 | 0.3                   | V    |
| 51   | NC       | Not connected                               |      |                       |      |
| 52   | NC       | Not connected                               |      |                       |      |
| 53   | NC       | Not connected                               |      |                       |      |
| 54   | NC       | Not connected                               |      |                       |      |
| 55   | NC       | Not connected                               |      |                       |      |
| 56   | SR3      | Squib 3 low-side pin                        | -0.3 | 35                    | V    |
| 57   | SF3      | Squib 3 high-side pin                       | -1.0 | 40                    | V    |
| 58   | SS23     | Squib 2 & 3 deployment supply pin           | -0.3 | 40                    | V    |
| 59   | SF2      | Squib 2 high-side pin                       | -1.0 | 40                    | V    |
| 60   | SR2      | Squib 2 low-side pin                        | -0.3 | 35                    | V    |
| 61   | SR7      | Squib 7 low-side pin                        | -0.3 | 35                    | V    |

Table 2. Absolute maximum ratings (continued)

| Pin# | Pin name    | Pin function                              | Min                | Max                | Unit |
|------|-------------|---|--------------------|--------------------|------|
| 62   | SF7         | Squib 7 high-side pin                     | -1.0               | 40                 | V    |
| 63   | SS67        | Squib 6 & 7 deployment supply pin         | -0.3               | 40                 | V    |
| 64   | SF6         | Squib 6 high-side pin                     | -1.0               | 40                 | V    |
| 65   | SR6         | Squib 6 low-side pin                      | -0.3               | 35                 | V    |
| 66   | GND A       | Analog ground                             | -0.3               | 0.3                | V    |
| 67   | SAF_CS0     | SPI interface safing sensor chip select 0 | -0.3               | $VCC+0.3 \leq 6.5$ | V    |
| 68   | SAF_CS1     | SPI interface safing sensor chip select 1 | -0.3               | $VCC+0.3 \leq 6.5$ | V    |
| 69   | SAF_CS2     | SPI interface safing sensor chip select 2 | -0.3               | $VCC+0.3 \leq 6.5$ | V    |
| 70   | ISOTX       | ISO9141 transmit pin                      | -0.3               | $VCC+0.3 \leq 6.5$ | V    |
| 71   | WD2_LockOut | WD2 fault output                          | -0.3               | $VCC+0.3 \leq 6.5$ | V    |
| 72   | NC          | Not connected                             |                    |                    |      |
| 73   | ISORX       | ISO9141 receiver pin                      | -0.3               | $VCC+0.3 \leq 6.5$ | V    |
| 74   | WS1         | Wheel speed output Ch1                    | -0.3               | $VCC+0.3 \leq 6.5$ | V    |
| 75   | WS0         | Wheel speed output Ch0                    | -0.3               | $VCC+0.3 \leq 6.5$ | V    |
| 76   | VCCSEL      | VCC select                                | -0.3               | 40                 | V    |
| 77   | ACL         | EOL disposal control input                | -0.3               | 40                 | V    |
| 78   | WAKEUP      | Wake-up control input                     | -0.3               | 40                 | V    |
| 79   | VBATMON     | Battery line voltage monitor              | -18 <sup>(1)</sup> | 40                 | V    |
| 80   | VSF         | Safing regulator supply output            | -0.3               | 40                 | V    |
| 81   | VIN         | Battery connection                        | -0.3               | 40                 | V    |
| 82   | VER         | Reserve voltage                           | -0.3               | 40                 | V    |
| 83   | ERBOOST     | Energy reserve regulator output           | -0.3               | 40                 | V    |
| 84   | ERBSTSW     | ER Boost switching output                 | -0.3               | 40                 | V    |
| 85   | BSTGND      | Boost regulators ground                   | -0.3               | 0.3                | V    |
| 86   | SYNCBSTSW   | SYNC Boost switching output               | -0.3               | 40                 | V    |
| 87   | SYNCBOOST   | SYNC boost output voltage                 | -0.3               | 40                 | V    |
| 88   | SATBCKSW    | SAT Buck switching output                 | -0.3               | 40                 | V    |
| 89   | SATGND      | SAT Buck regulator ground                 | -0.3               | 0.3                | V    |
| 90   | SATBUCK     | SAT Buck output voltage                   | -0.3               | 40                 | -    |
| 91   | VCCBCKSW    | VCC Buck switch output                    | -0.3               | 40                 | V    |
| 92   | VCCGND      | VCC Buck Ground                           | -0.3               | 0.3                | V    |
| 93   | CVDD        | Internal 3.3V regulator output            | -0.3               | 4.6                | V    |
| 94   | GNDD        | Digital ground                            | -0.3               | 0.3                | -    |
| 95   | VCC         | VCC Buck voltage                          | -0.3               | 6.5                | V    |
| 96   | ARM1        | Arming output 1                           | -0.3               | $VCC+0.3 \leq 6.5$ | V    |

Table 2. Absolute maximum ratings (continued)

| Pin# | Pin name         | Pin function                    | Min  | Max                   | Unit |
|------|------------------|---------------------------------|------|-----------------------|------|
| 97   | ARM2             | Arming output 2                 | -0.3 | $V_{CC}+0.3 \leq 6.5$ | V    |
| 98   | NC               | Not connected                   |      |                       |      |
| 99   | FENL             | LS driver FET control input     | -0.3 | $V_{CC}+0.3 \leq 6.5$ | V    |
| 100  | GND SUB2         | Substrate ground / Squib ground | -0.3 | 0.3                   | V    |
| -    | Exposed pad down | Substrate ground / Squib ground | -0.3 | 0.3                   | V    |

1. VBATMON negative AMR is -18 V or -20 mA.

### 3 Operative maximum ratings

Within the operating ratings the part operates as specified and without parameter deviations. Once taken beyond the operative ratings and returned back within, the part will recover with no damage or degradation.

Additional supply voltage and temperature conditions are given separately at the beginning of each specification table.

**Table 3. Operative maximum ratings**

| Pin # | Pin name | Pin function                      | Min  | Max                | Unit |
|-------|----------|-----------------------------------|------|--------------------|------|
| 1     | CS_RS    | Remote SPI interface chip select  | -0.1 | $VCC+0.1 \leq 5.5$ | V    |
| 2     | SCLK_RS  | Remote SPI interface clock        | -0.1 | $VCC+0.1 \leq 5.5$ | V    |
| 3     | MOSI_RS  | Remote SPI interface data in      | -0.1 | $VCC+0.1 \leq 5.5$ | V    |
| 4     | MISO_RS  | Remote SPI interface data out     | -0.1 | $VCC+0.1 \leq 5.5$ | V    |
| 5     | RESET    | Reset output                      | -0.1 | $VCC+0.1 \leq 5.5$ | V    |
| 6     | MISO_G   | Global SPI interface data out     | -0.1 | $VCC+0.1 \leq 5.5$ | V    |
| 7     | MOSI_G   | Global SPI interface data in      | -0.1 | $VCC+0.1 \leq 5.5$ | V    |
| 8     | SCLK_G   | Global SPI interface clock        | -0.1 | $VCC+0.1 \leq 5.5$ | V    |
| 9     | CS_G     | Global SPI interface chip select  | -0.1 | $VCC+0.1 \leq 5.5$ | V    |
| 10    | WDT/TM   | Watchdog disable                  | -0.1 | 15                 | V    |
| 11    | SR4      | Squib 4 low-side pin              | -0.1 | SS45               | V    |
| 12    | SF4      | Squib 4 high-side pin             | -1.0 | SS45               | V    |
| 13    | SS45     | Squib 4 & 5 deployment supply pin | -0.1 | VER                | V    |
| 14    | SF5      | Squib 5 high-side pin             | -1.0 | SS45               | V    |
| 15    | SR5      | Squib 5 low-side pin              | -0.1 | SS45               | V    |
| 16    | SR0      | Squib 0 low-side pin              | -0.1 | SS01               | V    |
| 17    | SF0      | Squib 0 high-side pin             | -1.0 | SS01               | V    |
| 18    | SS01     | Squib 0 & 1 deployment supply pin | -0.1 | VER                | V    |
| 19    | SF1      | Squib 1 high-side pin             | -1.0 | SS01               | V    |
| 20    | SR1      | Squib 1 low-side pin              | -0.1 | SS01               | V    |
| 21    | NC       | Not connected                     |      |                    |      |
| 22    | NC       | Not connected                     |      |                    |      |
| 23    | NC       | Not connected                     |      |                    |      |
| 24    | NC       | Not connected                     |      |                    |      |
| 25    | NC       | Not connected                     |      |                    |      |
| 26    | DCS8     | DC sensor interface channel 8     | -1   | 18                 | V    |
| 27    | DCS7     | DC sensor interface channel 7     | -1   | 18                 | V    |

Table 3. Operative maximum ratings (continued)

| Pin # | Pin name | Pin function                                | Min  | Max                  | Unit |
|-------|----------|---|------|----------------------|------|
| 28    | DCS6     | DC sensor interface channel 6               | -1   | 18                   | V    |
| 29    | DCS5     | DC sensor interface channel 5               | -1   | 18                   | V    |
| 30    | DCS4     | DC sensor interface channel 4               | -1   | 18                   | V    |
| 31    | DCS3     | DC sensor interface channel 3               | -1   | 18                   | V    |
| 32    | DCS2     | DC sensor interface channel 2               | -1   | 18                   | V    |
| 33    | DCS1     | DC sensor interface channel 1               | -1   | 18                   | V    |
| 34    | DCS0     | DC Sensor interface channel 0               | -1   | 18                   | V    |
| 35    | RSU0     | PSI-5/WSS ch. 0 remote sensor output        | -1   | $V_{RSU\_SYNC\_MAX}$ | V    |
| 36    | RSU1     | PSI-5/WSS ch. 1 remote sensor output        | -1   | $V_{RSU\_SYNC\_MAX}$ | V    |
| 37    | NC       | Not connected                               |      |                      |      |
| 38    | NC       | Not connected                               |      |                      |      |
| 39    | GPOD0    | GPO driver 0 drain output pin               | -0.1 | 40                   | V    |
| 40    | GPOS0    | GPO driver 0 source output pin              | -1   | 40                   | V    |
| 41    | GPOS1    | GPO driver 1 source output pin              | -1   | 40                   | V    |
| 42    | GPOD1    | GPO driver 1 drain output pin               | -0.1 | 40                   | V    |
| 43    | GPOD2    | GPO driver 2 drain output pin               | -0.1 | 40                   | V    |
| 44    | GPOS2    | GPO driver 2 source output pin              | -1   | 40                   | V    |
| 45    | COVRACT  | External crossover switch driver            | -0.1 | 40                   | V    |
| 46    | ISOK     | ISO9141 bus pin (K-LINE)                    | -0.1 | $VCC+0.1 \leq 5.5$   | V    |
| 47    | NC       | Not connected                               |      |                      |      |
| 48    | SATSYNC  | Initiate satellite sensor sync pulse        | -0.1 | $VCC+0.1 \leq 5.5$   | V    |
| 49    | PSINHB   | Active low passenger airbag inhibit control | -1   | 18                   | V    |
| 50    | GNDSUB1  | Substrate ground / Squib ground             | -0.1 | 0.1                  | V    |
| 51    | NC       | Not connected                               |      |                      |      |
| 52    | NC       | Not connected                               |      |                      |      |
| 53    | NC       | Not connected                               |      |                      |      |
| 54    | NC       | Not connected                               |      |                      |      |
| 55    | NC       | Not connected                               |      |                      |      |
| 56    | SR3      | Squib 3 low-side pin                        | -0.1 | SS23                 | V    |
| 57    | SF3      | Squib 3 high-side pin                       | -1.0 | SS23                 | V    |
| 58    | SS23     | Squib 2 & 3 deployment supply pin           | -0.1 | VER                  | V    |
| 59    | SF2      | Squib 2 high-side pin                       | -1.0 | SS23                 | V    |
| 60    | SR2      | Squib 2 low-side pin                        | -0.1 | SS23                 | V    |
| 61    | SR7      | Squib 7 low-side pin                        | -0.1 | SS67                 | V    |

Table 3. Operative maximum ratings (continued)

| Pin # | Pin name    | Pin function                              | Min  | Max            | Unit |
|-------|-------------|---|------|----------------|------|
| 62    | SF7         | Squib 7 high-side pin                     | -1.0 | SS67           | V    |
| 63    | SS67        | Squib 6 & 7 deployment supply pin         | -0.1 | VER            | V    |
| 64    | SF6         | Squib 6 high-side pin                     | -1.0 | SS67           | V    |
| 65    | SR6         | Squib 6 low-side pin                      | -0.1 | SS67           | V    |
| 66    | GND A       | Analog ground                             | -0.1 | 0.1            | V    |
| 67    | SAF_CS0     | SPI interface safing sensor chip select 0 | -0.1 | VCC+0.1 <= 5.5 | V    |
| 68    | SAF_CS1     | SPI interface safing sensor chip select 1 | -0.1 | VCC+0.1 <= 5.5 | V    |
| 69    | SAF_CS2     | SPI interface safing sensor chip select 2 | -0.1 | VCC+0.1 <= 5.5 | V    |
| 70    | ISOTX       | ISO9141 transmit pin                      | -0.1 | VCC+0.1 <= 5.5 | V    |
| 71    | WD2_LockOut | WD2 Fault Output                          | -0.1 | VCC+0.1 <= 5.5 | V    |
| 72    | NC          | Not connected                             |      |                |      |
| 73    | ISORX       | ISO9141 receiver pin                      | -0.1 | VCC+0.1 <= 5.5 | V    |
| 74    | WS1         | Wheel Speed Output Ch1                    | -0.1 | VCC+0.1 <= 5.5 | V    |
| 75    | WS0         | Wheel Speed Output Ch0                    | -0.1 | VCC+0.1 <= 5.5 | V    |
| 76    | VCCSEL      | VCC select                                | -0.1 | 35             | V    |
| 77    | ACL         | EOL disposal control input                | -0.1 | 35             | V    |
| 78    | WAKEUP      | Wake-up control input                     | -0.1 | VIN            | V    |
| 79    | VBATMON     | Battery line voltage monitor              | -1   | 18             | V    |
| 80    | VSF         | Safing regulator supply output            | -0.1 | 27             | V    |
| 81    | VIN         | Battery connection                        | -0.1 | 35             | V    |
| 82    | VER         | Reserve voltage                           | -0.1 | 35             | V    |
| 83    | ERBOOST     | Energy reserve regulator output           | -0.1 | 35             | V    |
| 84    | ERBSTSW     | ER Boost switching output                 | -0.1 | 35             | V    |
| 85    | BSTGND      | Boost regulators ground                   | -0.1 | 0.1            | V    |
| 86    | SYNCBSTSW   | SYNC Boost switching output               | -0.1 | 35             | V    |
| 87    | SYNCBOOST   | SYNC boost output voltage                 | -0.1 | 35             | V    |
| 88    | SATBCKSW    | SAT Buck switching output                 | -0.1 | 35             | V    |
| 89    | SATGND      | SAT Buck regulator ground                 | -0.1 | 0.1            | V    |
| 90    | SATBUCK     | SAT Buck output voltage                   | -0.1 | 10             | -    |
| 91    | VCCBCKSW    | VCC Buck switch Output                    | -0.1 | 10             | V    |
| 92    | VCCGND      | VCC Buck Ground                           | -0.1 | 0.1            | V    |
| 93    | CVDD        | Internal 3.3V regulator output            | -0.1 | 3.6            | V    |
| 94    | GNDD        | Digital ground                            | -0.1 | 0.1            | -    |
| 95    | VCC         | VCC Buck Voltage                          | -0.1 | 5.5            | V    |

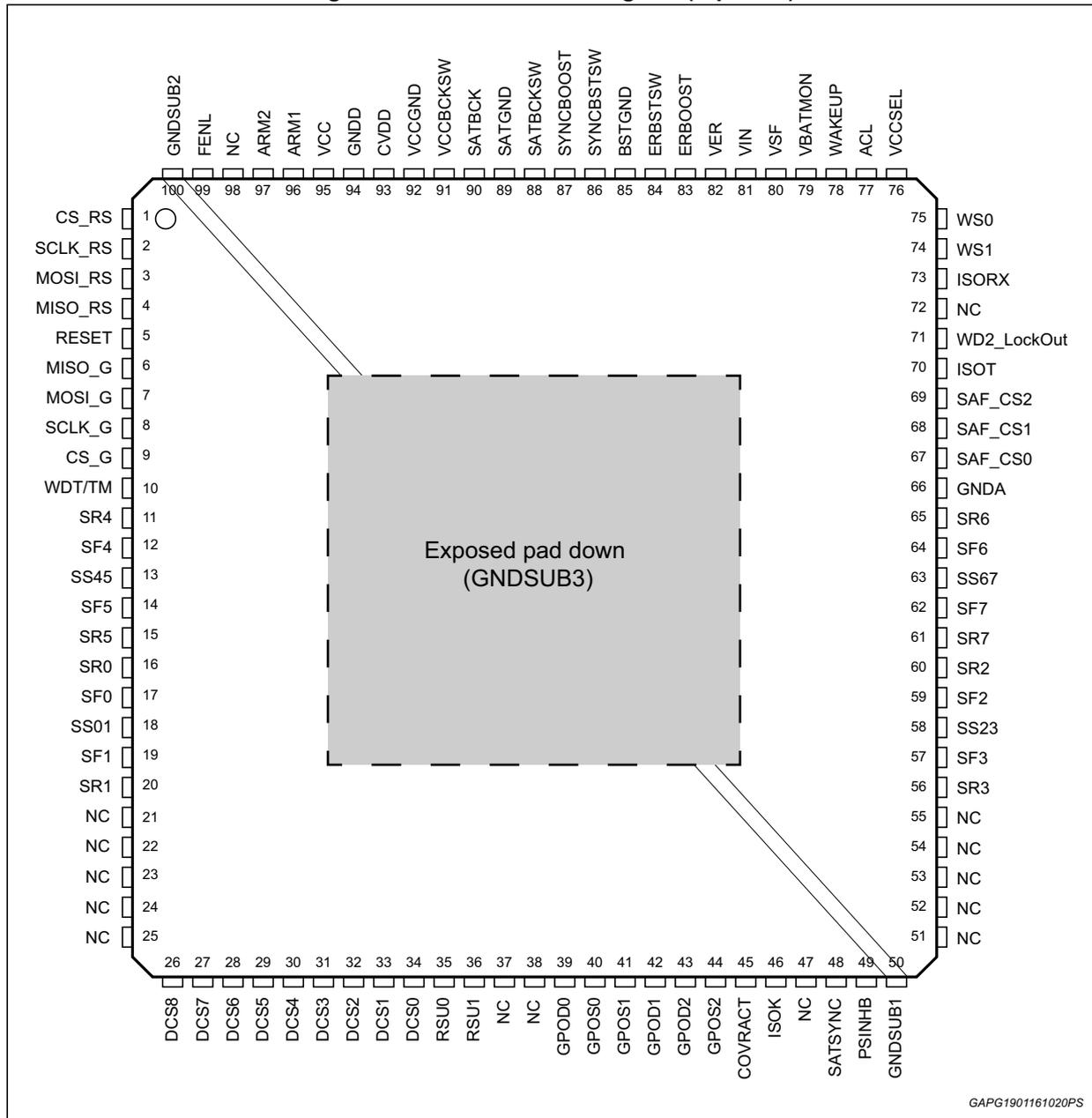
Table 3. Operative maximum ratings (continued)

| Pin # | Pin name         | Pin function                    | Min  | Max            | Unit |
|-------|------------------|---------------------------------|------|----------------|------|
| 96    | ARM1             | Arming Output 1                 | -0.1 | VCC+0.1 <= 5.5 | V    |
| 97    | ARM2             | Arming Output 2                 | -0.1 | VCC+0.1 <= 5.5 | V    |
| 98    | NC               | Not connected                   |      |                |      |
| 99    | FENL             | LS Driver FET control input     | -0.1 | VCC+0.1 <= 5.5 | V    |
| 100   | GNDSUB2          | Substrate ground / Squib ground | -0.1 | 0.1            | V    |
| -     | Exposed Pad Down | Substrate ground / Squib ground | -0.1 | 0.1            | V    |

# 4 Pin out

The L9679P pin out is shown below. The IC is housed in a 100 pin package (14 x 14 x 1.0mm) with a 7.6 x 7.6 mm exposed pad down.

Figure 1. Pin connection diagram (top view)

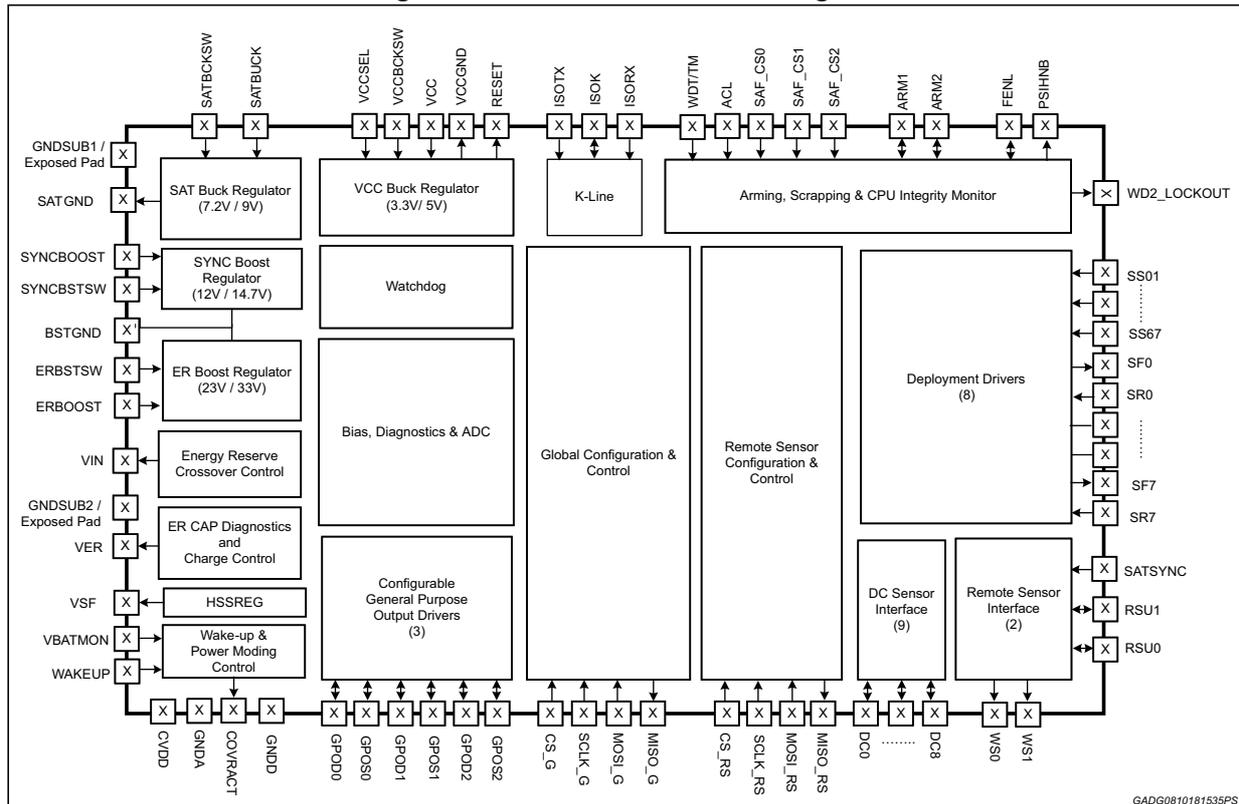


The exposed pad is electrically shorted to the substrate pins GNDSUB1 and GNDSUB2. These three connection nodes are to be kept shorted on the application.

## 5 Overview and block diagram

The L9679P IC is an application specific standard component air bag system chip. Its main functions include, power management, deployment drivers, remote sensor interfaces (PSI-5 satellite sensors), diagnostics, deployment arming, hall-effect sensor interface, general purpose output drivers, watchdog timer and a dedicated passenger airbag disarm signal. A block diagram for this IC is shown in *Figure 2*.

**Figure 2. Device function block diagram**



## 5.1 Power supply

- Integrated 1.882 MHz boost regulator, 33 V  $\pm$  5% or 23 V  $\pm$  5% nominal output
- Integrated 1.882 MHz boost regulator, 12 V/14.75 V nominal output, user selectable via SPI command
- Integrated 1.882 MHz synchronous buck regulator, 7.2 V/9 V  $\pm$  4% nominal output, user selectable via SPI command
- Integrated 1.882 MHz synchronous buck regulator, 5 V  $\pm$  3% or 3.3 V  $\pm$  3% nominal output, user selectable via VCCSEL pin
- Over and under voltage detection and shutdown for all regulators
- Under-voltage lockout to guarantee buck regulator outputs disabled and discharged
- Integrated energy reserve capacitor fixed constant current source (50 mA, nominal) switch for controlled inrush and charge characteristics
- Integrated energy reserve diagnostics, capacitor value and ESR
- Integrated energy reserve crossover switch with current limit and battery input voltage monitoring
- Crossover switch 'active' output signal
- Integrated 25 V/20 V SPI selectable linear regulator for high side safing FET gate supply enabled via SPI or arming logic
- Reset output

## 5.2 Deployment drivers

- 8 high side deployment drivers, 8 low side deployment drivers
- User programmable deployment options
  - 1.20 A or 1.75 A minimum
  - programmable time in 0.1ms increments
- Capability to deploy a squib with a minimum current of 1.2 / 1.75 A and the SFx pin shorted to ground up to 25 V on SSxy
- Independently-controlled high-side and low-side FETs
- Squib resistance measurement
- Firing current monitor feature
- High and low side FET tests
- Open & shorts diagnostics, including between loop drivers
- Independent fire enable logic, SPI and discrete digital input

### 5.3 Remote sensor interfaces

- Two channel receiver
  - standard PSI-5 v1.3 compatible with sync pulse
- Current limit with short circuit protection diagnostics
- PSI-5 satellite sensor mode
  - Auto-adjusting current trip points for each satellite channel
  - Even parity, 8 or 10 bit messages, 125k or 189kbps
  - Satellite message error detection

### 5.4 DC sensor interfaces

- Nine integrated switch interfaces with current sense capability
- Compatible with Hall-effect, resistive and switch sensors
- Current limit protected
- System dedicated path to disable the passenger airbag with input from DC sensor interface

### 5.5 General purpose outputs

- Three configurable high-side or low-side drivers
- ON-OFF mode and PWM 0-100% fine control
- Diagnostics for short circuit protection and open load detection
- Current limit and reverse battery protected

### 5.6 Arming logic

- User configurable safing algorithms with 12 safing records
- Four digital sensor interfaces through SPI
- Independent user programmable thresholds
- Independent user programmable latch timers
- Two discrete and independent arming logic outputs
- Two discrete and independent internal arming signals
- End-of-life interface

## 5.7 Other features

- One dedicated 32-bit SPI bus for global configuration and control
- One dedicated 32-bit SPI bus for remote sensor configuration and control
- Integrated watchdog control with 2 independent structures: windowed WD and algorithmic WD
- Temperature sensor
- Independent thermal shutdown protection on the ER boost switch, the SYNC boost switch, the energy reserve crossover switch, the energy reserve charge paths, the remote sensor interfaces and the general purpose outputs
- All diagnostics are digital and are available through SPI communications
- Configurable logic operation, 5 V or 3.3 V

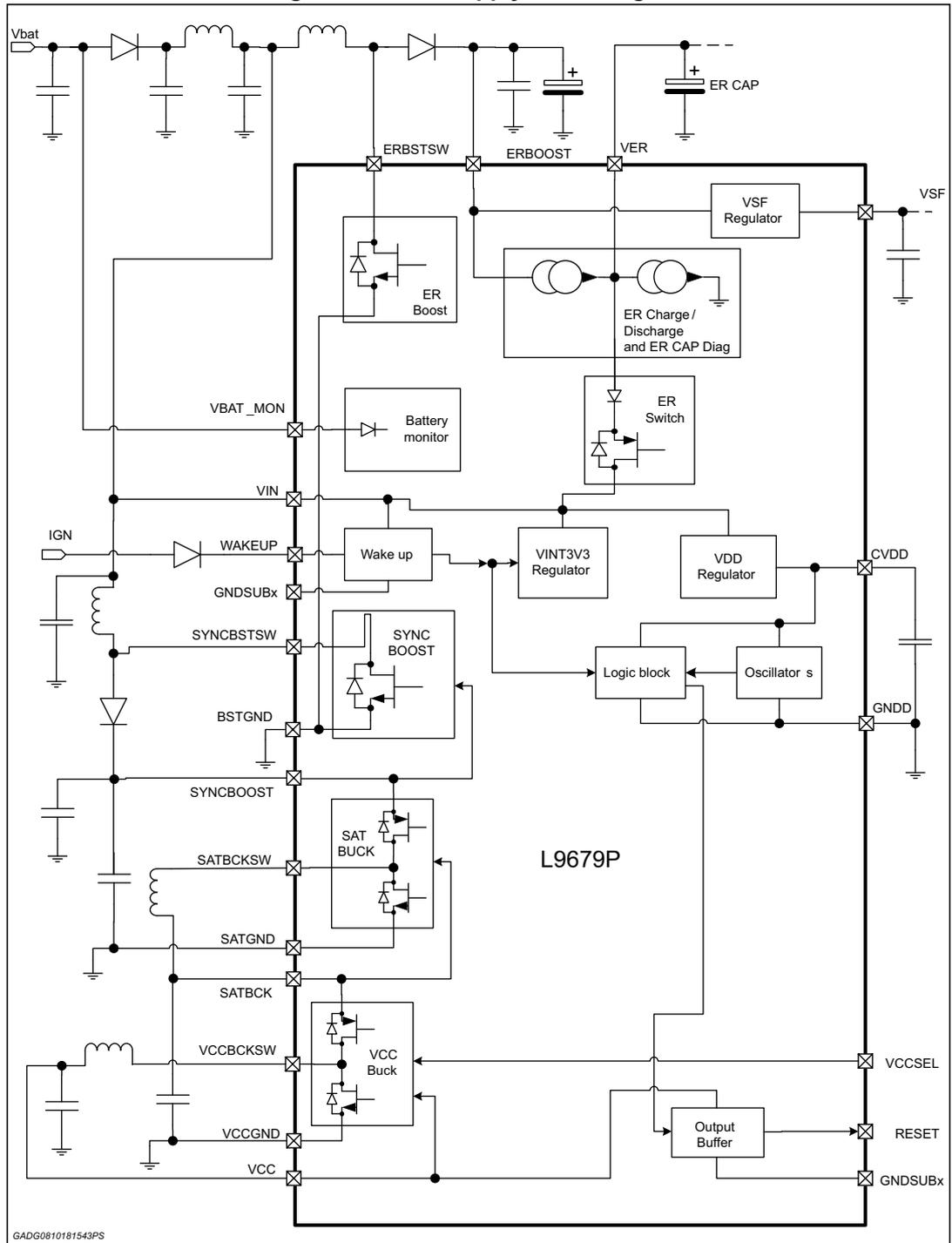
## 6 Start-up and power control

### 6.1 Power supply overview

The L9679P IC contains a complete power management system able to provide all necessary voltages for a high feature airbag system or integrated safety system. A general block diagram is shown in [Figure 3](#). The power supply block contains the following features:

- Two 3.3 V internal regulators for operating internal logic (CVDD) and analog circuits (VINT3V3). An external CVDD pin is used to provide filtering capacitance to digital section supply rail.
- Energy reserve supply (ERBOOST) achieved through an integrated 1.882 MHz switching boost regulator. The energy reserve capacitor is charged using an internal constant current source controllable through SPI. Besides, a second current source is available to discharge the capacitor. The primary function for the second current source is to diagnose the integrity of the energy reserve capacitor, value and ESR. During system shutdown, the device can enable the discharge current source via SPI command to quickly dissipate the remaining energy stored in the energy reserve capacitor.
- Sync pulse supply (SYNCBOOST) is achieved through an integrated 1.882 MHz switching boost regulator. The SYNCBOOST regulator ensures a minimum voltage is available for operating the satellite sync signal and also provides the input voltage to the remote sensor buck regulator. The sync pulse boost regulator is disabled for battery voltage levels resulting in an output voltage above the set regulation point.
- The integrated current limited ER switch requires no external components. This switch is controlled through the integrated power control state machine and is enabled either once a loss of battery is detected or a shutdown command is received. Under the same conditions also the discrete digital pin COVRACT is activated allowing the control of an external optional cross-over switch.
- Two 1.882MHz synchronous buck regulators for remote sensor supply and VCC. The SATBUCK regulator, remote sensor buck supply, is sourced from the SYNCBOOST regulator and can be selected to be either 7.2 V or 9 V nominal. The VCC regulator is sourced from the SATBUCK regulator and is user selectable through the VCCSEL pin to either 5 V or 3.3 V nominal voltage.
- Battery voltage sense input comparator with hysteresis and wake-up input are the primary control signals for the power supply control state machine.
- Based on own mission profile and ECU total current consumption, the user must evaluate if the activation of fast slope option of each ERBoost, SyncBoost and SatBuck regulator (bit 8/9/10, \$3F SW\_REGS\_CONF SPI register) is needed to increase the overall efficiency.

Figure 3. Power supply block diagram

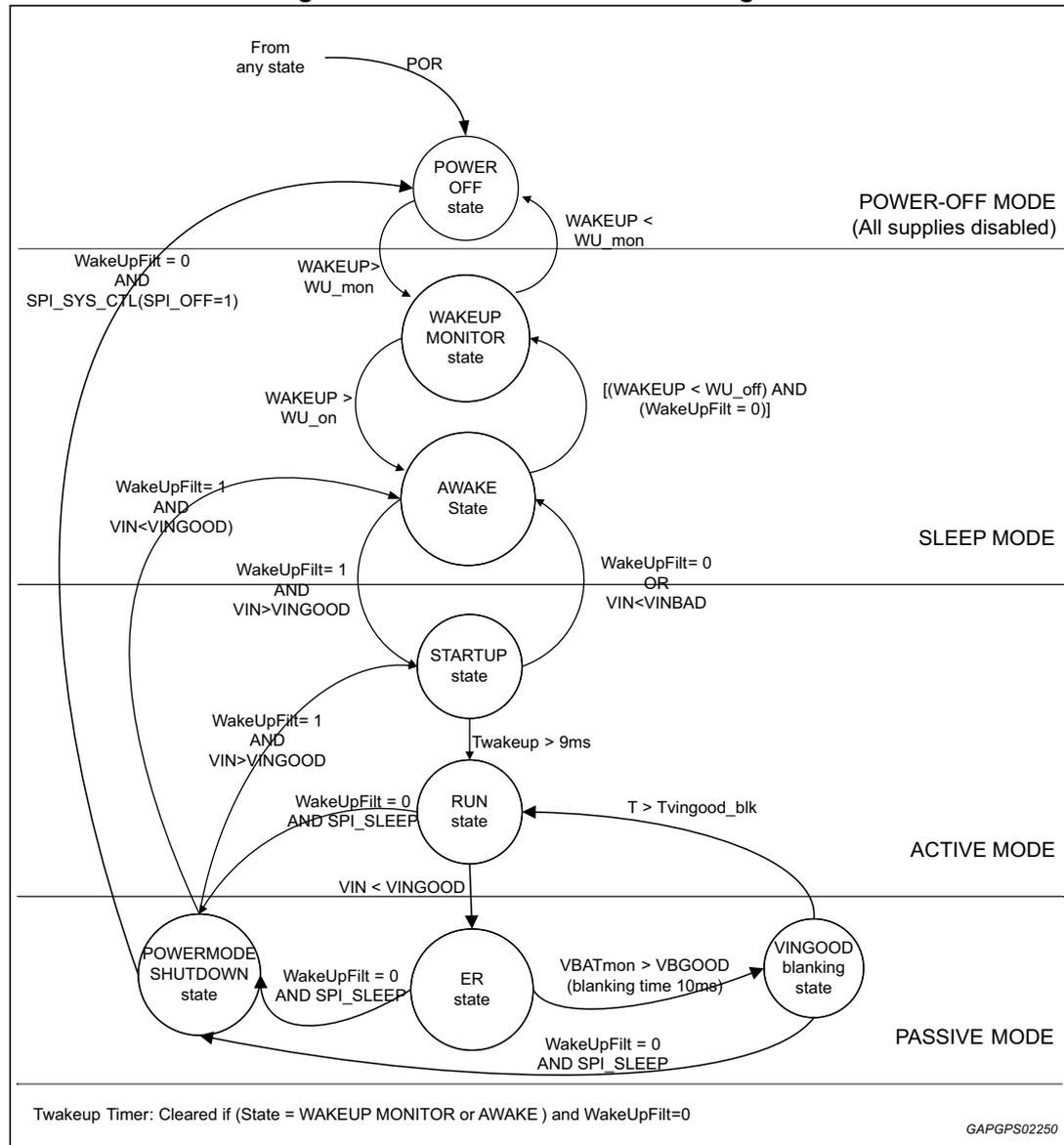


## 6.2 Power mode control

Start-up and power down of the L9679P are controlled by the WAKEUP pin, VBATMON pin, VIN pin, device status and the SPI interface. There are four main power modes: power-off, sleep, active and passive mode.

Each power mode is described below and represented in the state flow diagram shown in [Figure 4](#). The descriptions include references to conditions and sometimes nominal values. The absolute values for each condition are listed in the electrical specifications section.

**Figure 4. Power control state flow diagram**



### 6.2.1 POWER OFF mode

During the POWER-OFF Mode all supplies are disabled keeping the system in a quiescent state with very low current draw from battery. As soon as WAKEUP>WU\_mon the IC will move to SLEEP Mode.

### 6.2.2 SLEEP mode

During the Sleep mode the VINT3V3 and CVDD internal regulators are turned on and the IC is ready for full activation of all the other supplies. As soon as VIN voltage is over a minimum threshold, all the other supplies are turned on and the IC enters the ACTIVE mode.

### 6.2.3 ACTIVE mode

This is the normal operating mode for the system.

All power supplies are enabled and the energy reserve boost converter starts to increase the voltage at ERBOOST. Likewise, the SYNCBOOST boost converter continues to charge and regulate to a nominal 12 V (default level at startup). Once the SYNCBOOST has reached a good value, the SATBUCK regulator starts up. In turn, when SATBUCK has ramped up, VCC regulator is enabled. Once the VCC buck regulator is in regulation, RESET is released allowing the system microcontroller and other components to begin their power-on sequence. Among these, also the ER charge current generator can be enabled by the microcontroller via a dedicated SPI command.

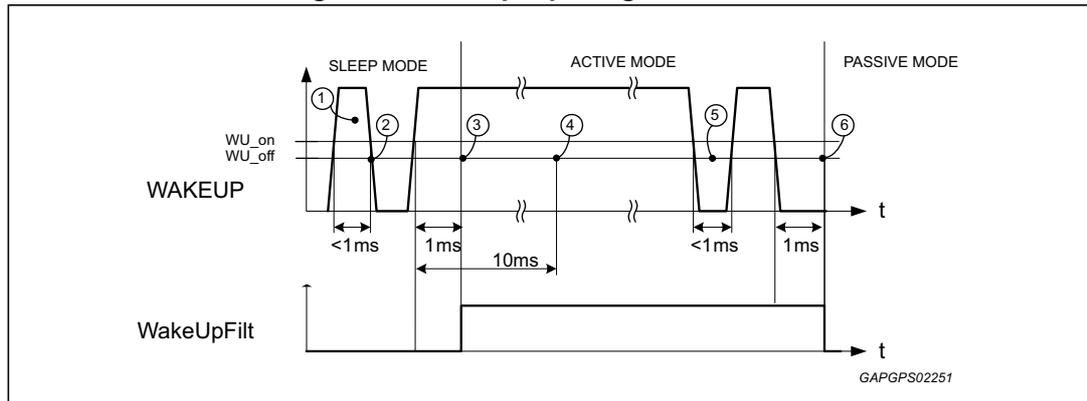
The active mode can be left when either WAKEUP pin or VIN voltage drop down. For the very first 9ms after having entered the active mode, the WAKEUP pin low would immediately cause the IC to switch back to sleep mode. After that time, WAKEUP pin low must be first confirmed by a  $\mu\text{C}$  SPI\_SLEEP command prior to cause the system to switch to passive mode. Passive mode is also entered in case of VIN voltage low.

### 6.2.4 PASSIVE mode

In this state, the reserve capacitor charge current and the ERBOOST boost converter are disabled. When in passive mode the device activates both the COVRACT output pin and the integrated ER switch to allow VIN to be connected to the ER capacitor. In this time, VIN is supposed to be increased up to almost VER level and the system operation relies on energy from the ER capacitor. Two scenarios are possible: high or low battery. If  $V_{IN} < V_{INGOOD}$ , the device moved from RUN state in ACTIVE mode to the ER state. Here, the ER capacitor is depleted while supplying all the regulators until the POR on internal regulator occurs. The threshold to decide the ER switch activation is based on VIN, because VIN is the supply voltage rail for ERBOOST regulator. If the device has still a good battery level, it entered the POWERMODE SHUTDOWN thanks to a microcontroller command to switch off. In this case, the VER node will be discharged down to approximately VIN level, which then will be supplied out of the battery line. System will continue to run up to a dedicated SPI command to disable the SATBUCK regulator, which will lead the device to enter the POWEROFF state.

The wake-up pin is filtered to suppress undesired state changes resulting from transients or glitches. Typical conditions are shown in the chart below and summarized by state.

Figure 5. Wake-up input signal behaviour



Condition summary:

1. No change of sleep mode state but current consumption may exceed specification for sleep mode.
2. The sleep mode current returns to within specified limits.
3. Power supply exits sleep mode. Switchers start operating if applicable voltages exceed under voltage lockouts. As  $T_{\text{wakeUp}}$  timeout is not elapsed, a low level at WAKEUP instantaneously sends the system back to sleep.
4. Sleep reset is released and the entire system starts operating. An SPI command to enter sleep state would not be executed.
5. No change in system status, an SPI command to turn off switchers would be ignored.
6. No change in system status, but an SPI command to turn off switchers would be accepted and turn the system off.

With the below table, all the functionalities of the device are shown with respect of the power states. When one function is flagged, the related circuitry cannot be activated on that state.

Table 4. Functions disabling by state

| Functions                | Power MODE |                |       |         |     |                     |    |                  |
|--------------------------|------------|----------------|-------|---------|-----|---------------------|----|------------------|
|                          | Power off  | Sleep          |       | Active  |     | Passive             |    |                  |
|                          | Power off  | Wakeup monitor | Awake | Startup | Run | Power mode shutdown | ER | VINGOOD blanking |
| Wakeup detector          | X          |                |       |         |     |                     |    |                  |
| Internal regulators      | X          | X              |       |         |     |                     |    |                  |
| ERBOOST regulator        | X          | X              | X     |         |     | X                   |    |                  |
| SYNCBOOST regulator      | X          | X              | X     |         |     |                     |    |                  |
| ER CAP charge current    | X          | X              | X     |         |     | X                   | X  | X                |
| ER CAP discharge current | X          | X              | X     |         |     |                     | X  | X                |
| ER switch                | X          | X              | X     | X       | X   |                     |    |                  |
| COVRACT                  | X          | X              | X     | X       | X   |                     |    | X                |

Table 4. Functions disabling by state (continued)

| Functions                | Power MODE |                |       |         |     |                     |    |                  |
|--------------------------|------------|----------------|-------|---------|-----|---------------------|----|------------------|
|                          | Power off  | Sleep          |       | Active  |     | Passive             |    |                  |
|                          | Power off  | Wakeup monitor | Awake | Startup | Run | Power mode shutdown | ER | VINGOOD blanking |
| SATBUCK regulator        | X          | X              | X     |         |     |                     |    |                  |
| VCC regulator            | X          | X              | X     |         |     |                     |    |                  |
| Deployment Drivers       | X          | X              | X     |         |     |                     |    |                  |
| VSF Safing FET regulator | X          | X              | X     |         |     |                     |    |                  |
| Remote Sensor Interfaces | X          | X              | X     |         |     |                     |    |                  |
| Watchdog                 | X          | X              | X     |         |     |                     |    |                  |
| Diagnostics              | X          | X              | X     |         |     |                     |    |                  |
| DC Sensor Interface      | X          | X              | X     |         |     |                     |    |                  |
| GPO drivers              | X          | X              | X     |         |     |                     |    |                  |
| Safing Logic             | X          | X              | X     |         |     |                     |    |                  |

### 6.2.5 Power-up and power-down sequences

The behaviour of the IC during normal power-up and power-down is shown in *Figure 6* to *Figure 9*. The following sequences represent just a subset of all possible power-up and power-down scenarios. In *Figure 6* a normal IC power-up controlled by the state of the WAKEUP pin is shown.

Figure 6. Normal power-up sequence

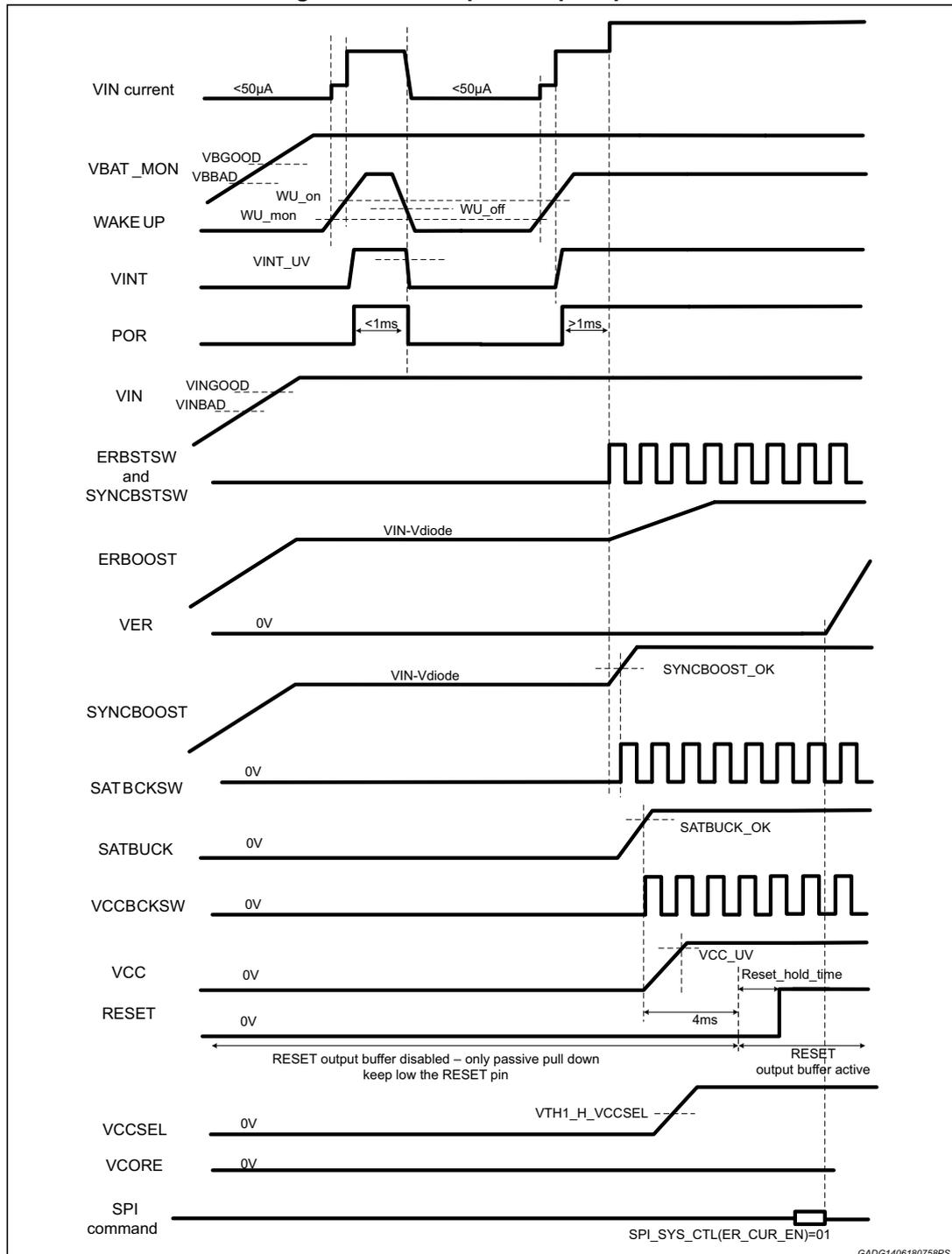
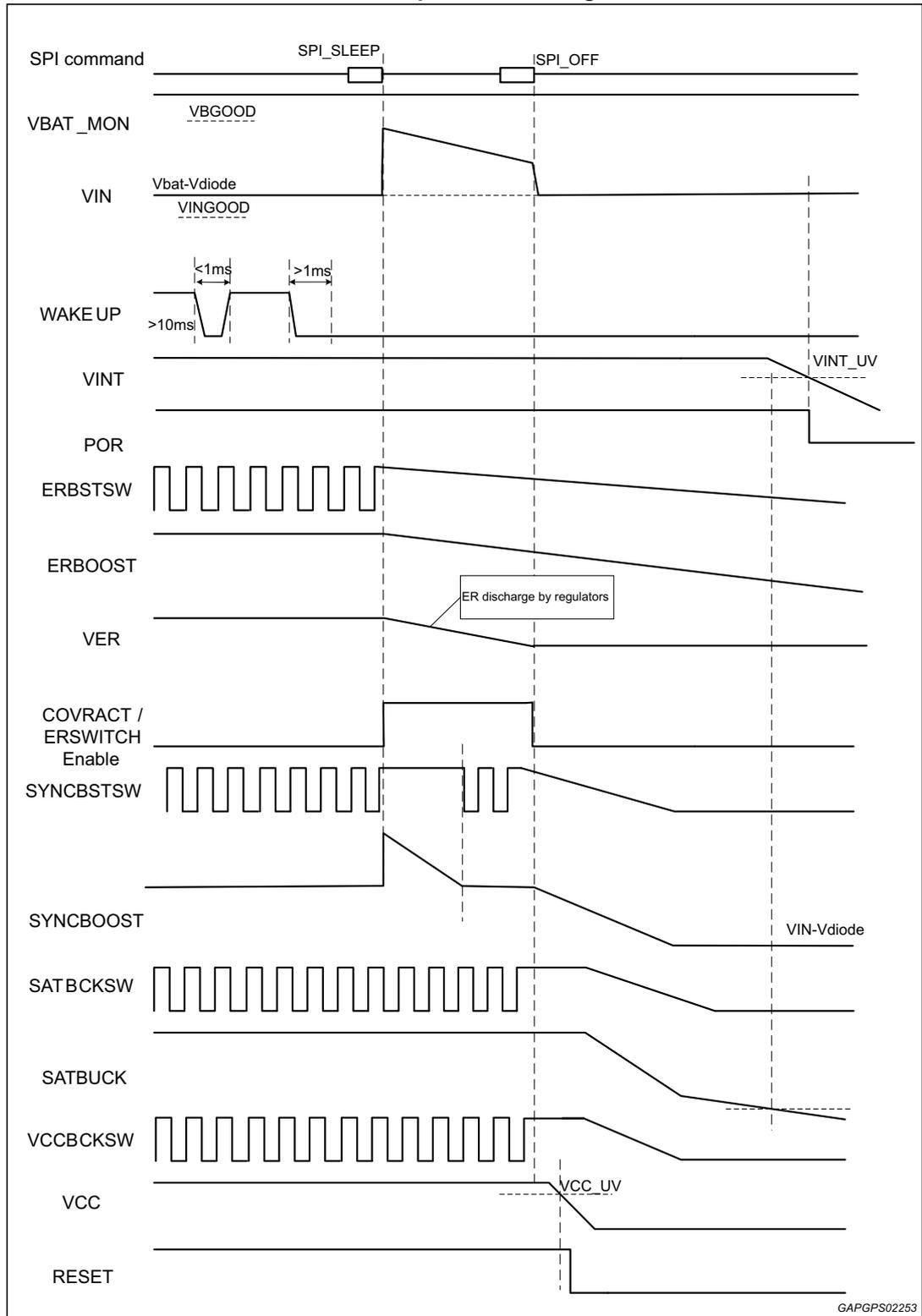


Figure 7. Normal power down sequence through POWERMODE SHUTDOWN state - no ER capacitive discharge



**Figure 8. Normal power down sequence through Powermode Shutdown state - ER capacitive discharge**

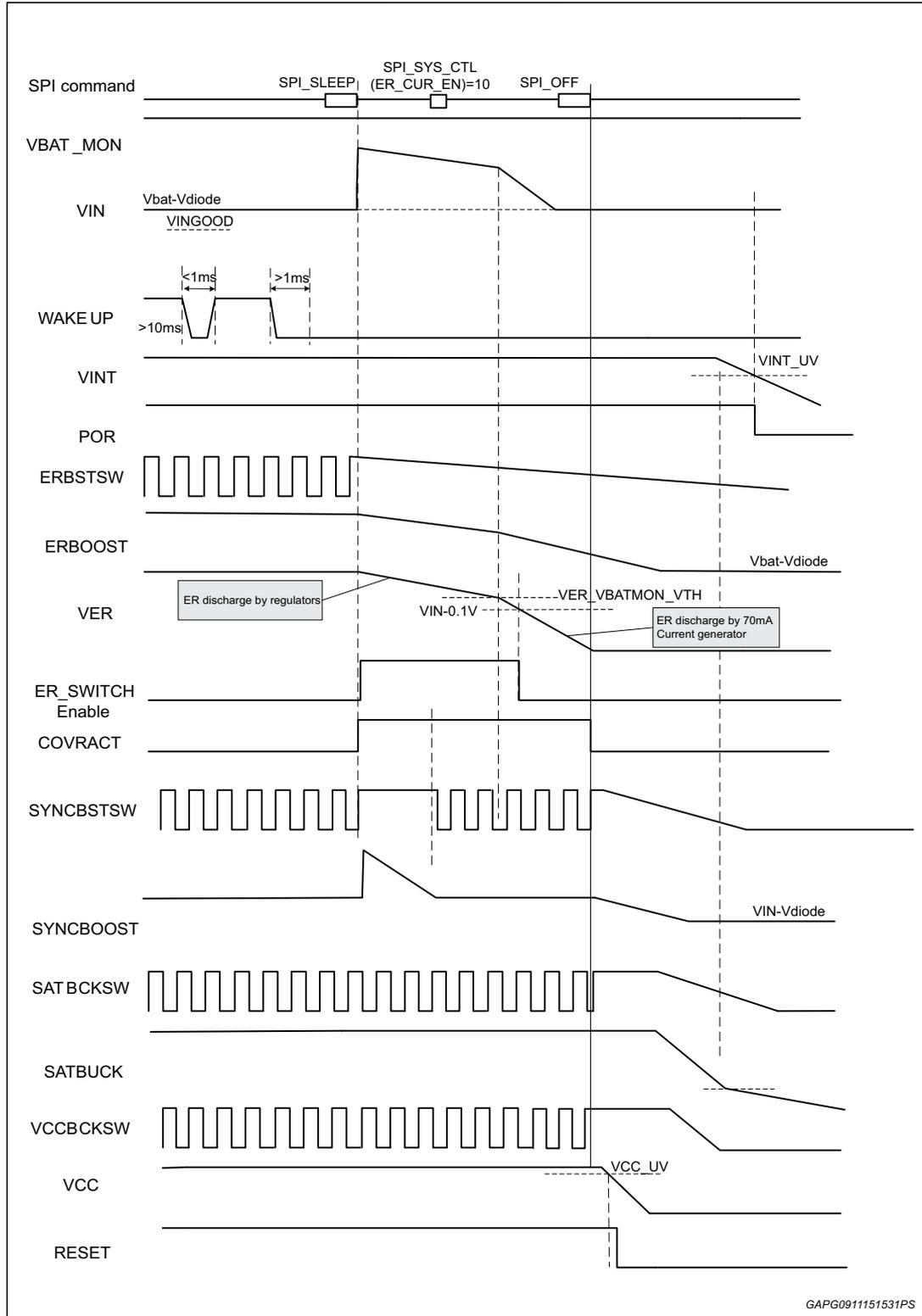
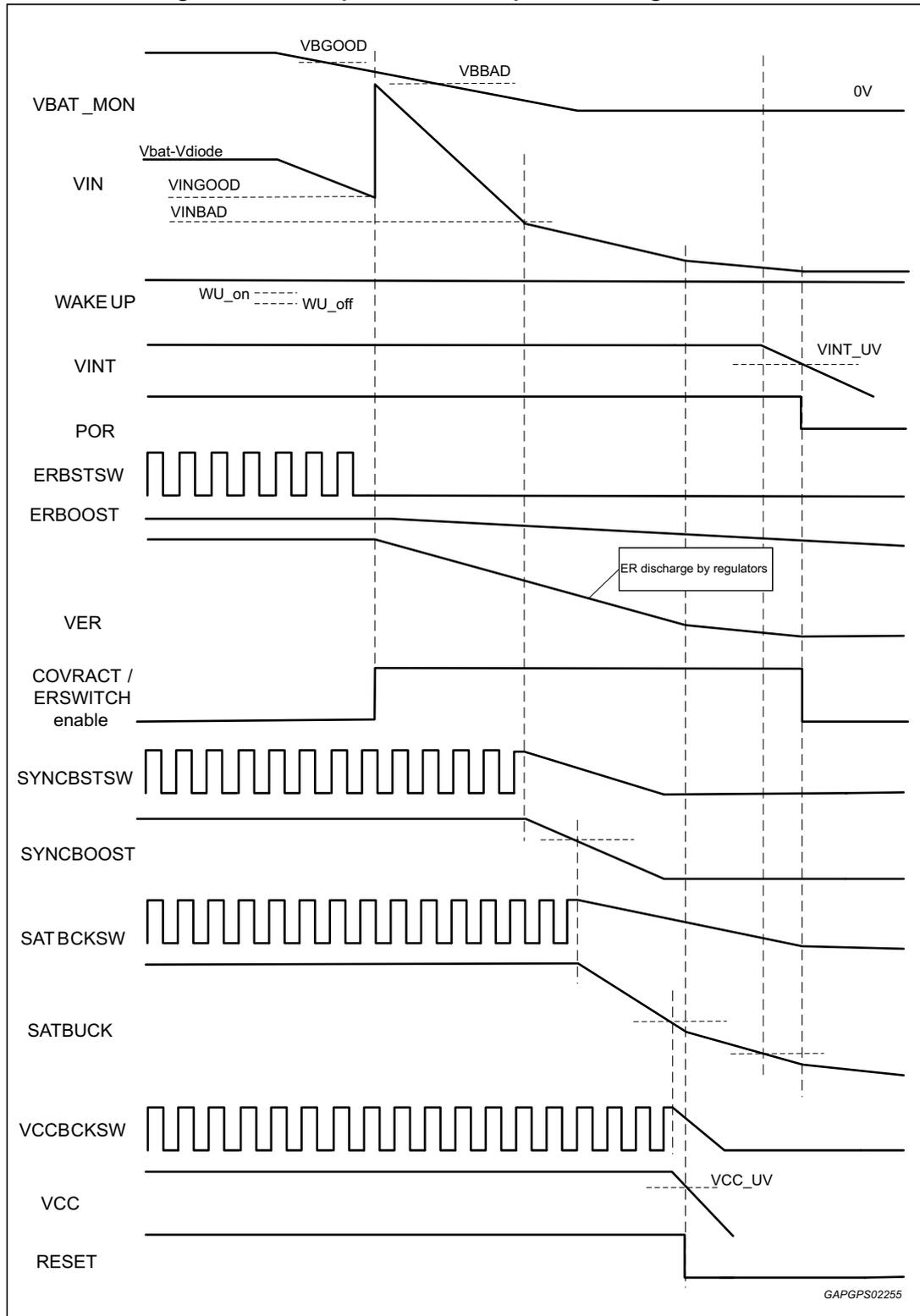


Figure 9. Normal power down sequence through ER state



## 6.2.6 IC operating states

Different states can be identified while operating the device. These states allow safe and predictable initialization, test, operation and final disposal of the part (scrapping).

As soon as the RESET signal is de-asserted at the beginning of the ACTIVE mode, the microcontroller powers up. At this stage, L9679P is in the Init state: during this state the device must be initialized by the controller. In particular, the watchdog timer window can be programmed during this state.

When the watchdog service begins (upon the first successful watchdog feed), the device switches to Diag state for diagnostics purposes. The remaining configuration of the device is allowed in this state, in particular for safing records and deployment masks. Several tests are also enabled while in this state and all these tests are mutually exclusive to one another. HS and LS switch tests of the squib drivers can only be processed during this Diag state. Also high side safing FET can only be run during this state. When not in Diag state, any commands for squib driver switch tests will be ignored. Other checks are also performed: on the arming outputs to check for non-stuck-at conditions on the pins and on the configured firing time configuration through one of the ARMx pin. The SSM remains in this state until commanded to transition into the Safing state or Scrap state via the dedicated SPI commands.

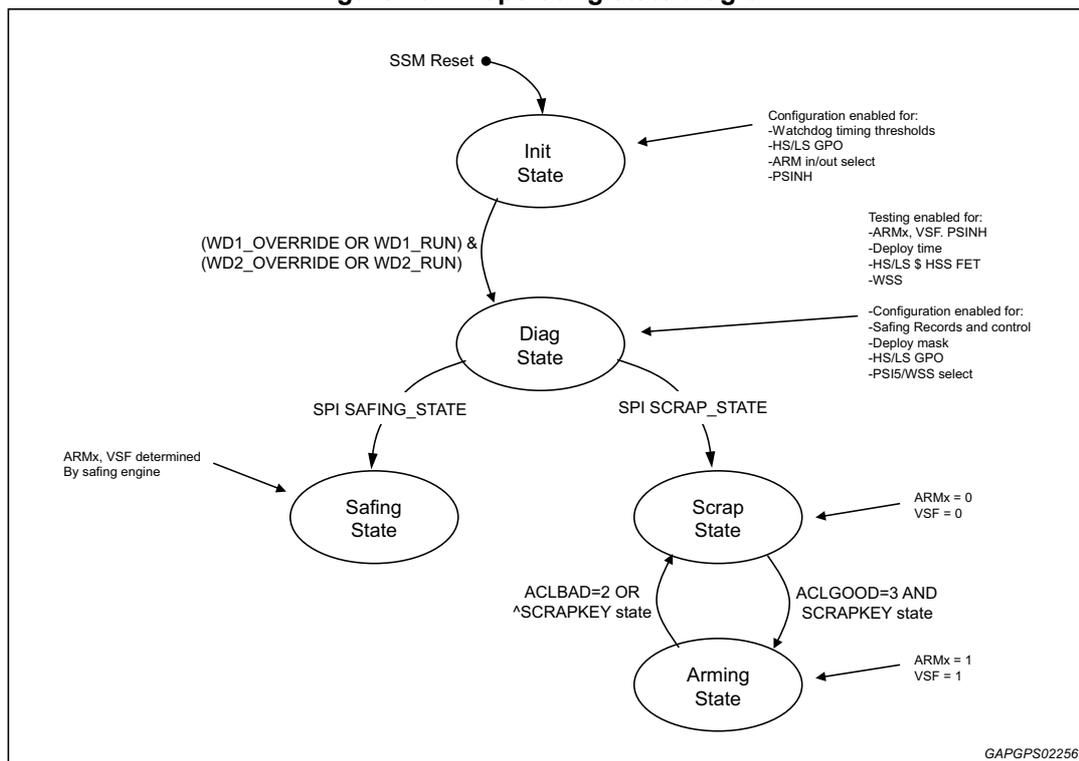
Upon reception of the SAFING\_STATE command while in Diag state, the device enters Safing state. This is the primary run-time state for normal operation, and the logic performs the safing function, including monitoring of sensor data and setting of the ARMx signals. The only means of exiting Safing state is by the assertion of the SSM\_Reset signal.

The Scrap state is entered upon reception of the SCRAP\_STATE command while in Diag state. While in Scrap state, the part allows the main microcontroller to initiate a transition to Arming state, and monitoring of the Remote Sensor SPI interface and the safing logic is disabled. From Scrap state, the device can transition to Arming state only, and the only means of moving back to Init state is through an SSM\_Reset.

In order to protect from inadvertent entry into Arming state, and to prevent undesired activation of the safing signals, a handshake mechanism is used to control entry into, and exit from Arming state. This handshake is described further in Section 11.6. While in Arming state, the arming outputs are asserted. Exit from Arming state occurs when the periodic SCRAP\_KEY commands cease (timeout), the key value is incorrect, or when SSM\_Reset is asserted. Upon exit, the device re-enters Scrap state, except for the case of SSM\_Reset, which results in entry into Init state.

The device operating states are shown in [Figure 10](#).

Figure 10. IC operating state diagram



### 6.3 ERBOOST switching regulator

The L9679P IC uses an advanced energy reserve switching regulator operating at 1.882MHz nominal. The higher switching frequency enables the user to select smaller less expensive inductors and moves the operating frequency to permit easier compliance with system emissions.

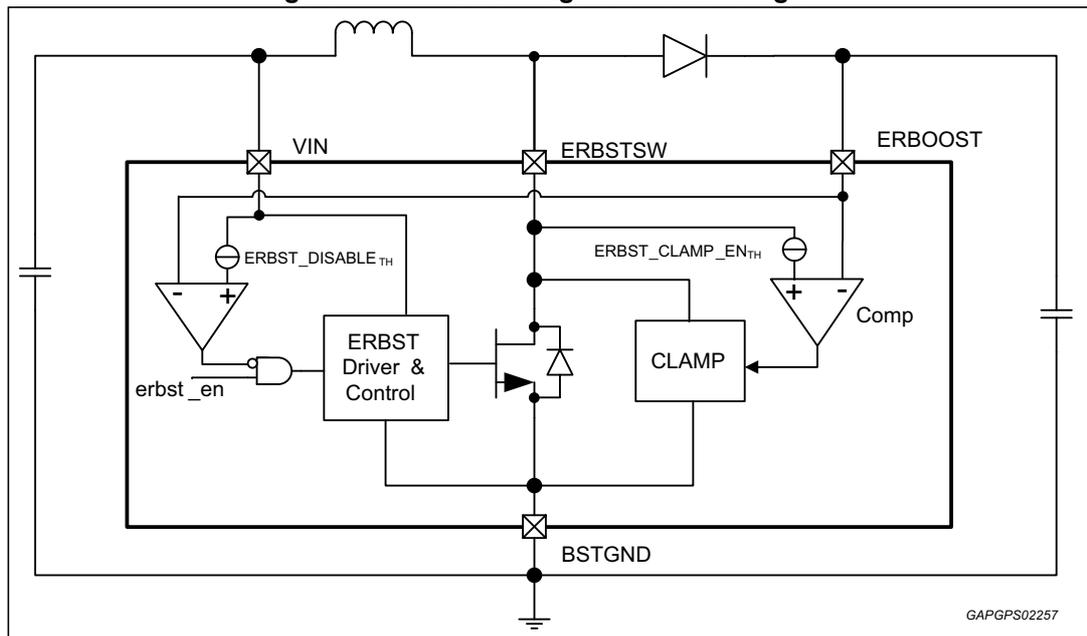
The ERBoost switching regulator uses a classical peak current mode control loop to properly regulate the output voltage and includes an over-voltage protection that immediately switch off the PowerMOS to protect the device. The regulator includes also a soft start circuit which apply a ramp on the over current threshold from the 40% of IOC\_ERBST value to the maximum one with 16 steps and within  $T_{SOFTST\_OC\_ERBST}$ . The soft start is restarted every time the regulator has a transition from the ER\_BST\_OFF to the ER\_BST\_ON state.

The energy reserve boost regulator charges the external system tank capacitor through an integrated fixed current source significantly reducing in-rush currents typical of large energy reserve capacitors. The boost circuit provides energy for the reserve capacitor with assumed run time load of less than 20 mA and to the VSF regulator. Once system shutdown is initiated or a loss of battery condition is diagnosed, the boost regulator is by default disabled so that system power can be taken from the energy reserve capacitor. Alternatively, the ER Boost could be kept on even during the ER State by setting the SYS\_CFG(KEEP\_ER\_BOOST\_ON) bit.

The energy reserve boost regulator defaults to 23 V at power-on and can be set to 33 V nominal by the user through an SPI command. The boost converter can also be disabled by the user through an SPI command. Enabling, disabling and setting the boost output voltage

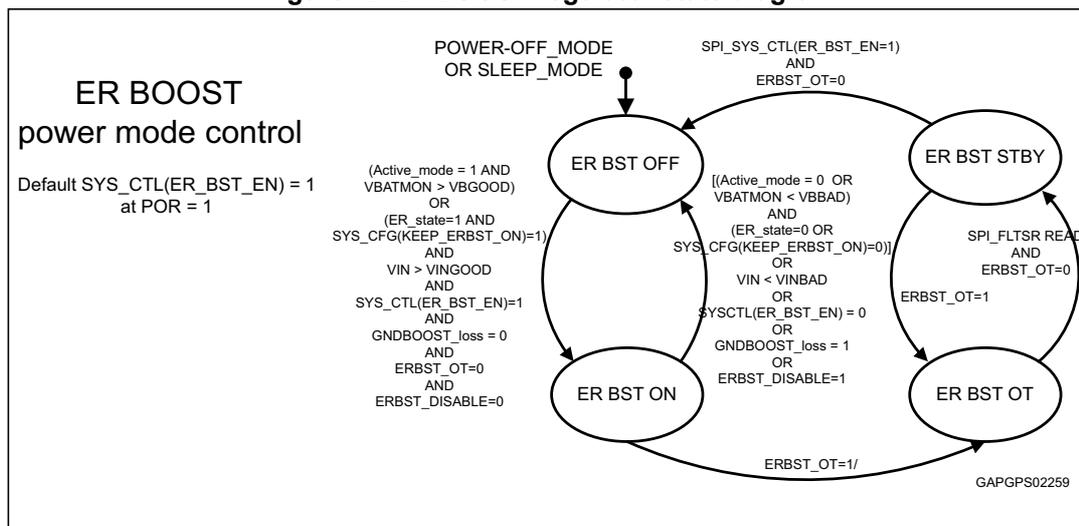
is done through the System Control (SYS\_CTL) register. Boost converter diagnostics include over voltage and under voltage and the circuit is fully protected against shorts. Boost fault status is available through the SPI in Fault Status Register (FLTSR). The integrated FET featuring the boost switch is protected against short to battery by means of a thermal shutdown circuit. When thermal fault is detected the FET is switched off and latched in this state until the related fault flag ERBST\_OT in the FLTSR register is read. In case of loss of BSTGND ground the FET is not turned on. Loss of ground can be detected also when the FET is off thanks to a pull-up current present on the BSTGND pin. The FET will be automatically reactivated as soon as ground connection is restored. Over-voltage protection from load dump and inductive flyback is provided via an active clamp and an ER\_Boost disable circuitry, see [Figure 11](#).

**Figure 11. ERBOOST regulator block diagram**



Normal run time power for the system is provided directly from the battery input, not from the boost. Boost energy is available to the system through the energy reserve crossover switch once battery is lost or a commanded system shutdown is initiated.

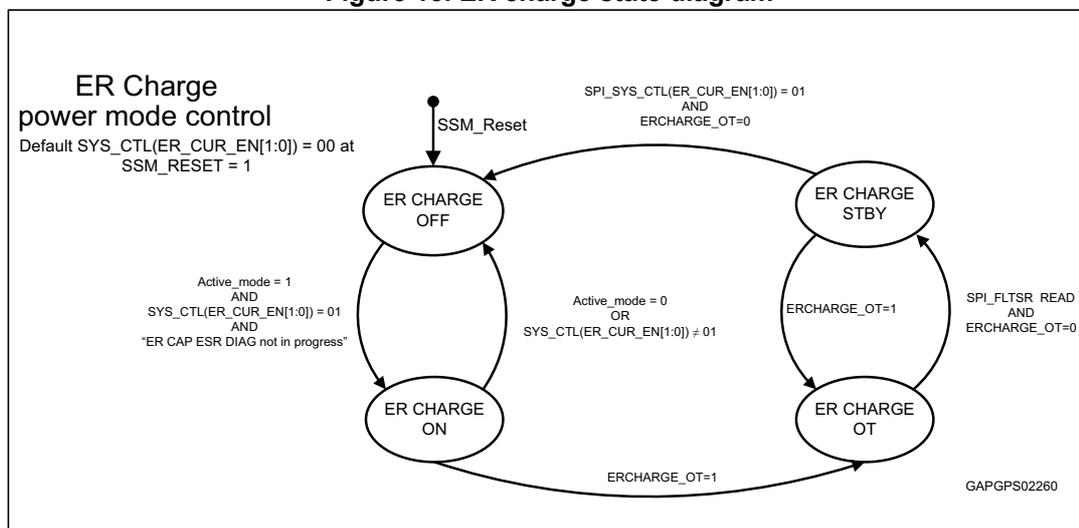
Figure 12. ERBOOST regulator state diagram



### 6.4 Energy reserve capacitor charging and discharging circuits

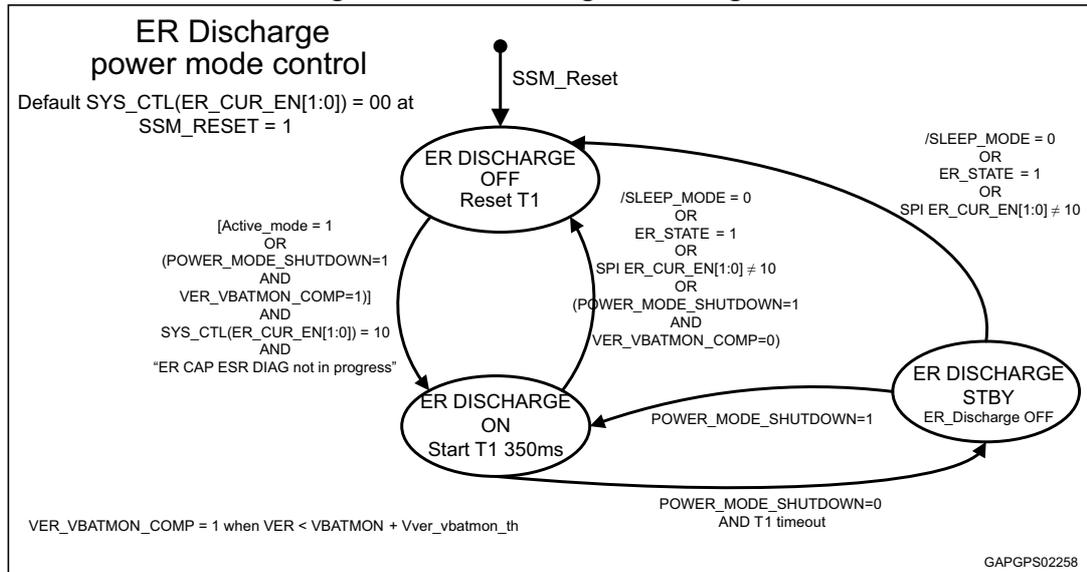
The energy reserve capacitor connected to VER pin can be charged in an efficient way by means of a current generator. Its capability is 50 mA nominal, so that for example a 10 mF capacitor can be charged in approximately 4.8 s to 24 V. The current generator is activated or deactivated by SPI command only while in ACTIVE mode. When not in ACTIVE mode, the generator is always switched off in order to decouple ERBOOST node voltage from VER reserve voltage.

Figure 13. ER charge state diagram



L9679P also offers a safe control to discharge the ER capacitor by means of a fixed current generator. This discharge can be controlled via SPI command while not in SLEEP mode. Furthermore, this discharge circuit is mutually exclusive with the ER charging circuit, to avoid inefficient way of controlling the charge on the VER energy reserve capacitor.

Figure 14. ER discharge state diagram



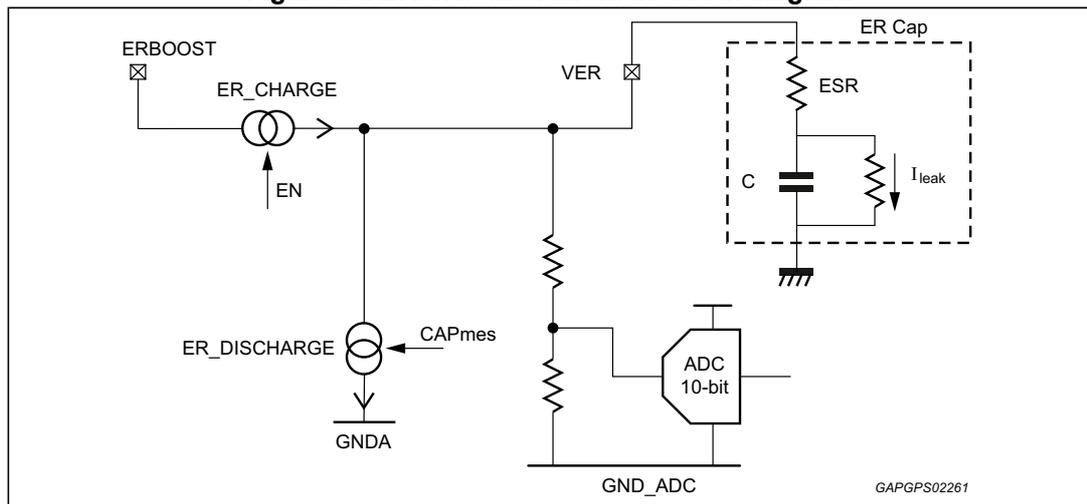
## 6.5 ER CAP diagnostic

The L9679P IC contains a full integrated solution to check the connection, value and series resistance of energy reserve capacitor independent from ER Cap leakage current and Boost Voltage level.

### 6.5.1 ER CAP measurement

The IC contains two current generators used to charge and discharge the energy reserve capacitor connected on ER pin. The simplified block diagram is shown in the figure below.

Figure 15. ER CAP measurement block diagram

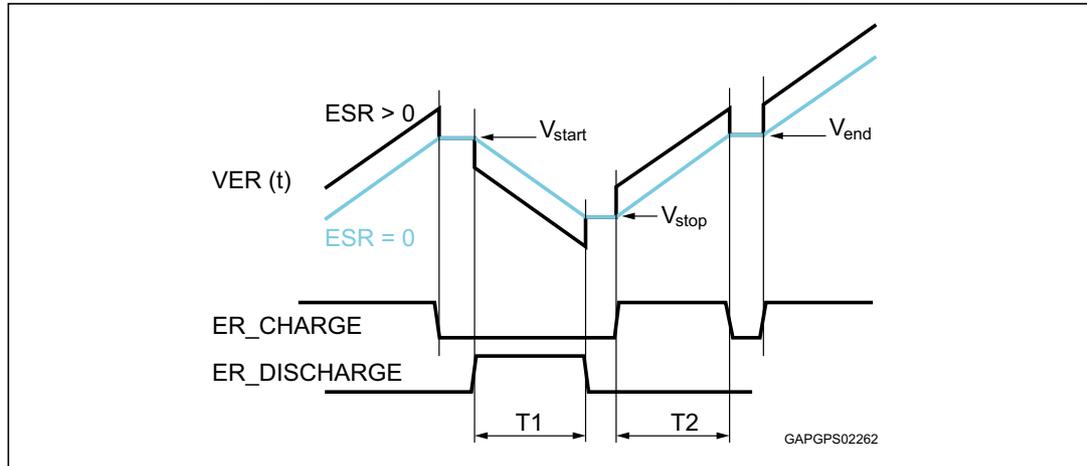


To obtain an accurate ER CAP measurement, the VER voltage conversion must be required when both current generators are off, namely no current flows through ER cap permits to avoid ESR error contribution.

The user can decide the charge and discharge time based on the ER CAP used in application, in order to maximize the differential voltage and then improve the accuracy.

Anyway, a timeout on ER Discharge current has been implemented to prevent thermal issue, so the discharge time cannot be longer than 350 ms.

Figure 16. ER CAP measurement timing diagram



The following formulas can be used to retrieve the ER CAP value from the voltage and timing measurements.

$$\Delta V_1 + \Delta V_2 = \frac{I_1 + I_{LEAK}}{C} T_1 + \frac{I_2 - I_{LEAK}}{C} T_2$$

$$C = \frac{2 \cdot I \cdot T}{V_{start} + V_{end} - 2 \cdot V_{stop}}$$

T<sub>1</sub> = discharge time

T<sub>2</sub> = charge time, same as discharge time

T<sub>1</sub> = T<sub>2</sub> = T

ΔV<sub>1</sub> = V<sub>start</sub> - V<sub>stop</sub>

ΔV<sub>2</sub> = V<sub>end</sub> - V<sub>stop</sub>

I<sub>1</sub> = discharge current

I<sub>2</sub> = charge current, same as discharge current

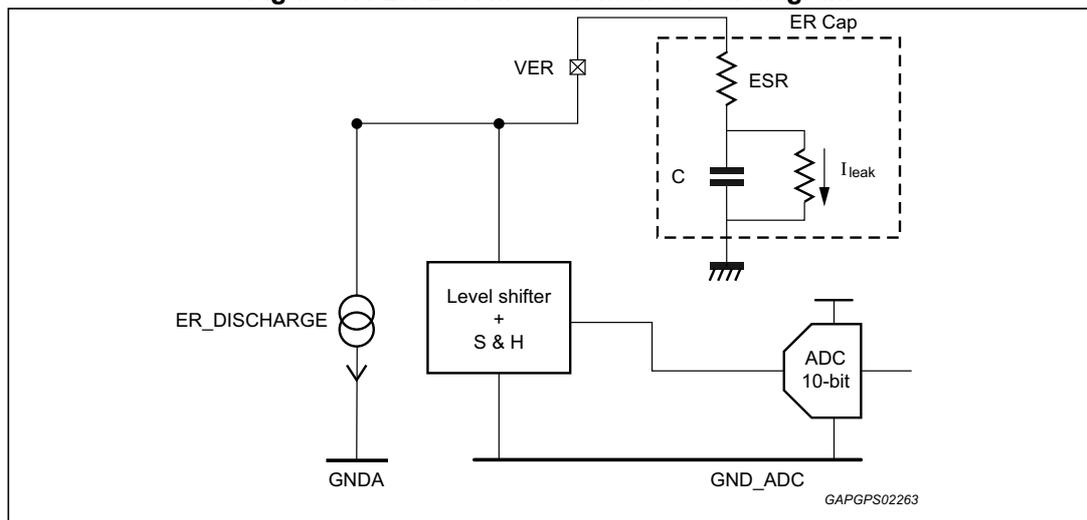
I<sub>1</sub> = I<sub>2</sub> = I

I<sub>LEAK</sub> = leakage current

### 6.5.2 ER CAP ESR measurement

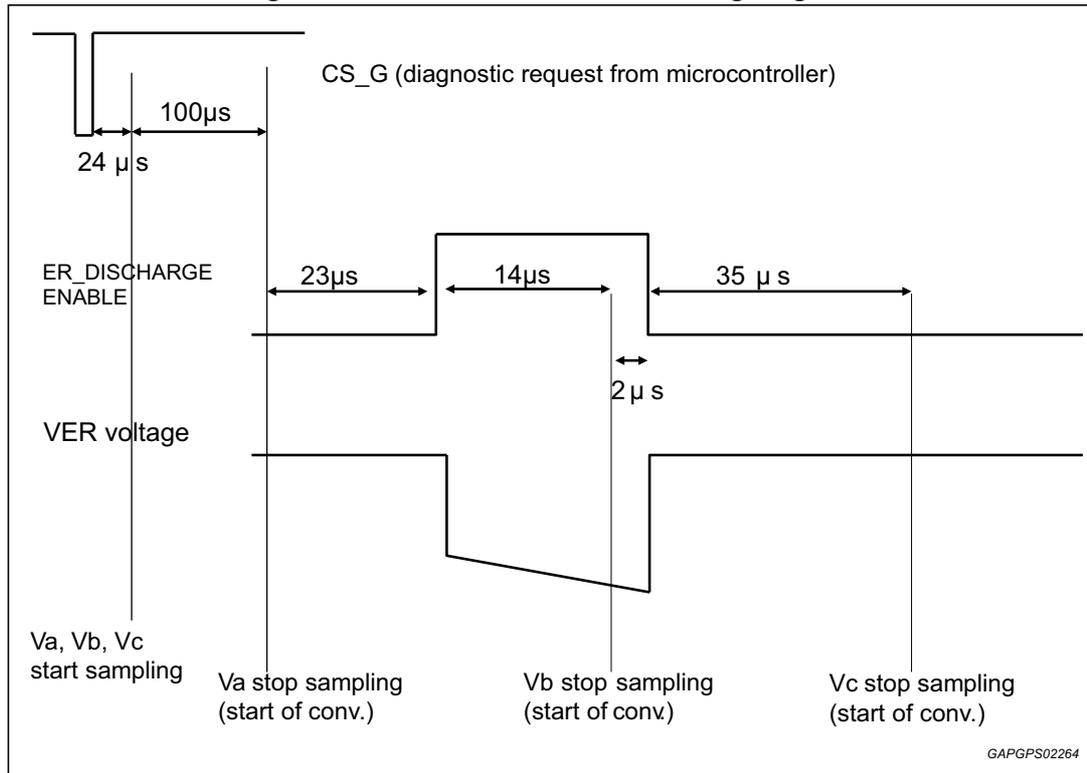
The IC contains the capability to perform a measurement of the equivalent series resistance of energy reserve capacitor. In this case the discharge current is 10 times higher to create a voltage difference proportional to the ER CAP ESR. The voltage measurement and conversion is automatically executed once the user requires the ESR measurement through the LPDIAGREQ register.

Figure 17. ER ESR measurement block diagram



Upon an ESR measurement is requested, the IC executes an internal automatic sequence to take three voltage measurements at the ER node, toggling the ER discharge current source on and off as shown in [Figure 18](#). The test lasts for  $T_{\text{ESR\_DIAG}}$ . After this time has elapsed, the results can be retrieved by reading the **DIAGCTRL\_x** registers. The three ER voltage measurements are provided at the same time in **DIAGCTRLA**, **DIAGCTRLB** and **DIAGCTRLC** registers. During the execution of the ESR measurement no other activity on ADC is allowed. The user must ensure no other ADC requests are queued to be executed at the same time of ESR measurement. The ESR diagnostic, once initiated, will continue without interruption even if the device enters in ER State because of a battery loss event.

Figure 18. ER ESR measurement timing diagram



The ER CAP ESR can be calculated according to the following formula:

$$ESR_{ERCAP} = \frac{V_C - V_B}{G_{ER\_ESR} \cdot I_{ER\_DISCHARGE\_HIGH}} + OFF_{ER\_ESR}$$

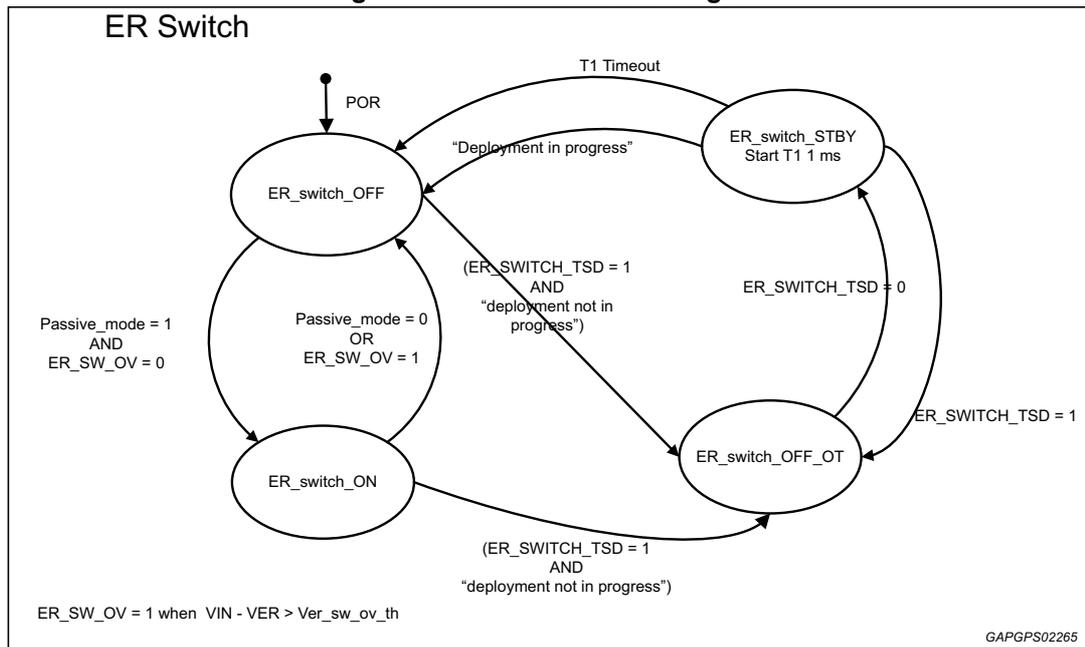
## 6.6 ER switch and COVRACT pin

L9679P allows the system to run out of the reserve capacitor energy stored on VER node by means of the charging boost regulator. In this way, an extended operation can take place even in case of battery lost. The ER switch implements a connection from the VER pin to the VIN node, supply input for the SYNCBOOST regulator and for internal power supplies.

The ER switch is automatically activated upon entering the PASSIVE mode. Voltage difference between VIN and VER is monitored in order to prevent VER back-feeding when VIN exceeds VER by  $V_{ER\_SW\_OV\_TH}$ . The ER switch is automatically deactivated upon the above mentioned overvoltage detection.

During PASSIVE mode the discrete digital output pin COVRACT is activated to allow for external optional cross-over switch control (except during VINGOOD blanking state, where the COVRACT is deactivated).

Figure 19. ER switch state diagram



## 6.7 SYNCBOOST boost regulator

The SYNCBOOST boost regulator also operates at 1.882 MHz allowing the user to select smaller less expensive external components. The regulator provides a 12 V/14.75 V nominal for the sync pulse feature used in PSI-5 bussed satellite sensor configuration. The regulator also provides the power for the SATBUCK regulator.

The SyncBoost switching regulator uses a classical peak current mode control loop to properly regulate the output voltage and includes an over-voltage protection that immediately switch off the PowerMOS to protect the device. The regulator includes also a soft start circuit which apply a ramp on the over current threshold from the 40% of  $I_{OC\_SYNCBST}$  value to the maximum one with 16 steps and within  $T_{SOFTST\_OC\_SYNCBST}$ . The soft start is restarted every time the regulator is enabled, namely there is a transition from the SYNCBOOST\_OFF state to the SYNCBOOST\_ON state.

In normal operation, the SYNCBOOST regulator operates directly from battery providing a voltage level to operate the sync pulse driver circuit. Should the input voltage be greater than regulation point, the output voltage will track the input voltage less any drops in the external components.

The boost regulator is enabled automatically by the power control state machine, but can be disabled on purpose via SPI command through the  $\text{SYS\_CTL}(\text{SYNCBST\_EN})$  bit. The regulation point is fixed at a nominal 12 V at startup. User may increase the output regulation voltage to 14.75 V nominal by setting the SATV bit via a dedicated SPI command, should an extended voltage range be needed.

Boost converter diagnostics include over voltage and under voltage, reported by the  $\text{S\_BST\_NOK}$  bit in the  $\text{POWER\_STATE}$  register, and the circuit is fully protected against shorts. The integrated FET featuring the boost switch is protected against short to battery by means of a thermal shutdown circuit. When thermal fault is detected the FET is switched off and latched in this state until the related fault flag  $\text{ERBST\_OT}$  in the  $\text{FLTSTR}$  register is read.

In case of loss of ground the FET is not turned on. Loss of ground can be detected also when the FET is off thanks to a pull-up current present on the BSTGND pin. The FET will be automatically reactivated as soon as ground connection is restored. Over-voltage protection from load dump and inductive flyback is provided via an active clamp and a SYNC\_Boost disable circuitry, see *Figure 20*.

Figure 20. SYNCBOOST regulator block diagram

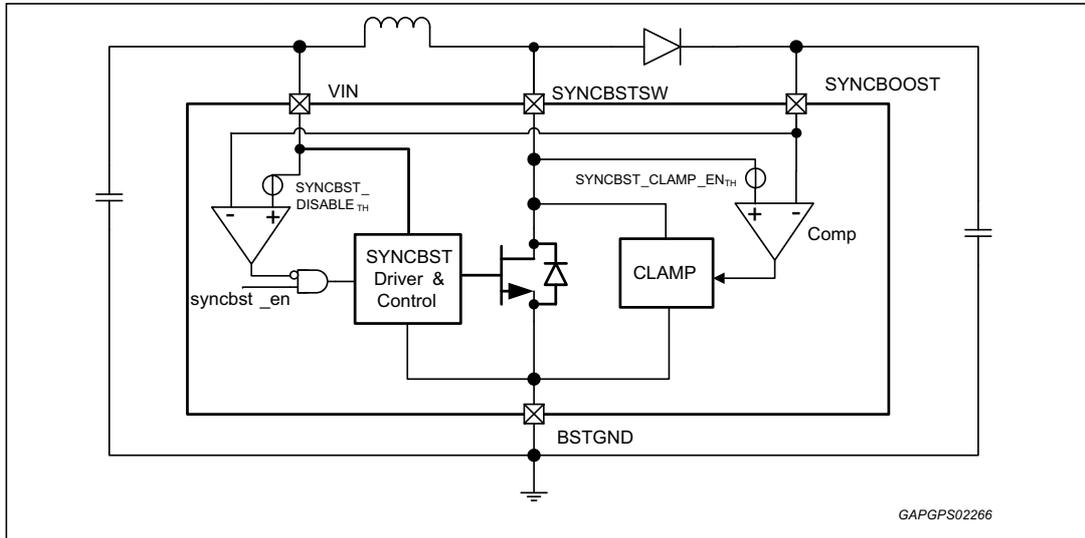
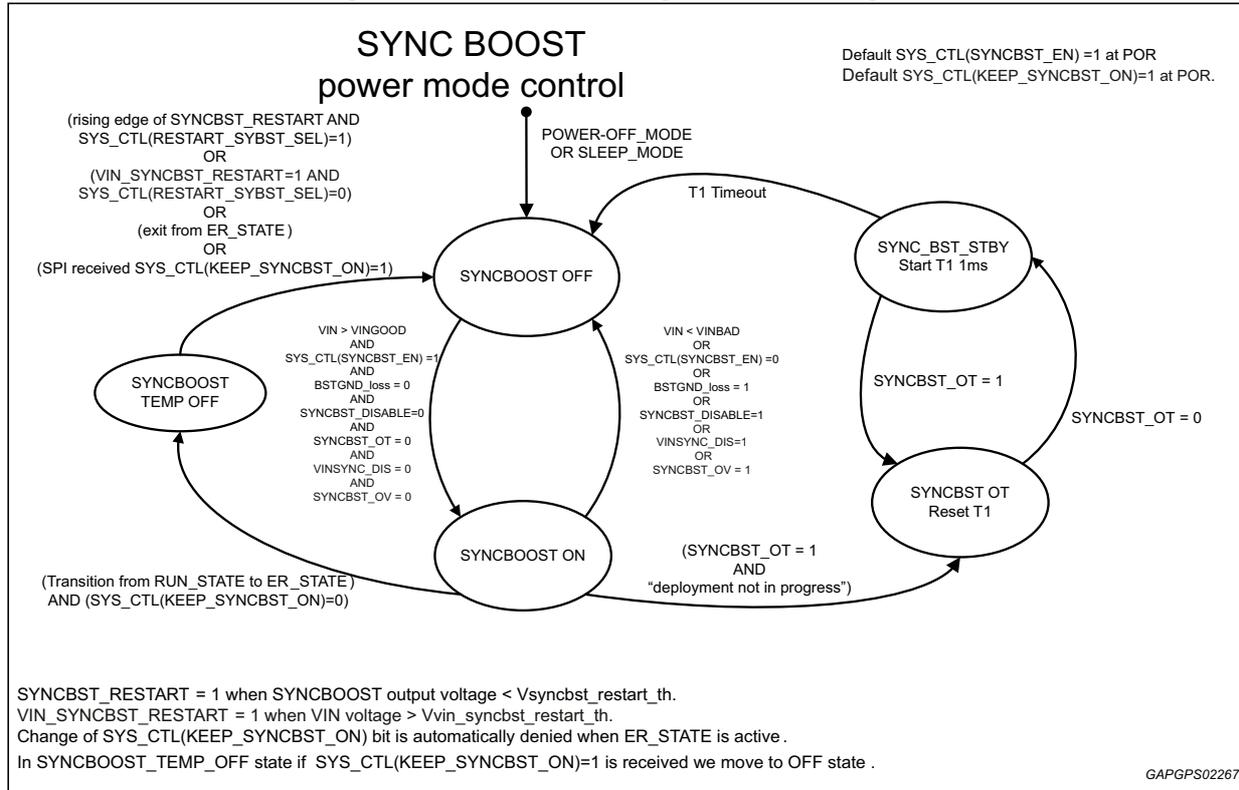


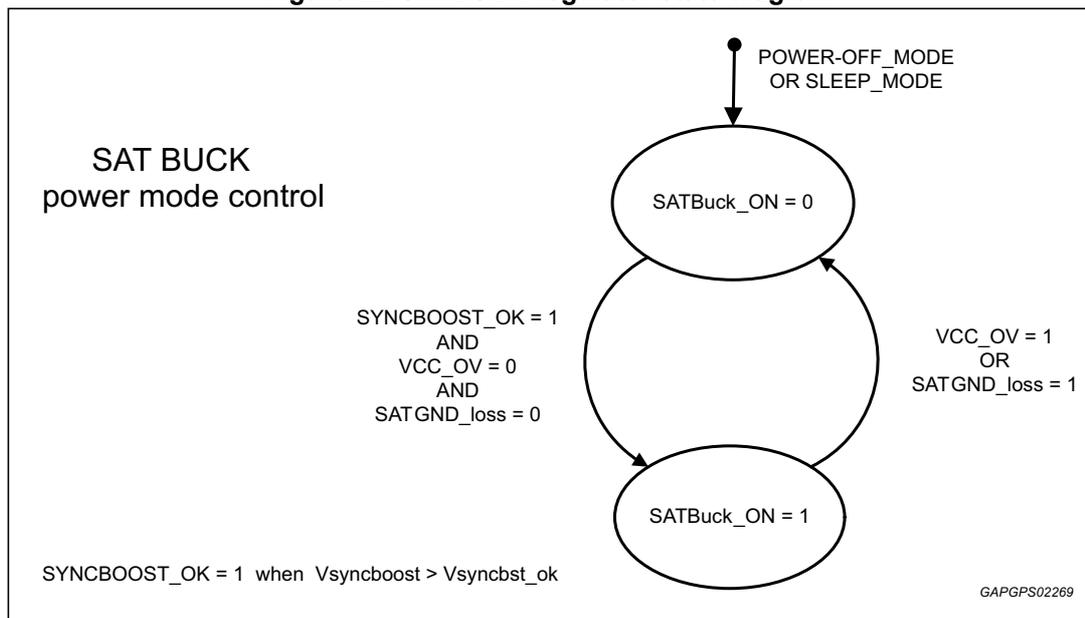
Figure 21. SYNCBOOST regulator state diagram



## 6.8 SATBUCK regulator

The SATBUCK regulator provides a nominal 7.2 V regulated output voltage at startup for the remote satellite and wheel speed interface circuitry and the VCC buck regulator. The buck regulator is enabled automatically by the power control state machine. This regulator is protected against short circuits. Should the user need a higher voltage range for the remote sensor interface, a specific SPI command allows the output voltage to be increased at 9 V nominal by setting the SAT\_V bit. Fault status is available through SPI in the Fault Status Register (FLTSR). The buck converter operates at 1.882 MHz allowing the user to select smaller less expensive external components. Moreover, the synchronous buck regulator integrates the external recirculation diode.

Figure 22. SATBUCK regulator state diagram



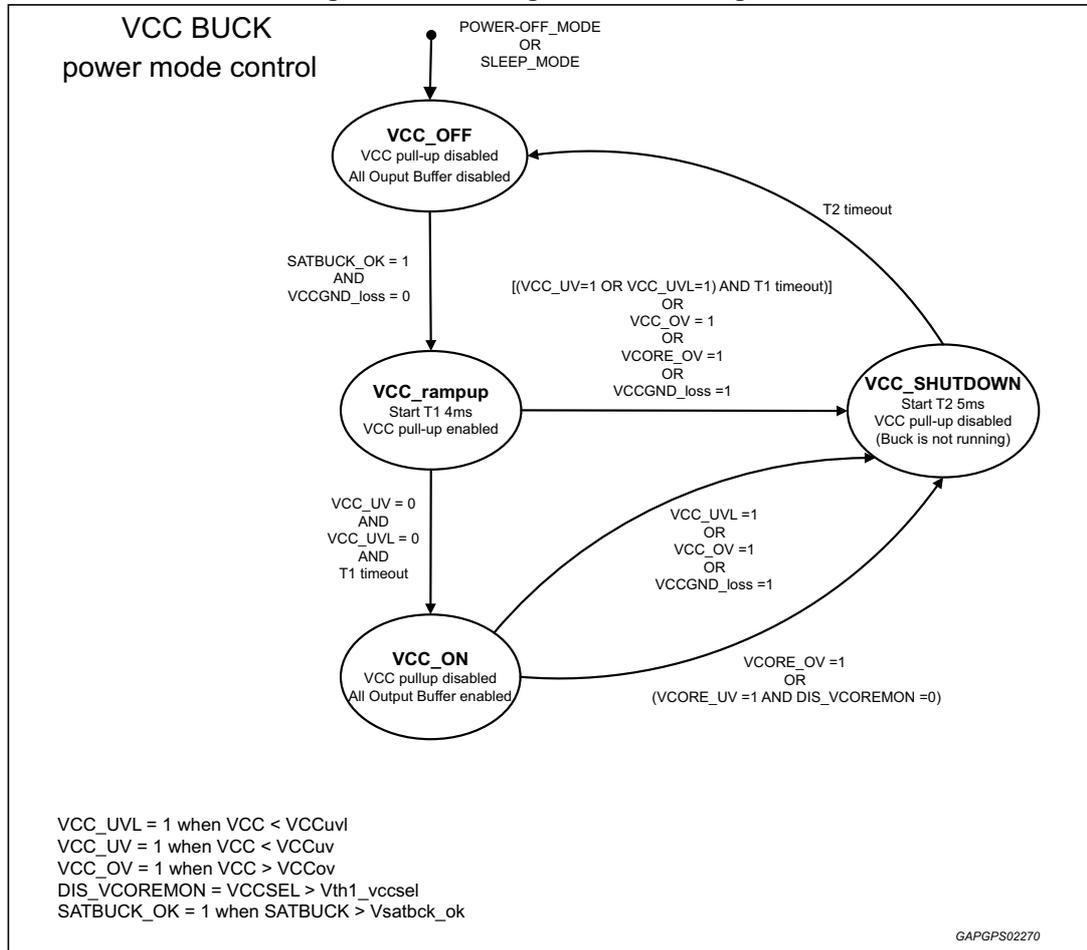
## 6.9 VCC buck regulator

The VCC buck regulator also operates at 1.882 MHz and is user selectable to either 3.3 V or 5 V nominal output voltage. The user can select the output voltage through the VCCSEL pin. To select 5 V operation, the user must bias VCCSEL to a level higher than  $V_{TH2\_H\_VCCSEL}$  for instance SyncBoost. For 3.3 V operation, the VCCSEL pin must be biased to a level lower than  $V_{TH2\_L\_VCCSEL}$ . An internal weak pull down is connected to VCCSEL to ensure the input remains at ground potential in case of open pin. The internal power control state machine will read the VCCSEL input pin and latch the resulting state upon the SATBUCK voltage reaches the good value (SATBUCK\_OK = 1). Upon latching the VCCSEL state, the VCC buck regulator cannot be changed by the user.

The VCC regulator has over and under voltage detections and shutdown capability and it is also protected against short circuits. During start-up an internal pull up current is enabled in order to detect a potential VCC pin open fault through the over voltage detection. This pull up current is disabled once in VCC\_ON or VCC\_SHUTDOWN states. During normal operation, VCC\_ON state, the VCC pin open fault is quickly detected through the Under Voltage Detection Low to prevent any MCU damage.

An open VCC pin shall lead to an under voltage condition on VCC supply monitor. The SPI related signals (SCLK, MISO, MOSI, CS) or other digital nets shall not power the VCC pin due to back-feeding paths.

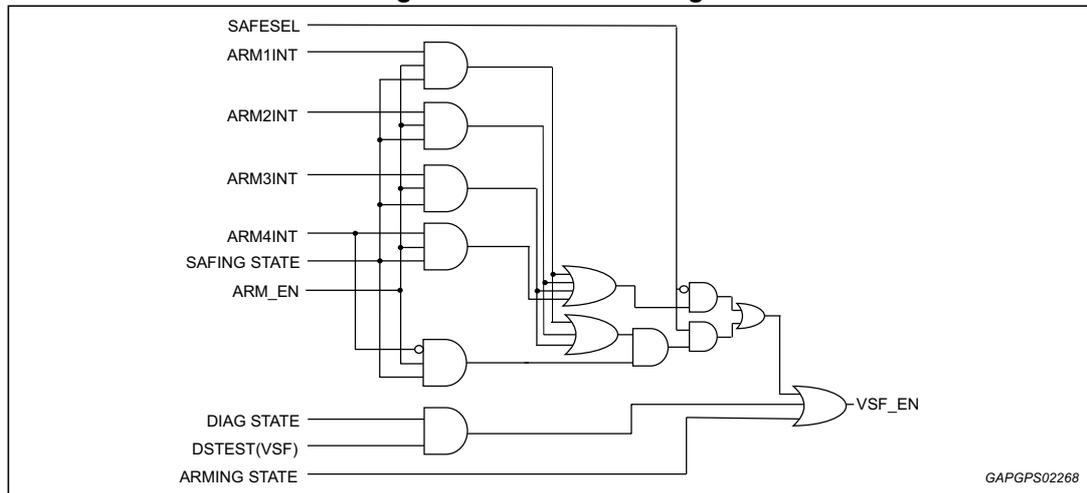
Figure 23. VCC regulator state diagram



## 6.10 VSF regulator and control

The L9679P provides a low current linear regulator that can be used in the system design to bias the external high side safing switch. The regulator output is 20 V nominal (configurable to 25 V via SPI command). VSF is enabled if any of the ARMxINT signal is asserted, as shown in [Figure 24](#). The VSF regulator supply input is ERBOOST.

Figure 24. VSF control logic



VSF voltage can be monitored by the user through the internal ADC. Characteristics for this function are shown in the electrical performance tables.

## 6.11 Oscillators

The device integrates two trimmed oscillators, both of them with spread spectrum capability selectable via the CLK\_CNF register.

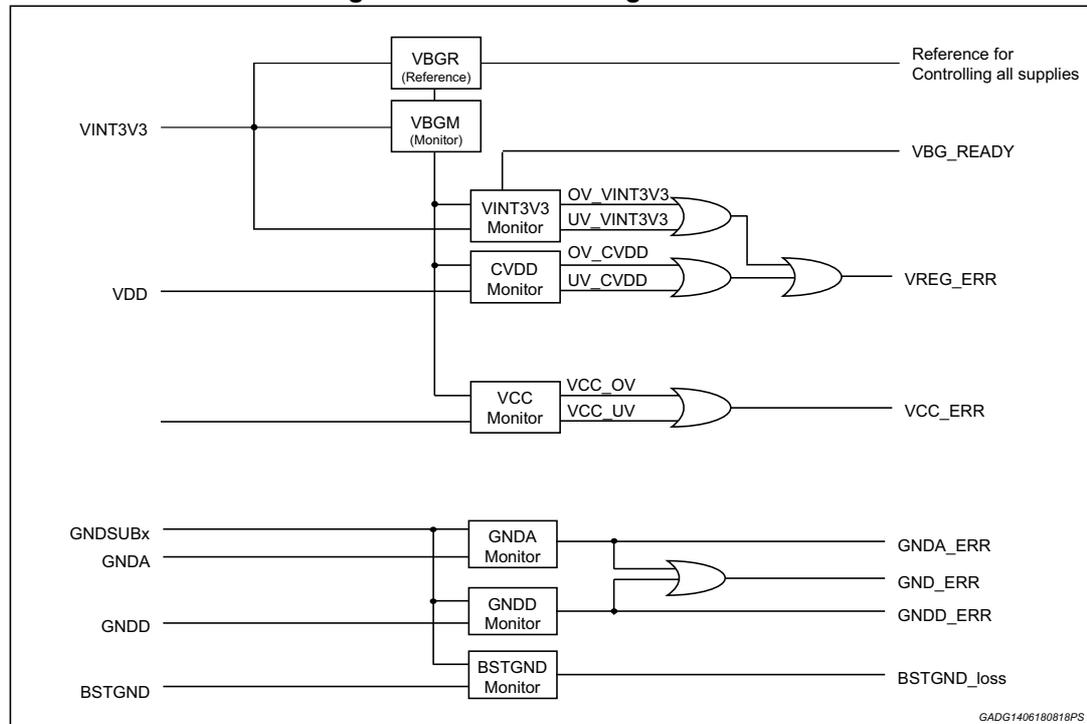
The main oscillator runs at 16 MHz typ and is used to provide clock to the internal synchronous logic. Moreover, this frequency is divided down by factor 8.5 to generate clocks for the switching regulators (1.882 MHz typ).

The auxiliary oscillator runs at 7.5 MHz typ and is used to monitor the main oscillator. In case the main oscillator frequency was lower than the  $f_{OSC\_LOW\_TH}$  threshold or higher than the  $f_{OSC\_HIGH\_TH}$  threshold, the condition is detected by the frequency monitor circuit and then latched into the CLKFRERR flag in the FLT SR register and a POR is issued.

## 6.12 Reset control

The device provides reset logic to safely control system operation in the event of internal ECU failures. Several internal reset signals are generated depending on the type of failure detected. In *Figure 25* the voltage monitoring diagram is shown.

**Figure 25. Internal voltage monitors**



An active low pin output (RESET pin) is driven from the L9679P to allow resetting of external devices such as the microcontroller, sensors, and other ICs within the ECU.

Three internal reset signals are generated by the device:

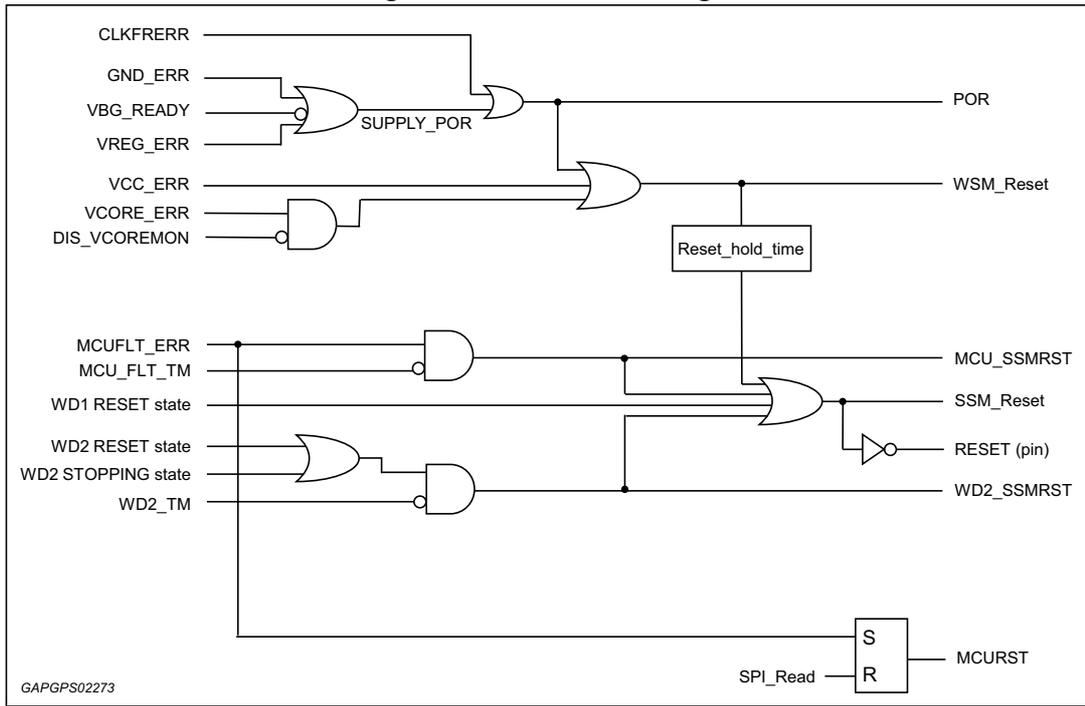
- **POR**  
Power On Reset - This reset is asserted when a failure is detected in the internal supplies or bandgap circuits. When active, all other resets are asserted.
- **WSM\_RESET**  
Watchdog State Machine Reset - This reset is generated when the POR is active or when a failure is detected in the VCC supply.
- **SSM\_RESET**  
System State Machine Reset - This reset is asserted when the POR or the WSM\_RESET are active, or when a failure is detected in either Watchdog state machine.

The RESET pin is the active-low signal driven on the output pin, and is an inverted form of SSM\_RESET.

The cause of the RESET activation is latched and reported into the Fault Status Register FLTSR and cleared upon SPI reading.

The reset logic shall be controlled as shown in the diagram below:

Figure 26. Reset control logic



## 7 SPI interfaces

The L9679P system solution device has many user selectable features controlled through serial communications by the integrated microcontroller. The device features two SPI interfaces: one global SPI and one Remote Sensor SPI. The global SPI interface provides general configuration, control and status functions for the device, while the Remote Sensor SPI provides dedicated access to Remote Sensor Data and Status Registers.

### 7.1 SPI protocol

Each SPI interface (Global and Remote Sensor) use their own dedicated set of 4 I/O pins: CS\_G, SCLK\_G, MOSI\_G and MISO\_G for Global SPI; CS\_RS, SCLK\_RS, MOSI\_RS and MISO\_RS for Remote Sensor SPI. Both the SPI interfaces use the same protocol described here below (the suffix ‘\_X’ used in the SPI pin names below is intended to stand for either ‘\_G’ or ‘\_RS’ depending on the particular SPI interface considered)

The IC SPI interface is composed by an input shift register, an output shift register and four control signals. MOSI\_X is the data input to the input shift register. MISO\_X is the data output from the output shift register. SCLK\_X is the clock input used to shift data into the input shift register or out from the output one while CS\_X is the active low chip select input.

All SPI communications are executed in exact 32 bit increments. The general format of the 32 bit transmission for the SPI interface is shown in [Table 5](#).

Data sent to the IC (i.e. MOSI\_X) consists of a target read register ID (RID), a target write register ID (WID), write data parity (WPAR) and 16 bits of data (WRITE). WRITE data is the data to be written to the target write register indicated by WID. Data returned from the IC (i.e. MISO\_X) consists of a global status word (GSW), read data parity (RPAR) and 20 bits of data (READ). READ data will be the contents of the target read register as indicated by the RID bits. The parity bits WPAR and RPAR cover all the 32 bits of the MOSI and MISO frames, respectively. Odd parity type is used.

**Table 5. SPI MOSI and MISO frames layout**

| SPI register R/W |             |          |    |    |    |    |    |          |    |    |    |      |    |             |    |    |  |
|------------------|-------------|----------|----|----|----|----|----|----------|----|----|----|------|----|-------------|----|----|--|
|                  | 31          | 30       | 29 | 28 | 27 | 26 | 25 | 24       | 23 | 22 | 21 | 20   | 19 | 18          | 17 | 16 |  |
| SPI_MOSI         | GID         | RID[6:0] |    |    |    |    |    | WID[6:0] |    |    |    |      |    | WPAR        |    |    |  |
| SPI_MISO         | GSW[10:0]   |          |    |    |    |    |    |          |    |    |    | RPAR |    | READ[19:16] |    |    |  |
|                  | 15          | 14       | 13 | 12 | 11 | 10 | 9  | 8        | 7  | 6  | 5  | 4    | 3  | 2           | 1  | 0  |  |
| SPI_MOSI         | WRITE[15:0] |          |    |    |    |    |    |          |    |    |    |      |    |             |    |    |  |
| SPI_MISO         | READ[15:0]  |          |    |    |    |    |    |          |    |    |    |      |    |             |    |    |  |

The communications is controlled through CS\_X, enabling and disabling communication. When CS\_X is at logic high, all SPI communication I/O is tri-stated and no data is accepted. When CS\_X is low, data is latched on the rising edge of SCLK\_X and data is shifted on the falling edge. The MOSI\_X pin receives serial data from the master with MSB first. Likewise for MISO\_X, data is read MSB first, LSB last.

The L9679P contains a data validation method through the SCLK\_X input to keep transmissions with not exactly 32 bits from being written to the device. The SCLK\_X input counts the number of received clocks and should the clock counter exceed or count fewer

than 32 clocks, the received message is discarded and a SPI\_FLT bit is flagged in the Global Status Word (GSW). The SPI\_FLT bit is also set in case of parity error detected on the MOSI\_X frame. Any attempt to access to a register with forbidden access mode (read or write) is not leading to changes to the internal registers but the SPI\_FLT bit is not set in this case.

## 7.2 Global SPI register map

The Global SPI interface consists of several 32-bit registers to allow for configuration, control and status of the IC as well as special manufacturing test modes. The register definition is defined by the read register ID (RID) and the write register ID (WID) as shown in [Table 6](#). Global ID bit (GID) is used to extend available register addresses, but it is shared between RID and WID; only RID and WID with the same GID value can be addressed within the same SPI word. The operating states here show in which states the SPI command is processed.

The L9679P checks the validity of the received WID and RID fields in the MOSI\_G frame. Should a SPI write command with WID matching a writable register be received in an illegal operating state, the command will be discarded and the ERR\_WID bit will be flagged in the next Global Status Word GSW. The ERR\_WID flag is not set in case WID is addressing a read/only register. Should a SPI read command be received containing an unused RID address, the command will be discarded and the ERR\_RID bit will be flagged in the current GSW.



Table 6. Global SPI register map

| GID | RID / WID |   |   |   |   |   |   |   | Hex  | R/W | Name        | Description   | Operating State <sup>(1)</sup> |      |         |       |        |
|-----|-----------|---|---|---|---|---|---|---|------|-----|-------------|---|--------------------------------|------|---------|-------|--------|
|     |           |   |   |   |   |   |   |   |      |     |             |   | Init                           | Diag | Ssafing | Scrap | Arming |
| 0   | 0         | 0 | 0 | 0 | 0 | 0 | 0 | 0 | \$00 | R   | FLTSR       | Global fault status register  |                                |      |         |       |        |
| 0   | 0         | 0 | 0 | 0 | 0 | 0 | 0 | 1 | \$01 | R/W | SYS_CFG     | Power supply configuration <sup>(2)</sup>   | X                              | X    | X       | X     | X      |
| 0   | 0         | 0 | 0 | 0 | 0 | 0 | 1 | 0 | \$02 | R/W | SYS_CTL     | Register for power management   | X                              | X    | X       | X     | X      |
| 0   | 0         | 0 | 0 | 0 | 0 | 0 | 1 | 1 | \$03 | W   | SPI_SLEEP   | Sleep Mode command  | X                              | X    | X       | X     | X      |
| 0   | 0         | 0 | 0 | 0 | 0 | 1 | 0 | 0 | \$04 | R   | SYS_STATE   | Read register to report in which state the power control state machine is and also in which operating state the device is |                                |      |         |       |        |
| 0   | 0         | 0 | 0 | 0 | 0 | 1 | 0 | 1 | \$05 | R   | POWER_STATE | Power state register (feedback on regulators' status and voltage thresholds)  |                                |      |         |       |        |
| 0   | 0         | 0 | 0 | 0 | 0 | 1 | 1 | 0 | \$06 | R/W | DCR_0       | Deployment configuration register   |                                | X    | X       | X     | X      |
| 0   | 0         | 0 | 0 | 0 | 0 | 1 | 1 | 1 | \$07 | R/W | DCR_1       |   |                                | X    | X       | X     | X      |
| 0   | 0         | 0 | 0 | 0 | 1 | 0 | 0 | 0 | \$08 | R/W | DCR_2       |   |                                | X    | X       | X     | X      |
| 0   | 0         | 0 | 0 | 0 | 1 | 0 | 0 | 1 | \$09 | R/W | DCR_3       |   |                                | X    | X       | X     | X      |
| 0   | 0         | 0 | 0 | 0 | 1 | 0 | 1 | 0 | \$0A | R/W | DCR_4       |   |                                | X    | X       | X     | X      |
| 0   | 0         | 0 | 0 | 0 | 1 | 0 | 1 | 1 | \$0B | R/W | DCR_5       |   |                                | X    | X       | X     | X      |
| 0   | 0         | 0 | 0 | 0 | 1 | 1 | 0 | 0 | \$0C | R/W | DCR_6       |   |                                | X    | X       | X     | X      |
| 0   | 0         | 0 | 0 | 0 | 1 | 1 | 0 | 1 | \$0D | R/W | DCR_7       |   |                                | X    | X       | X     | X      |
| 0   | 0         | 0 | 0 | 0 | 1 | 1 | 1 | 0 | \$0E |     |             |   |                                |      |         |       |        |
| 0   | 0         | 0 | 0 | 0 | 1 | 1 | 1 | 1 | \$0F |     |             |   |                                |      |         |       |        |
| 0   | 0         | 0 | 0 | 1 | 0 | 0 | 0 | 0 | \$10 |     |             |   |                                |      |         |       |        |
| 0   | 0         | 0 | 0 | 1 | 0 | 0 | 0 | 1 | \$11 |     |             |   |                                |      |         |       |        |
| 0   | 0         | 0 | 0 | 1 | 0 | 0 | 1 | 0 | \$12 | R/W | DEPCOM      | Deployment command register   |                                |      | X       |       | X      |
| 0   | 0         | 0 | 0 | 1 | 0 | 0 | 1 | 1 | \$13 | R   | DSR_0       | Deployment status register  |                                |      |         |       |        |
| 0   | 0         | 0 | 0 | 1 | 0 | 1 | 0 | 0 | \$14 | R   | DSR_1       |   |                                |      |         |       |        |
| 0   | 0         | 0 | 0 | 1 | 0 | 1 | 0 | 1 | \$15 | R   | DSR_2       |   |                                |      |         |       |        |



**Table 6. Global SPI register map (continued)**

| GID | RID / WID |   |   |   |   |   |   | Hex  | R/W | Name          | Description                           | Operating State <sup>(1)</sup> |      |         |       |        |
|-----|-----------|---|---|---|---|---|---|------|-----|---------------|---------------------------------------|--------------------------------|------|---------|-------|--------|
|     |           |   |   |   |   |   |   |      |     |               |                                       | Init                           | Diag | Ssafing | Scrap | Arming |
| 0   | 0         | 0 | 1 | 0 | 1 | 1 | 0 | \$16 | R   | DSR_3         | Deployment status register            |                                |      |         |       |        |
| 0   | 0         | 0 | 1 | 0 | 1 | 1 | 1 | \$17 | R   | DSR_4         |                                       |                                |      |         |       |        |
| 0   | 0         | 0 | 1 | 1 | 0 | 0 | 0 | \$18 | R   | DSR_5         |                                       |                                |      |         |       |        |
| 0   | 0         | 0 | 1 | 1 | 0 | 0 | 1 | \$19 | R   | DSR_6         |                                       |                                |      |         |       |        |
| 0   | 0         | 0 | 1 | 1 | 0 | 1 | 0 | \$1A | R   | DSR_7         |                                       |                                |      |         |       |        |
| 0   | 0         | 0 | 1 | 1 | 0 | 1 | 1 | \$1B |     |               |                                       |                                |      |         |       |        |
| 0   | 0         | 0 | 1 | 1 | 1 | 0 | 0 | \$1C |     |               |                                       |                                |      |         |       |        |
| 0   | 0         | 0 | 1 | 1 | 1 | 0 | 1 | \$1D |     |               |                                       |                                |      |         |       |        |
| 0   | 0         | 0 | 1 | 1 | 1 | 1 | 0 | \$1E |     |               |                                       |                                |      |         |       |        |
| 0   | 0         | 0 | 1 | 1 | 1 | 1 | 1 | \$1F | R   | DCMTS01       | Deployment current monitor register   |                                |      |         |       |        |
| 0   | 0         | 1 | 0 | 0 | 0 | 0 | 0 | \$20 | R   | DCMTS23       |                                       |                                |      |         |       |        |
| 0   | 0         | 1 | 0 | 0 | 0 | 0 | 1 | \$21 | R   | DCMTS45       |                                       |                                |      |         |       |        |
| 0   | 0         | 1 | 0 | 0 | 0 | 1 | 0 | \$22 | R   | DCMTS67       |                                       |                                |      |         |       |        |
| 0   | 0         | 1 | 0 | 0 | 0 | 1 | 1 | \$23 |     |               |                                       |                                |      |         |       |        |
| 0   | 0         | 1 | 0 | 0 | 1 | 0 | 0 | \$24 |     |               |                                       |                                |      |         |       |        |
| 0   | 0         | 1 | 0 | 0 | 1 | 0 | 1 | \$25 | R/W | SPIDEPEN      | Lock/Unlock command                   |                                |      | X       |       | X      |
| 0   | 0         | 1 | 0 | 0 | 1 | 1 | 0 | \$26 | R   | LP_GNDLOSS    | Loss of ground fault for squib loops  |                                |      |         |       |        |
| 0   | 0         | 1 | 0 | 0 | 1 | 1 | 1 | \$27 | R   | VERSION_ID    | Device version                        |                                |      |         |       |        |
| 0   | 0         | 1 | 0 | 1 | 0 | 0 | 0 | \$28 | R/W | WD_RETRY_CONF | Watchdog Retry Configuration          | X                              |      |         |       |        |
| 0   | 0         | 1 | 0 | 1 | 0 | 0 | 1 | \$29 | W   |               |                                       |                                |      |         |       |        |
| 0   | 0         | 1 | 0 | 1 | 0 | 1 | 0 | \$2A | R/W | WDTCR         | Watchdog first level configuration    | X                              |      |         |       |        |
| 0   | 0         | 1 | 0 | 1 | 0 | 1 | 1 | \$2B | R/W | WD1T          | Watchdog first level key transmission | X                              | X    | X       | X     | X      |
| 0   | 0         | 1 | 0 | 1 | 1 | 0 | 0 | \$2C | R   | WD_STATE      | Watchdog first and second level state |                                |      |         |       |        |
| 0   | 0         | 1 | 0 | 1 | 1 | 0 | 1 | \$2D | R/W | CLK_CONF      | Clock configuration                   | X                              | X    | X       | X     | X      |
| 0   | 0         | 1 | 0 | 1 | 1 | 1 | 0 | \$2E | R   | SCRAP_SEED    | Scrap Seed command                    |                                |      |         |       |        |

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SPI Interfaces



Table 6. Global SPI register map (continued)

| GID | RID / WID |   |   |   |   |   |   | Hex  | R/W | Name         | Description   | Operating State <sup>(1)</sup> |      |         |       |        |
|-----|-----------|---|---|---|---|---|---|------|-----|--------------|---|--------------------------------|------|---------|-------|--------|
|     |           |   |   |   |   |   |   |      |     |              |   | Init                           | Diag | Ssafing | Scrap | Arming |
| 0   | 0         | 1 | 0 | 1 | 1 | 1 | 1 | \$2F | W   | SCRAP_KEY    | Scrap Key command   |                                |      |         | X     | X      |
| 0   | 0         | 1 | 1 | 0 | 0 | 0 | 0 | \$30 | W   | SCRAP_STATE  | Scrap State command   |                                | X    |         |       |        |
| 0   | 0         | 1 | 1 | 0 | 0 | 0 | 1 | \$31 | W   | SAFING_STATE | Safing State command  |                                | X    |         |       |        |
| 0   | 0         | 1 | 1 | 0 | 0 | 1 | 0 | \$32 | W   | WD2_RECOVER  | Watchdog second level recovery command  | X                              | X    | X       | X     | X      |
| 0   | 0         | 1 | 1 | 0 | 0 | 1 | 1 | \$33 | R   | WD2_SEED     | Watchdog second level seed transmission                                       |                                |      |         |       |        |
| 0   | 0         | 1 | 1 | 0 | 1 | 0 | 0 | \$34 | W   | WD2_KEY      | Watchdog second level key transmission  | X                              | X    | X       | X     | X      |
| 0   | 0         | 1 | 1 | 0 | 1 | 0 | 1 | \$35 | W   | WD_TEST      | Watchdog first and second level test  | X                              | X    | X       | X     | X      |
| 0   | 0         | 1 | 1 | 0 | 1 | 1 | 0 | \$36 | R/W | SYSDIAGREQ   | Diagnostic command for system safing  |                                | X    |         |       |        |
| 0   | 0         | 1 | 1 | 0 | 1 | 1 | 1 | \$37 | R   | LPDIAGSTAT   | Diagnostic result register for deployment loops                               |                                |      |         |       |        |
| 0   | 0         | 1 | 1 | 1 | 0 | 0 | 0 | \$38 | R/W | LPDIAGREQ    | Diagnostic configuration command for deployment loops                         |                                | X    | X       | X     | X      |
| 0   | 0         | 1 | 1 | 1 | 0 | 0 | 1 | \$39 | R/W | SWCTRL       | DC sensor diagnostic configuration  |                                | X    | X       | X     | X      |
| 0   | 0         | 1 | 1 | 1 | 0 | 1 | 0 | \$3A | R/W | DIAGCTRL_A   | In WID is AtoD converter control register A. In RID is AtoD result A request. |                                | X    | X       | X     | X      |
| 0   | 0         | 1 | 1 | 1 | 0 | 1 | 1 | \$3B | R/W | DIAGCTRL_B   | In WID is AtoD converter control register B. In RID is AtoD result B request. |                                | X    | X       | X     | X      |
| 0   | 0         | 1 | 1 | 1 | 1 | 0 | 0 | \$3C | R/W | DIAGCTRL_C   | In WID is AtoD converter control register C. In RID is AtoD result C request. |                                | X    | X       | X     | X      |
| 0   | 0         | 1 | 1 | 1 | 1 | 0 | 1 | \$3D | R/W | DIAGCTRL_D   | In WID is AtoD converter control register D. In RID is AtoD result D request. |                                | X    | X       | X     | X      |
| 0   | 0         | 1 | 1 | 1 | 1 | 1 | 0 | \$3E |     |              |   |                                |      |         |       |        |
| 0   | 0         | 1 | 1 | 1 | 1 | 1 | 1 | \$3F | R/W | SW_REGS_CONF | Configuration register for switching regulators                               |                                | X    | X       | X     | X      |
| 0   | 1         | 0 | 0 | 0 | 0 | 0 | 0 | \$40 |     |              |   |                                |      |         |       |        |
| 0   | 1         | 0 | 0 | 0 | 0 | 0 | 1 | \$41 |     |              |   |                                |      |         |       |        |
| 0   | 1         | 0 | 0 | 0 | 0 | 1 | 0 | \$42 | R/W | GPOCR        | General Purpose Output configuration  | X                              | X    |         |       |        |
| 0   | 1         | 0 | 0 | 0 | 0 | 1 | 1 | \$43 | R/W | GPOCTRL0     | General Purpose Output 0 control register                                     | X                              | X    | X       | X     | X      |



**Table 6. Global SPI register map (continued)**

| GID | RID / WID |   |   |   |   |   |   |      | Hex | R/W      | Name   | Description | Operating State <sup>(1)</sup> |      |         |       |        |
|-----|-----------|---|---|---|---|---|---|------|-----|----------|--|-------------|--------------------------------|------|---------|-------|--------|
|     |           |   |   |   |   |   |   |      |     |          |  |             | Init                           | Diag | Ssafing | Scrap | Arming |
| 0   | 1         | 0 | 0 | 0 | 1 | 0 | 0 | \$44 | R/W | GPOCTRL1 | General Purpose Output 1 control register    | X           | X                              | X    | X       | X     |        |
| 0   | 1         | 0 | 0 | 0 | 1 | 0 | 1 | \$45 | R/W | GPOCTRL2 | General Purpose Output 2 control register    | X           | X                              | X    | X       | X     |        |
| 0   | 1         | 0 | 0 | 0 | 1 | 1 | 0 | \$46 | R   | GPOFLTSR | General Purpose Output fault status register |             |                                |      |         |       |        |
| 0   | 1         | 0 | 0 | 0 | 1 | 1 | 1 | \$47 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 0 | 1 | 0 | 0 | 0 | \$48 | R   | ISOFLTSR | ISOK Fault Status Register                   |             | X                              |      |         |       |        |
| 0   | 1         | 0 | 0 | 1 | 0 | 0 | 1 | \$49 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 0 | 1 | 0 | 1 | 0 | \$4A | R/W | RSCR0    | PSI5/WSS configuration register              |             | X                              |      |         |       |        |
| 0   | 1         | 0 | 0 | 1 | 0 | 1 | 1 | \$4B | R/W | RSCR1    |  |             | X                              |      |         |       |        |
| 0   | 1         | 0 | 0 | 1 | 1 | 0 | 0 | \$4C |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 0 | 1 | 1 | 0 | 1 | \$4D |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 0 | 1 | 1 | 1 | 0 | \$4E | R/W | RSCTRL   | Remote sensor control register               |             | X                              | X    | X       | X     |        |
| 0   | 1         | 0 | 0 | 1 | 1 | 1 | 1 | \$4F |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 0 | 0 | 0 | 0 | \$50 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 0 | 0 | 0 | 1 | \$51 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 0 | 0 | 1 | 0 | \$52 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 0 | 0 | 1 | 1 | \$53 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 0 | 1 | 0 | 0 | \$54 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 0 | 1 | 0 | 1 | \$55 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 0 | 1 | 1 | 0 | \$56 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 0 | 1 | 1 | 1 | \$57 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 1 | 0 | 0 | 0 | \$58 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 1 | 0 | 0 | 1 | \$59 |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 1 | 0 | 1 | 0 | \$5A |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 1 | 0 | 1 | 1 | \$5B |     |          |  |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 1 | 1 | 0 | 0 | \$5C |     |          |  |             |                                |      |         |       |        |



Table 6. Global SPI register map (continued)

| GID | RID / WID |   |   |   |   |   |   |      | Hex | R/W              | Name                                    | Description | Operating State <sup>(1)</sup> |      |         |       |        |
|-----|-----------|---|---|---|---|---|---|------|-----|------------------|---|-------------|--------------------------------|------|---------|-------|--------|
|     |           |   |   |   |   |   |   |      |     |                  |   |             | Init                           | Diag | Ssafing | Scrap | Arming |
| 0   | 1         | 0 | 1 | 1 | 1 | 0 | 1 | \$5D |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 1 | 1 | 1 | 0 | \$5E |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 0 | 1 | 1 | 1 | 1 | 1 | \$5F |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 0 | 0 | 0 | 0 | \$60 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 0 | 0 | 0 | 1 | \$61 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 0 | 0 | 1 | 0 | \$62 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 0 | 0 | 1 | 1 | \$63 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 0 | 1 | 0 | 0 | \$64 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 0 | 1 | 0 | 1 | \$65 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 0 | 1 | 1 | 0 | \$66 | R/W | SAF_ALGO_CONF    | Safing Algorithm configuration register |             | X                              |      |         |       |        |
| 0   | 1         | 1 | 0 | 0 | 1 | 1 | 1 | \$67 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 1 | 0 | 0 | 0 | \$68 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 1 | 0 | 0 | 1 | \$69 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 1 | 0 | 1 | 0 | \$6A | R   | ARM_STATE        | Status of arming signals                |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 1 | 0 | 1 | 1 | \$6B |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 1 | 1 | 0 | 0 | \$6C |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 1 | 1 | 0 | 1 | \$6D |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 0 | 1 | 1 | 1 | 0 | \$6E | R/W | LOOP_MATRIX_ARM1 | Assignment of ARM 1 pin to which LOOPS  |             | X                              |      |         |       |        |
| 0   | 1         | 1 | 0 | 1 | 1 | 1 | 1 | \$6F | R/W | LOOP_MATRIX_ARM2 | Assignment of ARM 2 pin to which LOOPS  |             | X                              |      |         |       |        |
| 0   | 1         | 1 | 1 | 0 | 0 | 0 | 0 | \$70 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 1 | 0 | 0 | 0 | 1 | \$71 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 1 | 0 | 0 | 1 | 0 | \$72 |     |                  |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 1 | 0 | 0 | 1 | 1 | \$73 | R   | AEPSTS_ARM1      | Arming pulse stretch timer value        |             |                                |      |         |       |        |
| 0   | 1         | 1 | 1 | 0 | 1 | 0 | 0 | \$74 | R   | AEPSTS_ARM2      |   |             |                                |      |         |       |        |
| 0   | 1         | 1 | 1 | 0 | 1 | 0 | 1 | \$75 |     |                  |   |             |                                |      |         |       |        |



**Table 6. Global SPI register map (continued)**

| GID | RID / WID |   |   |   |   |   |   |      | Hex | R/W                 | Name                                      | Description | Operating State <sup>(1)</sup> |      |         |       |        |   |  |
|-----|-----------|---|---|---|---|---|---|------|-----|---------------------|---|-------------|--------------------------------|------|---------|-------|--------|---|--|
|     |           |   |   |   |   |   |   |      |     |                     |   |             | Init                           | Diag | Ssafing | Scrap | Arming |   |  |
| 0   | 1         | 1 | 1 | 0 | 1 | 1 | 0 | \$76 |     |                     |   |             |                                |      |         |       |        |   |  |
| 0   | 1         | 1 | 1 | 0 | 1 | 1 | 1 | \$77 |     |                     |   |             |                                |      |         |       |        |   |  |
| 0   | 1         | 1 | 1 | 1 | 0 | 0 | 0 | \$78 | R/W | PADTHRESH_HI        | Passenger Inhibit Thresholds              |             | X                              |      |         |       |        |   |  |
| 0   | 1         | 1 | 1 | 1 | 0 | 0 | 1 | \$79 | R/W | PADTHRESH_LO        |   |             | X                              |      |         |       |        |   |  |
| 0   | 1         | 1 | 1 | 1 | 0 | 1 | 0 | \$7A | R/W | LOOP_MATRIX_PSINH   | Assignment of PSINH signal to which LOOPS |             | X                              |      |         |       |        |   |  |
| 0   | 1         | 1 | 1 | 1 | 0 | 1 | 1 | \$7B |     |                     |   |             |                                |      |         |       |        |   |  |
| 0   | 1         | 1 | 1 | 1 | 1 | 0 | 0 | \$7C |     |                     |   |             |                                |      |         |       |        |   |  |
| 0   | 1         | 1 | 1 | 1 | 1 | 0 | 1 | \$7D |     |                     |   |             |                                |      |         |       |        |   |  |
| 0   | 1         | 1 | 1 | 1 | 1 | 1 | 0 | \$7E |     |                     |   |             |                                |      |         |       |        |   |  |
| 0   | 1         | 1 | 1 | 1 | 1 | 1 | 1 | \$7F | R/W | SAF_ENABLE          | Safing record enable                      |             | X                              | X    | X       | X     | X      | X |  |
| 1   | 0         | 0 | 0 | 0 | 0 | 0 | 0 | \$80 | R/W | SAF_REQ_MASK_1      | Safing record request mask                |             | X                              |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 0 | 0 | 0 | 1 | \$81 | R/W | SAF_REQ_MASK_2      |   |             | X                              |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 0 | 0 | 1 | 0 | \$82 | R/W | SAF_REQ_MASK_3      |   |             | X                              |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 0 | 0 | 1 | 1 | \$83 | R/W | SAF_REQ_MASK_4      |   |             | X                              |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 0 | 1 | 0 | 0 | \$84 | R/W | SAF_REQ_MASK_5      |   |             | X                              |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 0 | 1 | 0 | 1 | \$85 | R/W | SAF_REQ_MASK_6      |   |             | X                              |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 0 | 1 | 1 | 0 | \$86 | R/W | SAF_REQ_MASK_7      |   |             | X                              |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 0 | 1 | 1 | 1 | \$87 | R/W | SAF_REQ_MASK_8      |   |             | X                              |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 1 | 0 | 0 | 0 | \$88 | R/W | SAF_REQ_MASK_9      |   |             | X                              |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 1 | 0 | 0 | 1 | \$89 |     |                     |   |             |                                |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 1 | 0 | 1 | 0 | \$8A |     |                     |   |             |                                |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 1 | 0 | 1 | 1 | \$8B |     |                     |   |             |                                |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 1 | 1 | 0 | 0 | \$8C |     |                     |   |             |                                |      |         |       |        |   |  |
| 1   | 0         | 0 | 0 | 1 | 1 | 0 | 1 | \$8D | R/W | SAF_REQ_MASK_14_pt1 |   |             | X                              |      |         |       |        |   |  |

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Table 6. Global SPI register map (continued)

| GID | RID / WID |   |   |   |   |   |   | Hex  | R/W | Name                  | Description                  | Operating State <sup>(1)</sup> |      |         |       |        |
|-----|-----------|---|---|---|---|---|---|------|-----|-----------------------|------------------------------|--------------------------------|------|---------|-------|--------|
|     |           |   |   |   |   |   |   |      |     |                       |                              | Init                           | Diag | Ssafing | Scrap | Arming |
| 1   | 0         | 0 | 0 | 1 | 1 | 1 | 0 | \$8E | R/W | SAF_REQ_MASK_14_pt2   | Safing record request mask   |                                | X    |         |       |        |
| 1   | 0         | 0 | 0 | 1 | 1 | 1 | 1 | \$8F | R/W | SAF_REQ_MASK_15_pt1   |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 0 | 0 | 0 | 0 | \$90 | R/W | SAF_REQ_MASK_15_pt2   |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 0 | 0 | 0 | 1 | \$91 | R/W | SAF_REQ_MASK_16_pt1   |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 0 | 0 | 1 | 0 | \$92 | R/W | SAF_REQ_MASK_16_pt2   |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 0 | 0 | 1 | 1 | \$93 | R/W | SAF_REQ_TARGET_1      | Safing record request target |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 0 | 1 | 0 | 0 | \$94 | R/W | SAF_REQ_TARGET_2      |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 0 | 1 | 0 | 1 | \$95 | R/W | SAF_REQ_TARGET_3      |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 0 | 1 | 1 | 0 | \$96 | R/W | SAF_REQ_TARGET_4      |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 0 | 1 | 1 | 1 | \$97 | R/W | SAF_REQ_TARGET_5      |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 1 | 0 | 0 | 0 | \$98 | R/W | SAF_REQ_TARGET_6      |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 1 | 0 | 0 | 1 | \$99 | R/W | SAF_REQ_TARGET_7      |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 1 | 0 | 1 | 0 | \$9A | R/W | SAF_REQ_TARGET_8      |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 1 | 0 | 1 | 1 | \$9B | R/W | SAF_REQ_TARGET_9      |                              |                                | X    |         |       |        |
| 1   | 0         | 0 | 1 | 1 | 1 | 0 | 0 | \$9C |     |                       |                              |                                |      |         |       |        |
| 1   | 0         | 0 | 1 | 1 | 1 | 0 | 1 | \$9D |     |                       |                              |                                |      |         |       |        |
| 1   | 0         | 0 | 1 | 1 | 1 | 1 | 0 | \$9E |     |                       |                              |                                |      |         |       |        |
| 1   | 0         | 0 | 1 | 1 | 1 | 1 | 1 | \$9F |     |                       |                              |                                |      |         |       |        |
| 1   | 0         | 1 | 0 | 0 | 0 | 0 | 0 | \$A0 | R/W | SAF_REQ_TARGET_14_pt1 |                              |                                | X    |         |       |        |
| 1   | 0         | 1 | 0 | 0 | 0 | 0 | 1 | \$A1 | R/W | SAF_REQ_TARGET_14_pt2 |                              | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 0 | 0 | 1 | 0 | \$A2 | R/W | SAF_REQ_TARGET_15_pt1 |                              | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 0 | 0 | 1 | 1 | \$A3 | R/W | SAF_REQ_TARGET_15_pt2 |                              | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 0 | 1 | 0 | 0 | \$A4 | R/W | SAF_REQ_TARGET_16_pt1 |                              | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 0 | 1 | 0 | 1 | \$A5 | R/W | SAF_REQ_TARGET_16_pt2 |                              | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 0 | 1 | 1 | 0 | \$A6 | R/W | SAF_RESP_MASK_1       | Safing record response mask  |                                | X    |         |       |        |



**Table 6. Global SPI register map (continued)**

| GID | RID / WID |   |   |   |   |   |   | Hex  | R/W | Name                 | Description                   | Operating State <sup>(1)</sup> |      |         |       |        |
|-----|-----------|---|---|---|---|---|---|------|-----|----------------------|-------------------------------|--------------------------------|------|---------|-------|--------|
|     |           |   |   |   |   |   |   |      |     |                      |                               | Init                           | Diag | Ssafing | Scrap | Arming |
| 1   | 0         | 1 | 0 | 0 | 1 | 1 | 1 | \$A7 | R/W | SAF_RESP_MASK_2      |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 1 | 0 | 0 | 0 | \$A8 | R/W | SAF_RESP_MASK_3      |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 1 | 0 | 0 | 1 | \$A9 | R/W | SAF_RESP_MASK_4      |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 1 | 0 | 1 | 0 | \$AA | R/W | SAF_RESP_MASK_5      |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 1 | 0 | 1 | 1 | \$AB | R/W | SAF_RESP_MASK_6      |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 1 | 1 | 0 | 0 | \$AC | R/W | SAF_RESP_MASK_7      |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 1 | 1 | 0 | 1 | \$AD | R/W | SAF_RESP_MASK_8      |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 1 | 1 | 1 | 0 | \$AE | R/W | SAF_RESP_MASK_9      |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 0 | 1 | 1 | 1 | 1 | \$AF |     |                      |                               |                                |      |         |       |        |
| 1   | 0         | 1 | 1 | 0 | 0 | 0 | 0 | \$B0 |     |                      | Safing record response mask   |                                |      |         |       |        |
| 1   | 0         | 1 | 1 | 0 | 0 | 0 | 1 | \$B1 |     |                      |                               |                                |      |         |       |        |
| 1   | 0         | 1 | 1 | 0 | 0 | 1 | 0 | \$B2 |     |                      |                               |                                |      |         |       |        |
| 1   | 0         | 1 | 1 | 0 | 0 | 1 | 1 | \$B3 | R/W | SAF_RESP_MASK_14_pt1 |                               |                                | X    |         |       |        |
| 1   | 0         | 1 | 1 | 0 | 1 | 0 | 0 | \$B4 | R/W | SAF_RESP_MASK_14_pt2 |                               |                                | X    |         |       |        |
| 1   | 0         | 1 | 1 | 0 | 1 | 0 | 1 | \$B5 | R/W | SAF_RESP_MASK_15_pt1 |                               |                                | X    |         |       |        |
| 1   | 0         | 1 | 1 | 0 | 1 | 1 | 0 | \$B6 | R/W | SAF_RESP_MASK_15_pt2 |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 1 | 0 | 1 | 1 | 1 | \$B7 | R/W | SAF_RESP_MASK_16_pt1 |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 1 | 1 | 0 | 0 | 0 | \$B8 | R/W | SAF_RESP_MASK_16_pt2 |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 1 | 1 | 0 | 0 | 1 | \$B9 | R/W | SAF_RESP_TARGET_1    |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 1 | 1 | 0 | 1 | 0 | \$BA | R/W | SAF_RESP_TARGET_2    |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 1 | 1 | 0 | 1 | 1 | \$BB | R/W | SAF_RESP_TARGET_3    |                               | X                              |      |         |       |        |
| 1   | 0         | 1 | 1 | 1 | 1 | 0 | 0 | \$BC | R/W | SAF_RESP_TARGET_4    | Safing record response target |                                | X    |         |       |        |
| 1   | 0         | 1 | 1 | 1 | 1 | 0 | 1 | \$BD | R/W | SAF_RESP_TARGET_5    |                               |                                | X    |         |       |        |
| 1   | 0         | 1 | 1 | 1 | 1 | 1 | 0 | \$BE | R/W | SAF_RESP_TARGET_6    |                               |                                | X    |         |       |        |
| 1   | 0         | 1 | 1 | 1 | 1 | 1 | 1 | \$BF | R/W | SAF_RESP_TARGET_7    |                               |                                | X    |         |       |        |



Table 6. Global SPI register map (continued)

| GID | RID / WID |   |   |   |   |   |   | Hex  | R/W | Name                   | Description                   | Operating State <sup>(1)</sup> |      |         |       |        |
|-----|-----------|---|---|---|---|---|---|------|-----|------------------------|-------------------------------|--------------------------------|------|---------|-------|--------|
|     |           |   |   |   |   |   |   |      |     |                        |                               | Init                           | Diag | Ssafing | Scrap | Arming |
| 1   | 1         | 0 | 0 | 0 | 0 | 0 | 0 | \$C0 | R/W | SAF_RESP_TARGET_8      |                               | X                              |      |         |       |        |
| 1   | 1         | 0 | 0 | 0 | 0 | 0 | 1 | \$C1 | R/W | SAF_RESP_TARGET_9      |                               | X                              |      |         |       |        |
| 1   | 1         | 0 | 0 | 0 | 0 | 1 | 0 | \$C2 |     |                        |                               |                                |      |         |       |        |
| 1   | 1         | 0 | 0 | 0 | 0 | 1 | 1 | \$C3 |     |                        |                               |                                |      |         |       |        |
| 1   | 1         | 0 | 0 | 0 | 1 | 0 | 0 | \$C4 |     |                        |                               |                                |      |         |       |        |
| 1   | 1         | 0 | 0 | 0 | 1 | 0 | 1 | \$C5 |     |                        |                               |                                |      |         |       |        |
| 1   | 1         | 0 | 0 | 0 | 1 | 1 | 0 | \$C6 | R/W | SAF_RESP_TARGET_14_pt1 | Safing record response target |                                | X    |         |       |        |
| 1   | 1         | 0 | 0 | 0 | 1 | 1 | 1 | \$C7 | R/W | SAF_RESP_TARGET_14_pt2 |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 0 | 1 | 0 | 0 | 0 | \$C8 | R/W | SAF_RESP_TARGET_15_pt1 |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 0 | 1 | 0 | 0 | 1 | \$C9 | R/W | SAF_RESP_TARGET_15_pt2 |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 0 | 1 | 0 | 1 | 0 | \$CA | R/W | SAF_RESP_TARGET_16_pt1 |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 0 | 1 | 0 | 1 | 1 | \$CB | R/W | SAF_RESP_TARGET_16_pt2 |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 0 | 1 | 1 | 0 | 0 | \$CC | R/W | SAF_DATA_MASK_1        | Safing record data mask       |                                | X    |         |       |        |
| 1   | 1         | 0 | 0 | 1 | 1 | 0 | 1 | \$CD | R/W | SAF_DATA_MASK_2        |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 0 | 1 | 1 | 1 | 0 | \$CE | R/W | SAF_DATA_MASK_3        |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 0 | 1 | 1 | 1 | 1 | \$CF | R/W | SAF_DATA_MASK_4        |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 1 | 0 | 0 | 0 | 0 | \$D0 | R/W | SAF_DATA_MASK_5        |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 1 | 0 | 0 | 0 | 1 | \$D1 | R/W | SAF_DATA_MASK_6        |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 1 | 0 | 0 | 1 | 0 | \$D2 | R/W | SAF_DATA_MASK_7        |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 1 | 0 | 0 | 1 | 1 | \$D3 | R/W | SAF_DATA_MASK_8        |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 1 | 0 | 1 | 0 | 0 | \$D4 | R/W | SAF_DATA_MASK_9        |                               |                                | X    |         |       |        |
| 1   | 1         | 0 | 1 | 0 | 1 | 0 | 1 | \$D5 |     |                        |                               |                                |      |         |       |        |
| 1   | 1         | 0 | 1 | 0 | 1 | 1 | 0 | \$D6 |     |                        |                               |                                |      |         |       |        |
| 1   | 1         | 0 | 1 | 0 | 1 | 1 | 1 | \$D7 |     |                        |                               |                                |      |         |       |        |
| 1   | 1         | 0 | 1 | 1 | 0 | 0 | 0 | \$D8 |     |                        |                               |                                |      |         |       |        |



**Table 6. Global SPI register map (continued)**

| GID | RID / WID |   |   |   |   |   |   |      | Hex | R/W                  | Name                    | Description | Operating State <sup>(1)</sup> |      |         |       |        |
|-----|-----------|---|---|---|---|---|---|------|-----|----------------------|-------------------------|-------------|--------------------------------|------|---------|-------|--------|
|     |           |   |   |   |   |   |   |      |     |                      |                         |             | Init                           | Diag | Ssafing | Scrap | Arming |
| 1   | 1         | 0 | 1 | 1 | 0 | 0 | 1 | \$D9 | R/W | SAF_DATA_MASK_14_pt1 | Safing record data mask |             | X                              |      |         |       |        |
| 1   | 1         | 0 | 1 | 1 | 0 | 1 | 0 | \$DA | R/W | SAF_DATA_MASK_14_pt2 |                         |             | X                              |      |         |       |        |
| 1   | 1         | 0 | 1 | 1 | 0 | 1 | 1 | \$DB | R/W | SAF_DATA_MASK_15_pt1 |                         |             | X                              |      |         |       |        |
| 1   | 1         | 0 | 1 | 1 | 1 | 0 | 0 | \$DC | R/W | SAF_DATA_MASK_15_pt2 |                         |             | X                              |      |         |       |        |
| 1   | 1         | 0 | 1 | 1 | 1 | 0 | 1 | \$DD | R/W | SAF_DATA_MASK_16_pt1 |                         |             | X                              |      |         |       |        |
| 1   | 1         | 0 | 1 | 1 | 1 | 1 | 0 | \$DE | R/W | SAF_DATA_MASK_16_pt2 |                         |             | X                              |      |         |       |        |
| 1   | 1         | 0 | 1 | 1 | 1 | 1 | 1 | \$DF | R/W | SAF_THRESHOLD_1      | Safing record threshold |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 0 | 0 | 0 | 0 | \$E0 | R/W | SAF_THRESHOLD_2      |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 0 | 0 | 0 | 1 | \$E1 | R/W | SAF_THRESHOLD_3      |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 0 | 0 | 1 | 0 | \$E2 | R/W | SAF_THRESHOLD_4      |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 0 | 0 | 1 | 1 | \$E3 | R/W | SAF_THRESHOLD_5      |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 0 | 1 | 0 | 0 | \$E4 | R/W | SAF_THRESHOLD_6      |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 0 | 1 | 0 | 1 | \$E5 | R/W | SAF_THRESHOLD_7      |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 0 | 1 | 1 | 0 | \$E6 | R/W | SAF_THRESHOLD_8      |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 0 | 1 | 1 | 1 | \$E7 | R/W | SAF_THRESHOLD_9      |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 1 | 0 | 0 | 0 | \$E8 |     |                      |                         |             |                                |      |         |       |        |
| 1   | 1         | 1 | 0 | 1 | 0 | 0 | 1 | \$E9 |     |                      |                         |             |                                |      |         |       |        |
| 1   | 1         | 1 | 0 | 1 | 0 | 1 | 0 | \$EA |     |                      |                         |             |                                |      |         |       |        |
| 1   | 1         | 1 | 0 | 1 | 0 | 1 | 1 | \$EB |     |                      |                         |             |                                |      |         |       |        |
| 1   | 1         | 1 | 0 | 1 | 1 | 0 | 0 | \$EC | R/W | SAF_THRESHOLD_14     |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 1 | 1 | 0 | 1 | \$ED | R/W | SAF_THRESHOLD_15     |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 1 | 1 | 1 | 0 | \$EE | R/W | SAF_THRESHOLD_16     |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 0 | 1 | 1 | 1 | 1 | \$EF | R/W | SAF_CONTROL_1        | Safing record control   |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 1 | 0 | 0 | 0 | 0 | \$F0 | R/W | SAF_CONTROL_2        |                         |             | X                              |      |         |       |        |
| 1   | 1         | 1 | 1 | 0 | 0 | 0 | 1 | \$F1 | R/W | SAF_CONTROL_3        |                         |             | X                              |      |         |       |        |

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**Table 6. Global SPI register map (continued)**

| GID | RID / WID |   |   |   |   |   |   |      | Hex | R/W            | Name                  | Description                    | Operating State <sup>(1)</sup> |      |         |       |        |
|-----|-----------|---|---|---|---|---|---|------|-----|----------------|-----------------------|--------------------------------|--------------------------------|------|---------|-------|--------|
|     |           |   |   |   |   |   |   |      |     |                |                       |                                | Init                           | Diag | Ssafing | Scrap | Arming |
| 1   | 1         | 1 | 1 | 0 | 0 | 1 | 0 | \$F2 | R/W | SAF_CONTROL_4  | Safing record control |                                | X                              |      |         |       |        |
| 1   | 1         | 1 | 1 | 0 | 0 | 1 | 1 | \$F3 | R/W | SAF_CONTROL_5  |                       |                                | X                              |      |         |       |        |
| 1   | 1         | 1 | 1 | 0 | 1 | 0 | 0 | \$F4 | R/W | SAF_CONTROL_6  |                       |                                | X                              |      |         |       |        |
| 1   | 1         | 1 | 1 | 0 | 1 | 0 | 1 | \$F5 | R/W | SAF_CONTROL_7  |                       |                                | X                              |      |         |       |        |
| 1   | 1         | 1 | 1 | 0 | 1 | 1 | 0 | \$F6 | R/W | SAF_CONTROL_8  |                       |                                | X                              |      |         |       |        |
| 1   | 1         | 1 | 1 | 0 | 1 | 1 | 1 | \$F7 | R/W | SAF_CONTROL_9  |                       |                                | X                              |      |         |       |        |
| 1   | 1         | 1 | 1 | 1 | 0 | 0 | 0 | \$F8 |     |                |                       |                                |                                |      |         |       |        |
| 1   | 1         | 1 | 1 | 1 | 0 | 0 | 1 | \$F9 |     |                |                       |                                |                                |      |         |       |        |
| 1   | 1         | 1 | 1 | 1 | 0 | 1 | 0 | \$FA |     |                |                       |                                |                                |      |         |       |        |
| 1   | 1         | 1 | 1 | 1 | 0 | 1 | 1 | \$FB |     |                |                       |                                |                                |      |         |       |        |
| 1   | 1         | 1 | 1 | 1 | 1 | 0 | 0 | \$FC | R/W | SAF_CONTROL_14 |                       |                                | X                              |      |         |       |        |
| 1   | 1         | 1 | 1 | 1 | 1 | 0 | 1 | \$FD | R/W | SAF_CONTROL_15 |                       |                                | X                              |      |         |       |        |
| 1   | 1         | 1 | 1 | 1 | 1 | 1 | 0 | \$FE | R/W | SAF_CONTROL_16 |                       |                                | X                              |      |         |       |        |
| 1   | 1         | 1 | 1 | 1 | 1 | 1 | 1 | \$FF | R   | SAF_CC         |                       | Safing Record Compare Complete |                                |      |         |       |        |

1. A check mark indicates in which operating state a WRITE-command is valid.

2. KEEP\_ERBOOST\_ON, LOW\_POWER\_MODE, VSF\_V and VINGOOD\_FILT\_SEL bits are writable in all states, the other bits of SYS\_CFG are only writable in INIT state.

## 7.3 Global SPI tables

A summary of all the registers contained within the global SPI map are shown below and are referenced throughout the specification as they apply. The SPI register tables also specify the effect of the internal reset signals assertion on each bit field (the symbol '-' is used to indicate that the register is not affected by the relevant reset signal').

### Global SPI global status word

The Global SPI of L9679P contains an 11-bit word that returns global status information. The Global Status Word (GSW) of the Global SPI is the most significant 11 bits of MISO\_G data.

**Table 7. Global SPI Global Status Word**

| MISO_G | GSW | Name     | POR | WSM | SSM | Description   |
|--------|-----|----------|-----|-----|-----|---|
| 31     | 10  | SPIFLT   | 0   | 0   | 0   | SPI Fault, set if previous SPI frame had wrong parity check or wrong number of bits, cleared upon read<br>0 No fault<br>1 Fault   |
| 30     | 9   | DEPOK    | 0   | 0   | 0   | General Deployment Successful Flag, logical OR of the corresponding CHxDS bits (bit 15) in DSRx Registers<br>0 All the DSRx-CHDS bits are 0<br>1 At least one of the DSRx-CHDS bits is 1  |
| 29     | 8   | 0        | 0   | 0   | 0   | Unused  |
| 28     | 7   | WDT/TM_S | 0   | 0   | 0   | State of WDT/TM pin<br>0 WDT/TM=0<br>1 WDT/TM=1   |
| 27     | 6   | ERSTATE  | 0   | 0   | 0   | Set when Powermode state machine is in ER state<br>0 Powermode state machine is not in ER state<br>1 Powermode state machine is in ER state   |
| 26     | 5   | POWERFLT | 0   | 0   | 0   | Fault present in Power State Register, logical OR between bits from 18 to 9 of POWER_STATE Register<br>0 All the bits from 18 to 9 in the POWER_STATE Registers are 0s<br>1 At least one of the bits from 18 to 9 in the POWER_STATE Registers is 1 |
| 25     | 4   | FLT      | 1   | 1   | 1   | Fault present in Fault Status Register (FLTSR), logical OR between all bits of FLTSR<br>0 All the bits in the Fault Status Register (FLTSR) are 0s<br>1 At least one of the bits in the Fault Status Register (FLTSR) is 1                          |
| 24     | 3   | CONVRDY2 | 0   | 0   | 0   | ADC Conversion of request C or D has been completed so new results are available<br>0 No new data available<br>1 New data available   |

Table 7. Global SPI Global Status Word (continued)

| MISO_G | GSW | Name     | POR | WSM | SSM | Description   |
|--------|-----|----------|-----|-----|-----|---|
| 23     | 2   | CONVRDY1 | 0   | 0   | 0   | ADC Conversion of request A or B has been completed so new results are available<br>0 No new data available<br>1 New data available |
| 22     | 1   | ERR_WID  | 0   | 0   | 0   | Write address of previous SPI frame is not permitted in current operating phase<br>0 No Error<br>1 Error                            |
| 21     | 0   | ERR_RID  | 0   | 0   | 0   | Read address received in the actual SPI frame is unused so data in the response is don't care<br>0 No Error<br>1 Error              |

## Global SPI read/write register

## 7.3.1 Fault status register (FLTSR)

|      | 19          | 18 | 17       | 16       | 15            | 14 | 13 | 12 | 11         | 10     | 9      | 8       | 7      | 6      | 5       | 4 | 3      | 2      | 1 | 0   |     |
|------|-------------|----|----------|----------|---------------|----|----|----|------------|--------|--------|---------|--------|--------|---------|---|--------|--------|---|-----|-----|
| MOSI | -           |    |          |          | X             | X  | X  | X  | X          | X      | X      | X       | X      | X      | X       | X | X      | X      | X | X   | X   |
| MISO | ERCHARGE_OT | 0  | ERBST_OT | CLKFRERR | WD2 retry cnt |    |    |    | OTPCRC_ERR | WD2_LO | WD2_TM | WD2_WDR | WD1_LO | WD1_TM | WD1_WDR | 0 | WSMRST | SSMRST | 0 | POR | POR |

ID: 00

Type: R

Read: 0000

Write: -

|                    |     | POR | WSM | SSM |   |
|--------------------|-----|-----|-----|-----|---|
| ERCHARGE_OT        | 0   | -   | -   | -   | ER charge over temperature bit<br>Set when over-temp condition detected, cleared on SPI read or POR=1<br>0 No Fault<br>1 Fault          |
| ERBST_OT           | 0   | -   | -   | -   | ER Boost over-temperature bit<br>Set when over-temp condition detected, cleared on SPI read or POR=1<br>0 No Fault<br>1 Fault           |
| CLKFRERR           | 0   | -   | -   | -   | Internal oscillator cross-check error bit<br>Set when osc. error detected, cleared on SPI read or SUPPLY_POR=1<br>0 No Fault<br>1 Fault |
| WD2_retry_cnt[3:0] | \$0 | \$0 | \$0 |     | Value of WD2 retry counter  |
| OTPCRC_ERR         | 0   | -   | -   | -   | OTP CRC error bit<br>Set when OTP error detected (tested at release of POR), cleared by POR=1<br>0 No Fault<br>1 Fault                  |
| WD2_LO             | 1   | 0   | -   | -   | WD2 lockout - reflects WD2 lockout state<br>0 WD2 Lockout inactive<br>1 WD2 Lockout active  |
| WD2_TM             | 0   | 0   | 0   |     | WD2 test mode - reflects WD2TM signal state   |

|         |   |   |   |   |
|---------|---|---|---|---|
|         |   |   |   | 0 WD2TM=0<br>1 WD2TM=1  |
| WD2_WDR | 0 | 0 | - | WD2 reset latch - set when WD2RESET or STOPPING states are entered, cleared upon read<br><br>0 WD2RST signal = 0<br>1 WD2RST signal = 1               |
| WD1_LO  | 1 | 1 | - | WD1 lockout - reflects WD1 lockout state<br>Set and cleared per Watchdog Timer Flow Diagram<br><br>0 WD1 Lockout inactive<br>1 WD1 Lockout active     |
| WD1_TM  | 0 | 0 | 0 | WD1 test mode - reflects WD1TM signal state<br>Set and cleared per Watchdog Timer Flow Diagram<br><br>0 WD1TM=0<br>1 WD1TM=1                          |
| WD1_WDR | 0 | 0 | - | WD1 reset latch<br>Set and cleared per Watchdog Timer Flow Diagram<br><br>0 WD1_WDR signal = 0<br>1 WD1_WDR signal = 1                                |
| WSMRST  | 1 | 1 | - | Watchdog state machine reset<br>Set when WSM reset goes to '1', cleared upon SPI read<br><br>0 WSM reset has not occurred<br>1 WSM reset has occurred |
| SSMRST  | 1 | 1 | 1 | Safing state machine reset<br>Set when SSM reset goes to '1', cleared upon SPI read<br><br>0 SSM reset has not occurred<br>1 SSM Reset has occurred   |
| POR     | 1 | - | - | Power on Reset<br>Set when POR goes to '1', cleared upon SPI read<br><br>0 POR reset has not occurred<br>1 POR Reset has occurred                     |

### 7.3.2 System configuration register (SYS\_CFG)

|      | 19 | 18 | 17 | 16 | 15                 | 14 | 13             | 12            | 11       | 10               | 9                       | 8      | 7 | 6     | 5 | 4         | 3       | 2     | 1                | 0          |
|------|----|----|----|----|--------------------|----|----------------|---------------|----------|------------------|-------------------------|--------|---|-------|---|-----------|---------|-------|------------------|------------|
| MOSI |    |    |    |    | EN_AUTO_SWITCH_OFF | X  | LOW_POWER_MODE | KEEP_ERBST_ON | PSINHSEL | HI_LEV_DIAG_TIME | RSU_SYNCULSE_SHIFT_CONF | SQMEAS |   | VMEAS |   | DCS_PAD_V | SAFESEL | VSF_V | VINGOOD_FILT_SEL | WD1_TO_DIS |
| MISO | 0  | 0  | 0  | 0  | EN_AUTO_SWITCH_OFF | 0  | LOW_POWER_MODE | KEEP_ERBST_ON | PSINHSEL | HI_LEV_DIAG_TIME | RSU_SYNCULSE_SHIFT_CONF | SQMEAS |   | VMEAS |   | DCS_PAD_V | SAFESEL | VSF_V | VINGOOD_FILT_SEL | WD1_TO_DIS |

**ID:** 01

**Type:** R/W

**Read:** 0100

**Write:** 0002

|                    | POR | WSM | SSM |  |
|--------------------|-----|-----|-----|--|
| EN_AUTO_SWITCH_OFF | 0   | 0   | 0   | Enable auto switch off ISRC current source and DCS regulator after measurement completion<br>0 Auto switch off disabled<br>1 Auto switch off enabled |
| LOW_POWER_MODE     | 0   | -   | -   | Selection of over current detection for SYNCBOOST, SATBUCK and VCCBUCK<br>0 High current level<br>1 Low current level                                |
| KEEP_ERBST_ON      | 1   | 1   | 1   | ER Boost behaviour during ER state<br>0 ER Boost is disabled<br>1 ER Boost stay enabled  |
| PSINHSEL           | 1   | 1   | 1   | PSINH engine mode select<br>Updated by SSM_RESET or SPI write  |

|                          |    |    |    |  |
|--------------------------|----|----|----|--|
|                          |    |    |    | 0 Internal<br>1 External   |
| HI_LEV_DIAG_TIME         | 0  | 0  | 0  | Selection of duration of high level squib diagnostics<br>0 Short time (see high level diag diagram)<br>1 Long time (see high level diag diagram)                               |
| RSU_SYNCPULSE_SHIFT_CONF | 0  | 0  | 0  | Selection of sync pulses shift duration<br>0 Long time<br>1 Short time   |
| SQMEAS                   | 00 | 00 | 00 | Sample number in DC sensor, squib measurement and temperature conversions<br>Updated by SSM_RESET or SPI write<br>00 8 samples<br>01 16 samples<br>10 4 samples<br>11 2 sample |
| VMEAS                    | 00 | 00 | 00 | Sample number in any other voltage measurement conversions<br>Updated by SSM_RESET or SPI write<br>00 4 samples<br>01 16 samples<br>10 8 samples<br>11 1 sample                |
| DCS_PAD_V                | 0  | 0  | 0  | Passenger inhibit measurement mode<br>0 Current<br>1 Voltage   |
| SAFESEL                  | 1  | 1  | 1  | Safing engine mode select<br>Updated by SSM_RESET or SPI write<br>0 Internal safing engine<br>1 external safing engine   |

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|                  |   |   |   |   |
|------------------|---|---|---|---|
| VSF_V            | 0 | 0 | 0 | VSF voltage select<br>Updated by SSM_RESET or SPI write<br>0 20V<br>1 25V   |
| VINGOOD_FILT_SEL | 0 | - | - | Selector of filter time for VINGOOD going low (time is fixed to 3.5 $\mu$ s for VINGOOD going high)<br>0 1 $\mu$ s<br>1 3.5 $\mu$ s                                     |
| WD1_TO_DIS       | 0 | 0 | - | Disable of initial 500 ms timeout function of WD1 state machine<br>Updated by WSM_RESET or SPI write<br>0 timeout function is enabled<br>1 timeout function is disabled |

### 7.3.3 System control register (SYS\_CTL)

|      | 19 | 18 | 17 | 16 | 15                | 14          | 13              | 12         | 11             | 10 | 9        | 8         | 7 | 6         | 5          | 4       | 3 | 2                | 1       | 0     |
|------|----|----|----|----|-------------------|-------------|-----------------|------------|----------------|----|----------|-----------|---|-----------|------------|---------|---|------------------|---------|-------|
| MOSI | -  |    |    |    | RESTART_SYBST_SEL | PD&VRCM_SEL | KEEP_SYNCBST_ON | VIN_TH_SEL | VBATMON_TH_SEL |    | ER_BST_V | ER_CUR_EN |   | ER_BST_EN | SYNCBST_EN | SPI_OFF | x | ERSWITCH_LIM_SEL | SYBST_V | SAT_V |
| MISO | 0  | 0  | 0  | 0  | RESTART_SYBST_SEL | PD&VRCM_SEL | KEEP_SYNCBST_ON | VIN_TH_SEL | VBATMON_TH_SEL |    | ER_BST_V | ER_CUR_EN |   | ER_BST_EN | VSUP_EN    | SPI_OFF | 0 | ERSWITCH_LIM_SEL | SYBST_V | SAT_V |

**ID:** 02  
**Type:** R/W  
**Read:** 0200  
**Write:** 0004

|                   |   |     |     |     |   |
|-------------------|---|-----|-----|-----|---|
|                   |   | POR | WSM | SSM |   |
| RESTART_SYBST_SEL | 0 | -   | -   | -   | Selection of comparator used to restart sync boost in erstate (don't care in case SYS_CTL(KEEP_SYNCBST_ON) bit is high)   |
|                   |   |     |     |     | 0 VIN comparator is used; syncboost is switched off entering erstate and switched on once VIN goes above VIN_fastslope threshold.   |
|                   |   |     |     |     | 1 SYNCBST comparator is used; syncboost is switched off entering erstate and switched on when SYNCBST voltage falls down VSYNCBST_RESTART_TH threshold (this condition requires that SYNCBST voltage has been pulled up above the same threshold previously). |
| PD&VRCM_SEL       | 0 | 0   | 0   | 0   | Squib pull down current level and VRCM leakage to GND threshold selection   |
|                   |   |     |     |     | 0 1 mA pull down current and 450 µA VRCM leakage to GND threshold   |
|                   |   |     |     |     | 15 mA pull down current and 2 mA VRCM leakage to GND threshold  |
| KEEP_SYNCBST_ON   | 1 | -   | -   | -   | SYNC Boost behaviour during ER state  |
|                   |   |     |     |     | 0 SYNC Boost is disabled entering in ER state   |
|                   |   |     |     |     | 1 SYNC Boost stay enabled in ER state. If boost is OFF in ER state and this command is received during that state the boost is switched on.   |
| VIN_TH_SEL        | 0 | 0   | 0   | 0   | VIN comparators threshold selector  |
|                   |   |     |     |     | 0 VINGOOD= VINgood0   |
|                   |   |     |     |     | 1 VINGOOD= VINgood1   |

|                  |    |    |    |  |
|------------------|----|----|----|--|
| VBATMON_TH_SEL   | 00 | 00 | 00 | VBATMON comparators threshold selector<br>00 VBGGOOD= VBgood0<br>01 VBGGOOD= VBgood1<br>10 VBGGOOD= VBgood2<br>11 VBGGOOD= VBgood0   |
| ER_BST_V         | 0  | 0  | 0  | ER Boost voltage select<br>Updated by SSM_RESET or SPI write<br>0 set 23 V boost<br>1 set 33 V boost   |
| ER_CUR_EN        | 00 | 00 | 00 | ER charge / discharge control<br>00 Current sources off<br>01 ER charge enabled<br>10 ER discharge enabled<br>11 Current sources off   |
| ER_BST_EN        | 1  | 1  | 1  | Boost enable<br>Updated by SSM_RESET or SPI write<br>0 ER_BOOST OFF request<br>1 ER_BOOST ON request   |
| SYNCBST_EN       | 1  | 1  | 1  | Syncboost enable<br>Updated by SSM_RESET or SPI write<br>0 SYNC_BOOST OFF request<br>1 SYNC_BOOST ON request   |
| SPI_OFF          | 0  | 0  | 0  | Go to POWER OFF state from POWERMODE SHUTDOWN state<br>Updated by SSM_RESET or SPI write while in POWERMODE SHUTDOWN state<br>0 no effect<br>1 transition to POWER OFF state |
| ERSWITCH_LIM_SEL | 0  | -  | -  | ERswitch current limitation select<br>Updated by POR or SPI write<br>0 Low current limit<br>1 High current limit is no more available  |
| SYBST_V          | 0  | 0  | 0  | Sync Boost voltage select<br>Updated by SSM_RESET or SPI write<br>0 Low - syncboost = 12 V<br>1 High - syncboost = 14.75 V   |

SAT\_V 0 0 0 SatBuck and Satellite Interface voltage select  
 Updated by SSM\_RESET or SPI write  
 0 Low - satbuck=7.2V  
 1 High - satbuck=9V

**7.3.4 SPI Sleep command register (SPI\_SLEEP)**

|      |    |    |    |    |        |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |   |
|------|----|----|----|----|--------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|---|
|      | 19 | 18 | 17 | 16 | 15     | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |   |
| MOSI | -  |    |    |    | \$3C95 |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | -      | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

**ID:** 03  
**Type:** W  
**Read:** -  
**Write:** 0006

|            |     |     |     |  |
|------------|-----|-----|-----|--|
|            | POR | WSM | SSM |  |
| SLEEP_MODE | N/A | N/A | N/A | Non-latched command that allows transition into POWERMODE_SHUTDOWN state according to the Power Control State Flow Diagram |

### 7.3.5 System state register (SYS\_STATE)

|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10             | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2               | 1 | 0 |
|------|----|----|----|----|----|----|----|----|----|----------------|---|---|---|---|---|---|---|-----------------|---|---|
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X              | X | X | X | X | X | X | X | X               | X | X |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | OPER_CTL_STATE |   |   | 0 | 0 | 0 | 0 | 0 | POWER_CTL_STATE |   |   |

**ID:** 04

**Type:** R

**Read:** 0400

**Write:** -

POR  
WSM  
SSM  
 OPER\_CTL\_STATE[2:0] 000 000 000 Reports Operating Control State

Updated per Power Up Phases diagram

- 000 = INIT
- 001 = DIAG
- 010 = SAFING
- 011 = SCRAP
- 100 = ARMING
- 101 unused
- 110 unused
- 111 unused

POWER\_CTL\_STATE[2:0] 000 - - Reports Power Control State

Updated per Power Control State Flow Diagram

- 000 = AWAKE
- 001 = STARTUP
- 010 = RUN
- 011 = ER
- 100 = POWER MODE SHUTDOWN
- 101 unused
- 110 unused
- 111 unused

### 7.3.6 Power state register (POWER\_STATE)

|      | 19     | 18    | 17          | 16     | 15          | 14        | 13          | 12         | 11     | 10     | 9 | 8         | 7          | 6           | 5           | 4        | 3         | 2           | 1       | 0       |   |
|------|--------|-------|-------------|--------|-------------|-----------|-------------|------------|--------|--------|---|-----------|------------|-------------|-------------|----------|-----------|-------------|---------|---------|---|
| MOSI | -      |       |             |        | X           | X         | X           | X          | X      | X      | X | X         | X          | X           | X           | X        | X         | X           | X       | X       | X |
| MISO | WAKEUP | VBBAD | NOT_VBGGOOD | VINBAD | NOT_VINGOOD | S_BST_NOK | SATBUCK_NOK | ER_BST_NOK | VCC_UV | VCC_OV | 0 | ER_BST_ON | ER_CHRG_ON | ER_LCDIS_ON | ER_HCDIS_ON | ER_SW_ON | S_BST_ACT | SATBUCK_ACT | VCC_ACT | VSF_ACT |   |

**ID:** 05  
**Type:** R  
**Read:** 0500  
**Write:** -

- |             |   |     |     |     |   |
|-------------|---|-----|-----|-----|---|
|             |   | POR | WSM | SSM |   |
| WAKEUP      | - | -   | -   | -   | WAKEUP pin status<br>Set and cleared based on voltage<br>0 WAKEUP pin < WU_off<br>1 WAKEUP pin > WU_on    |
| VBBAD       | - | -   | -   | -   | VBATMON bad pin status<br>Set and cleared based on voltage<br>1 VBATMON < VBBAD<br>0 VBATMON > VBBAD      |
| NOT_VBGGOOD | - | -   | -   | -   | VBATMON good pin status<br>Set and cleared based on voltage<br>1 VBATMON < VBGGOOD<br>0 VBATMON > VBGGOOD |
| VINBAD      | - | -   | -   | -   | VIN bad pin status<br>Set and cleared based on voltage<br>0 VIN > VINBAD<br>1 VIN < VINBAD                |
| NOT_VINGOOD | - | -   | -   | -   | VIN good pin status<br>Set and cleared based on voltage<br>0 VIN > VINGOOD<br>1 VIN < VINGOOD             |
| S_BST_NOK   | - | -   | -   | -   | SYNCBOOST bad pin status  |

|             |   |   |   |   |
|-------------|---|---|---|---|
|             |   |   |   | Set based on voltage, cleared on SPI read<br>1 V_SYNCBOOST < SYNCBOOST_OK<br>0 V_SYNCBOOST > SYNCBOOST_OK   |
| SATBUCK_NOK | - | - | - | SATBUCK bad pin status<br>Set based on voltage, cleared on SPI read<br>1 V_SATBUCK < SATBUCK_OK<br>0 V_SATBUCK > SATBUCK_OK   |
| ER_BST_NOK  | - | - | - | ERBOOST pin status<br>Set and cleared based on voltage<br>1 V_ERBOOST < ERBOOST_OK<br>0 V_ERBOOST > ERBOOST_OK  |
| VCC_UV      | - | - | - | VCC_UV status<br>Set based on voltage, cleared on SPI read<br>0 VCC > VCC_UV<br>1 VCC < VCC_UV  |
| VCC_OV      | - | - | - | VCC_OV status<br>Set based on voltage, cleared on SPI read<br>0 VCC < VCC_OV<br>1 VCC > VCC_OV  |
| ER_BST_ON   | 0 | - | - | ERBOOST_ON state<br>Updated according to ER_BOOST Control Behavior diagram<br>0 RBOOST_OFF or ERBOOST_OT state or ER_BST_STBY state (boost not running)<br>1 ERBOOST_ON state (boost running) |
| ER_CHRG_ON  | 0 | 0 | 0 | ERCHARGE_ON state<br>Updated according to ER_CHARGE Power Mode Control diagram<br>0 ERCHARGE_ON = 0<br>1 ERCHARGE_ON = 1  |
| ER_LCDIS_ON | 0 | - | - | ER Low Current Discharge State<br>Updated according to ER Low current discharge state diagram<br>0 ER_LCDIS_OFF<br>1 ER_LCDIS_ON  |

|             |   |   |   |  |
|-------------|---|---|---|--|
| ER_HCDIS_ON | 0 | - | - | ER High Current Discharge State<br>Updated according to ER High Current discharge state diagram<br>0 ER_HCDIS_OFF<br>1 ER_HCDIS_ON   |
| ER_SW_ON    | 0 | - | - | ER_SWITCH State<br>Updated according to ER Switch state diagram<br>0 ER_SWITCH_OFF<br>1 ER_SWITCH_ON   |
| S_BST_ACT   | 0 | - | - | SYNCBOOST Active state<br>Updated according to SYNCBOOST Power Mode Control state diagram<br>0 SYNCBOOST supply in SYNCBOOST_OFF state<br>1 SYNCBOOST supply in SYNCBOOST_ON state |
| SATBUCK_ACT | 0 | 0 | 0 | SATBUCK Active state<br>Updated according to SATBUCK Power Mode Control state diagram<br>0 SATBUCK supply in SATBUCK_OFF state<br>1 SATBUCK supply in SATBUCK_ON state             |
| VCC_ACT     | 0 | - | - | Buck Active state<br>Updated according to VCC Power Mode Control state diagram<br>0 VCC supply in VCC_OFF or VCC_SHUTDOWN states<br>1 VCC supply in VCC_RAMPUP or VCC_ON states    |
| VSF_ACT     | 0 | 0 | 0 | VSF Active state<br>Updated according to VSF Control Logic diagram<br>0 VSF_EN = 0<br>1 VSF_EN = 1   |

### 7.3.7 Deployment configuration registers (DCR\_x)

**Deployment Configuration Channel 0 (DCR\_0)**  
**Deployment Configuration Channel 2 (DCR\_2)**  
**Deployment Configuration Channel 4 (DCR\_4)**  
**Deployment Configuration Channel 6 (DCR\_6)**

|             | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11          | 10 | 9 | 8 | 7 | 6 | 5 | 4           | 3               | 2 | 1           | 0 |
|-------------|----|----|----|----|----|----|----|----|-------------|----|---|---|---|---|---|-------------|-----------------|---|-------------|---|
| <b>MOSI</b> | -  |    |    |    | X  | X  | X  | X  | Deploy_Time |    |   |   |   |   |   | Dep_Current | Dep_expire_time | X | PD_CURR_CSR |   |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | Deploy_Time |    |   |   |   |   |   | Dep_Current | Dep_expire_time | 0 | PD_CURR_CSR |   |

**ID:** 06 (DCR\_0)  
 08 (DCR\_2)  
 0A (DCR\_4)  
 0C (DCR\_6)

**Type:** R/W

**Read:** 0600 (DCR\_0)  
 0800 (DCR\_2)  
 0A00 (DCR\_4)  
 0C00 (DCR\_6)

**Write:** 000C (DCR\_0)  
 0010 (DCR\_2)  
 0014 (DCR\_4)  
 0018 (DCR\_6)

POR WSM SSM

Deploy\_Time[5:0] 0000 0000 0000 Default deployment time = 0 μs (no deployment, 8 us pulse output on ARM1 pin during PULSE TEST)

Deployment time: actual deployment time (ms) = Deploy\_Time\*0.064ms (0.064ms/count up to 4.032ms max)

Dep\_Current[1:0] 00 00 00 Deployment Current limit select  
 Updated by SSM\_RESET or SPI write while in DIAG state  
 00 Unused (no deploy)  
 01 1.75 A min  
 10 1.2 A min  
 11 Unused (no deploy)

Dep\_expire\_time[1:0] 00 00 00 Deploy command expiration timer select



Updated by SSM\_RESET or SPI write while in DIAG state

- 00 500 ms
- 01 250 ms
- 10 125 ms
- 11 0 ms

PD\_CURR\_CSR    0    0    0    Pull down current control for Common SR connection  
 Updated by SSM\_RESET or SPI write

- 0 PD Current OFF only for channel selected for diagnostic measurement, ON for all other channel
- 1 PD Current OFF for both channels of the channel pair selected for diagnostic measurement, ON for all other channel

**Deployment Configuration Channel 1 (DCR\_1)**  
**Deployment Configuration Channel 3 (DCR\_3)**  
**Deployment Configuration Channel 5 (DCR\_5)**  
**Deployment Configuration Channel 7 (DCR\_7)**

|             | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11          | 10 | 9 | 8 | 7 | 6 | 5 | 4           | 3               | 2 | 1 | 0 |  |  |
|-------------|----|----|----|----|----|----|----|----|-------------|----|---|---|---|---|---|-------------|-----------------|---|---|---|--|--|
| <b>MOSI</b> | -  |    |    |    | X  | X  | X  | X  | Deploy_Time |    |   |   |   |   |   | Dep_Current | Dep_expire_time | X | X |   |  |  |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | Deploy_Time |    |   |   |   |   |   | Dep_Current | Dep_expire_time | 0 | 0 |   |  |  |

**ID:**            07 (DCR\_1)  
 09 (DCR\_3)  
 0B (DCR\_5)  
 0D (DCR\_7)

**Type:**        R/W

**Read:**        0700 (DCR\_1)  
 0900 (DCR\_3)  
 0B00 (DCR\_5)  
 0D00 (DCR\_7)

**Write:** 000E (DCR\_1)  
 0012 (DCR\_3)  
 0016 (DCR\_5)  
 001A (DCR\_7)

|                      | POR        | WSM        | SSM        |   |
|----------------------|------------|------------|------------|---|
| Deploy_Time[5:0]     | 0000<br>00 | 0000<br>00 | 0000<br>00 | Default deployment time = 0 $\mu$ s (no deployment, 8 us pulse output on ARM1 pin during PULSE TEST)<br><br>Deployment time: actual deployment time (ms) = Deploy_Time*0.064 ms (0.064 ms/count up to 4.032 ms max) |
| Dep_Current[1:0]     | 00         | 00         | 00         | Deployment Current limit select<br><br>Updated by SSM_RESET or SPI write while in DIAG state<br><br>00 Unused (no deploy)<br>01 1.75A min<br>10 1.2A min<br>11 Unused (no deploy)                                   |
| Dep_expire_time[1:0] | 00         | 00         | 00         | Deploy command expiration timer select<br><br>Updated by SSM_RESET or SPI write while in DIAG state<br><br>00 500 ms<br>01 250 ms<br>10 125 ms<br>11 0 ms   |

### 7.3.8 Deployment command (DEPCOM)

|      |    |    |    |    |    |    |    |    |           |           |           |           |           |           |           |           |           |           |           |           |
|------|----|----|----|----|----|----|----|----|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11        | 10        | 9         | 8         | 7         | 6         | 5         | 4         | 3         | 2         | 1         | 0         |
| MOSI | -  |    |    |    | X  | X  | X  | X  | CHBDEPREQ | CHADEPREQ | CH9DEPREQ | CH8DEPREQ | CH7DEPREQ | CH6DEPREQ | CH5DEPREQ | CH4DEPREQ | CH3DEPREQ | CH2DEPREQ | CH1DEPREQ | CH0DEPREQ |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | CHBDEP    | CHADEP    | CH9DEP    | CH8DEP    | CH7DEP    | CH6DEP    | CH5DEP    | CH4DEP    | CH3DEP    | CH2DEP    | CH1DEP    | CH0DEP    |

**ID:** 12  
**Type:** R/W  
**Read:** 1200  
**Write:** 0024

|           |     |     |     |  |
|-----------|-----|-----|-----|--|
|           | POR | WSM | SSM |  |
| CHxDEPREQ | N/A | N/A | N/A | Channel x Deploy Request - non-latched channel-specific deploy request   |
|           |     |     |     | 0 No change to deployment control for channel x  |
|           |     |     |     | 1 Clear and start Expiration timer if in ARMING or SAFING state and in DEPLOY_ENABLED state                    |
| CHxDEP    | 0   | 0   | 0   | Channel x deployment expiration timer enable   |
|           |     |     |     | Set when SPI_DEPCOM(CHxDEPREQ=1) AND in ARMING or SAFING state AND in DEP_ENABLED state                        |
|           |     |     |     | Cleared on SSM_RESET OR when in DEP_DISABLED state OR when Deploy Expiration Timer x reaches timeout threshold |
|           |     |     |     | 1 Expiration timer enabled - Deploy command still valid  |
|           |     |     |     | 0 Expiration Timer disabled - Deploy command no more valid   |

### 7.3.9 Deployment status registers (DSR\_x)

- Deployment Status Channel 0 (DSR\_0)
- Deployment Status Channel 1 (DSR\_1)
- Deployment Status Channel 2 (DSR\_2)
- Deployment Status Channel 3 (DSR\_3)
- Deployment Status Channel 5 (DSR\_5)
- Deployment Status Channel 6 (DSR\_6)
- Deployment Status Channel 7 (DSR\_7)

|      |    |    |    |    |       |         |    |         |    |    |   |   |   |   |                  |   |   |   |   |   |   |
|------|----|----|----|----|-------|---------|----|---------|----|----|---|---|---|---|------------------|---|---|---|---|---|---|
|      | 19 | 18 | 17 | 16 | 15    | 14      | 13 | 12      | 11 | 10 | 9 | 8 | 7 | 6 | 5                | 4 | 3 | 2 | 1 | 0 |   |
| MOSI | -  |    |    |    | X     | X       | X  | X       | X  | X  | X | X | X | X | X                | X | X | X | X | X | X |
| MISO | 0  | 0  | 0  | 0  | CHxDS | CHxSTAT | 0  | DCRXERR |    |    |   |   |   |   | DEP_CHx_ExpTimer |   |   |   |   |   |   |

**ID:** 13 (DSR\_0)  
 14 (DSR\_1)  
 15 (DSR\_2)  
 16 (DSR\_3)  
 17 (DSR\_4)  
 18 (DSR\_5)  
 19 (DSR\_6)  
 1A (DSR\_7)

**Type:** R

**Read:** 1300 (DSR\_0)  
 1400 (DSR\_1)  
 1500 (DSR\_2)  
 1600 (DSR\_3)  
 1700 (DSR\_4)  
 1800 (DSR\_5)  
 1900 (DSR\_6)  
 1A00 (DSR\_7)

**Write:** -

|         |     |     |     |  |
|---------|-----|-----|-----|--|
|         | POR | WSM | SSM |  |
| CHxDS   | 0   | 0   | 0   | Channel x deployment successful<br>Updated according to Deployment Driver Control Logic<br>(set when deployment terminates on ch x due to deploy timer timeout,<br>cleared on SSM_RESET OR when deployment starts on ch x)<br><br>0 Deployment not successful<br>1 Deployment successful |
| CHxSTAT | 0   | 0   | 0   | Channel x deployment status<br>Updated according to Deployment Driver Control Logic<br>(set when deployment starts on ch x, cleared on SSM_RESET OR when<br>deployment terminates due to deploy timer timeout, LS Over current OR<br>GND Loss)   |

---

|                       |      |      |      |   |  |
|-----------------------|------|------|------|---|--|
|                       |      |      |      | 0 | Deployment not in progress   |
|                       |      |      |      | 1 | Deployment in progress   |
| DCRxERR               | 0    | 0    | 0    |   | Deployment configuration register error  |
|                       |      |      |      | 0 | Deploy configuration change accepted and stored in memory  |
|                       |      |      |      | 1 | Deploy configuration change rejected because deploy is in progress<br>(or DEP_EXPIRE_TIME changed when in DEP_ENABLED state)   |
| DEP_CHx_ExpTimer[5:0] | 0000 | 0000 | 0000 |   | Channel x Deployment Expiration Timer value 8 ms/count   |
|                       | 00   | 00   | 00   |   | Updated according to Deployment Driver Control Logic<br>(Cleared on SSM_RESET OR when Exp Timer times out OR when<br>SPI_DEPREQx is received while in DEP_ENABLED state AND in ARMING<br>or SAFING states) |

### 7.3.10 Deployment current monitor registers (DCMTSxy)

- Deployment Current Monitor Status Channel 0,1 (DDCMTS01)**
- Deployment Current Monitor Status Channel 2,3 (DDCMTS23)**
- Deployment Current Monitor Status Channel 4,5 (DDCMTS45)**
- Deployment Current Monitor Status Channel 6,7 (DDCMTS67)**

|             |    |    |    |    |                          |    |    |    |    |    |   |                          |   |   |   |   |   |   |   |   |   |
|-------------|----|----|----|----|--------------------------|----|----|----|----|----|---|--------------------------|---|---|---|---|---|---|---|---|---|
|             | 19 | 18 | 17 | 16 | 15                       | 14 | 13 | 12 | 11 | 10 | 9 | 8                        | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |   |
| <b>MOSI</b> | -  |    |    |    | X                        | X  | X  | X  | X  | X  | X | X                        | X | X | X | X | X | X | X | X | X |
| <b>MISO</b> | 0  | 0  | 0  | 0  | Current_Mon_Timer_y[7:0] |    |    |    |    |    |   | Current_Mon_Timer_x[7:0] |   |   |   |   |   |   |   |   |   |

**ID:** 1F (DDCMTS01)  
 20 (DDCMTS23)  
 21 (DDCMTS45)  
 22 (DDCMTS67)

**Type:** R

**Read:** 1F00 (DDCMTS01)  
 2000 (DDCMTS23)  
 2100 (DDCMTS45)  
 2202 (DDCMTS67)

**Write:** -

|                          | POR  | WSM  | SSM  |  |
|--------------------------|------|------|------|--|
| Current_Mon_Timer_y[7:0] | \$00 | \$00 | \$00 | Channel y current monitor timer value corresponding to SPI command DCMTSxy.<br>Set to default (cleared) on SSM_RESET or when a new deployment starts on channel y. Increments each 16 μs while deployment current exceeds monitor threshold on channel y |
| Current_Mon_Timer_x[7:0] | \$00 | \$00 | \$00 | Channel x current monitor timer value corresponding to SPI command DCMTSxy.<br>Set to default (cleared) on SSM_RESET or when a new deployment starts on channel x. Increments each 16 μs while deployment current exceeds monitor threshold on channel y |

### 7.3.11 Deploy enable register (SPIDEPEN)

|      |    |    |    |    |                   |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
|------|----|----|----|----|-------------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
|      | 19 | 18 | 17 | 16 | 15                | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| MOSI | -  |    |    |    | DEPEN_WR[15:0]    |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | DEPEN_STATE[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**ID:** 25  
**Type:** R/W  
**Read:** 2500  
**Write:** 004A

|                |     |     |     |   |
|----------------|-----|-----|-----|---|
|                | POR | WSM | SSM |   |
| DEPEN_WR[15:0] | N/A | N/A | N/A | Non-latched encoded value for LOCK / UNLOCK command |
|                |     |     |     | \$0FF0 LOCK - enter DEP_DISABLED state              |
|                |     |     |     | \$F00F UNLOCK - enter DEP_ENABLED state.            |

DEPEN\_STATE[15:0] \$0FF0\$0FF0\$0FF0Deploy Enabled State  
 Updated according to Global SPI Deployment Enable State Diagram

\$0FF0 In DEP\_DISABLED state  
 \$F00F In DEP\_ENABLED state

### 7.3.12 Deployment ground loss register (LP\_GNDLOSS)

|      |    |    |    |    |    |    |    |    |          |          |          |          |          |          |          |          |          |          |          |          |
|------|----|----|----|----|----|----|----|----|----------|----------|----------|----------|----------|----------|----------|----------|----------|----------|----------|----------|
|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11       | 10       | 9        | 8        | 7        | 6        | 5        | 4        | 3        | 2        | 1        | 0        |
| MOSI | -  |    |    |    | X  | X  | X  | X  | X        | X        | X        | X        | X        | X        | X        | X        | X        | X        | X        | X        |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | GNDLOSSB | GNDLOSSA | GNDLOSS9 | GNDLOSS8 | GNDLOSS7 | GNDLOSS6 | GNDLOSS5 | GNDLOSS4 | GNDLOSS3 | GNDLOSS2 | GNDLOSS1 | GNDLOSS0 |

**ID:** 26  
**Type:** R  
**Read:** 2600  
**Write:** -

|          |     |     |     |   |
|----------|-----|-----|-----|---|
|          | POR | WSM | SSM |   |
| GNDLOSSx | 0   | 0   | 0   | Loop x Squib Ground loss  |
|          |     |     |     | Cleared upon SSM_RESET or SPI read. Set when GND loss is detected during deployment or loop diag's (HS sw test, LS sw test, squib resistance) |
|          |     |     |     | 0 Loss of ground not detected   |
|          |     |     |     | 1 Loss of ground detected   |

### 7.3.13 Device version register (VERSION\_ID)

|             | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10        | 9 | 8 | 7 | 6 | 5     | 4 | 3 | 2 | 1 | 0 |   |
|-------------|----|----|----|----|----|----|----|----|----|-----------|---|---|---|---|-------|---|---|---|---|---|---|
| <b>MOSI</b> | -  |    |    |    | X  | X  | X  | X  | X  | X         | X | X | X | X | X     | X | X | X | X | X | X |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | DEVICE ID |   |   | 0 | 0 | VERSN |   |   |   |   |   |   |

**ID:** 27

**Type:** R

**Read:** 2700

**Write:** -

|           | POR | WSM | SSM |  |
|-----------|-----|-----|-----|--|
| DEVICE ID | -   | -   | -   | Identification of the device<br>Static value - never updated<br>001 Low end<br>010 Medium end<br>011 High end  |
| VERSN     | -   | -   | -   | Identification of the silicon version<br>Static value - never updated<br>000000 AA version<br>000001 AB version<br>001000 BA version<br>001001 BB version<br>010000 CA version |

### 7.3.14 Watchdog retry configuration register (WD\_RETRY\_CONF)

|             | 19 | 18 | 17 | 16 | 15 | 14 | 13         | 12           | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4            | 3 | 2 | 1 | 0 |  |
|-------------|----|----|----|----|----|----|------------|--------------|----|----|---|---|---|---|---|--------------|---|---|---|---|--|
| <b>MOSI</b> | -  |    |    |    |    |    | WD2_ERR_TH | WD2_RETRY_TH |    |    | X | X | X | X | X | WD1_RETRY_TH |   |   |   |   |  |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0  | 0  | WD2_ERR_TH | WD2_RETRY_TH |    |    | 0 | 0 | 0 | 0 | 0 | WD1_RETRY_TH |   |   |   |   |  |

**ID:** 28  
**Type:** R/W  
**Read:** 2800  
**Write:** 0050

- |              |   |     |     |   |  |
|--------------|---|-----|-----|---|--|
|              |   | POR | WSM | SSM   |  |
| WD2_ERR_TH   | 4 | 4   | -   | WD2 error counter threshold (number of W2 reset permitted before going to WD2_STOP state)                         |  |
| WD2_RETRY_TH | 4 | 4   | -   | WD2 retry counter threshold (number of W2 errors permitted before asserting WD2_Lockout and increment WD2_ERRcnt) |  |
| WD1_RETRY_TH | 7 | 7   | -   | WD1 retry counter threshold (number of WD errors permitted before latching WD1_LOCKOUT=1)                         |  |

### 7.3.15 Watchdog timer configuration register (WDTCR)

|             | 19 | 18 | 17 | 16 | 15 | 14       | 13          | 12 | 11 | 10 | 9 | 8 | 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----|----|----|----|----|----------|-------------|----|----|----|---|---|---------------|---|---|---|---|---|---|---|
| <b>MOSI</b> | -  |    |    |    |    | X        | WDTMIN[6:0] |    |    |    |   |   | WDTDELTA[6:0] |   |   |   |   |   |   |   |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0  | WD1_MODE | WDTMIN[6:0] |    |    |    |   |   | WDTDELTA[6:0] |   |   |   |   |   |   |   |

**ID:** 2A  
**Type:** R/W  
**Read:** 2A00  
**Write:** 0054

- |          |   |     |     |          |  |
|----------|---|-----|-----|----------|--|
|          |   | POR | WSM | SSM      |  |
| WD1_MODE | 0 | 0   | -   | WD1_MODE |  |
- Updated by WSM RESET or SPI write while in WD1 INIT state  
 0 Fast WD1 mode - nominal 8 μs timer resolution (2 ms max value)  
 1 Slow WD1 mode - nominal 64 μs timer resolution (16.3 ms max value)

- WDTMIN[6:0] \$32 \$32 - WD1 window minimum value - resolution according to WD1\_MODE bit (\$32 = 400 μs in WD1 fast mode)  
Updated by WSM RESET or SPI write while in WD1 INT state.
- WDTDELTA[6:0] \$19 \$19 - WD1 window delta value - WDTMAX = WDTMIN + WDTDELTA - resolution according to WD1\_MODE bit (\$19 = 200 μs in WD1 fast mode)  
Updated by WSM RESET or SPI write while in WD1 INT state.

### 7.3.16 WD1 timer control register (WD1T)

|      |    |    |    |    |           |    |    |    |    |    |   |   |   |   |   |   |   |   |             |             |  |
|------|----|----|----|----|-----------|----|----|----|----|----|---|---|---|---|---|---|---|---|-------------|-------------|--|
|      | 19 | 18 | 17 | 16 | 15        | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1           | 0           |  |
| MOSI | -  |    |    |    | X         | X  | X  | X  | X  | X  | X | X | X | X | X | X | X | X | X           | WD1CTL[1:0] |  |
| MISO | 0  | 0  | 0  | 0  | WD1_TIMER |    |    |    |    |    |   |   | 0 | 0 | 0 | 0 | 0 | 0 | WD1CTL[1:0] |             |  |

**ID:** 2B  
**Type:** RW  
**Read:** 2B00  
**Write:** 0056

|             |  |      |      |  |
|-------------|--|------|------|--|
|             | POR  | WSM  | SSM  |  |
| WD1CTL[1:0] | 00   | 00   | 00   | WD1 Control command  |
|             | Updated by SSM_RESET or SPI write                                  |      |      |  |
|             | 00 NOP   |      |      |  |
|             | 01 Code 'A'  |      |      |  |
|             | 10 Code 'B'  |      |      |  |
|             | 11 NOP   |      |      |  |
|             | 1 Slow WD1 mode - nominal 64μs timer resolution (16.3ms max value) |      |      |  |
| WD1_TIMER   | \$00   | \$00 | \$00 | WD1 window timer value<br>-Cleared by SSM_RESET or by WD1 refresh, incremented every 8 μs or 64 μs while in WD1_RUN or WD1_TEST states |

### 7.3.17 WD state register (WDSTATE)

|             |    |    |    |    |    |                  |    |    |               |    |                  |   |   |                |   |   |   |   |   |   |   |
|-------------|----|----|----|----|----|------------------|----|----|---------------|----|------------------|---|---|----------------|---|---|---|---|---|---|---|
|             | 19 | 18 | 17 | 16 | 15 | 14               | 13 | 12 | 11            | 10 | 9                | 8 | 7 | 6              | 5 | 4 | 3 | 2 | 1 | 0 |   |
| <b>MOSI</b> | -  |    |    |    | X  | X                | X  | X  | X             | X  | X                | X | X | X              | X | X | X | X | X | X | X |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0  | WD1_ERR_CNT[3:0] |    |    | WD_STATE[2:0] |    | WD2_ERR_CNT[3:0] |   |   | WD2_STATE[2:0] |   |   |   |   |   |   |   |

**ID:** 2C  
**Type:** R  
**Read:** 2C00  
**Write:** -

|                  | POR  | WSM  | SSM |  |
|------------------|------|------|-----|--|
| WD1_ERR_CNT[3:0] | 0000 | 0000 | -   | Watchdog 1 error counter<br>Updated according to Watchdog State Diagram  |
| WD1_STATE[2:0]   | 000  | 000  | -   | Watchdog state<br>Updated according to Watchdog State Diagram<br>000 INITIAL<br>001 RUN<br>010 TEST<br>011 RESET<br>100 OVERRIDE   |
| WD2_ERR_CNT[3:0] | 0000 | 0000 | -   | Watchdog 2 error counter<br>Updated according to Watchdog State Diagram  |
| WD2_STATE[3:0]   | 0000 | 0000 | -   | Watchdog state<br>Updated according to Watchdog State Diagram<br>0000 INITIAL<br>0001 OVERRIDE<br>0010 INITSEED<br>0011 RUN<br>0100 TEST<br>0101 QUAL<br>0110 LOCK<br>0111 STOPPING<br>1000 STOP<br>1001 RESET |

### 7.3.18 Clock configuration register (CLK\_CONF)

|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9                               | 8 | 7                               | 6 | 5                             | 4 | 3          | 2           | 1                             | 0 |
|------|----|----|----|----|----|----|----|----|----|----|---------------------------------|---|---------------------------------|---|-------------------------------|---|------------|-------------|-------------------------------|---|
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | VCCBCK_F_SEL[VCCBCK_F_SEL[1:0]] |   | SATBCK_F_SEL[SATBCK_F_SEL[1:0]] |   | SYBST_F_SEL[SYBST_F_SEL[1:0]] |   | AUX_SS_DIS | MAIN_SS_DIS | ERBST_F_SEL[ERBST_F_SEL[1:0]] |   |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | VCCBCK_F_SEL[VCCBCK_F_SEL[1:0]] |   | SATBCK_F_SEL[SATBCK_F_SEL[1:0]] |   | SYBST_F_SEL[SYBST_F_SEL[1:0]] |   | AUX_SS_DIS | MAIN_SS_DIS | ERBST_F_SEL[ERBST_F_SEL[1:0]] |   |

**ID:** 2D

**Type:** R/W

**Read:** 2D00

**Write:** 005A

|                   |    | POR | WSM | SSM |  |
|-------------------|----|-----|-----|-----|--|
| VCCBCK_F_SEL[1:0] | 00 | -   | -   | -   | VCCBuck switching frequency select<br>Updated by POR or SPI write<br><br>00 1.88 MHz<br>01 2.13 MHz<br>10 2.00 MHz<br>11 2.00 MHz      |
| SATBCK_F_SEL[1:0] | 00 | -   | -   | -   | SatBuck switching frequency select<br>Updated by POR or SPI write<br><br>00 1.88 MHz<br>01 2.13 MHz<br>10 2.00 MHz<br>11 2.00 MHz      |
| SYBST_F_SEL[1:0]  | 00 | -   | -   | -   | Sync Boost switching frequency select<br>Updated by POR or SPI write<br><br>00 1.88 MHz<br>01 2.13 MHz<br>10 2.00 MHz<br>11 2.00 MHz   |
| AUX_SS_DIS        | 1  | -   | -   | -   | Auxiliary oscillator Spread Spectrum disable<br>Updated by POR or SPI write<br>0 Spread Spectrum enabled<br>1 Spread Spectrum disabled |

- MAIN\_SS\_DIS 0 - - Main oscillator Spread Spectrum disable  
 Updated by POR or SPI write  
 0 Spread Spectrum enabled  
 1 Spread Spectrum disabled
- ERBST\_F\_SEL[1:0] 00 - - ER Boost switching frequency select  
 Updated by POR or SPI write  
 00 1.88 MHz  
 01 2.13 MHz  
 10 2.00 MHz  
 11 2.00 MHz

**7.3.19 Scrap seed read command register (SCRAP\_SEED)**

|      |    |    |    |    |    |    |    |    |    |    |   |   |           |   |   |   |   |   |   |   |   |
|------|----|----|----|----|----|----|----|----|----|----|---|---|-----------|---|---|---|---|---|---|---|---|
|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7         | 6 | 5 | 4 | 3 | 2 | 1 | 0 |   |
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | X | X         | X | X | X | X | X | X | X | X |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | SEED[7:0] |   |   |   |   |   |   |   |   |

**ID:** 2E  
**Type:** R  
**Read:** -  
**Write:** 2E00

|     |     |     |
|-----|-----|-----|
| POR | WSM | SSM |
| N/A | N/A | N/A |

SEED[7:0] \$00 \$00 \$00 Random scrap seed value - generated from a free-running 8-bit counter

### 7.3.20 Scrap key write command register (SCRAP\_KEY)

|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7        | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|----|----|----|----|----|----|---|---|----------|---|---|---|---|---|---|---|
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | X | KEY[7:0] |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0        | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

**ID:** 2F  
**Type:** W  
**Read:** -  
**Write:** 005E

|     |     |     |
|-----|-----|-----|
| POR | WSM | SSM |
| N/A | N/A | N/A |

KEY[7:0] \$00 \$00 \$00 KEY value submitted to the SCRAP state machine (correct value is derived from the seed value using a simple logical inversion on the even-numbered bits (0, 2, 4, 6))

### 7.3.21 Scrap state entry command register (SCRAP\_STATE)

|      | 19 | 18 | 17 | 16 | 15     | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|--------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| MOSI | -  |    |    |    | \$3535 |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | 0      | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

**ID:** 30  
**Type:** W  
**Read:** -  
**Write:** 0060

|     |     |     |
|-----|-----|-----|
| POR | WSM | SSM |
| N/A | N/A | N/A |

Non-latched Scrap State entry command  
 Enter Scrap state from DIAG state

### 7.3.22 Safing state entry command register (SAFING\_STATE)

|      |    |    |    |    |        |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |   |
|------|----|----|----|----|--------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|---|
|      | 19 | 18 | 17 | 16 | 15     | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |   |
| MOSI | -  |    |    |    | \$ACAC |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | 0      | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

**ID:** 31  
**Type:** W  
**Read:** -  
**Write:** 0062

POR WSM SSM  
 N/A N/A N/A

Non-latched Safing State entry command

Enter safing state from DIAG state and clear arming pulse stretch counter (if received in DIAG or SAFING state)

### 7.3.23 WD2 recover write command register (WD2\_RECOVER)

|      |    |    |    |    |    |    |    |    |    |    |   |   |      |   |   |   |   |   |   |   |
|------|----|----|----|----|----|----|----|----|----|----|---|---|------|---|---|---|---|---|---|---|
|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7    | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | X | \$AA |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0    | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

**ID:** 32  
**Type:** W  
**Read:** -  
**Write:** 0064

POR WSM SSM  
 N/A N/A N/A

Non-latched command to clear WD2\_retry counter during WD2 LOCK state

### 7.3.24 WD2 seed read command register (WD2\_SEED)

|             | 19 | 18 | 17 | 16 | 15                | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |   |
|-------------|----|----|----|----|-------------------|----|----|----|----|----|---|---|---------------|---|---|---|---|---|---|---|---|
| <b>MOSI</b> | -  |    |    |    | X                 | X  | X  | X  | X  | X  | X | X | X             | X | X | X | X | X | X | X | X |
| <b>MISO</b> | 0  | 0  | 0  | 0  | WD2_PREV_KEY[7:0] |    |    |    |    |    |   |   | WD2_SEED[7:0] |   |   |   |   |   |   |   |   |

**ID:** 33  
**Type:** R  
**Read:** -  
**Write:** 3300

POR  
 WSM  
 SSM

WD2\_PREV\_KEY[7:0] \$0D \$0D \$0D Previous WD2 key value - stored key from previous comparison

WD2\_SEED[7:0] \$F0 \$F0 \$F0 Random WD2 seed value - generated from a free-running 8-bit counter

### 7.3.25 WD2 key write command register (WD2\_KEY)

|             | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7        | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----|----|----|----|----|----|----|----|----|----|---|---|----------|---|---|---|---|---|---|---|
| <b>MOSI</b> | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | X | KEY[7:0] |   |   |   |   |   |   |   |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0        | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

**ID:** 34  
**Type:** W  
**Read:** -  
**Write:** 0068

POR  
 WSM  
 SSM

KEY[7:0] \$00 \$00 \$00 KEY value submitted to the WD2 state machine

(correct value is derived from  $WD2\_KEY = WD2\_SEED \oplus WD2\_PREV\_KEY + \$01$  where  $\oplus$  denotes a bit-wise XOR operation)

### 7.3.26 WD test command register (WD\_TEST)

|             | 19 | 18 | 17 | 16 | 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7               | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----|----|----|----|-----------------|----|----|----|----|----|---|---|-----------------|---|---|---|---|---|---|---|
| <b>MOSI</b> | -  |    |    |    | WD1_TEST = \$3C |    |    |    |    |    |   |   | WD2_TEST = \$3C |   |   |   |   |   |   |   |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0               | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0               | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

**ID:** 35  
**Type:** W  
**Read:** -  
**Write:** 006A

|     |     |     |                                       |
|-----|-----|-----|---------------------------------------|
| POR | WSM | SSM |                                       |
| N/A | N/A | N/A | Non-latched WD1 and WD2 Test Commands |

WD1\_TEST and WD2\_TEST SPI command as described in Watchdog State Diagram

**7.3.27 System diagnostic register (SYSDIAGREQ)**

|             | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3           | 2 | 1 | 0 |  |
|-------------|----|----|----|----|----|----|----|----|----|----|---|---|---|---|---|---|-------------|---|---|---|--|
| <b>MOSI</b> | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | X | X | X | X | X | DSTEST[3:0] |   |   |   |  |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | DSTEST[3:0] |   |   |   |  |

**ID:** 36  
**Type:** R/W  
**Read:** 3600  
**Write:** 006C

POR      WSM      SSM  
 |        |        |  
 |        |        |

DSTEST[3:0] 0000 0000 0000 Diagnostic State Test selection

Updated by SSM\_RESET or SPI write while in DIAG state

- 0000 = all outputs inactive
- 0001 = ARM 1 pin active
- 0010 = ARM 2 pin active
- 0011 = ARM 3 pin active
- 0100 = ARM 4 pin active
- 0101 = PSINHB pin inactive (high)
- 0110 = VSF regulator active
- 0111 = HS squib driver FET active
- 1000 = LS squib driver FET active
- 1001 = Output deployment timing pulses on ARM1 (separated by 8 ms)
- 1010 = HS squib driver FET active to test full path (FET switched off by the comparator used in the deployment current timer monitor)
- 1011 - 1111 = all outputs inactive

### 7.3.28 Diagnostic result register for deployment loops (LPDIAGSTAT)

|      | 19         | 18  | 17 | 16 | 15    | 14        | 13     | 12     | 11                                    | 10 | 9 | 8 | 7   | 6   | 5   | 4   | 3          | 2 | 1 | 0 |   |
|------|------------|-----|----|----|-------|-----------|--------|--------|---------------------------------------|----|---|---|-----|-----|-----|-----|------------|---|---|---|---|
| MOSI | -          |     |    |    | X     | X         | X      | X      | X                                     | X  | X | X | X   | X   | X   | X   | X          | X | X | X | X |
| MISO | DIAG_LEVEL | TIP | 0  | FP | FETON | HS_DRV_OK | HSR_HI | HSR_LO | RES_MEAS_CHSEL/HIGH_LEV_DIAG_SELECTED |    |   |   | SBL | STG | STB | SQP | LEAK_CHSEL |   |   |   |   |

**ID:** 37  
**Type:** R  
**Read:** 3700  
**Write:** -

|            |   |     |     |     |   |
|------------|---|-----|-----|-----|---|
|            |   | POR | WSM | SSM |   |
| DIAG_LEVEL | 0 | 0   | 0   | 0   | Diagnostic mode selector Not present for low level diagnostic<br>Updated by SSM_RESET or SPI write to LPDIAGREQ<br>0 low level mode<br>1 high level mode  |
| TIP        | 0 | 0   | 0   | 0   | High level diagnostic test is running<br>Updated by SSM_RESET or Loops diagnostic state machine<br>0 High level diagnostic test is not running<br>1 High level diagnostic test is running             |
| FP         | 0 | 0   | 0   | 0   | Fault present before requested diagnostic<br>Updated by SSM_RESET or Loops diagnostic state machine<br>0 Fault not present before requested diagnostic<br>1 Fault present before requested diagnostic |
| FETON      | 0 | 0   | 0   | 0   | FET activation during diagnostic<br>Updated by SSM_RESET or Loops diagnostic state machine or when HS or LS FET is activated during DIAG state  |

|                     |      |      |      |  |                                   |
|---------------------|------|------|------|--|-----------------------------------|
|                     |      |      |      | 0 FET is off during diagnostic   |                                   |
|                     |      |      |      | 1 FET is on during diagnostic  |                                   |
| HS_DRV_OK           | 0    | 0    | 0    | FET Test Status  |                                   |
|                     |      |      |      | Updated by SSM_RESET or Loops diagnostic state machine or when driver full path test is run test is run      |                                   |
|                     |      |      |      | 0 HS squib driver full path test did not complete successfully   |                                   |
|                     |      |      |      | 1 HS squib driver full path test complete successfully   |                                   |
| HSR_HI              | 0    | 0    | 0    | HSR Diagnostic - HIGH Range  |                                   |
|                     |      |      |      | Updated by SSM_RESET or Loops diagnostic state machine or when squib resistance test is run                  |                                   |
|                     |      |      |      | 0 HSR measurement < HSR HIGH value   |                                   |
|                     |      |      |      | 1 HSR measurement > HSR HIGH value   |                                   |
| HSR_LO              | 0    | 0    | 0    | HSR Diagnostic - Low Range   |                                   |
|                     |      |      |      | Updated by SSM_RESET or Loops diagnostic state machine or when squib resistance test is run                  |                                   |
|                     |      |      |      | 1 HSR measurement < HSR LOW value  |                                   |
|                     |      |      |      | 0 HSR measurement > HSR LOW value  |                                   |
| RES_MEAS_CHSEL[3:0] | 0000 | 0000 | 0000 | Channel selected for resistance measurement  | HIGH_LEV_DIAG_SELECTED[3:0]       |
|                     |      |      |      | Updated by SSM_RESET or Loops diagnostic state machine or as determined by squib resistance channel selected |                                   |
|                     |      |      |      | 0000 = Ch 0  | 0000 No diagnostic selected       |
|                     |      |      |      | 0001 = Ch 1  | 0001 VRCM CHECK                   |
|                     |      |      |      | 0010 = Ch 2  | 0010 Leakage CHECK                |
|                     |      |      |      | 0011 = Ch 3  | 0011 Short Between Loops CHECK    |
|                     |      |      |      | 0100 = Ch 4  | 0100 ER cap ESR measure           |
|                     |      |      |      | 0101 = Ch 5  | 0101 Squib resistance range CHECK |
|                     |      |      |      | 0110 = Ch 6  | 0110 Squib resistance measurement |
|                     |      |      |      | 0111 = Ch 7  | 0111 FET test                     |
|                     |      |      |      | 0100 - 1111 None Selected  |                                   |
| SBL                 | 0    | 0    | 0    | Short between loop state   |                                   |
|                     |      |      |      | Updated by SSM_RESET or Loops diagnostic state machine   |                                   |
|                     |      |      |      | 0 Short between squib loops is not present   |                                   |
|                     |      |      |      | 1 Short between squib loops is present   |                                   |
| STG                 | 0    | 0    | 0    | Short to Ground Test Status  |                                   |

Updated by SSM\_RESET or Loops diagnostic state machine or as determined by squib leakage diagnostic

- 0 STG not detected
- 1 STG detected

STB 0 0 0 Short to Battery Test Status

Updated by SSM\_RESET or Loops diagnostic state machine or as determined by squib leakage diagnostic

- 0 STB not detected
- 1 STB detected

SQP 0 0 0 Squib PIN where leakage test has been performed

Updated by SSM\_RESET or Loops diagnostic state machine or as determined by squib leakage diagnostic

- 0 SRx
- 1 SFx

LEAK\_CHSEL[3:0] 0000 0000 0000 Channel selected for leakage measurement

Updated by SSM\_RESET or Loops diagnostic state machine or as determined by squib leakage diagnostic

- 0000 = Ch 0
- 0001 = Ch 1
- 0010 = Ch 2
- 0011 = Ch 3
- 0100 = Ch 4
- 0101 = Ch 5
- 0110 = Ch 6
- 0111 = Ch 7
- 1100 - 1111 None Selected

### 7.3.29 Loops diagnostic configuration command register for low level diagnostic (LPDIAGREQ)

|      |    |    |    |    |            |               |         |            |    |       |           |   |                     |   |   |                 |   |   |   |   |
|------|----|----|----|----|------------|---------------|---------|------------|----|-------|-----------|---|---------------------|---|---|-----------------|---|---|---|---|
|      | 19 | 18 | 17 | 16 | 15         | 14            | 13      | 12         | 11 | 10    | 9         | 8 | 7                   | 6 | 5 | 4               | 3 | 2 | 1 | 0 |
| MOSI | -  |    |    |    | DIAG_LEVEL | ISRC_CURR_SEL | PD_CURR | ISRC [1:0] |    | ISINK | VRCM[1:0] |   | RES_MEAS_CHSEL[3:0] |   |   | LEAK_CHSEL[3:0] |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | DIAG_LEVEL | ISRC_CURR_SEL | PD_CURR | ISRC [1:0] |    | ISINK | VRCM[1:0] |   | RES_MEAS_CHSEL[3:0] |   |   | LEAK_CHSEL[3:0] |   |   |   |   |

**ID:** 38  
**Type:** R/W  
**Read:** 3800  
**Write:** 0070

|               | POR | WSM | SSM |   |
|---------------|-----|-----|-----|---|
| DIAG_LEVEL    | 0   | 0   | 0   | Diagnostic mode selector<br>Updated by SSM_RESET or SPI write<br>0 low level mode<br>1 N/A - see description below  |
| ISRC_CURR_SEL | 0   | 0   | 0   | Selection of ISRC current value<br>0 40 mA<br>1 8 mA  |
| PD_CURR       | 0   | 0   | 0   | Pull down current control<br>Updated by SSM_RESET or SPI write<br>0 Request OFF only for channels connected to VRCM or ISINK or ISRC, ON for all other channels<br>1 Request OFF for all channels |
| ISRC [1:0]    | 00  | 00  | 00  | High side current source for channel selected in RES_MEAS_CHSEL[3:0]<br>Updated by SSM_RESET or SPI write<br>00 = OFF   |

- 01 = ON 40 mA/ 8 mA current for channel selected in RES\_MEAS\_CHSEL, OFF on all other channels
- 10 = ON bypass current for channel selected in RES\_MEAS\_CHSEL, OFF ON all other channels
- 11 = ON ISRC 40mA or 8mA current for channel selected in RES\_MEAS\_CHSEL and connect the SRM Differential Amplifier to the other squib channel of the selected channel pair

ISINK 0 0 0 Low Side current sink control (max 50 mA)

Updated by SSM\_RESET or SPI write

- 0 All channels OFF
- 1 ON for channel selected by RES\_MEAS\_CHSEL[3:0], OFF on all other channels

VRCM[1:0] 00 00 00 Voltage Regulator Current Monitor control

Updated by SSM\_RESET or SPI write

- 00 VRCM not connected
- 01 VRCM connected to SFx of channel selected by LEAK\_CHSEL[3:0]
- 10 VRCM connected to SRx of channel selected by LEAK\_CHSEL[3:0] and pull down current of the same channel disabled
- 11 VRCM connected to SRx of channel selected by LEAK\_CHSEL[3:0] and pull down current of the same channel enabled (ISINK and ISRC must be switched off)

RES\_MEAS\_CHSEL[3:0] 0000 0000 0000 Squib Resistance Measurement Channel select - selects the channel and muxes for the resistance test, and the channel for HS driver test (full path fet test) activation

Updated by SSM\_RESET or SPI write

- 0000 Channel 0
- 0001 Channel 1
- 0010 Channel 2
- 0011 Channel 3
- 0100 Channel 4
- 0101 Channel 5
- 0110 Channel 6
- 0111 Channel 7
- 0100 - 1111 None Selected

LEAK\_CHSEL[3:0] 0000 0000 0000 Squib Leakage Measurement Channel select - selects the channel and muxes for the leakage test, and the channel for HS/LS FET test activation.

Updated by SSM\_RESET or SPI write

- 0000 Channel 0

0001 Channel 1  
0010 Channel 2  
0011 Channel 3  
0100 Channel 4  
0101 Channel 5  
0110 Channel 6  
0111 Channel 7  
0100 - 1111 None Selected

**7.3.30 Loops diagnostic configuration command register for high level diagnostic (LPDIAGREQ)**

|      |    |    |    |    |            |    |    |    |    |    |   |   |                     |   |   |     |                      |   |   |   |
|------|----|----|----|----|------------|----|----|----|----|----|---|---|---------------------|---|---|-----|----------------------|---|---|---|
|      | 19 | 18 | 17 | 16 | 15         | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7                   | 6 | 5 | 4   | 3                    | 2 | 1 | 0 |
| MOSI | -  |    |    |    | DIAG_LEVEL | X  | X  | X  | X  | X  | X | X | HIGH_LEVEL_DIAG_SEL |   |   | SQP | LOOP_DIAG_CHSEL[3:0] |   |   |   |
| MISO | 0  | 0  | 0  | 0  | DIAG_LEVEL | 0  | 0  | 0  | 0  | 0  | 0 | 0 | HIGH_LEVEL_DIAG_SEL |   |   | SQP | LOOP_DIAG_CHSEL[3:0] |   |   |   |

**ID:** 38  
**Type:** R/W  
**Read:** 3800  
**Write:** 0070

|            |     |     |     |                             |
|------------|-----|-----|-----|-----------------------------|
|            | POR | WSM | SSM |                             |
| DIAG_LEVEL | 0   | 0   | 0   | Diagnostic mode selector    |
|            | 0   | 0   | 0   | N/A - see description above |
|            | 1   | 1   | 1   | high level mode             |

|                     |     |     |     |  |
|---------------------|-----|-----|-----|--|
| HIGH_LEVEL_DIAG_SEL | 000 | 000 | 000 | Selection of high level squib diagnostic |
|                     |     |     |     | Updated by SSM_RESET or SPI write        |
|                     | 000 |     |     | No diagnostic selected                   |
|                     | 001 |     |     | VRCM CHECK                               |
|                     | 010 |     |     | Leakage CHECK                            |
|                     | 011 |     |     | Short Between Loops CHECK                |
|                     | 100 |     |     | ER cap ESR measure                       |
|                     | 101 |     |     | Squib resistance range CHECK             |
|                     | 110 |     |     | Squib resistance measurement             |
|                     | 111 |     |     | FET test                                 |

|     |   |   |   |   |
|-----|---|---|---|---|
| SQP | 0 | 0 | 0 | Squib pin select for all leakage diagnostic |
|     |   |   |   | Updated by SSM_RESET or SPI write           |



- 0 SRx
- 1 SFx

LOOP\_DIAG\_CHSEL[3:0] 0000 0000 0000 Channel select - selects the channel and muxes for all squib diagnostic.

Updated by SSM\_RESET or SPI write

- 0000 Channel 0
- 0001 Channel 1
- 0010 Channel 2
- 0011 Channel 3
- 0100 Channel 4
- 0101 Channel 5
- 0110 Channel 6
- 0111 Channel 7
- 1100 - 1111 None Selected

### 7.3.31 DC sensor diagnostic configuration command register (SWCTRL)

|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8        | 7                    | 6     | 5 | 4 | 3         | 2 | 1 | 0 |
|------|----|----|----|----|----|----|----|----|----|----|---|----------|----------------------|-------|---|---|-----------|---|---|---|
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | PSINHPOL | DCS_PDCURRDCS_PDCURR | SWOEN | X | X | CHID[3:0] |   |   |   |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | PSINHPOL |                      | SWOEN | 0 | 0 | CHID[3:0] |   |   |   |

**ID:** 39  
**Type:** R/W  
**Read:** 3900  
**Write:** 0072

|            |     |     |     |  |
|------------|-----|-----|-----|--|
|            | POR | WSM | SSM |  |
| PSINHPOL   | 0   | 0   | 0   | Selector of in range/ out of range for passenger inhibit function<br>0 if result is inside thresholds the counter is initialized to start value<br>1 if result is outside thresholds the counter is initialized to start value |
| DCS_PDCURR | 0   | 0   | 0   | Disable of all pull down current for DC sensor<br>Updated by SSM_RESET or SPI write<br>0 OFF for channel under voltage or current measurement, ON for all other channels<br>1 OFF for all channels                             |



SWOEN 0 0 0 Switch Output Enable

Updated by SSM\_RESET or SPI write

0 OFF

1 ON

CHID[3:0] 0000 0000 0000 Channel ID - selects DC sensor channel for output activation

Updated by SSM\_RESET or SPI write

0000 Channel 0

0001 Channel 1

0010 Channel 2

0011 Channel 3

0100 Channel 4

0101 Channel 5

0110 Channel 6

0111 Channel 7

1000 Channel 8

0100 - 1111 None Selected

### 7.3.32 ADC request and data registers (DIAGCTRL\_x)

#### ADC A control command (DIAGCTRL\_A)

|      | 19        | 18 | 17 | 16            | 15 | 14 | 13 | 12 | 11 | 10            | 9 | 8 | 7 | 6             | 5 | 4 | 3 | 2 | 1 | 0 |
|------|-----------|----|----|---------------|----|----|----|----|----|---------------|---|---|---|---------------|---|---|---|---|---|---|
| MOSI | -         |    |    |               | X  | X  | X  | X  | X  | X             | X | X | X | ADCREQ_A[6:0] |   |   |   |   |   |   |
| MISO | NEWDATA_A | 0  | 0  | ADCREQ_A[6:0] |    |    |    |    |    | ADCRES_A[9:0] |   |   |   |               |   |   |   |   |   |   |

**ID:** 3A  
**Type:** RW  
**Read:** 3A00  
**Write:** 0074

#### ADC B control command (DIAGCTRL\_B)

|      | 19        | 18 | 17 | 16            | 15 | 14 | 13 | 12 | 11 | 10            | 9 | 8 | 7 | 6             | 5 | 4 | 3 | 2 | 1 | 0 |
|------|-----------|----|----|---------------|----|----|----|----|----|---------------|---|---|---|---------------|---|---|---|---|---|---|
| MOSI | -         |    |    |               | X  | X  | X  | X  | X  | X             | X | X | X | ADCREQ_B[6:0] |   |   |   |   |   |   |
| MISO | NEWDATA_B | 0  | 0  | ADCREQ_B[6:0] |    |    |    |    |    | ADCRES_B[9:0] |   |   |   |               |   |   |   |   |   |   |

**ID:** 3B  
**Type:** R/W  
**Read:** 3B00  
**Write:** 0076

#### ADC C control command (DIAGCTRL\_C)

|      | 19        | 18 | 17 | 16            | 15 | 14 | 13 | 12 | 11 | 10            | 9 | 8 | 7 | 6             | 5 | 4 | 3 | 2 | 1 | 0 |
|------|-----------|----|----|---------------|----|----|----|----|----|---------------|---|---|---|---------------|---|---|---|---|---|---|
| MOSI | -         |    |    |               | X  | X  | X  | X  | X  | X             | X | X | X | ADCREQ_C[6:0] |   |   |   |   |   |   |
| MISO | NEWDATA_C | 0  | 0  | ADCREQ_C[6:0] |    |    |    |    |    | ADCRES_C[9:0] |   |   |   |               |   |   |   |   |   |   |

**ID:** 3C  
**Type:** R/W  
**Read:** 3C00  
**Write:** 0078

**ADC D control command (DIAGCTRL\_D)**

|             |           |    |    |               |    |    |    |    |    |               |   |   |   |               |   |   |   |   |   |   |
|-------------|-----------|----|----|---------------|----|----|----|----|----|---------------|---|---|---|---------------|---|---|---|---|---|---|
|             | 19        | 18 | 17 | 16            | 15 | 14 | 13 | 12 | 11 | 10            | 9 | 8 | 7 | 6             | 5 | 4 | 3 | 2 | 1 | 0 |
| <b>MOSI</b> | -         |    |    |               | X  | X  | X  | X  | X  | X             | X | X | X | ADCREQ_D[6:0] |   |   |   |   |   |   |
| <b>MISO</b> | NEWDATA_D | 0  | 0  | ADCREQ_D[6:0] |    |    |    |    |    | ADCRES_D[9:0] |   |   |   |               |   |   |   |   |   |   |

**ID:** 3D  
**Type:** R/W  
**Read:** 3D00  
**Write:** 007A

|           |     |     |     |   |
|-----------|-----|-----|-----|---|
|           | POR | WSM | SSM |   |
| NEWDATA_x | 0   | 0   | 0   | New data available from conversion        |
|           |     |     |     | Updated by SSM_RESET or ADC state machine |
|           |     |     |     | 0 cleared on read                         |
|           |     |     |     | 1 conversion finished                     |

ADCREQ\_x[6:0] \$00 \$00 \$00 ADC Request select command  
 Updated by SSM\_RESET or SPI write to DIAGCTRL\_x

Measurement

- \$00 Unused
- \$01 Ground Ref
- \$02 Full scale Ref
- \$03 DCSx voltage
- \$04 DCSx current
- \$05 DCSx resistance
- \$06 Squib x resistance
- \$07 Internal BG reference voltage (BGR)
- \$08 Internal BG monitor voltage (BGM)
- \$09 Vcore
- \$0A Temperature
- \$0B DCS 0 voltage
- \$0C DCS 1 voltage
- \$0D DCS 2 voltage
- \$0E DCS 3 voltage
- \$0F DCS 4 voltage
- \$10 DCS 5 voltage
- \$11 DCS 6 voltage
- \$12 DCS 7 voltage
- \$13 DCS 8 voltage

\$14 Vb voltage of ER ESR measure (valid only for ADCREQ\_x field of MISO response when ESR measure results are available)  
\$15 Va voltage of ER ESR measure (valid only for ADCREQ\_x field of MISO response when ESR measure results are available)  
\$16 Vc voltage of ER ESR measure (valid only for ADCREQ\_x field of MISO response when ESR measure results are available)  
\$20 VBATMON pin voltage  
\$21 VIN pin voltage  
\$22 Internal analog supply voltage (VINT)  
\$23 Internal digital supply voltage (VDD)  
\$24 ERBOOST pin voltage  
\$25 SYNCBOOST pin voltage  
\$26 VER pin voltage  
\$27 SATBUCK voltage  
\$28 VCC voltage  
\$29 WAKEUP pin voltage  
\$2A VSF pin voltage  
\$2B WDTDIS pin voltage  
\$2C GPOD0 pin voltage  
\$2D GPOS0 pin voltage  
\$2E GPOD1 pin voltage  
\$2F GPOS1 pin voltage  
\$30 GPOD2 pin voltage  
\$31 GPOS2 pin voltage  
\$32 RSU0 pin Voltage  
\$33 RSU1 pin Voltage  
\$34 RSU2 pin Voltage  
\$35 RSU3 pin Voltage  
\$36 SS0 pin voltage  
\$37 SS1 pin voltage  
\$38 SS2 pin voltage  
\$39 SS3 pin voltage  
\$3A SS4 pin voltage  
\$3B SS5 pin voltage  
\$3C SS6 pin voltage  
\$3D SS7 pin voltage  
\$3E SS8 pin voltage  
\$3F SS9 pin voltage  
\$40 SSA pin voltage  
\$41 SSB pin voltage  
\$46 SF0  
\$47 SF1  
\$48 SF2  
\$49 SF3  
\$4A SF4  
\$4B SF5  
\$4C SF6  
\$4D SF7

ADCRES\_x[9:0] \$000 \$000 \$000 10-bit ADC result value corresponding to ADCREQ\_x request  
 Updated by SSM\_RESET or ADC state machine

### 7.3.33 Configuration register for switching regulators (SW\_REGS\_CONF)

|      | 19 | 18 | 17 | 16 | 15                  | 14                 | 13                 | 12                 | 11                 | 10                   | 9                   | 8                   | 7                  | 6 | 5                  | 4 | 3                 | 2 | 1                 | 0 |
|------|----|----|----|----|---------------------|--------------------|--------------------|--------------------|--------------------|----------------------|---------------------|---------------------|--------------------|---|--------------------|---|-------------------|---|-------------------|---|
| MOSI | -  |    |    |    | LOW_ERBST_ILIM_ERON | EN_VCC_GNDLOSS_DET | EN_SAT_GNDLOSS_DET | SATBCK_LS_ON_DELAY | VCCBCK_LS_ON_DELAY | SATBCK_FORCE_F_SLOPE | SYBST_FORCE_F_SLOPE | ERBST_FORCE_F_SLOPE | VCCBCK_PH_SEL[1:0] |   | SATBCK_PH_SEL[1:0] |   | SYBST_PH_SEL[1:0] |   | ERBST_PH_SEL[1:0] |   |
| MISO | 0  | 0  | 0  | 0  | LOW_ERBST_ILIM_ERON | EN_VCC_GNDLOSS_DET | EN_SAT_GNDLOSS_DET | SATBCK_LS_ON_DELAY | VCCBCK_LS_ON_DELAY | SATBCK_FORCE_F_SLOPE | SYBST_FORCE_F_SLOPE | ERBST_FORCE_F_SLOPE | VCCBCK_PH_SEL      |   | SATBCK_PH_SEL      |   | SYBST_PH_SEL      |   | ERBST_PH_SEL      |   |

**ID:** 3F  
**Type:** R/W  
**Read:** 3F00  
**Write:** 007E

- |                     |   |     |     |     |  |
|---------------------|---|-----|-----|-----|--|
|                     |   | POR | WSM | SSM |  |
| LOW_ERBST_ILIM_ERON | 0 | -   | -   | -   | ERBoost current limitation behavior selection<br>Updated by POR or SPI write<br>0 ERBoost current limitation is NOT reduced if ER Switch is activated<br>1 ERBoost current limitation is reduced if ER Switch is activated |
| EN_VCC_GNDLOSS_DET  | 0 | -   | -   | -   | New VCC ground loss detection enable<br>Updated by POR or SPI write<br>0 run time ground loss detection disabled<br>1 run time ground loss detection enabled   |
| EN_SAT_GNDLOSS_DET  | 0 | -   | -   | -   | New SAT ground loss detection enable<br>Updated by POR or SPI write<br>0 run time ground loss detection disabled<br>1 run time ground loss detection enabled   |
| SATBCK_LS_ON_DELAY  | 0 | -   | -   | -   | SATBuck low side activation delay<br>Updated by POR or SPI write   |

|                      |    |   |   |  |
|----------------------|----|---|---|--|
|                      |    |   |   | 0 No delay is applied  |
|                      |    |   |   | 1 Delay is applied   |
| VCCBCK_LS_ON_DELAY   | 0  | - | - | VCCBuck low side activation delay<br>Updated by POR or SPI write   |
|                      |    |   |   | 0 No delay is applied  |
|                      |    |   |   | 1 Delay is applied   |
| SATBCK_FORCE_F_SLOPE | 0  | - | - | SatBuck fast slope selection<br>Updated by POR or SPI write  |
|                      |    |   |   | 0 Fast slope activation depends on VIN voltage   |
|                      |    |   |   | 1 Fast slope is forced ON  |
| SYBST_FORCE_F_SLOPE  | 0  | - | - | SyncBoost fast slope selection<br>Updated by POR or SPI write  |
|                      |    |   |   | 0 Fast slope activation depends on VIN voltage   |
|                      |    |   |   | 1 Fast slope is forced ON  |
| ERBST_FORCE_F_SLOPE  | 0  | - | - | ER Boost fast slope selection<br>Updated by POR or SPI write   |
|                      |    |   |   | 0 Fast slope activation depends on VIN voltage   |
|                      |    |   |   | 1 Fast slope is forced ON  |
| VCCBCK_PH_SEL[1:0]   | 11 | - | - | VCCBuck phase shifting selection (if switching frequency is different respect to another regulator, the phase shift between them is not guaranteed)<br>Updated by POR or SPI write   |
|                      |    |   |   | 00 0 ns switching ON shift respect to t0   |
|                      |    |   |   | 01 125 ns switching ON shift respect to t0   |
|                      |    |   |   | 10 250 ns switching ON shift respect to t0   |
|                      |    |   |   | 11 375 ns switching ON shift respect to t0   |
| SATBCK_PH_SEL[1:0]   | 10 | - | - | SatBuck phase shifting selection (if switching frequency is different respect to another regulator, the phase shift between them is not guaranteed)<br>Updated by POR or SPI write   |
|                      |    |   |   | 00 0 ns switching ON shift respect to t0   |
|                      |    |   |   | 01 125 ns switching ON shift respect to t0   |
|                      |    |   |   | 10 250 ns switching ON shift respect to t0   |
|                      |    |   |   | 11 375 ns switching ON shift respect to t0   |
| SYBST_PH_SEL[1:0]    | 01 | - | - | SyncBoost phase shifting selection (if switching frequency is different respect to another regulator, the phase shift between them is not guaranteed)<br>Updated by POR or SPI write |
|                      |    |   |   | 00 0 ns switching ON shift respect to t0   |

- 01 125 ns switching ON shift respect to t0
- 10 250 ns switching ON shift respect to t0
- 11 375 ns switching ON shift respect to t0

ERBST\_PH\_SEL[1:0] 00 - - ER Boost phase shifting selection (if switching frequency is different respect to another regulator, the phase shift between them is not guaranteed)  
Updated by POR or SPI write

- 00 0 ns switching ON shift respect to t0
- 01 125 ns switching ON shift respect to t0
- 10 250 ns switching ON shift respect to t0
- 11 375 ns switching ON shift respect to t0

### 7.3.34 Global configuration register for GPO driver function (GPOCR)

|      |    |    |    |    |    |    |    |    |    |    |   |   |   |   |   |   |   |              |              |              |
|------|----|----|----|----|----|----|----|----|----|----|---|---|---|---|---|---|---|--------------|--------------|--------------|
|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2            | 1            | 0            |
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | X | X | X | X | X | X | GPO2LSGPO2LS | GPO1LSGPO1LS | GPO0LSGPO0LS |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | GPO2LSGPO2LS | GPO1LSGPO1LS | GPO0LSGPO0LS |

**ID:** 42  
**Type:** R/W  
**Read:** 4200  
**Write:** 0084

POR      WSM      SSM  
 GPOxLS 0    0    0 GPO driver configuration bit

Updated by SSM\_RESET or SPI write

- 0 High-side Driver configuration for GPOx (ER\_BOOST\_OK is required to enable GPO as HS)
- 1 Low-side Driver configuration for GPOx (ER\_BOOST\_OK is not required to enable GPO as LS)

### 7.3.35 GPOx control register (GPOCTRLx)

Channel 0 (GPOCTRL0)

Channel 1 (GPOCTRL1)

Channel 2 (GPOCTRL2)

|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5            | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|----|----|----|----|----|----|---|---|---|---|--------------|---|---|---|---|---|
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | X | X | X | GPOxPWM[5:0] |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | GPOxPWM[5:0] |   |   |   |   |   |

**ID:** 43 (GPOCTRL0)  
44 (GPOCTRL1)  
45 (GPOCTRL2)

**Type:** RW

**Read:** 4300 (GPOCTRL0)  
4400 (GPOCTRL1)  
4500 (GPOCTRL2)

**Write:** 0086 (GPOCTRL0)  
0088 (GPOCTRL1)  
008A (GPOCTRL2)

POR WSM SSM

GPOxPWM 000000 000000 000000 6 bit value for PWM% with scaling of 1.6% per count

Updated by SSM\_RESET or SPI write

7.3.36 GPO fault status register (GPOFLTSR)

|      |             |             |             |    |               |          |         |           |            |           |          |         |           |            |           |          |         |           |            |           |   |
|------|-------------|-------------|-------------|----|---------------|----------|---------|-----------|------------|-----------|----------|---------|-----------|------------|-----------|----------|---------|-----------|------------|-----------|---|
|      | 19          | 18          | 17          | 16 | 15            | 14       | 13      | 12        | 11         | 10        | 9        | 8       | 7         | 6          | 5         | 4        | 3       | 2         | 1          | 0         |   |
| MOSI | -           |             |             |    | X             | X        | X       | X         | X          | X         | X        | X       | X         | X          | X         | X        | X       | X         | X          | X         | X |
| MISO | GPO2DISABLE | GPO1DISABLE | GPO0DISABLE | 0  | GPOS_NOT_CONF | GPO2TEMP | GPO2LIM | GPO2ONOPN | GPO2OFFOPN | GPO2SHORT | GPO1TEMP | GPO1LIM | GPO1ONOPN | GPO1OFFOPN | GPO1SHORT | GPO0TEMP | GPO0LIM | GPO0ONOPN | GPO0OFFOPN | GPO0SHORT |   |

ID: 46  
 Type: R  
 Read: 4600  
 Write: -

|               | POR | WSM | SSM |   |
|---------------|-----|-----|-----|---|
| GPO2DISABLE   | 1   | 1   | 1   | GPO 2 disable state<br>0 GPO enable to work<br>1 GPO disabled due to thermal fault or configuration not received or ERBOOST not OK (only HS mode) |
| GPO1DISABLE   | 1   | 1   | 1   | GPO 1 disable state<br>0 GPO enable to work<br>1 GPO disabled due to thermal fault or configuration not received or ERBOOST not OK (only HS mode) |
| GPO0DISABLE   | 1   | 1   | 1   | GPO 0 disable state<br>0 GPO enable to work<br>1 GPO disabled due to thermal fault or configuration not received or ERBOOST not OK (only HS mode) |
| GPOS_NOT_CONF | 1   | 1   | 1   | GPOs configuration status<br>0 GPOs configured (activation is permitted)<br>1 GPOs not yet configured (activation is denied)                      |
| GPO2TEMP      | 0   | 0   | 0   | GPO 2Thermal Fault<br>Cleared as reported in GPO-Over Temp diagram, set by detection circuit<br>0 Fault not detected<br>1 Fault detected          |

|            |   |   |   |  |
|------------|---|---|---|--|
| GPO2LIM    | 0 | 0 | 0 | GPO 2 Current Limit Flag<br>Cleared by SSM_RESET or SPI read, set by detection circuit while ON<br>0 Fault not detected<br>1 Fault detected  |
| GPO2ONOPN  | 0 | 0 | 0 | GPO 2 Open Detection<br>Cleared by SSM_RESET or SPI read, set by detection circuit while ON<br>0 Fault not detected<br>1 Fault detected  |
| GPO2OFFOPN | 0 | 0 | 0 | GPO 2 Open detection in OFF condition<br>Cleared by SSM_RESET or SPI read, set by detection circuit while OFF<br>0 Fault not detected<br>1 Fault detected  |
| GPO2SHORT  | 0 | 0 | 0 | GPO 2 Short Detection in OFF condition (short to battery in HS mode, short to ground in LS mode)<br>Cleared by SSM_RESET or SPI read, set by detection circuit while OFF<br>0 Fault not detected<br>1 Fault detected |
| GPO1TEMP   | 0 | 0 | 0 | GPO 1 Thermal Fault<br>Cleared as reported in GPO-Over Temp diagram, set by detection circuit<br>0 Fault not detected<br>1 Fault detected  |
| GPO1LIM    | 0 | 0 | 0 | GPO 1 Current Limit Flag<br>Cleared by SSM_RESET or SPI read, set by detection circuit while ON<br>0 Fault not detected<br>1 Fault detected  |
| GPO1ONOPN  | 0 | 0 | 0 | GPO 1 Open Detection<br>Cleared by SSM_RESET or SPI read, set by detection circuit while ON<br>0 Fault not detected<br>1 Fault detected  |
| GPO1OFFOPN | 0 | 0 | 0 | GPO 1 Open detection in OFF condition<br>Cleared by SSM_RESET or SPI read, set by detection circuit while OFF<br>0 Fault not detected<br>1 Fault detected  |

|            |   |   |   |   |
|------------|---|---|---|---|
| GPO1SHORT  | 0 | 0 | 0 | <p>GPO 1 Short Detection in OFF condition (short to battery in HS mode, short to ground in LS mode)</p> <p>Cleared by SSM_RESET or SPI read, set by detection circuit while OFF</p> <p>0 Fault not detected</p> <p>1 Fault detected</p> |
| GPO0TEMP   | 0 | 0 | 0 | <p>GPO 0 Thermal Fault</p> <p>Cleared as reported in GPO-Over Temp diagram, set by detection circuit</p> <p>0 Fault not detected</p> <p>1 Fault detected</p>  |
| GPO0LIM    | 0 | 0 | 0 | <p>GPO 0 Current Limit Flag</p> <p>Cleared by SSM_RESET or SPI read, set by detection circuit while ON</p> <p>0 Fault not detected</p> <p>1 Fault detected</p>  |
| GPO0ONOPN  | 0 | 0 | 0 | <p>GPO 0 Open Detection</p> <p>OK Cleared by SSM_RESET or SPI read, set by detection circuit while ON</p> <p>0 Fault not detected</p> <p>1 Fault detected</p>   |
| GPO0OFFOPN | 0 | 0 | 0 | <p>GPO 0 Open detection in OFF condition</p> <p>Cleared by SSM_RESET or SPI read, set by detection circuit while OFF</p> <p>0 Fault not detected</p> <p>1 Fault detected</p>  |
| GPO0SHORT  | 0 | 0 | 0 | <p>GPO 0 Short Detection in OFF condition (short to battery in HS mode, short to ground in LS mode)</p> <p>Cleared by SSM_RESET or SPI read, set by detection circuit while OFF</p> <p>0 Fault not detected</p> <p>1 Fault detected</p> |

### 7.3.37 ISOK fault status register (ISOFLTSR)

|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1       | 0      |   |
|------|----|----|----|----|----|----|----|----|----|----|---|---|---|---|---|---|---|---|---------|--------|---|
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | X | X | X | X | X | X | X | X       | X      | X |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | ISOTEMP | ISOLIM |   |

**ID:** 47

**Type:** R

**Read:** 4700

**Write:** -

|         |     |     |     |                |
|---------|-----|-----|-----|----------------|
|         | POR | WSM | SSM |                |
| ISOTEMP | 0   | 0   | 0   | ISO Temp fault |

Cleared by SSM\_RESET or SPI read, set by detection circuit  
 0 Fault not detected  
 1 Fault detected

|        |   |   |   |                        |
|--------|---|---|---|------------------------|
| ISOLIM | 0 | 0 | 0 | ISO current limit flag |
|--------|---|---|---|------------------------|

Cleared by SSM\_RESET or SPI read, set by detection circuit while ON (ISOK) = 0  
 0 Fault not detected  
 1 Fault detected

**7.3.38 Wheel speed sensor test request register (WSS\_TEST)**

|             |    |    |    |    |    |    |    |    |    |    |   |              |   |   |   |   |   |   |             |   |
|-------------|----|----|----|----|----|----|----|----|----|----|---|--------------|---|---|---|---|---|---|-------------|---|
|             | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8            | 7 | 6 | 5 | 4 | 3 | 2 | 1           | 0 |
| <b>MOSI</b> | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | WSSSEL [6:0] |   |   |   |   |   | X | WSSTP/WSSTP |   |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | WSSSEL [6:0] |   |   |   |   |   | X | WSSTP/WSSTP |   |

**ID:** 48  
**Type:** RW  
**Read:** 4800  
**Write:** 0090

|              |        |        |        |  |
|--------------|--------|--------|--------|--|
|              | POR    | WSM    | SSM    |  |
| WSSSEL [6:0] | 000000 | 000000 | 000000 | Wheel Speed Sensor Selection - code below uniquely selects one of the four WSx outputs to place a static output level on<br>1011001 WSS Test Mode for WS1 Output<br>1010110 WSS Test Mode for WS0 Output<br>all other WSS Test Mode disabled |
| WSSTP        | 0      | 0      | 0      | WSx Output Test Value<br>1 Output for selected WSx set 'high'<br>0 Output for selected WSx set 'low'   |

### 7.3.39 PSI5 configuration register for channel x (RSCRx)

#### PSI5 configuration register for channel 0 (RSCR0)

#### PSI5 configuration register for channel 1 (RSCR1)

|      | 19 | 18 | 17 | 16 | 15            | 14                | 13                  | 12         | 11     | 10      | 9           | 8 | 7 | 6 | 5      | 4         | 3        | 2 | 1 | 0 |
|------|----|----|----|----|---------------|-------------------|---------------------|------------|--------|---------|-------------|---|---|---|--------|-----------|----------|---|---|---|
| MOSI | -  |    |    |    | REDUCED_RANGE | BLOCK_CURR_IN_MSG | PERIOD_MEAS_DISABLE | FIX_THRESH | TSxDIS | BLKTSEL | WSFILT[3:0] |   |   |   | RSPTEN | AVG/SSDIS | STS[3:0] |   |   |   |
| MISO | 0  | 0  | 0  | 0  | REDUCED_RANGE | BLOCK_CURR_IN_MSG | PERIOD_MEAS_DISABLE | FIX_THRESH | TSxDIS | BLKTSEL | WSFILT[3:0] |   |   |   | RSPTEN | AVG/SSDIS | STS[3:0] |   |   |   |

**ID:** 4A (RSCR0)  
4B (RSCR1)

**Type:** R/W

**Read:** 4A00 (RSCR0)  
4B00 (RSCR1)

**Write:** 0094 (RSCR0)  
0096 (RSCR1)

#### PSI5 configured channel

|                   | POR | WSM | SSM |   |
|-------------------|-----|-----|-----|---|
| REDUCED_RANGE     | 0   | 0   | 0   | Tracking speed of base and delta current<br>0 Fast tracking of Ibase if rx_sat_pre_filt is low; Slow tracking otherwise.<br>Fast tracking of Idelta if rx_sat_pre_filt is high; Blocked otherwise.<br>1 Fast tracking of Ibase if current is less than (Ibase+(Idelta/4));<br>Slow tracking otherwise.<br>Fast tracking of Idelta if current is higher than (top current -(Idelta/4));<br>Slow otherwise. |
| BLOCK_CURR_IN_MSG | 0   | 0   | 0   | Tracking enable of base and delta current during message transmission<br>0 Ibase tracking is enabled during blanking and after start bits recognition.<br>Idelta tracking is disabled during blanking and enabled after start bits recognition.   |

|                     |      |      |      |  |
|---------------------|------|------|------|--|
|                     |      |      |      | 1 Ibase tracking is enabled during blanking and disabled after start bits recognition.<br>Delta tracking is disabled during blanking and enabled after start bits recognition  |
| PERIOD_MEAS_DISABLE | 0    | 0    | 0    | Disabling of start bits period measure to decode following bits<br>0 Period is measured<br>1 Period is not measured (default is used)  |
| FIX_THRESH          | 0    | 0    | 0    | PSI5 selection of fixed or auto adaptive thresholds<br>0 auto adaptive threshold<br>1 fixed threshold (threshold is latched when this bit is set to high, we recommend to set this bit before enabling of the interface)   |
| TSxDIS              | 0    | 0    | 0    | Time Slot Control Disable<br>0 Slot control enabled<br>1 Slot control disabled   |
| BLKTxSEL            | 0    | 0    | 0    | Blanking Time Selection<br>0 Blanking time = 5ms<br>1 Blanking time = 10ms   |
| WSFILT[3:0]         | 0010 | 0010 | 0010 | Wheel speed filter time selection<br>189k:                    125k:<br>(16+x)*Tosc            (24+x)*Tosc            Tosc=1/16MHz  |
| RSPTEN              | 0    | 0    | 0    | Pass Through mode Enable<br>0 Off<br>1 On  |
| AVG/SSDIS           | 0    | 0    | 0    | Current average enable during message transmission<br>0 Off (base and delta work as configured with bits #12, 14, 15)<br>1 On: base is freezed during data message and during blanking time and delta is averaged during message (fcut of the filter=2500 Hz) while is freezed during blanking time. |

STS[3:0] 0000 0000 0000 Sensor Type Selection

0000 Synchronous PSI5, parity, 8-bit, 125k (P8P-500/3L)  
0001 Synchronous PSI5, parity, 8-bit, 189k (P8P-500/3H)  
0010 Synchronous PSI5, parity, 10-bit, 125k (P10P-500/3L)  
0011 Synchronous PSI5, parity, 10-bit, 189k (P10P-500/3H)  
0100 Synchronous PSI5, parity, 8-bit, 125k (P8P-500/3L)  
0101 Synchronous PSI5, parity, 8-bit, 189k (P8P-500/4H)  
0110 Synchronous PSI5, parity, 10-bit, 125k (P10P-500/3L)  
0111 Synchronous PSI5, parity, 10-bit, 189k (P10P-500/4H)  
1000 NA  
1001 NA  
1010 NA  
1011 NA  
1100 unused (default automatically selected)  
1101 unused (default automatically selected)  
1110 unused (default automatically selected)  
1111 unused (default automatically selected)

**7.3.40 Remote sensor control register (RSCTRL)**

|             |    |    |    |    |    |    |    |    |    |    |   |   |       |         |       |         |       |         |       |         |
|-------------|----|----|----|----|----|----|----|----|----|----|---|---|-------|---------|-------|---------|-------|---------|-------|---------|
|             | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7     | 6       | 5     | 4       | 3     | 2       | 1     | 0       |
| <b>MOSI</b> | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | X | CH3EN | SYNC3EN | CH2EN | SYNC2EN | CH1EN | SYNC1EN | CH0EN | SYNC0EN |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | CH3EN | SYNC3EN | CH2EN | SYNC2EN | CH1EN | SYNC1EN | CH0EN | SYNC0EN |

**ID:** 4E  
**Type:** R/W  
**Read:** 4E00  
**Write:** 009C

|         |   |     |     |     |                                   |
|---------|---|-----|-----|-----|-----------------------------------|
|         |   | POR | WSM | SSM |                                   |
| CHxEN   | 0 | 0   | 0   | 0   | Channel x Output enable           |
|         |   |     |     |     | Updated by SSM_RESET or SPI write |
|         |   |     |     |     | 0 Off                             |
|         |   |     |     |     | 1 On                              |
| SYNCxEN | 0 | 0   | 0   | 0   | Channel x Sync Pulse Enable       |
|         |   |     |     |     | 0 Off                             |
|         |   |     |     |     | 1 On                              |

**7.3.41 Safing algorithm configuration register (SAF\_ALGO\_CONF)**

|             |    |    |    |    |         |    |         |    |    |    |         |   |   |   |         |   |   |         |   |   |
|-------------|----|----|----|----|---------|----|---------|----|----|----|---------|---|---|---|---------|---|---|---------|---|---|
|             | 19 | 18 | 17 | 16 | 15      | 14 | 13      | 12 | 11 | 10 | 9       | 8 | 7 | 6 | 5       | 4 | 3 | 2       | 1 | 0 |
| <b>MOSI</b> | -  |    |    |    | NO_DATA | X  | ARMN_TH |    |    |    | ARMP_TH |   |   |   | SUB_VAL |   |   | ADD_VAL |   |   |
| <b>MISO</b> | 0  | 0  | 0  | 0  | NO_DATA | 0  | ARMN_TH |    |    |    | ARMP_TH |   |   |   | SUB_VAL |   |   | ADD_VAL |   |   |

**ID:** 66  
**Type:** R/W  
**Read:** 6600  
**Write:** 00CC

- |         |   |     |     |     |                              |
|---------|---|-----|-----|-----|------------------------------|
|         |   | POR | WSM | SSM |                              |
| NO_DATA | 0 | 0   | 0   | 0   | Event counter no data select |
- Updated by SSM\_RESET or SPI write while in DIAG state
- 0 Event counter reset to 0 if CC=0 or (ABS value of response > limit determined by LIM\_SELx) and LIM\_ENx=1 when SPI read of SAF\_CC bit is performed (end of sample cycle)
  - 1 Event counter decremented by SUB\_VAL if CC=0 or (ABS value of response > limit determined by LIM\_SELx) and LIM\_ENx=1 when SPI read of SAF\_CC bit is performed (end of sample cycle)
- ARMN\_TH 0011 0011 0011 Negative event counter threshold to assert arming
- Updated by SSM\_RESET or SPI write while in DIAG state
- 0000 Negative event counter disabled
- ARMP\_TH 0011 0011 0011 Positive event counter threshold to assert arming
- Updated by SSM\_RESET or SPI write while in DIAG state
- 0000 Positive event counter disabled
- SUB\_VAL 011 011 011 Decremental step size of the event counter
- Updated by SSM\_RESET or SPI write while in DIAG state
- ADD\_VAL 001 001 001 Incremental step size of the event counter
- Updated by SSM\_RESET or SPI write while in DIAG state



### 7.3.42 Arming signals register (ARM\_STATE)

|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9        | 8              | 7             | 6         | 5 | 4 | 3       | 2        | 1    | 0 |   |
|------|----|----|----|----|----|----|----|----|----|----|----------|----------------|---------------|-----------|---|---|---------|----------|------|---|---|
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | X        | X              | X             | X         | X | X | X       | X        | X    | X | X |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | PSINHINT | PSINH_EXP_TIME | ACL_PIN_STATE | ACL_VALID | 0 | 0 | ARMINT2 | ARMINT_1 | FENL | 0 |   |

**ID:** 6A  
**Type:** R  
**Read:** 6A00  
**Write:** -

|                | POR | WSM | SSM |  |
|----------------|-----|-----|-----|--|
| ARMINT_x       | -   | -   | -   | State of armint signals<br>Updated per Safing Engine output logic diagram in case of internal safing engine otherwise is the echo of ARMx pins   |
| ACL_VALID      | 0   | 0   | 0   | Valid ACL detection<br>0 Cleared when ACL_BAD=2<br>1 Set when ACL_GOOD=3   |
| ACL_PIN_STATE  | -   | -   | -   | Echo of ACL pin  |
| PSINH_EXP_TIME | 0   | 0   | 0   | State of PSINH expiration timer<br>0 If timer is 0<br>1 If timer is counting   |
| PSINHINT       | -   | -   | -   | State of PSINHINT signal<br>Updated per PSINH output logic diagram in case of internal engine otherwise is the echo of PSINH pin inverted        |
| FNL            | -   | -   | -   | State of external arming control signal (used to arm low side of deployment loops only in case of external arming)<br>Updated based on pin state |

### 7.3.43 ARMx assignment registers to specific Loops (LOOP\_MATRIX\_ARMx)

Assignment of ARM1 to specific loops (LOOP\_MATRIX\_ARM1)

Assignment of ARM2 to specific loops (LOOP\_MATRIX\_ARM2)

|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7       | 6       | 5       | 4       | 3       | 2       | 1       | 0       |
|------|----|----|----|----|----|----|----|----|----|----|---|---|---------|---------|---------|---------|---------|---------|---------|---------|
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | X | ARMx_L7 | ARMx_L6 | ARMx_L5 | ARMx_L4 | ARMx_L3 | ARMx_L2 | ARMx_L1 | ARMx_L0 |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | ARMx_L7 | ARMx_L6 | ARMx_L5 | ARMx_L4 | ARMx_L3 | ARMx_L2 | ARMx_L1 | ARMx_L0 |

**ID:** 6E (LOOP\_MATRIX\_ARM1)  
6F (LOOP\_MATRIX\_ARM2)

**Type:** R/W

**Read:** 6E00 (LOOP\_MATRIX\_ARM1)  
6F00 (LOOP\_MATRIX\_ARM2)

**Write:** 00DC (LOOP\_MATRIX\_ARM1)  
00DE (LOOP\_MATRIX\_ARM2)

|         | POR | WSM | SSM |                            |
|---------|-----|-----|-----|----------------------------|
| ARMx_Ly | 0   | 0   | 0   | Configures ARMx for Loop_y |

Updated by SSM\_RESET or SPI write while in DIAG state

0 ARMx signal is not associated with Loopy

1 ARMx signal is associated with Loopy

**7.3.44 ARMx enable pulse stretch timer status (AEPSTS\_ARMx)**

**ARM1 enable pulse stretch timer status (AEPSTS\_ARM1)**  
**ARM2 enable pulse stretch timer status (AEPSTS\_ARM2)**

|             |    |    |    |    |    |    |    |    |    |    |                  |   |   |   |   |   |   |   |   |   |   |
|-------------|----|----|----|----|----|----|----|----|----|----|------------------|---|---|---|---|---|---|---|---|---|---|
|             | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9                | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |   |
| <b>MOSI</b> | -  |    |    |    | X  | X  | X  | X  | X  | X  | X                | X | X | X | X | X | X | X | X | X | X |
| <b>MISO</b> | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | Timer Count[9:0] |   |   |   |   |   |   |   |   |   |   |

**ID:** 73 (AEPSTS\_ARM1)  
 74 (AEPSTS\_ARM2)

**Type:** R

**Read:** 7300 (AEPSTS\_ARM1)  
 7400 (AEPSTS\_ARM2)

**Write:** -

POR WSM SSM

Timer Count \$000 \$000 \$000 10-bit ARMing Enable Pulse Stretcher timer value

Cleared by SSM\_RESET

Loaded with initial value based on ARMx bit and DWELL[1:0] of SAF\_CONTROL\_y while safining is met for record y provided current value is < DWELL[1:0] value

Decrementd every 2ms while > 0

Contains remaining pulse stretcher timer value

### 7.3.45 Passenger inhibit upper threshold for DC sensor 0 (PADTHRESH\_HI)

|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9            | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|----|----|----|----|----|----|--------------|---|---|---|---|---|---|---|---|---|
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | PADTHRESH_HI |   |   |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | PADTHRESH_HI |   |   |   |   |   |   |   |   |   |

**ID:** 78  
**Type:** R/W  
**Read:** 7800  
**Write:** 00F0

POR  
 WSM  
 SSM

PADTHRESH\_HI \$000 \$000 \$000 Upper threshold - measurements above this upper value will assert the PSINH signal and deactivate loops identified in the PSINH mask

### 7.3.46 Passenger inhibit lower threshold for DC sensor 0 (PADTHRESH\_LO)

|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9            | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|----|----|----|----|----|----|--------------|---|---|---|---|---|---|---|---|---|
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | PADTHRESH_LO |   |   |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | PADTHRESH_LO |   |   |   |   |   |   |   |   |   |

**ID:** 79  
**Type:** R/W  
**Read:** 7900  
**Write:** 00F2

POR  
 WSM  
 SSM

PADTHRESH\_LO \$3FF \$3FF \$3FF Lower threshold - measurements below this lower value will assert the PSINH signal and deactivate loops identified in the PSINH mask

### 7.3.47 Assignment of PSINH signal to specific Loop(s) (LOOP\_MATRIX\_PSINH)

|      | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7        | 6        | 5        | 4        | 3        | 2        | 1        | 0        |
|------|----|----|----|----|----|----|----|----|----|----|---|---|----------|----------|----------|----------|----------|----------|----------|----------|
| MOSI | -  |    |    |    | X  | X  | X  | X  | X  | X  | X | X | PSINH_L7 | PSINH_L6 | PSINH_L5 | PSINH_L4 | PSINH_L3 | PSINH_L2 | PSINH_L1 | PSINH_L0 |
| MISO | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | PSINH_L7 | PSINH_L6 | PSINH_L5 | PSINH_L4 | PSINH_L3 | PSINH_L2 | PSINH_L1 | PSINH_L0 |

**ID:** 7A  
**Type:** R/W  
**Read:** 7A00  
**Write:** 00F4

PSINH\_Ly    POR    WSM    SSM  
 0    0    0    0    Configures PSINH for Loop\_y  
 0 PSINH signal is not associated with Loopy  
 1 PSINH signal is associated with Loopy

### 7.3.48 Safing records enable register (SAF\_ENABLE)

|      | 19 | 18 | 17 | 16 | 15       | 14       | 13       | 12 | 11 | 10 | 9 | 8       | 7       | 6       | 5       | 4       | 3       | 2       | 1       | 0       |
|------|----|----|----|----|----------|----------|----------|----|----|----|---|---------|---------|---------|---------|---------|---------|---------|---------|---------|
| MOSI | -  |    |    |    | EN_SAF16 | EN_SAF15 | EN_SAF14 | X  | X  | X  | X | EN_SAF9 | EN_SAF8 | EN_SAF7 | EN_SAF6 | EN_SAF5 | EN_SAF4 | EN_SAF3 | EN_SAF2 | EN_SAF1 |
| MISO | 0  | 0  | 0  | 0  | EN_SAF16 | EN_SAF15 | EN_SAF14 | 0  | 0  | 0  | 0 | EN_SAF9 | EN_SAF8 | EN_SAF7 | EN_SAF6 | EN_SAF5 | EN_SAF4 | EN_SAF3 | EN_SAF2 | EN_SAF1 |

**ID:** 7F  
**Type:** R/W  
**Read:** 7F00  
**Write:** 00FE

EN\_SAFx    POR    WSM    SSM  
 0    0    0    0    Safing Record enable  
 Updated by SSM\_RESET or SPI write  
 0 Disable  
 1 Enable



### 7.3.49 Safing records request mask registers (SAF\_REQ\_MASK\_x)

Safing record request mask for record 1 (SAF\_REQ\_MASK\_1)  
 Safing record request mask for record 2 (SAF\_REQ\_MASK\_2)  
 Safing record request mask for record 3 (SAF\_REQ\_MASK\_3)  
 Safing record request mask for record 4 (SAF\_REQ\_MASK\_4)  
 Safing record request mask for record 5 (SAF\_REQ\_MASK\_5)  
 Safing record request mask for record 6 (SAF\_REQ\_MASK\_6)  
 Safing record request mask for record 7 (SAF\_REQ\_MASK\_7)  
 Safing record request mask for record 8 (SAF\_REQ\_MASK\_8)  
 Safing record request mask for record 9 (SAF\_REQ\_MASK\_9)  
 Safing record request mask for record 14\_pt1 (SAF\_REQ\_MASK\_14)\_pt1  
 Safing record request mask for record 14\_pt2 (SAF\_REQ\_MASK\_14)\_pt2  
 Safing record request mask for record 15\_pt1 (SAF\_REQ\_MASK\_15)\_pt1  
 Safing record request mask for record 15\_pt2 (SAF\_REQ\_MASK\_15)\_pt2  
 Safing record request mask for record 16\_pt1 (SAF\_REQ\_MASK\_16)\_pt1  
 Safing record request mask for record 16\_pt2 (SAF\_REQ\_MASK\_16)\_pt2

|      | 19 | 18 | 17 | 16 | 15                  | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|---------------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| MOSI | -  |    |    |    | SAF_REQ_MASKx[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | SAF_REQ_MASKx[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**ID:** 80 (SAF\_REQ\_MASK\_1)  
 81 (SAF\_REQ\_MASK\_2)  
 82 (SAF\_REQ\_MASK\_3)  
 83 (SAF\_REQ\_MASK\_4)  
 84 (SAF\_REQ\_MASK\_5)  
 85 (SAF\_REQ\_MASK\_6)  
 86 (SAF\_REQ\_MASK\_7)  
 87 (SAF\_REQ\_MASK\_8)  
 88 (SAF\_REQ\_MASK\_9)  
 8D (SAF\_REQ\_MASK\_14\_pt1)  
 8E (SAF\_REQ\_MASK\_14\_pt2)  
 8F (SAF\_REQ\_MASK\_15\_pt1)  
 90 (SAF\_REQ\_MASK\_15\_pt2)  
 91 (SAF\_REQ\_MASK\_16\_pt1)  
 92 (SAF\_REQ\_MASK\_16\_pt2)

**Type:** R/W

**Read:** 8000 (SAF\_REQ\_MASK\_1)  
 8100 (SAF\_REQ\_MASK\_2)  
 8200 (SAF\_REQ\_MASK\_3)  
 8300 (SAF\_REQ\_MASK\_4)  
 8400 (SAF\_REQ\_MASK\_5)  
 8500 (SAF\_REQ\_MASK\_6)  
 8600 (SAF\_REQ\_MASK\_7)  
 8700 (SAF\_REQ\_MASK\_8)  
 8800 (SAF\_REQ\_MASK\_9)  
 8D00 (SAF\_REQ\_MASK\_14\_pt1)  
 8E00 (SAF\_REQ\_MASK\_14\_pt2)

8F00 (SAF\_REQ\_MASK\_15\_pt1)  
 9000 (SAF\_REQ\_MASK\_15\_pt2)  
 9100 (SAF\_REQ\_MASK\_16\_pt1)  
 9200 (SAF\_REQ\_MASK\_16\_pt2)

**Write:**

8000 (SAF\_REQ\_MASK\_1)  
 8002 (SAF\_REQ\_MASK\_2)  
 8004 (SAF\_REQ\_MASK\_3)  
 8006 (SAF\_REQ\_MASK\_4)  
 8008 (SAF\_REQ\_MASK\_5)  
 800A (SAF\_REQ\_MASK\_6)  
 800C (SAF\_REQ\_MASK\_7)  
 800E (SAF\_REQ\_MASK\_8)  
 8010 (SAF\_REQ\_MASK\_9)  
 801A (SAF\_REQ\_MASK\_14\_pt1)  
 801C (SAF\_REQ\_MASK\_14\_pt2)  
 801E (SAF\_REQ\_MASK\_15\_pt1)  
 8020 (SAF\_REQ\_MASK\_15\_pt2)  
 8022 (SAF\_REQ\_MASK\_16\_pt1)  
 8424 (SAF\_REQ\_MASK\_16\_pt2)

|   |   |   |
|---|---|---|
| R | M | M |
| P | W | S |

SAF\_REQ\_MASKx[15:0] \$0000\$0000\$0000 Safing Request Mask for safing record x - 16-bit request mask that is bit-wise ANDed with MOSI data from SPI monitor  
 Updated by SSM\_RESET or SPI write while in DIAG state

### 7.3.50 Safing records request target registers (SAF\_REQ\_TARGET\_x)

Safing record request mask for record 1 (SAF\_REQ\_TARGET\_1)  
 Safing record request mask for record 2 (SAF\_REQ\_TARGET\_2)  
 Safing record request mask for record 3 (SAF\_REQ\_TARGET\_3)  
 Safing record request mask for record 4 (SAF\_REQ\_TARGET\_4)  
 Safing record request mask for record 5 (SAF\_REQ\_TARGET\_5)  
 Safing record request mask for record 6 (SAF\_REQ\_TARGET\_6)  
 Safing record request mask for record 7 (SAF\_REQ\_TARGET\_7)  
 Safing record request mask for record 8 (SAF\_REQ\_TARGET\_8)  
 Safing record request mask for record 9 (SAF\_REQ\_TARGET\_9)  
 Safing record request mask for record 14\_pt1 (SAF\_REQ\_TARGET\_14)\_pt1  
 Safing record request mask for record 14\_pt2 (SAF\_REQ\_TARGET\_14)\_pt2  
 Safing record request mask for record 15\_pt1 (SAF\_REQ\_TARGET\_15)\_pt1  
 Safing record request mask for record 15\_pt2 (SAF\_REQ\_TARGET\_15)\_pt2  
 Safing record request mask for record 16\_pt1 (SAF\_REQ\_TARGET\_16)\_pt1  
 Safing record request mask for record 16\_pt2 (SAF\_REQ\_TARGET\_16)\_pt2

|      | 19 | 18 | 17 | 16 | 15                   | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|----------------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| MOSI | -  |    |    |    | SAF_REQ_TARGET[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | SAF_REQ_TARGET[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**ID:** 93 (SAF\_REQ\_TARGET\_1)  
 94 (SAF\_REQ\_TARGET\_2)  
 95 (SAF\_REQ\_TARGET\_3)  
 96 (SAF\_REQ\_TARGET\_4)  
 97 (SAF\_REQ\_TARGET\_5)  
 98 (SAF\_REQ\_TARGET\_6)  
 99 (SAF\_REQ\_TARGET\_7)  
 9A (SAF\_REQ\_TARGET\_8)  
 9B (SAF\_REQ\_TARGET\_9)  
 A0 (SAF\_REQ\_TARGET\_14\_pt1)  
 A1 (SAF\_REQ\_TARGET\_14\_pt2)  
 A2 (SAF\_REQ\_TARGET\_15\_pt1)  
 A3 (SAF\_REQ\_TARGET\_15\_pt2)  
 A4 (SAF\_REQ\_TARGET\_16\_pt1)  
 A5 (SAF\_REQ\_TARGET\_16\_pt2)

**Type:** R/W

**Read:** 9300 (SAF\_REQ\_TARGET\_1)  
 9400 (SAF\_REQ\_TARGET\_2)  
 9500 (SAF\_REQ\_TARGET\_3)  
 9600 (SAF\_REQ\_TARGET\_4)  
 9700 (SAF\_REQ\_TARGET\_5)  
 9800 (SAF\_REQ\_TARGET\_6)  
 9900 (SAF\_REQ\_TARGET\_7)  
 9A00 (SAF\_REQ\_TARGET\_8)  
 9B00 (SAF\_REQ\_TARGET\_9)  
 A000 (SAF\_REQ\_TARGET\_14\_pt1)  
 A100 (SAF\_REQ\_TARGET\_14\_pt2)

A200 (SAF\_REQ\_TARGET\_15\_pt1)  
 A300 (SAF\_REQ\_TARGET\_15\_pt2)  
 A400 (SAF\_REQ\_TARGET\_16\_pt1)  
 A500 (SAF\_REQ\_TARGET\_16\_pt2)

**Write:**

8026 (SAF\_REQ\_TARGET\_1)  
 8028 (SAF\_REQ\_TARGET\_2)  
 802A (SAF\_REQ\_TARGET\_3)  
 802C (SAF\_REQ\_TARGET\_4)  
 802E (SAF\_REQ\_TARGET\_5)  
 8030 (SAF\_REQ\_TARGET\_6)  
 8032 (SAF\_REQ\_TARGET\_7)  
 8034 (SAF\_REQ\_TARGET\_8)  
 8036 (SAF\_REQ\_TARGET\_9)  
 8040 (SAF\_REQ\_TARGET\_14\_pt1)  
 8042 (SAF\_REQ\_TARGET\_14\_pt2)  
 8044 (SAF\_REQ\_TARGET\_15\_pt1)  
 8246 (SAF\_REQ\_TARGET\_15\_pt2)  
 8048 (SAF\_REQ\_TARGET\_16\_pt1)  
 804A (SAF\_REQ\_TARGET\_16\_pt2)

|   |   |   |
|---|---|---|
| R | M | M |
| P | W | S |

SAF\_REQ\_TARGET[15:0] \$0000\$0000\$0000 Safing Request target for safing record x - 16-bit request target that is compared to the bit-wise AND result of the SAF\_REQ\_MASKx and MOSI data from SPI monitor  
 Updated by SSM\_RESET or SPI write while in DIAG state

### 7.3.51 Safing records response mask registers (SAF\_RESP\_MASK\_x)

**Safing record response mask for record 1 (SAF\_RESP\_MASK\_1)**  
**Safing record response mask for record 2 (SAF\_RESP\_MASK\_2)**  
**Safing record response mask for record 3 (SAF\_RESP\_MASK\_3)**  
**Safing record response mask for record 4 (SAF\_RESP\_MASK\_4)**  
**Safing record response mask for record 5 (SAF\_RESP\_MASK\_5)**  
**Safing record response mask for record 6 (SAF\_RESP\_MASK\_6)**  
**Safing record response mask for record 7 (SAF\_RESP\_MASK\_7)**  
**Safing record response mask for record 8 (SAF\_RESP\_MASK\_8)**  
**Safing record response mask for record 9 (SAF\_RESP\_MASK\_9)**  
**Safing record response mask for record 14\_pt1 (SAF\_RESP\_MASK\_14\_pt1)**  
**Safing record response mask for record 14\_pt2 (SAF\_RESP\_MASK\_14\_pt2)**  
**Safing record response mask for record 15\_pt1 (SAF\_RESP\_MASK\_15\_pt1)**  
**Safing record response mask for record 15\_pt2 (SAF\_RESP\_MASK\_14\_pt2)**  
**Safing record response mask for record 16\_pt1 (SAF\_RESP\_MASK\_16\_pt1)**  
**Safing record response mask for record 16\_pt2 (SAF\_RESP\_MASK\_16\_pt2)**

|             | 19 | 18 | 17 | 16 | 15                   | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----|----|----|----|----------------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| <b>MOSI</b> | -  |    |    |    | SAF_RESP_MASKx[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| <b>MISO</b> | 0  | 0  | 0  | 0  | SAF_RESP_MASKx[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**ID:** A6 (SAF\_RESP\_MASK\_1)  
 A7 (SAF\_RESP\_MASK\_2)  
 A8 (SAF\_RESP\_MASK\_3)  
 A9 (SAF\_RESP\_MASK\_4)  
 AA (SAF\_RESP\_MASK\_5)  
 AB (SAF\_RESP\_MASK\_6)  
 AC (SAF\_RESP\_MASK\_7)  
 AD (SAF\_RESP\_MASK\_8)  
 AE (SAF\_RESP\_MASK\_9)  
 B3 (SAF\_RESP\_MASK\_14\_pt1)  
 B4 (SAF\_RESP\_MASK\_14\_pt2)  
 B5 (SAF\_RESP\_MASK\_15\_pt1)  
 B6 (SAF\_RESP\_MASK\_15\_pt2)  
 B7 (SAF\_RESP\_MASK\_16\_pt1)  
 B8 (SAF\_RESP\_MASK\_16\_pt2)

**Type:** R/W

**Read:**

**Read:** A600 (SAF\_RESP\_MASK\_1)  
 A700 (SAF\_RESP\_MASK\_2)  
 A800 (SAF\_RESP\_MASK\_3)  
 A900 (SAF\_RESP\_MASK\_4)  
 AA00 (SAF\_RESP\_MASK\_5)  
 AB00 (SAF\_RESP\_MASK\_6)  
 AC00 (SAF\_RESP\_MASK\_7)  
 AD00 (SAF\_RESP\_MASK\_8)  
 AE00 (SAF\_RESP\_MASK\_9)

B300 (SAF\_RESP\_MASK\_14\_pt1)  
 B400 (SAF\_RESP\_MASK\_14\_pt2)  
 B500 (SAF\_RESP\_MASK\_15\_pt1)  
 B600 (SAF\_RESP\_MASK\_15\_pt2)  
 B700 (SAF\_RESP\_MASK\_16\_pt1)  
 B801 (SAF\_RESP\_MASK\_16\_pt1)

**Write:** 804C (SAF\_RESP\_MASK\_1)  
 804E (SAF\_RESP\_MASK\_2)  
 8050 (SAF\_RESP\_MASK\_3)  
 8052 (SAF\_RESP\_MASK\_4)  
 8054 (SAF\_RESP\_MASK\_5)  
 8056 (SAF\_RESP\_MASK\_6)  
 8058 (SAF\_RESP\_MASK\_7)  
 805A (SAF\_RESP\_MASK\_8)  
 805C (SAF\_RESP\_MASK\_9)  
 8066 (SAF\_RESP\_MASK\_14\_pt1)  
 8068 (SAF\_RESP\_MASK\_14\_pt2)  
 806A (SAF\_RESP\_MASK\_15\_pt1)  
 806C (SAF\_RESP\_MASK\_15\_pt2)  
 806E (SAF\_RESP\_MASK\_16\_pt1)  
 8070 (SAF\_RESP\_MASK\_16\_pt2)

|  |             |                  |             |
|--|-------------|------------------|-------------|
|  | P<br>O<br>R | M<br>I<br>S<br>O | S<br>S<br>M |
|--|-------------|------------------|-------------|

SAF\_RESP\_MASKx[15:0] 0000 0000 0000 Safing Response Mask for safing record x - 16-bit response mask that is bit-wise ANDed with MISO data from SPI monitor  
 Updated by SSM\_RESET or SPI write while in DIAG state

### 7.3.52 Safing records response mask registers (SAF\_RESP\_TARGET\_x)

Safing record response target for record 1 (SAF\_RESP\_TARGET\_1)  
 Safing record response target for record 2 (SAF\_RESP\_TARGET\_2)  
 Safing record response target for record 3 (SAF\_RESP\_TARGET\_3)  
 Safing record response target for record 4 (SAF\_RESP\_TARGET\_4)  
 Safing record response target for record 5 (SAF\_RESP\_TARGET\_5)  
 Safing record response target for record 6 (SAF\_RESP\_TARGET\_6)  
 Safing record response target for record 7 (SAF\_RESP\_TARGET\_7)  
 Safing record response target for record 8 (SAF\_RESP\_TARGET\_8)  
 Safing record response target for record 9 (SAF\_RESP\_TARGET\_9)  
 Safing record response target for record 14\_pt1 (SAF\_RESP\_TARGET\_14)\_pt1  
 Safing record response target for record 14\_pt2 (SAF\_RESP\_TARGET\_14)\_pt2  
 Safing record response target for record 15\_pt1 (SAF\_RESP\_TARGET\_15)\_pt1  
 Safing record response target for record 15\_pt2 (SAF\_RESP\_TARGET\_15)\_pt2  
 Safing record response target for record 16\_pt1 (SAF\_RESP\_TARGET\_16)\_pt1  
 Safing record response target for record 16\_pt2 (SAF\_RESP\_TARGET\_16)\_pt2

|      | 19 | 18 | 17 | 16 | 15                     | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|------------------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| MOSI | -  |    |    |    | SAF_RESP_TARGETx[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | SAF_RESP_TARGETx[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**ID:** B9 (SAF\_RESP\_TARGET\_1)  
 BA (SAF\_RESP\_TARGET\_2)  
 BB (SAF\_RESP\_TARGET\_3)  
 BC (SAF\_RESP\_TARGET\_4)  
 BD (SAF\_RESP\_TARGET\_5)  
 BE (SAF\_RESP\_TARGET\_6)  
 BF (SAF\_RESP\_TARGET\_7)  
 C0 (SAF\_RESP\_TARGET\_8)  
 C1 (SAF\_RESP\_TARGET\_9)  
 C6 (SAF\_RESP\_TARGET\_14\_pt1)  
 C7 (SAF\_RESP\_TARGET\_14\_pt2)  
 C8 (SAF\_RESP\_TARGET\_15\_pt1)  
 C9 (SAF\_RESP\_TARGET\_15\_pt2)  
 CA (SAF\_RESP\_TARGET\_16\_pt1)  
 CB (SAF\_RESP\_TARGET\_16\_pt2)

**Type:** R/W

**Read:** B900 (SAF\_RESP\_TARGET\_1)  
 BA00 (SAF\_RESP\_TARGET\_2)  
 BB00 (SAF\_RESP\_TARGET\_3)  
 BC00 (SAF\_RESP\_TARGET\_4)  
 BD00 (SAF\_RESP\_TARGET\_5)  
 BE00 (SAF\_RESP\_TARGET\_6)  
 BF00 (SAF\_RESP\_TARGET\_7)  
 C000 (SAF\_RESP\_TARGET\_8)  
 C100 (SAF\_RESP\_TARGET\_9)  
 C600 (SAF\_RESP\_TARGET\_14\_pt1)  
 C700 (SAF\_RESP\_TARGET\_14\_pt2)

C800 (SAF\_RESP\_TARGET\_15\_pt1)  
 C900 (SAF\_RESP\_TARGET\_15\_pt2)  
 CA00 (SAF\_RESP\_TARGET\_16\_pt1)  
 CB00 (SAF\_RESP\_TARGET\_16\_pt2)

**Write:** 8072 (SAF\_RESP\_TARGET\_1)  
 8074 (SAF\_RESP\_TARGET\_2)  
 8076 (SAF\_RESP\_TARGET\_3)  
 8078 (SAF\_RESP\_TARGET\_4)  
 807A (SAF\_RESP\_TARGET\_5)  
 807C (SAF\_RESP\_TARGET\_6)  
 807E (SAF\_RESP\_TARGET\_7)  
 8080 (SAF\_RESP\_TARGET\_8)  
 8082 (SAF\_RESP\_TARGET\_9)  
 808C (SAF\_RESP\_TARGET\_14\_pt1)  
 808E (SAF\_RESP\_TARGET\_14\_pt2)  
 8090 (SAF\_RESP\_TARGET\_15\_pt1)  
 8092 (SAF\_RESP\_TARGET\_15\_pt2)  
 8094 (SAF\_RESP\_TARGET\_16\_pt1)  
 CB00 (SAF\_RESP\_TARGET\_16\_pt2)

|  |     |     |     |
|--|-----|-----|-----|
|  | POR | WSM | SSM |
|  | P   | W   | S   |

SAF\_RESP\_TARGETx[15:0] 0000 0000 0000 Safing Response target for safing record x - 16-bit response target that is compared to the bit-wise AND result of the SAF\_RESP\_MASKx and MISO data from SPI monitor

Updated by SSM\_RESET or SPI write while in DIAG state

### 7.3.53 Safing records data mask registers (SAF\_DATA\_MASK\_x)

Safing record data mask for record 1 (SAF\_DATA\_MASK\_1)  
 Safing record data mask for record 2 (SAF\_DATA\_MASK\_2)  
 Safing record data mask for record 3 (SAF\_DATA\_MASK\_3)  
 Safing record data mask for record 4 (SAF\_DATA\_MASK\_4)  
 Safing record data mask for record 5 (SAF\_DATA\_MASK\_5)  
 Safing record data mask for record 6 (SAF\_DATA\_MASK\_6)  
 Safing record data mask for record 7 (SAF\_DATA\_MASK\_7)  
 Safing record data mask for record 8 (SAF\_DATA\_MASK\_8)  
 Safing record data mask for record 9 (SAF\_DATA\_MASK\_9)  
 Safing record data mask for record 14 (SAF\_DATA\_MASK\_14\_pt1)  
 Safing record data mask for record 14 (SAF\_DATA\_MASK\_14\_pt2)  
 Safing record data mask for record 15 (SAF\_DATA\_MASK\_15\_pt1)  
 Safing record data mask for record 15 (SAF\_DATA\_MASK\_15\_pt2)  
 Safing record data mask for record 16 (SAF\_DATA\_MASK\_16\_pt1)  
 Safing record data mask for record 16 (SAF\_DATA\_MASK\_16\_pt2)

|      | 19 | 18 | 17 | 16 | 15                   | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|----------------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| MOSI | -  |    |    |    | SAF_DATA_MASKx[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | SAF_DATA_MASKx[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**ID:** CC (SAF\_DATA\_MASK\_1)  
 CD (SAF\_DATA\_MASK\_2)  
 CE (SAF\_DATA\_MASK\_3)  
 CF (SAF\_DATA\_MASK\_4)  
 D0 (SAF\_DATA\_MASK\_5)  
 D1 (SAF\_DATA\_MASK\_6)  
 D2 (SAF\_DATA\_MASK\_7)  
 D3 (SAF\_DATA\_MASK\_8)  
 D4 (SAF\_DATA\_MASK\_9)  
 D9 (SAF\_DATA\_MASK\_14\_pt1)  
 DA (SAF\_DATA\_MASK\_14\_pt2)  
 DB (SAF\_DATA\_MASK\_15\_pt1)  
 DC (SAF\_DATA\_MASK\_15\_pt2)  
 DD (SAF\_DATA\_MASK\_16\_pt1)  
 DE (SAF\_DATA\_MASK\_16\_pt2)

**Type:** R/W

**Read:** CC00 (SAF\_DATA\_MASK\_1)  
 CD00 (SAF\_DATA\_MASK\_2)  
 CE00 (SAF\_DATA\_MASK\_3)  
 CF00 (SAF\_DATA\_MASK\_4)  
 D000 (SAF\_DATA\_MASK\_5)  
 D100 (SAF\_DATA\_MASK\_6)  
 D200 (SAF\_DATA\_MASK\_7)  
 D300 (SAF\_DATA\_MASK\_8)  
 D400 (SAF\_DATA\_MASK\_9)  
 D900 (SAF\_DATA\_MASK\_14\_pt1)  
 DA00 (SAF\_DATA\_MASK\_14\_pt2)

DB00 (SAF\_DATA\_MASK\_15\_pt1)  
 DC00 (SAF\_DATA\_MASK\_15\_pt2)  
 DD00 (SAF\_DATA\_MASK\_16\_pt1)  
 DE00 (SAF\_DATA\_MASK\_16\_pt2)

**Write:**

8099 (SAF\_DATA\_MASK\_1)  
 809A (SAF\_DATA\_MASK\_2)  
 809C (SAF\_DATA\_MASK\_3)  
 809E (SAF\_DATA\_MASK\_4)  
 80A0 (SAF\_DATA\_MASK\_5)  
 80A2 (SAF\_DATA\_MASK\_6)  
 80A4 (SAF\_DATA\_MASK\_7)  
 80A6 (SAF\_DATA\_MASK\_8)  
 80A8 (SAF\_DATA\_MASK\_9)  
 80B2 (SAF\_DATA\_MASK\_14\_pt1)  
 80B4 (SAF\_DATA\_MASK\_14\_pt2)  
 80B6 (SAF\_DATA\_MASK\_15\_pt1)  
 80B8 (SAF\_DATA\_MASK\_15\_pt2)  
 80BA (SAF\_DATA\_MASK\_16\_pt1)  
 80BC (SAF\_DATA\_MASK\_16\_pt2)

|     |     |     |
|-----|-----|-----|
| POR | WSM | SSM |
| P   | W   | S   |

SAF\_DATA\_MASKx[15:0] 0000 0000 0000 Safing Data Mask for safing record x - 16-bit data mask that is bit-wise ANDed with MISO data from SPI monitor  
 Updated by SSM\_RESET or SPI write while in DIAG state

### 7.3.54 Safing record threshold registers (SAF\_THRESHOLD\_x)

Safing record threshold for record 1 (SAF\_THRESHOLD\_1)  
 Safing record threshold for record 2 (SAF\_THRESHOLD\_2)  
 Safing record threshold for record 3 (SAF\_THRESHOLD\_3)  
 Safing record threshold for record 4 (SAF\_THRESHOLD\_4)  
 Safing record threshold for record 5 (SAF\_THRESHOLD\_5)  
 Safing record threshold for record 6 (SAF\_THRESHOLD\_6)  
 Safing record threshold for record 7 (SAF\_THRESHOLD\_7)  
 Safing record threshold for record 8 (SAF\_THRESHOLD\_8)  
 Safing record threshold for record 9 (SAF\_THRESHOLD\_9)  
 Safing record threshold for record 14 (SAF\_THRESHOLD\_14)  
 Safing record threshold for record 15 (SAF\_THRESHOLD\_15)  
 Safing record threshold for record 16 (SAF\_THRESHOLD\_16)

|      | 19 | 18 | 17 | 16 | 15                   | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|----------------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| MOSI | -  |    |    |    | SAF_THRESHOLDx[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| MISO | 0  | 0  | 0  | 0  | SAF_THRESHOLDx[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**ID:** DF (SAF\_THRESHOLD\_1)  
 E0 (SAF\_THRESHOLD\_2)  
 E1 (SAF\_THRESHOLD\_3)  
 E2 (SAF\_THRESHOLD\_4)  
 E3 (SAF\_THRESHOLD\_5)  
 E4 (SAF\_THRESHOLD\_6)  
 E5 (SAF\_THRESHOLD\_7)  
 E6 (SAF\_THRESHOLD\_8)  
 E7 (SAF\_THRESHOLD\_9)  
 EC (SAF\_THRESHOLD\_14)  
 ED (SAF\_THRESHOLD\_15)  
 EE (SAF\_THRESHOLD\_16)

**Type:** R/W

**Read:** DF00 (SAF\_THRESHOLD\_1)  
 E000 (SAF\_THRESHOLD\_2)  
 E100 (SAF\_THRESHOLD\_3)  
 E200 (SAF\_THRESHOLD\_4)  
 E300 (SAF\_THRESHOLD\_5)  
 E400 (SAF\_THRESHOLD\_6)  
 E500 (SAF\_THRESHOLD\_7)  
 E600 (SAF\_THRESHOLD\_8)  
 E700 (SAF\_THRESHOLD\_9)  
 EC00 (SAF\_THRESHOLD\_14)  
 ED00 (SAF\_THRESHOLD\_15)  
 EE00 (SAF\_THRESHOLD\_16)

**Write:** 80BE (SAF\_THRESHOLD\_1)  
 80C0 (SAF\_THRESHOLD\_2)  
 80C2 (SAF\_THRESHOLD\_3)

80C4 (SAF\_THRESHOLD\_4)  
80C6 (SAF\_THRESHOLD\_5)  
80C8 (SAF\_THRESHOLD\_6)  
80CA (SAF\_THRESHOLD\_7)  
80CC (SAF\_THRESHOLD\_8)  
80CE (SAF\_THRESHOLD\_9)  
80D8 (SAF\_THRESHOLD\_14)  
80DA (SAF\_THRESHOLD\_15)  
80DB (SAF\_THRESHOLD\_16)

POR      WSM      SSM

SAF\_THRESHOLD\_x    \$FFFF \$FFFF \$FFFF    Safing threshold for safing record x - 16-bit threshold used for safing data comparison

Updated by SSM\_RESET or SPI write while in DIAG state

### 7.3.55 Safing control x registers (SAF\_CONTROL\_x)

**Safing control registers for record 1 (SAF\_CONTROL\_1)**  
**Safing control registers for record 2 (SAF\_CONTROL\_2)**  
**Safing control registers for record 3 (SAF\_CONTROL\_3)**  
**Safing control registers for record 4 (SAF\_CONTROL\_4)**  
**Safing control registers for record 5 (SAF\_CONTROL\_5)**  
**Safing control registers for record 6 (SAF\_CONTROL\_6)**  
**Safing control registers for record 7 (SAF\_CONTROL\_7)**  
**Safing control registers for record 8 (SAF\_CONTROL\_8)**  
**Safing control registers for record 9 (SAF\_CONTROL\_9)**  
**Safing control registers for record 14 (SAF\_CONTROL\_14)**  
**Safing control registers for record 15 (SAF\_CONTROL\_15)**  
**Safing control registers for record 16 (SAF\_CONTROL\_16)**

|             | 19 | 18 | 17 | 16 | 15      | 14 | 13                   | 12       | 11      | 10    | 9            | 8 | 7 | 6 | 5     | 4     | 3        | 2 | 1 | 0   |
|-------------|----|----|----|----|---------|----|----------------------|----------|---------|-------|--------------|---|---|---|-------|-------|----------|---|---|-----|
| <b>MOSI</b> | -  |    |    |    | ARMSELx |    | SPIFLDSELxSPIFLDSELx | LIM SELx | LIM Enx | COMBx | DWEELLx[1:0] |   | X | X | ARM2x | ARM1x | CSx[2:0] |   |   | IFx |
| <b>MISO</b> | 0  | 0  | 0  | 0  | ARMSELx |    | SPIFLDSELxSPIFLDSELx | LIM SELx | LIM Enx | COMBx | DWEELLx[1:0] |   | 0 | 0 | ARM2x | ARM1x | CSx[2:0] |   |   | IFx |

**ID:** EF (SAF\_CONTROL\_1)  
 F0 (SAF\_CONTROL\_2)  
 F1 (SAF\_CONTROL\_3)  
 F2 (SAF\_CONTROL\_4)  
 F3 (SAF\_CONTROL\_5)  
 F4 (SAF\_CONTROL\_6)  
 F5 (SAF\_CONTROL\_7)  
 F6 (SAF\_CONTROL\_8)  
 F7 (SAF\_CONTROL\_9)  
 FC (SAF\_CONTROL\_14)  
 FD (SAF\_CONTROL\_15)  
 FE (SAF\_CONTROL\_16)

**Type:** R/W

**Read:** EF00 (SAF\_CONTROL\_1)  
 F000 (SAF\_CONTROL\_2)  
 F100 (SAF\_CONTROL\_3)  
 F200 (SAF\_CONTROL\_4)  
 F300 (SAF\_CONTROL\_5)  
 F400 (SAF\_CONTROL\_6)  
 F500 (SAF\_CONTROL\_7)  
 F600 (SAF\_CONTROL\_8)  
 F700 (SAF\_CONTROL\_9)  
 FC00 (SAF\_CONTROL\_14)

**Write:** FD00 (SAF\_CONTROL\_15)  
 FE00 (SAF\_CONTROL\_16)  
 80DE (SAF\_CONTROL\_1)  
 80E0 (SAF\_CONTROL\_2)  
 80E2 (SAF\_CONTROL\_3)  
 80E4 (SAF\_CONTROL\_4)  
 80E6 (SAF\_CONTROL\_5)  
 80E8 (SAF\_CONTROL\_6)  
 80EA (SAF\_CONTROL\_7)  
 80EC (SAF\_CONTROL\_8)  
 80EE (SAF\_CONTROL\_9)  
 80F8 (SAF\_CONTROL\_14)  
 80FA (SAF\_CONTROL\_15)  
 80FC (SAF\_CONTROL\_16)

|            | ROR | WSM | SSM |  |
|------------|-----|-----|-----|--|
| ARMSELx    | 00  | 00  | 00  | ARMINT select for safing record x - correlates A<br>Updated by SSM_RESET or SPI write while in DIAG state<br><br>00 ARMP OR ARMN<br>01 ARMP<br>10 ARMN<br>11 ARMP OR ARMN  |
| SPIFLDSELx | 0   | 0   | 0   | SPI field select for safing record x - determines which 16-bit field in long SPI messages (>31 bit) to use for response on MISO of SPI monitor.<br>In case of messages less than 32 bits this bit is don't care. Updated by SSM_RESET or SPI write while in DIAG state.<br><br>0 First 16 bits of SPI MISO frame used for Response Mask and Data Mask bit-wise AND<br>1 Last 16 bits of SPI MISO frame used for Response Mask and Data Mask bit-wise AND |
| LIM SELx   | 0   | 0   | 0   | Data range limit select for safing record x - When enabled, determines the range limit used for incoming sensor data<br>Updated by SSM_RESET or SPI write while in DIAG state<br><br>0 8-bit data range limit - incoming  data  >120d is not recognized as valid data<br>1 10-bit data range limit - incoming  data  > 480d is not recognized as valid data  |
| LIM Enx    | 0   | 0   | 0   | Data range limit enable for safing record x<br>Updated by SSM_RESET or SPI write while in DIAG state<br><br>0 Data range limit disabled<br>1 Data range limit enabled  |
| COMBx      | 0   | 0   | 0   | Combine function enable for safing record x<br>Updated by SSM_RESET or SPI write while in DIAG state   |

|             |     |     |     |  |
|-------------|-----|-----|-----|--|
|             |     |     |     | 0 Combine function disabled<br>1 Combine function enabled<br>For record pairs = x,x+1, the comparison for record x uses  data(x) + data(x+1)  and the comparison for record x+1 uses  data(x) - data(x+1) <br>Combine function is not available for 32 bits safining records (x=1,3,5,7,9,11 for high-end; x=1,3,5,7 for mid-end);   |
| DWELLx[1:0] | 00  | 00  | 00  | Safing dwell extension time select for safining record x<br>Updated by SSM_RESET or SPI write while in DIAG state<br><br>00 2048 ms<br>01 256 ms<br>10 32 ms<br>11 0 ms  |
| ARM2x       | 0   | 0   | 0   | ARM2INT select for safining record x - correlates safining result to ARM2INT<br>Updated by SSM_RESET or SPI write while in DIAG state<br><br>0 Safing record x not assigned to ARM2INT<br>1 Safing record x assigned to ARM2INT  |
| ARM1x       | 0   | 0   | 0   | ARM1INT select for safining record x - correlates safining result to ARM1INT<br>Updated by SSM_RESET or SPI write while in DIAG state<br><br>0 Safing record x not assigned to ARM1INT<br>1 Safing record x assigned to ARM1INT  |
| CSx[2:0]    | 000 | 000 | 000 | SPI Monitor CS select for safining record x<br>Updated by SSM_RESET or SPI write while in DIAG state<br><br>000 None selected for record x<br>001 SAF_CS0 selected for record x<br>010 SAF_CS1 selected for record x<br>011 SAF_CS2 selected for record x<br>100 None selected for record x<br>101 CS_RS selected for record x<br>110 None selected for record x<br>111 None selected for record x |
| IFx         | 0   | 0   | 0   | SPI format select for safining record x - selects response protocol for SPI monitor.<br>Updated by SSM_RESET or SPI write while in DIAG state<br><br>0 Out of frame response for record x<br>1 In Frame response for record x  |

**7.3.56 Safing record compare complete register (SAF\_CC)**

|      |    |    |    |    |                   |                   |                   |    |    |    |   |                  |                  |                  |                  |                  |                  |                  |                  |                  |   |
|------|----|----|----|----|-------------------|-------------------|-------------------|----|----|----|---|------------------|------------------|------------------|------------------|------------------|------------------|------------------|------------------|------------------|---|
|      | 19 | 18 | 17 | 16 | 15                | 14                | 13                | 12 | 11 | 10 | 9 | 8                | 7                | 6                | 5                | 4                | 3                | 2                | 1                | 0                |   |
| MOSI | -  |    |    |    | X                 | X                 | X                 | X  | X  | X  | X | X                | X                | X                | X                | X                | X                | X                | X                | X                | X |
| MISO | 0  | 0  | 0  | 0  | CC <sub>-16</sub> | CC <sub>-15</sub> | CC <sub>-14</sub> | 0  | 0  | 0  | 0 | CC <sub>-9</sub> | CC <sub>-8</sub> | CC <sub>-7</sub> | CC <sub>-6</sub> | CC <sub>-5</sub> | CC <sub>-4</sub> | CC <sub>-3</sub> | CC <sub>-2</sub> | CC <sub>-1</sub> |   |

**ID:** FF  
**Type:** R  
**Read:** FF00  
**Write:** -

|                   |   |     |     |     |  |
|-------------------|---|-----|-----|-----|--|
|                   |   | POR | WSM | SSM |  |
| CC <sub>-xx</sub> | 0 | 0   | 0   | 0   | Indicates compare complete status of each of the 16 safing records, and defines the end of the sample cycle for safing |

Cleared by SSM\_RESET or upon SPI read, set by safing engine when request, response mask and target registers match the incoming SPI frame

- 0 Compare not completed for record x
- 1 Compare completed for record x

## 7.4 Remote sensor SPI register map

The Remote Sensor SPI interface consists of twelve 32-bit read registers (one for each logical channel) to allow for access to decoded sensor data and fault registers. The registers are addressed by the read register ID and the Global ID bit.

The L9679P checks the validity of the received RID field in the MOSI\_RS frame. Should a SPI read command be received containing an unused RID address, the command will be discarded and the ERR\_RID bit will be flagged in the current GSW.

**Table 8. Remote sensor SPI register map**

| GID | RID / WID |   |   |   |   |   |   |      | Hex | R/W       | Name   | Description | Operating State |      |        |       |        |
|-----|-----------|---|---|---|---|---|---|------|-----|-----------|--|-------------|-----------------|------|--------|-------|--------|
|     |           |   |   |   |   |   |   |      |     |           |  |             | Init            | Diag | Safing | Scrap | Arming |
| 0   | 1         | 0 | 1 | 0 | 0 | 0 | 0 | \$50 | R   | RSDR0     | Remote sensor data/status registers (PSI-5 or WSS) |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 0 | 0 | 0 | 1 | \$51 | R   | RSDR1     |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 0 | 0 | 1 | 0 | \$52 |     |           |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 0 | 0 | 1 | 1 | \$53 |     |           |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 0 | 1 | 0 | 0 | \$54 | R   | RSDR4     |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 0 | 1 | 0 | 1 | \$55 | R   | RSDR5     |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 0 | 1 | 1 | 0 | \$56 |     |           |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 0 | 1 | 1 | 1 | \$57 |     |           |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 1 | 0 | 0 | 0 | \$58 | R   | RSDR8     |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 1 | 0 | 0 | 1 | \$59 | R   | RSDR9     |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 1 | 0 | 1 | 0 | \$5A |     |           |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 1 | 0 | 1 | 1 | \$5B |     |           |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 1 | 1 | 0 | 0 | \$5C | R   | RSTHR0_L  | Remote sensor (PSI-5 or WSS)                       |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 1 | 1 | 0 | 1 | \$5D | R   | RSTHR1_L  |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 1 | 1 | 1 | 0 | \$5E | R   | RSTHR2_L  |  |             |                 |      |        |       |        |
| 0   | 1         | 0 | 1 | 1 | 1 | 1 | 1 | \$5F | R   | RSTHR3_L  |  |             |                 |      |        |       |        |
| 0   | 1         | 1 | 0 | 0 | 0 | 0 | 0 | \$60 |     |           |  |             |                 |      |        |       |        |
| 0   | 1         | 1 | 0 | 0 | 0 | 0 | 1 | \$61 |     |           |  |             |                 |      |        |       |        |
| 0   | 1         | 1 | 0 | 0 | 0 | 1 | 0 | \$62 |     |           |  |             |                 |      |        |       |        |
| 0   | 1         | 1 | 0 | 0 | 0 | 1 | 1 | \$63 |     |           |  |             |                 |      |        |       |        |
| 0   | 1         | 1 | 0 | 1 | 0 | 1 | 0 | \$6A | R   | ARM_STATE | Arming signals status register                     |             |                 |      |        |       |        |
| 1   | 1         | 1 | 1 | 1 | 1 | 1 | 1 | \$FF | R   | SAF_CC    | Safing record compare complete register            |             |                 |      |        |       |        |

## 7.5 Remote sensor SPI tables

A summary of all the registers contained within the remote sensor SPI map are shown below and are referenced throughout the specification as they apply. The SPI register tables also specify the effect of the internal reset signals assertion on each bit field (the symbol ‘-’ is used to indicate that the register is not affected by the relevant reset signal’).

### 7.5.1 Remote sensor SPI global status word

The Remote Sensor SPI of L9679P contains an 11-bit word that returns global status information. The Global Status Word (GSW) of the Remote Sensor SPI is the most significant 11 bits of MISO\_RS data.

**Table 9. GSW - Remote sensor SPI global status word**

| MISO_RS | GSW | Name        | POR | WSM | SSM | Description   |
|---------|-----|-------------|-----|-----|-----|---|
| 31      | 10  | SPIFLT      | 0   | 0   | 0   | SPI Fault, set if previous SPI frame had wrong parity check or wrong number of bits, cleared upon read ‘              |
|         |     |             |     |     |     | 0 No fault  |
|         |     |             |     |     |     | 1 Fault   |
| 30      | 9   | 0           | 0   | 0   | 0   | Unused  |
| 29      | 8   | RSFLT       | 0   | 0   | 0   | Remote Sensor Interface Fault Present, logical OR of the corresponding FLTBIT bits (bit 15) for all faults but NODATA |
|         |     |             |     |     |     | 0 All the RSDRx-FLTBIT bits are 0   |
|         |     |             |     |     |     | 1 At least one of the RSDRx-FLTBIT bits is 1 and the associated fault code is different from NODATA                   |
| 28      | 7   | 0           | 0   | 0   | 0   | Unused  |
| 27      | 6   | 0           | 0   | 0   | 0   | Unused  |
| 26      | 5   | 0           | 0   | 0   | 0   | Unused  |
| 25      | 4   | 0           | 0   | 0   | 0   | Unused  |
| 24      | 3   | 0           | 0   | 0   | 0   | Unused  |
| 23      | 2   | 0           | 0   | 0   | 0   | Unused  |
| 22      | 1   | 0           | 0   | 0   | 0   | Unused  |
| 21      | 0   | ERR_RI<br>D | 0   | 0   | 0   | Read address received in the actual SPI frame is unused so data in the response is don't care                         |
|         |     |             |     |     |     | 0 No Error  |
|         |     |             |     |     |     | 1 Error   |

## 7.6 Remote sensor SPI read/write registers

### 7.6.1 Remote sensor data/fault registers (RSDRx @FLT = 0)

Note: The value in Bit15 (FLT) will re-define the use of the other bits, hence the tables below are divided into two groups (Section 7.6.1 and Section 7.6.2).

Remote Sensor 0 Data and Fault Flag Register ch 0, slot 1 (RSDR0)  
 Remote Sensor 1 Data and Fault Flag Register ch 1, slot 1 (RSDR1)  
 Remote Sensor 4 Data and Fault Flag Register ch 0, slot 2 (RSDR4)  
 Remote Sensor 5 Data and Fault Flag Register ch 1, slot 2 (RSDR5)  
 Remote Sensor 8 Data and Fault Flag Register ch 0, slot 3 (RSDR8)  
 Remote Sensor 9 Data and Fault Flag Register ch 1, slot 3 (RSDR9)

#### Bit 15 = 0 NO FAULT Condition

|                | 19  | 18 | 17 | 16    | 15     | 14         | 13 | 12 | 11 | 10 | 9          | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------|-----|----|----|-------|--------|------------|----|----|----|----|------------|---|---|---|---|---|---|---|---|---|
| MOSI_RS        |     |    |    |       | X      | X          | X  | X  | X  | X  | X          | X | X | X | X | X | X | X | X | X |
| MISO_RS (PSI5) | CRC |    | 0  | FLT=0 | On/Off | LCID [3:0] |    |    |    |    | DATA [9:0] |   |   |   |   |   |   |   |   |   |

**ID:** 50 (RSDR0)  
 51 (RSDR1)  
 54 (RSDR4)  
 55 (RSDR5)  
 58 (RSDR8)  
 59 (RSDR9)

**Type:** R

**Read:** 5000 (RSDR0)  
 5100 (RSDR1)  
 5400 (RSDR4)  
 5500 (RSDR5)  
 5800 (RSDR8)  
 5900 (RSDR9)

**Write:** -

|          | POR | WSM | SSM |  |
|----------|-----|-----|-----|--|
| CRC[2:0] | -   | -   | -   | CRC based on bits [16:0]<br>Updated based on bits [16:0] |

| FLT | 1 | 1 | 1 | Fault Status - Depending on Fault Status, the DATA bits are defined differently<br>Cleared when all of the following bits are '0': STG, STB, CURRENT_HI, OPENDET, RSTEMP, INVALID, SLOT_ERROR, NODATA |
|-----|---|---|---|---|
|-----|---|---|---|---|

|           |       |       |       |  |
|-----------|-------|-------|-------|--|
|           |       |       |       | Set when any of the following bits are '1': STG, STB, CURRENT_HI, OPENDET, RSTEMP, INVALID, SLOT_ERROR, NODATA           |
|           |       |       |       | 0 No fault   |
|           |       |       |       | 1 Fault  |
| On/Off    | 0     | 0     | 0     | Channel On/Off Status  |
|           |       |       |       | Cleared by SSM_RESET or when channel is commanded OFF via SPI RSCTRL or when the STG bit is set or the RSTEMP bit is set |
|           |       |       |       | Set when channel is commanded ON by SPI RSCTRL   |
|           |       |       |       | 0 Off  |
|           |       |       |       | 1 On   |
| LCID[3:0] | -     | -     | -     | Logical Channel ID   |
|           |       |       |       | Updated based on SPI read request  |
|           |       |       |       | 0000 RSU0 SLOT1  |
|           |       |       |       | 0001 RSU0 SLOT2  |
|           |       |       |       | 0010 RSU0 SLOT3  |
|           |       |       |       | 0100 RSU1 SLOT1  |
|           |       |       |       | 0101 RSU1 SLOT2  |
|           |       |       |       | 0110 RSU1 SLOT3  |
| DATA[9:0] | \$000 | \$000 | \$000 | 10-bit data from Manchester decoder  |
|           |       |       |       | Cleared by SSM_RESET or SPI read or when channel is commanded OFF via SPI RSCTRL   |
|           |       |       |       | updated when a valid PSI5 frame is received  |



|            |   |   |   |  |
|------------|---|---|---|--|
|            |   |   |   | 0 No fault<br>1 Fault  |
| STB        | 0 | 0 | 0 | Short to Battery<br>Cleared by SSM_RESET or SPI read or when channel is commanded OFF via SPI RSCTRL<br>Not cleared by channel OFF caused by STG or RSTEMP<br>Set when channel voltage exceeds VSUP for a time greater than T <sub>STBTH</sub><br>0 No fault<br>1 Fault  |
| CURRENT_HI | 0 | 0 | 0 | Current High<br>Cleared by SSM_RESET or SPI read or when channel is commanded OFF via SPI RSCTRL<br>Set when channel current exceeds ILKGG for a time determined by an up/down counter<br>0 No fault<br>1 Fault  |
| OPENDET    | 0 | 0 | 0 | Open Sensor Detected<br>Cleared by SSM_RESET or SPI read or when channel is commanded OFF via SPI RSCTRL<br>Set when channel current exceeds ILKGB for a time determined by an up/down counter<br>0 No fault<br>1 Fault  |
| RSTEMP     | 0 | 0 | 0 | Over temperature detected<br>Cleared by SSM_RESET or when channel is commanded OFF via SPI RSCTRL<br>Set when over-temp condition is detected<br>0 No fault<br>1 Fault   |
| INVALID    | 0 | 0 | 0 | Invalid Data<br>Cleared by SSM_RESET or SPI read or when channel is commanded OFF via SPI RSCTRL or if one of the following is set:<br>STG, STB, CURRENT_HI, OPEN_DET, RSTEMP, SLOT ERROR (PSI5) or if a new valid data is received.<br>Set in PSI5 configuration when two valid start bits are received and a Manchester error (# of bits, bit timing) or parity error is detected<br>0 No fault<br>1 Fault |
| NODATA     | 1 | 1 | 1 | No Data in buffer  |

Cleared when a valid PSI5/WSS frame is received or if one of the following is set: STG, STB, CURRENT\_HI, OPEN\_DET, RSTEMP, SLOT ERROR, PULSE OVERFLOW ERROR, INVALID

Set upon SPI read of RSDRx and none of the following bits are set: STG, STB, CURRENT\_HI, OPEN\_DET, RSTEMP, SLOT ERROR, PULSE OVERFLOW ERROR, INVALID

0 No fault

1 Fault

SLOT ERROR 0 0 0 Slot error fault (valid only for PSI5 sensors)

Cleared by SSM\_RESET or SPI read or when channel is commanded OFF via SPI RCTRL or if one of the following is set: STG, STB,

CURRENT\_HI, OPEN\_DET, RSTEMP or if a new valid data is received

Set in case of slot control enabled and frame not completely inside slot or more than one frame inside the slot

0 No fault

1 Fault

### 7.6.3 Remote sensor x current registers y (RSTHRx\_y)

Remote sensor 0, base current and delta to calculate 1st top current (RSTHR0\_L)  
 Remote sensor 1, base current and delta to calculate 1st top current (RSTHR1\_L)

|         |                     |    |    |    |    |    |    |    |    |    |                    |   |   |   |   |   |   |   |   |   |
|---------|---------------------|----|----|----|----|----|----|----|----|----|--------------------|---|---|---|---|---|---|---|---|---|
|         | 19                  | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9                  | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| MOSI_RS | -                   |    |    | X  | X  | X  | X  | X  | X  | X  | X                  | X | X | X | X | X | X | X | X | X |
| MISO_RS | DELTA 1ST TOP [9:0] |    |    |    |    |    |    |    |    |    | BASE CURRENT [9:0] |   |   |   |   |   |   |   |   |   |

**ID:** 5C (RSTHR0\_L)  
 5D (RSTHR1\_L)

**Type:** R

**Read:** 5C00 (RSTHR0\_L)  
 5D00 (RSTHR1\_L)

**Write:** -

POR WSM SSM

BASE CURRENT [9:0] \$A1 \$A1 \$A1 Base current measured by internal converter (93.75 µA ±9% each LSB).

DELTA 1ST TOP [9:0] \$103 \$103 \$103 Delta measured by internal converter respect to base current (93.75 µA ±9% each LSB) to get top current.

Low threshold = base current+(DELTA\_1ST\_TOP/2) in case of PSI5 without current averaged algorithm (bit 4 of RSRCx register equal to 0).

Low threshold = base current+(DELTA\_1ST\_TOP) in case of PSI5 with current averaged algorithm (bit 4 of RSRCx register equal to 1).

### 7.6.4 Arming signals status register (ARM\_STATE)

|                  | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9        | 8              | 7             | 6         | 5 | 4 | 3        | 2        | 1    | 0 |
|------------------|----|----|----|----|----|----|----|----|----|----|----------|----------------|---------------|-----------|---|---|----------|----------|------|---|
| MOSI/<br>MOSI_RS | -  |    |    |    | X  | X  | X  | X  | X  | X  | X        | X              | X             | X         | X | X | X        | X        | X    | X |
| MOSI/<br>MOSI_RS | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | PSINHINT | PSINH_EXP_TIME | ACL_PIN_STATE | ACL_VALID | 0 | 0 | ARMINT_2 | ARMINT_1 | FENL | 0 |

**ID:** 6A  
**Type:** R  
**Read:** 6A00  
**Write:** -

|                | POR | WSM | SSM |  |
|----------------|-----|-----|-----|--|
| ARMINT_x       | -   | -   | -   | State of ARMINT signals<br><br>Updated per Safing Engine output logic diagram in case of internal safing engine otherwise is the echo of ARMx pins   |
| ACL_VALID      | 0   | 0   | 0   | Valid ACL detection<br><br>0 Cleared when ACL_BAD=2<br>1 Set when ACL_GOOD=3   |
| ACL_PIN_STATE  | -   | -   | -   | Echo of ACL pin  |
| PSINH_EXP_TIME | 0   | 0   | 0   | State of PSINH expiration timer<br><br>0 If timer is 0<br>1 If timer is counting   |
| PSINHINT       | -   | -   | -   | State of PSINHINT signal<br><br>Updated per PSINH output logic diagram in case of internal engine otherwise is the echo of PSINH pin inverted        |
| FENL           | -   | -   | -   | State of external arming control signal (used to arm low side of deployment loops only in case of external arming)<br><br>Updated based on pin state |

### 7.6.5 Safing record compare complete register (SAF\_CC)

|                  |    |    |    |    |       |       |       |    |    |    |   |      |      |      |      |      |      |      |      |      |   |
|------------------|----|----|----|----|-------|-------|-------|----|----|----|---|------|------|------|------|------|------|------|------|------|---|
|                  | 19 | 18 | 17 | 16 | 15    | 14    | 13    | 12 | 11 | 10 | 9 | 8    | 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |   |
| MOSI/<br>MOSI_RS | -  |    |    |    | X     | X     | X     | X  | X  | X  | X | X    | X    | X    | X    | X    | X    | X    | X    | X    | X |
| MISO/<br>MISO_RS | 0  | 0  | 0  | 0  | CC_16 | CC_15 | CC_14 | 0  | 0  | 0  | 0 | CC_9 | CC_8 | CC_7 | CC_6 | CC_5 | CC_4 | CC_3 | CC_2 | CC_1 |   |

**ID:** FF  
**Type:** R  
**Read:** FF00  
**Write:** -

|       |   |     |     |     |  |
|-------|---|-----|-----|-----|--|
|       |   | POR | WSM | SSM |  |
| CC_xx | 0 | 0   | 0   | 0   | Indicates compare complete status of each of the 16 safing records, and defines the end of the sample cycle for safing |

Cleared by SSM\_RESET or upon SPI read, set by safing engine when request, response mask and target registers match the incoming SPI frame

- 0 Compare not completed for record x
- 1 Compare completed for record x

## 8 Deployment drivers

The squib deployment block consists of 8 independent high side drivers and 8 independent low side drivers. Squib deployment logic requires a deploy command received through SPI communications and either an arming condition processed by safing logic or a proper ARMx input pin assessment, depending on whether the internal safing engine is used or not. Both conditions must exist in order for the deployment to occur. Once a deployment is initiated, it can only be terminated by an SSM\_RESET event.

L9679P allows all 8 squib loops to be deployed at the very same time or in other possible timing sequence. Deployment drivers are capable of granting a successful deployment also in case of short to ground on low-side circuit (SRx pins). Firing voltage capability across high side circuit is maximum 25 V. High side and low side drivers account for a maximum series total resistance of 2  $\Omega$ . Each loop is granted for a minimum number of deployments of 50, under all normal operating conditions and with a deployment repetition time higher than 10s. Both the High and the Low side FET drivers are equipped with passive gate turn-off circuitries to guarantee the FETs are kept in off state also when the device is unpowered or during power-up/down transients.

### 8.1 Control logic

A block diagram representing the deployment driver logic is shown below. Deployment driver logic features include:

- Deploy command logic
- Deployment current selection
- Deployment current monitoring and deploy success feedback
- Diagnostic control and feedback

Figure 27. Deployment driver control blocks

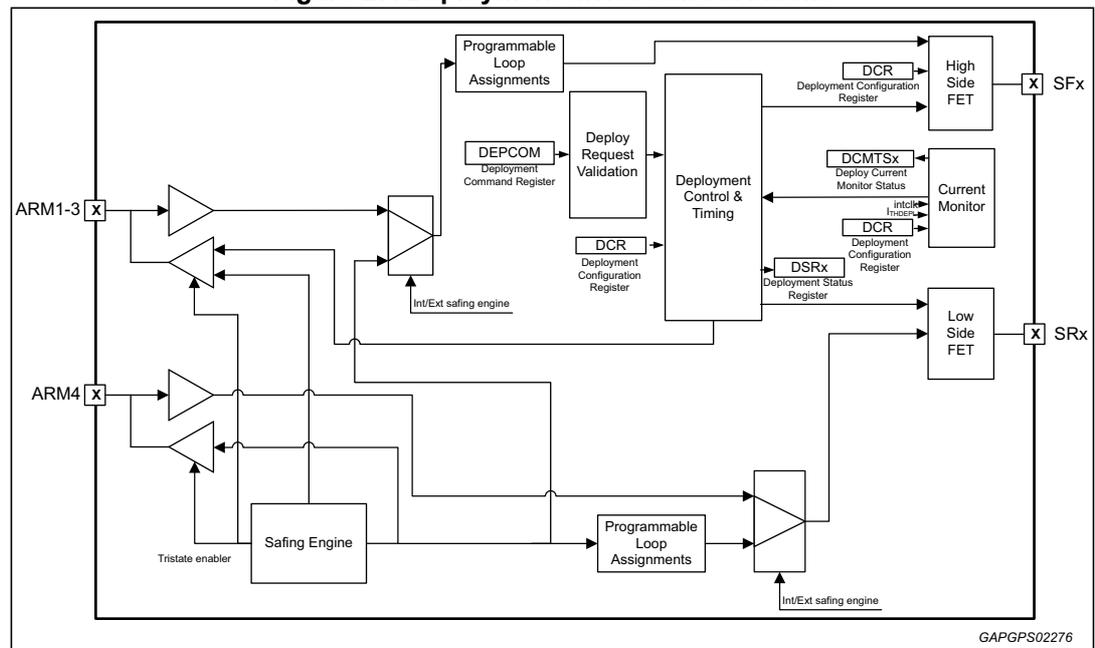


Figure 28. Deployment driver control logic - Enable signal

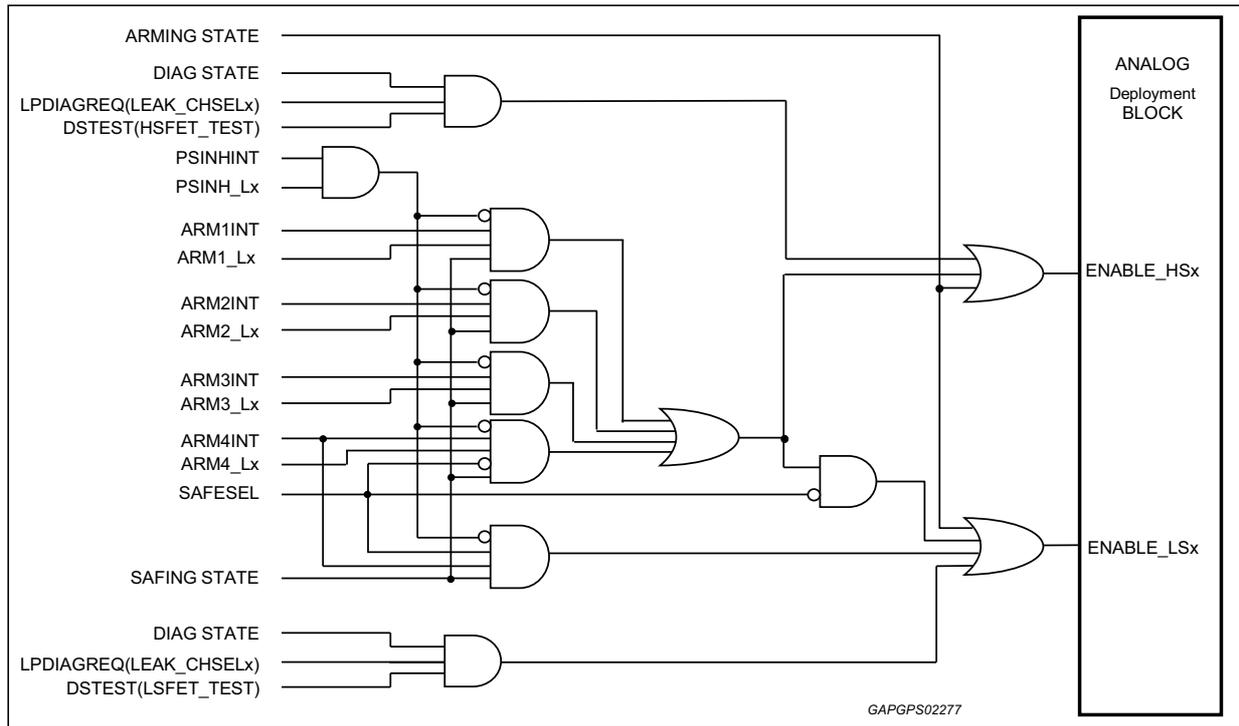
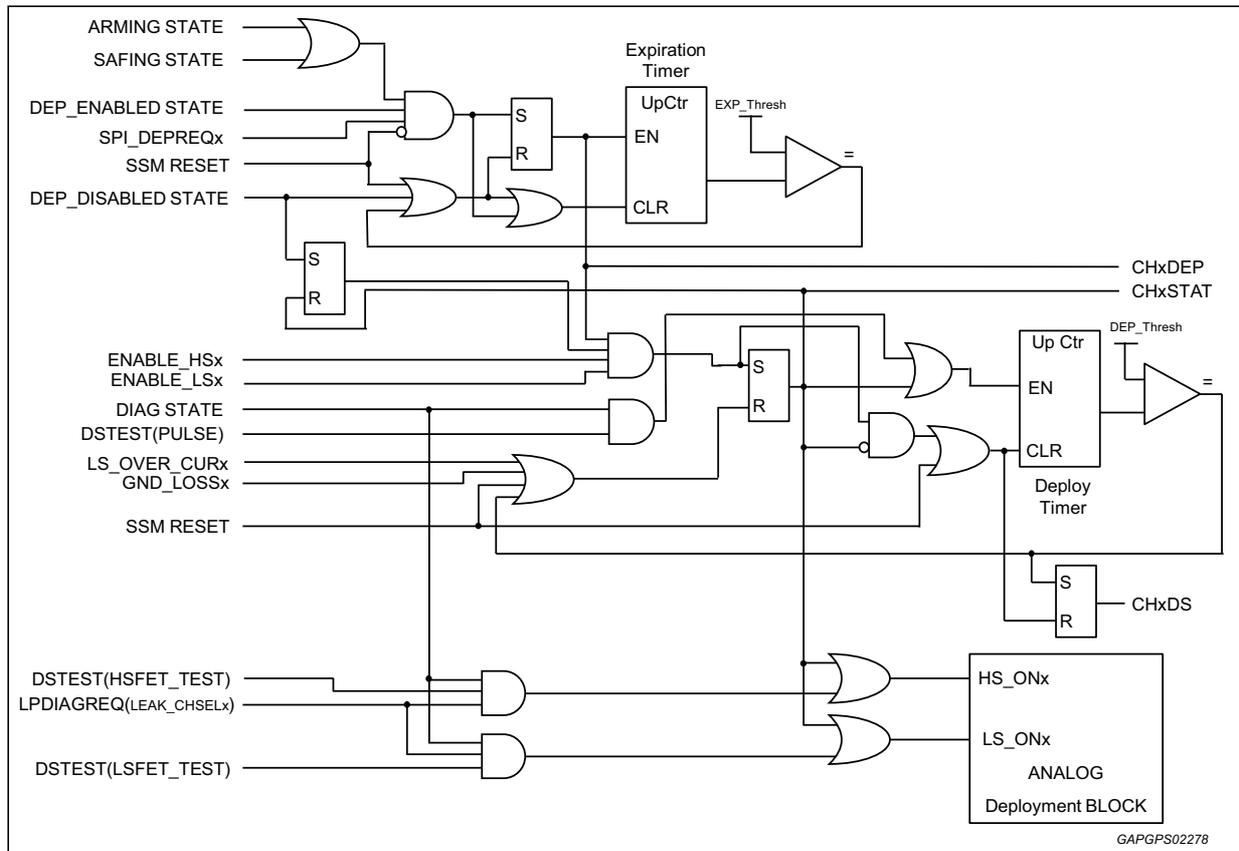


Figure 29. Deployment driver control logic - Turn-on signals



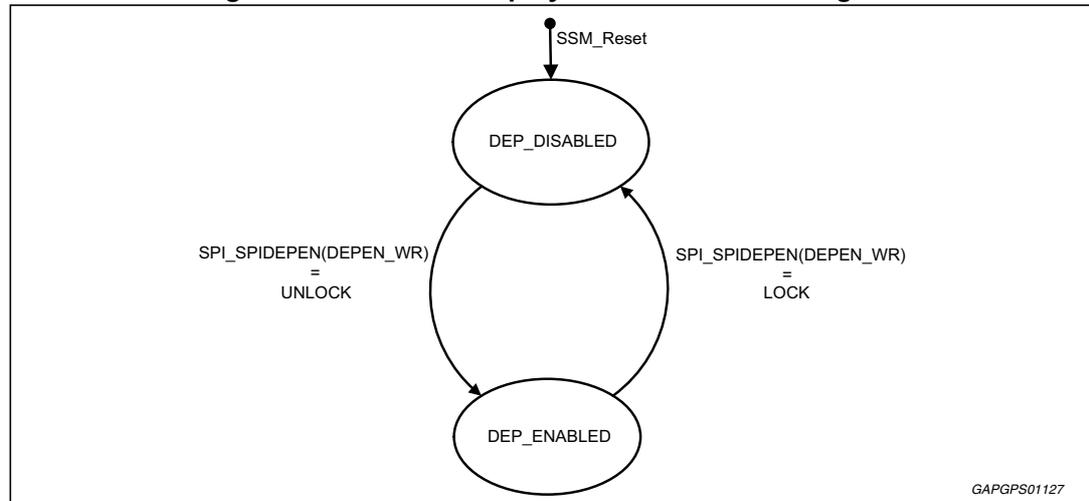


### 8.1.3 Deployment control flow

Deployment control logic requires the following conditions to be true to successfully operate a deployment:

- POR = 0
- SSM to be either in Safing State or Arming State
- a valid arming condition processed by safing logic or ARMx signals to be set (depending on selection of internal or external safing engine)
- channel-specific deploy command request bits to be set via SPI in the Deploy command Register (DEPCOM)
- a global deployment state has to be active, as described in the following figure.

**Figure 31. Global SPI deployment enable state diagram**



In case a multiple deployment request would be needed, i.e. deploying the same channel in sequence, a toggle on DEP\_DISABLED has to be performed and a new DEPCOM command on the same channel has to be sent.

The SPI DEPCOM command is ignored if the device is in the DEP\_DISABLED state and the deploy command is not set. While in DEP\_ENABLED state, the following functionalities that could be active are forced to their reset state:

- All squib and DC sensor diagnostic current or voltage sources
- All squib, DC sensor and ADC diagnostic MUX settings, state machine, etc.

The SPI\_LOCK and SPI\_UNLOCK signals are available in the SPIDEPEN command:

High-side and Low-side enablers (ARMx) are assigned to the desired channels by means of the programmable loop matrix. Deploy commands in the Deploy Command Register (DEPCOM) are channel specific.

Deployment requires a valid arming condition from safing logic or ARMx signals to be set any time before, during or after the specific sequence of deploy commands is received. It is feasible for a deploy command to be received without a valid arming condition from safing logic or the ARMx being set. In this case, the deploy command will be terminated according to the *Deploy command expiration timer*. Likewise, a valid arming condition signal can be set without receiving a Deploy Command. In this case, the enabling signals will remain

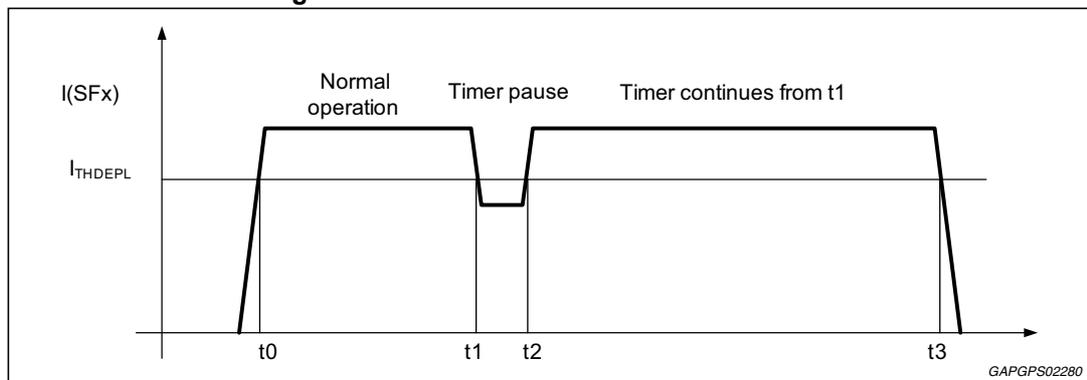
active according to the Arming Enable Pulse Stretch Timer or the ARMx enabling state. The Arming Enable Pulse Stretch Timers is available in the AEPSTS register.

### 8.1.4 Deployment current monitoring

A current comparator is used to indicate when the output current from the HSD, SFx, exceeds the deployment current threshold,  $I_{THDEPL}$ . The timer signal remains active and increments while the current meets the programmed deploy current as set in the Deploy Configuration Register. The deploy current counter value is stored in the Deploy Current Monitor Timer Register XY (DCMTSxy). There is a unique timer register for each channel.

If the deploy current falls below the specified current threshold momentarily and recovers, the deploy current counter will pause during the drop-out and continue once the current exceeds the threshold. The deploy current counter will not be reset by the presence or absence of current in the deployment channel.

**Figure 32. Current monitor counter behavior**



The deploy current counter is reset to \$0000 as soon as a toggle on DEP\_DISABLED is performed and a new DEPCOM command on the same channel is received.

### 8.1.5 Deployment success

Deploy success flag is set when the deploy timer elapses. This bit (CHxDS) is contained in the Deploy Status Register. Within the Global Status Word register (GSW), a single bit (DEPOK) is also set once any of the 12 deployment channels sets a deploy success flag.

## 8.2 Energy reserve - deployment voltage

One deployment voltage source pin is used for adjacent channels (e.g. SS23 for channels 2 and 3). These pins are directly connected to the high side drivers for each channel.

## 8.3 Deployment ground return

L9679P is hosted in a particular frame allowing squib driver ground feedback to be connected to an internal ground ring. This ring is electrically connected to the package exposed pad and to the GNDSUB1 and GNDSUB2 pins. Connection to these two pins is made by means of a strong metal layer, therefore this connection is sufficient for all deployments occurring simultaneously, even in case of only one out of the three possible connections being available.

## 8.4 Deployment driver protections

### 8.4.1 Delayed low-side deactivation

To control voltage spikes at the squib pins during drivers deactivation at the end of a deployment, the low side driver is switched off after  $t_{\text{depl\_ls-dly}}$  delay time with respect to the high side deactivation.

### 8.4.2 Low-side voltage clamp

The Low side driver is protected against overvoltage at the SRx pins by means of a clamping structure as shown in [Figure 30](#). When the Low side driver is turned off, voltage transients at the SRx pin may be caused by squib inductance. In this case a low side FET drain to gate clamp will reactivate the low side FET allowing for residual inductance current recirculation, thus preventing potential low side FET damage by overvoltage.

### 8.4.3 Short to battery

The Low side driver is equipped with current limitation and overcurrent protection circuitry. In case of short to battery at the squib pins, the short circuit current is limited by the Low side driver to  $I_{\text{LIMSRx}}$ . If this condition lasts for longer than  $t_{\text{LIM}}$  deglitch filter time then the low and high-side drivers will be switched off and latched in this state until a new deployment is commanded after SPI\_DEPEN is re-triggered.

### 8.4.4 Short to ground

The squib driver is designed to stand a short to ground at the squib pins during deployment. In particular, the current flowing through the short circuit is limited by the high side driver (deployment current) and the high-side FET is sized to handle the related energy.

In case the short to ground during deployment occurs after an open circuit, a protection against damage is also available. The high side current regulator would have normally reacted to the open circuit by increasing the Vgs of the high side FET. Thanks to a dedicated fast comparator detecting the open condition, the driver is able to discharge the FET gate quickly in order to reduce current overshoot and prevent potential driver damage when the short to ground occurs.

### 8.4.5 Intermittent open squib

A dedicated protection is also available in case of intermittent open load during deployment. In this case, if load is restored after an open circuit, due to slow reaction of the high-side current regulation loop, the current through the squib is limited only to  $I_{\text{LIMSRx}}$  by the low side driver. If this condition lasts for longer than  $t_{\text{LIMOS}}$  then the high side is turned off for  $t_{\text{HSOFFOS}}$  and then reactivated. By this feature, intermittent open squib and short to battery faults may be distinguished and handled properly by the drivers.

## 8.5 Diagnostics

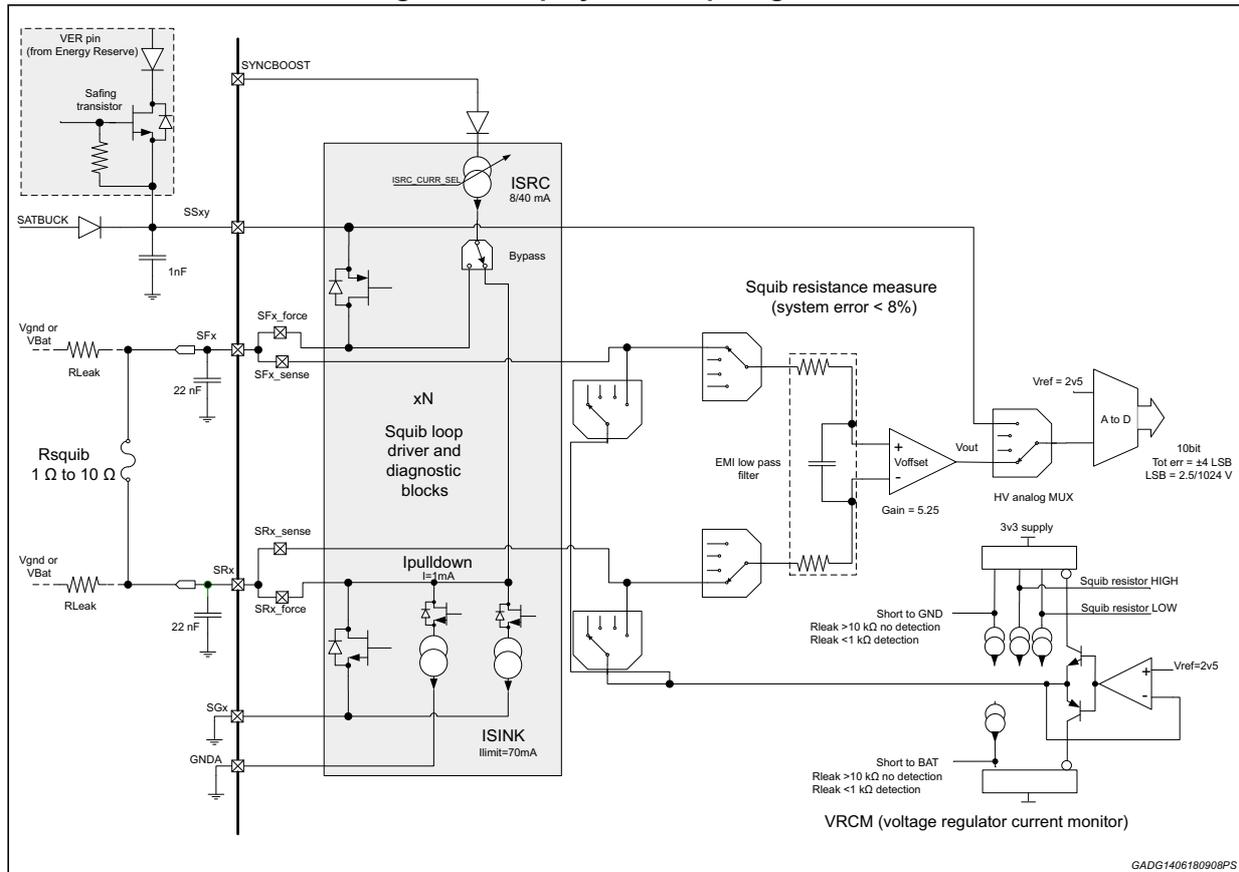
The L9679P provides the following diagnostic feedback for all deployment channels:

- High voltage leakage test for oxide isolation check on SFx and SRx
- Leakage to battery and ground on both SFx and SRx pins with or without a squib
- Short between loops diagnostics
- Squib resistance measurement with leakage cancellation and selectable range (10/50  $\Omega$ )
- High squib resistance with range from 500  $\Omega$  to 2000  $\Omega$
- SSxy, SFx and VER voltage status
- High and Low side FET diagnostics
- High side driver diagnostics
- Loss of ground return diagnostics
- High Side Safing FET diagnostics

The above diagnostic results are processed through a 10 bit Analog to digital algorithmic converter. These tests can be addressed in two different ways, with a high level approach or a low-level one. The main difference between the two approaches is that with the low level approach the user is allowed to precisely control the diagnostic circuitry, also deciding the proper timings involved in the different tests. On the other hand, the high level approach is an automatic way of getting diagnostic results for which an internal state machine is taking care of instructions and timings.

The following is block diagram of the Squib Diagnostics.

Figure 33. Deployment loop diagnostics



The leakage diagnostic includes short to battery, short to ground and shorts between loops. The test is applied to each SFx and SRx pin so shorts can be detected regardless of the resistance between the squib pins.

### 8.5.1 Low level diagnostic approach

In this approach, each of the test steps described in the sections below requires user intervention by issuing the proper SPI command.

#### High voltage leakage test for oxide isolation check

This test is mandatory to address possible leakages that could not be experienced at low voltages on SFx or SRx pins. The  $I_{source}$  current generator (ISRC) is enabled on the chosen SFx pin. To confirm that the SFx pin has then reached a suitable voltage level, a dedicated ADC measurement on the SFx pin can be requested. Once this test is performed, a leakage test on SFx and SRx pins can be issued to double check possible leakages.

#### Leakage to battery/ground diagnostics

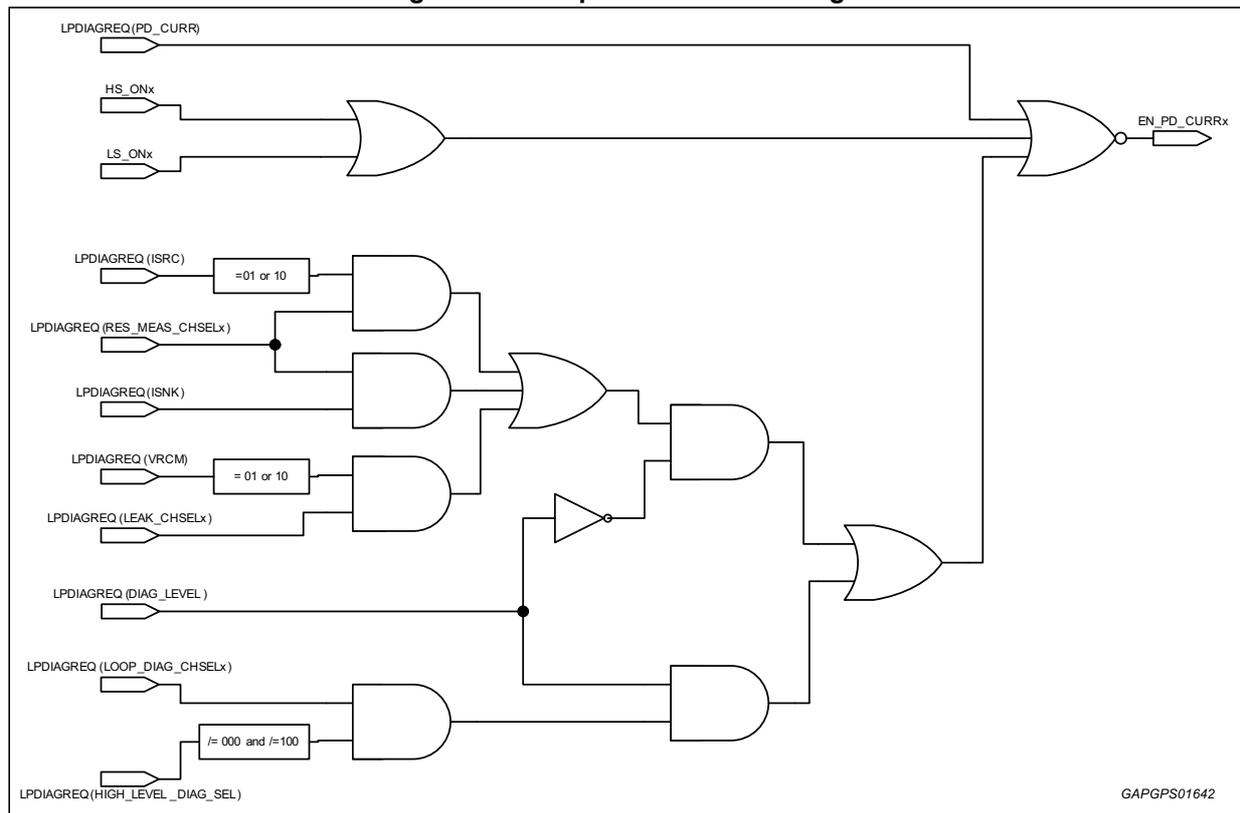
Prior to the real test, the Voltage Regulator Current Monitor block (VRCM) has to be tested and validated. The validation of VRCM goes into verifying both the short to battery and short to ground flags.

The  $I_{source}$  current generator (ISRC) is first connected to SFx pin to raise its voltage to SYNCBOOST. Then, the Voltage Regulator Current Monitor block (VRCM) is enabled and

connected to the selected SFx pin. The  $I_{\text{sink}}$  current limited switch (ISNK) is turned off, as well as the pull-down current generator. If the VRCM block works properly, the short to battery flag would be asserted.

Then, the  $I_{\text{sink}}$  current limited switch (ISNK) is connected to SRx pin, the Voltage Regulator Current Monitor block (VRCM) is enabled and connected to the selected SRx pin. The  $I_{\text{source}}$  current generator (ISRC) is turned off, as well as the pull-down current generator. If the VRCM block works properly, the short to ground flag would be asserted.

Figure 34. SRx pull-down enable logic



Once the VRCM block is validated, the real leakage tests can be performed. ISRC and ISNK currents have to be kept switched off. The VRCM shall be connected to the desired pin (either SFx or SRx pins); by doing this, also the pull-down current on the selected SRx pin is automatically deactivated). During the test, if no leakage is present the voltage on the selected SFx or SRx pin will be forced by the VRCM to the VREF level and no current is detected or sourced by the VRCM. If there is leakage to ground or battery, the VRCM will sink or source current trying to maintain VREF. Two current comparators, ISTB and ISTG, will detect the abnormal current flow and the relative flags will be given in the LPDIAGSTAT. These flags are not latched and report the real time status of the relevant comparators in case of low-level leakage diagnostic test. Voltage conversion is not required to have these flags updated. In LPDIAGSTAT register are also reported the channel and the pin (SFx or SRx) under test, respectively with LEAK\_CHSEL and SQP bit fields.

The pull-down currents on the other SRx pins are still active. Therefore, the leakage test that would show a leakage to ground may be depending on a real leakage on the pin under test or on a short between loops.

### Short between loops diagnostics

In case the previous test has reported a leakage to ground fault, the short between loops diagnostics shall be run. The same procedure is followed as described for normal leakage tests except the fact that in this case all the pull-down current generators have to be deactivated (not only the one for the pin under test), by means of the PD\_CURR bit in the Diagnostic Request Register (LPDIAGREQ). If a leakage or ground fault is not present, then the channel under test has a short to another squib loop.

**Table 10. Short between loops diagnostics decoding**

| Fault condition on squib channel | Channel leakage diagnostics with PD_CURR on (for other channels than the one under test) | Channel leakage diagnostics with PD_CURR off (for all channels) |
|----------------------------------|--|---|
| No shorts                        | No fault   | No fault  |
| Short to battery                 | STB fault  | STB fault   |
| Short to ground                  | STG fault  | STG fault   |
| Short between loops              | STG fault  | No fault  |

The condition of two open channels, i.e. without squib resistance connecting SFx to SRx, that have a short between loops on SFx cannot be detected. If only one of the two shorted SFx pins is open, the fault will be indicated on the open channel.

### Squib resistance measurement

During a resistance measurement, a two-step process is performed. At the first step, both ISRC current generator and ISNK current limited switch are enabled and connected to the selected SFx and SRx channel, through ISRC, ISRC\_CURR\_SEL, ISNK and RES\_MEAS\_CHSEL bit fields in the Loop Diagnostic Request Register (LPDIAGREQ). The ISRC current can be configured to either 40 mA or 8 mA nominal value through the ISRC\_CURR\_SEL bit in the LPDIAGREQ register providing the user with two different measurement range options. A differential voltage is created between the SFx and SRx pin based on the ISRC current and squib resistance between the pins. The SPI interface will provide the first resistance measurement voltage (Vdiff1) based on the amplifying factor of the differential amplifier and a 10 bit internal ADC conversion. The second measurement step (bypass measurement) is performed redirecting ISRC to the selected SRx pin, while keeping ISNK on; this way, the differential amplifier and following ADC will output the offset measurement through SPI (Vdiff2). Microcontroller is then allowed to calculate the mathematical difference between first and second measurements to obtain the real squib resistance value.

$$V_{diff1} = G_{RSQ} \times \left[ I_{SRC\_*} \times \left( \frac{R_{LKG\_SF} \times R_{SQ}}{R_{LKG\_SF} + R_{SQ}} \right) + \frac{R_{SQ}}{R_{LKG\_SF} + R_{SQ}} (V_{LKG\_SF} - V_{SRx\_RM}) \right] +$$

$$+ G_{RSQ} \times V_{off\_RSQ}$$

$$V_{diff2} = \frac{G_{RSQ} \times R_{SQ}}{R_{LKG\_SF} + R_{SQ}} \times (V_{LKG\_SF} - V_{SRx\_RM}) + G_{RSQ} \times V_{off\_RSQ}$$

$$R_{SQ} = \frac{V_{diff1} - V_{diff2}}{G_{RSQ} \times I_{SRC\_*}} \text{ (assuming } R_{LKG\_SF} \gg R_{SQ} \text{)}$$

The simplification in the calculation method reported above can result in some amount of error that is already incorporated in the overall tolerance of the squib resistance measurement reported in the electrical parameters table.

Values of each measurement step can be required addressing the proper ADCREQx code in [Section 7.3.32: ADC request and data registers \(DIAGCTRL\\_x\)](#).

This calculation is tolerant to leakages and, thanks to a dedicated EMI low-pass filter, also to high frequency noises on squib lines. Moreover, L9679P features a slew rate control on the ISRC current generator to mitigate emissions.

### High squib resistance diagnostics

With this test, the device is able to understand if the squib resistance value is below 200  $\Omega$ , between 500  $\Omega$  and 2000  $\Omega$  or beyond 5000  $\Omega$ . During a high squib resistance diagnostics, VRCM and ISNK are enabled and connected respectively to SFx and SRx on the selected channel. VREF voltage level will be output on SFx. Current flowing on SFx will be measured and compared to  $I_{SRlow}$  and  $I_{SRhigh}$  thresholds to identify if the resistance is above or below RSRlow or RSRhigh levels. The results are reported in the LPDIAGSTAT register. The relative flags (HSR\_HI and HSR\_LO) are not latched and reflect the current status of the comparators.

### High and low side FET diagnostics

This couple of tests can only be run during the diagnostic mode of the power-up sequence [Figure 10](#). Tests are performed individually for HS driver or LS driver, with two dedicated commands. Prior to either the HS or LS FET diagnostics being run, the VRCM has to be first enabled. Within the command to enable the VRCM, also the channel onto which the FET test will be run has to be selected with the LEAK\_CHSEL bit field. Running the leakage diagnostics with the appropriate delay time prior to either the HS or LS FET diagnostics will precondition the squib pin to the appropriate voltage level. When the FET diagnostic command is issued with the Diagnostic Register SPI command (SYSDIAGREQ), the VRCM flags will be cleared, the VRCM deglitch filter time is switched from the leakage diagnostic deglitch filter time (TFLT\_LKG) to the FET test deglitch filter time (TFLT\_LKGB\_FT) for both HS and LS and the output of the VRCM deglitch filter is now allowed to disable the appropriate HS or LS squib driver during FET test.

The device monitors the current through the VRCM. If the FET is working properly, this current will exceed  $I_{HS\_FET\_TH}$  or  $I_{LS\_FET\_TH}$  current threshold, respectively for HS or LS FET test for the deglitch filter time of TFLT\_LKGB\_FT, and the driver under test is turned off immediately and automatically.

If there is a substantial leakage fault to Vbat or GND present during the FET test, leading this leakage current to exceed the  $I_{HS\_FET\_TH}$  or  $I_{LS\_FET\_TH}$  current threshold, for the deglitch filter time of TFLT\_LKGB\_FT, then the driver under test is turned off immediately and automatically, and the corresponding VRCM flag, STG or STB, is set.

If the current does not exceed the current threshold, the test will be terminated and the driver is anyway turned off within  $T_{FETTIMEOUT}$ .

**Table 11. HS FET TEST**

| VRCM Flags |     | Result                                    |
|------------|-----|---|
| STG        | STB |   |
| 0          | 0   | FET test fail                             |
| 0          | 1   | FET test pass<br>OR<br>Leakage to Vbat    |
| 1          | 0   | FET test disabled<br>due to Leakage to Gd |
| 1          | 1   | State not possible                        |

**Table 12. LS FET TEST**

| VRCM Flags |     | Result                                      |
|------------|-----|---|
| STG        | STB |   |
| 0          | 0   | FET test fail                               |
| 0          | 1   | FET test disabled<br>due to Leakage to Vbat |
| 1          | 0   | FET test pass<br>OR<br>Leakage to GND       |
| 1          | 1   | State not possible                          |

During  $T_{FETTIMEOUT}$  period, the bit stating that the FET is enabled will be set (FETON=1) and will be cleared as soon as the FET is switched back off.

For all conditions the current on SFx/SRx pins will not exceed the VRCM current limitation value ( $I_{LIM\_VRCM\_SINK}$  or  $I_{LIM\_VRCM\_SRC}$ ). There may be higher currents on the squib lines due to the presence of filter capacitors. During these FET tests, energy available to the squib is limited to less than  $E_{FET\_TEST}$ . For high side FET diagnostics, if no faults were indicated in the preceding leakage diagnostics then a normal result would be [STB=1, STG=0]. If the returned result for the high side FET test is not as the previous then either the FET is not functional, a short to ground occurred during the test, or there is a missing SSxy connection for that channel.

For low side FET diagnostics if no faults were indicated in the preceding leakage diagnostics then a normal result would be [STB=0, STG=1]. If the returned result for the low side FET test is not as the previous then either the FET is not functional or a short to battery occurred during the test. In case of ground loss the low-side FET diagnostic would not indicate a FET fault.

The VRCM flags will be given in the LPDIAGSTAT register. The status of the VRCM flags after FET test is latched and can be cleared upon either LPDIAGREQ or SYSDIAGREQ SPI commands.

Finally, after FET test is completed, the VRCM deglitch filter time is switched from the FET test deglitch filter time (TFLT\_LKGB\_FT) to the leakage diagnostic test deglitch filter time

(TFLT\_LKG) for both HS and LS and the output of the VRCM deglitch filter is now not allowed to disable the appropriate HS or LS squib driver anymore.

### High side driver diagnostics

This test is intended to verify the proper functionality of the HS FET driver, but also the external squib connection and other internal circuitries.

First, the ISNK current has to be activated via the LPDIAGREQ register; the channel onto which the ISNK current is activated has to be selected with the RES\_MEAS\_CHSEL bit field. Then, the HS FET related to the loop channel as indicated in the RES\_MEAS\_CHSEL bit field is activated with the dedicated DSTEST code for the HS squib driver test in the Diagnostic Register SPI command (SYSDIAGREQ). In such condition, the HS driver will control the FET current to a level  $I_{LIM\_HS\_FET}$  much lower than the usual deployment current. The HS\_DRV\_OK flag will be set accordingly to the test result in the LPDIAGSTAT register, as soon as the deployment current monitoring comparator will detect that the current through the HS FET exceeds the diagnostic current threshold,  $90\% * I_{LIM\_HS\_FET}$ .

### Loss of ground return diagnostics

This diagnostics is available during a squib measurement or a high side driver diagnostics. This test is based on the voltage drop across the ground return, if the voltage drop exceeds  $SG_{xy\_OPEN}$ , ground connection is considered as lost. Should the ground connection on the squib driver circuit be missing, the bit related to the channel under test by the two above diagnostics will be activated in the LP\_GNDLOSS register. The flag is latched after a proper filter time  $T_{FLT\_SGOPEN}$  and cleared upon read.

### High side safing FET diagnostics

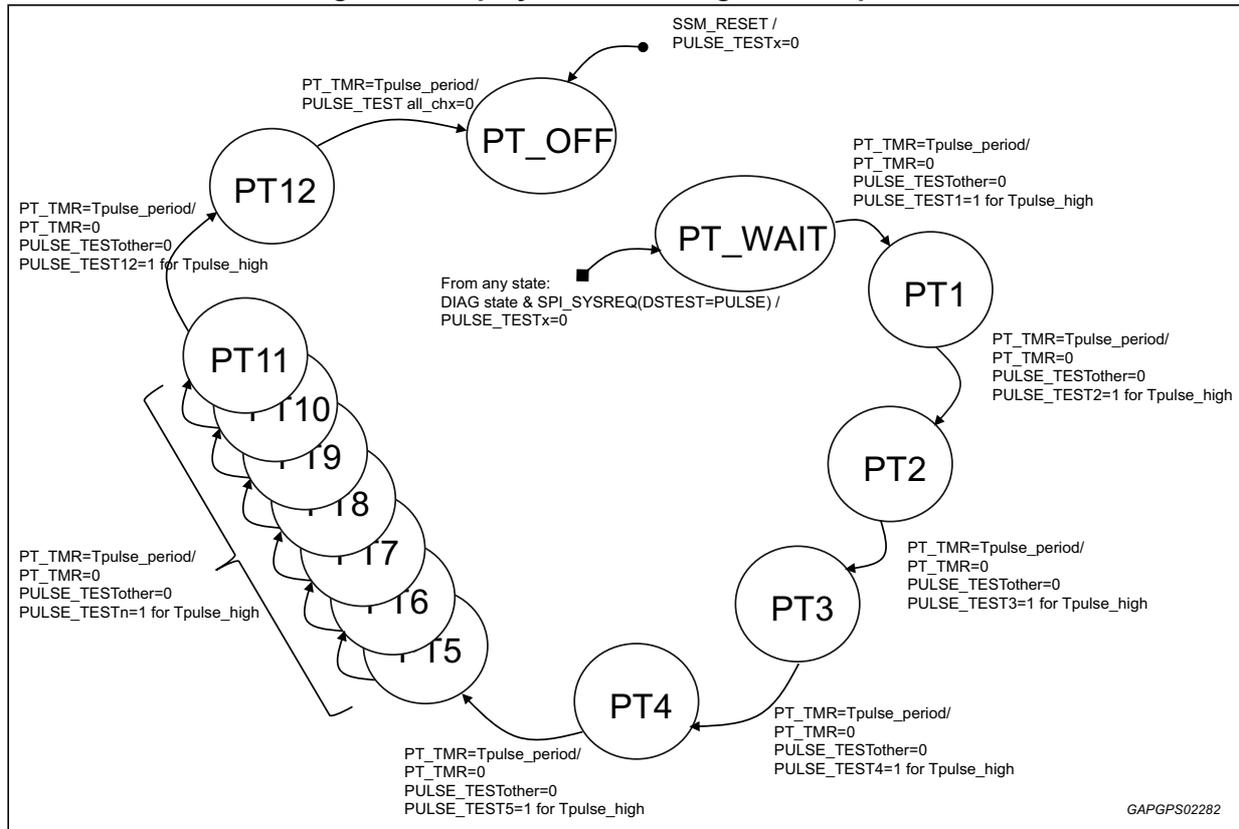
This test has to be issued during the Diag state of the power-up sequence ([Figure 10](#)). Safing FET has to be switched on with the proper code in DSTEST bit field of the SYSDIAGREQ. Therefore, when the command is received, the device will activate VSF regulator to supply the external safing FET controller. The user can measure the voltage levels of both the VSF regulator and the SSxy nodes. If the safing FET is properly switched on, the voltage on SSxy will be regulated.

The measurement request is done via Diagnostic Control command (DIAGCTRLx), while results will be reported through ADCRESx bit fields.

### Deployment Timer diagnostic

This test allows verifying the correct functionality and duration of the timers used to control the deployment times. This test can be executed only when the IC is in the Diag state by setting the appropriate code in the DSTEST field of the SYSDIAGREQ register. When the test is launched, the IC sequentially triggers the activation of the deployment timers of the various channels (each of them separated by 8ms idle time) and outputs the relevant waveform to the ARM1 output discrete pin. See the sequence detail in [Figure 35](#). The  $\mu C$  can therefore test the deployment times by measuring the duration of the high pulses sent by the IC on the ARM1 pin. The deployment time configuration used during this test is the latest one programmed in the DCRx registers. In case the test is run on a channel with no DCRx deployment time previously configured, a default 8  $\mu s$  high pulse is output on ARM for the relevant channel.

Figure 35. Deployment timer diagnostic sequence



### Squib diagnostic with common SRx connected loops

In case of two SRx pins are intentionally connected together, the PD\_CURR\_CSR bit of the Deployment Configuration register (DCR\_x, where x = 0, 2, 4, 6, 8, A) must be used to indicate which loop pairs have the common SRx connection. The purpose of this additional bit is to control the pull-down current on each channel to be consistent with or without the Common SRx connected loops. When the DCR\_x(PD\_CURR\_CSR) bit is set for one loop pair and the Deployment diagnostic is run on that loop pair, the pull-down current is disabled on both channels of the loop pair selected.

For the squib channel pair with common SRx connection, to understand if the two SFx pins are shorted together, the squib resistance measurement must be required with the following setting: LPDIAGREQ[12:11]=11. In this way the ISRC current generator is enabled on the channel selected by RES\_MEAS\_CHSEL[3:0] bits while the Differential Operational Amplifier is connected on the other channel of the squib channel pair. If the short between the two SFx pin is not present then the Squib resistance measurement results will be close to 0, otherwise it will be half the real squib resistance.

### Loop diagnostics control and results registers

Diagnostic tests and channels for each test are controlled through the Loop Diagnostic Request Register (LPDIAGREQ), diagnostic results are stored in the Loop Diagnostic Status Register (LPDIAGSTAT).

### 8.5.2 High level diagnostic approach

In this approach, the test steps described in the sections below are coded into a dedicated state machine that helps reducing the user intervention to a minimum.

The high-level diagnostic commands are contained in the LPDIAGREQ, LOOP\_DIAG\_SEL, and LOOP\_DIAG\_CHSEL registers. The high-level diagnostic response is available in the LPDIAGSTAT register.

The concept is depicted in the following figures.

**Figure 36. High level loop diagnostic flow1**

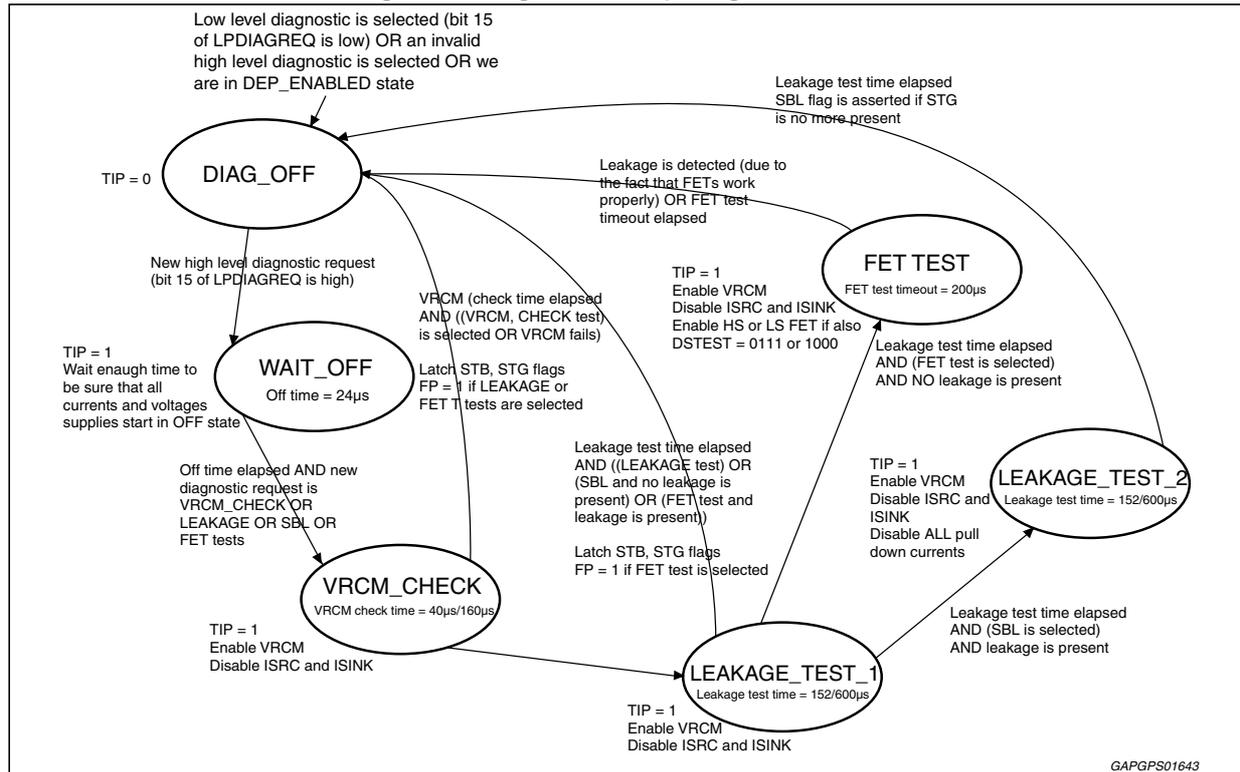
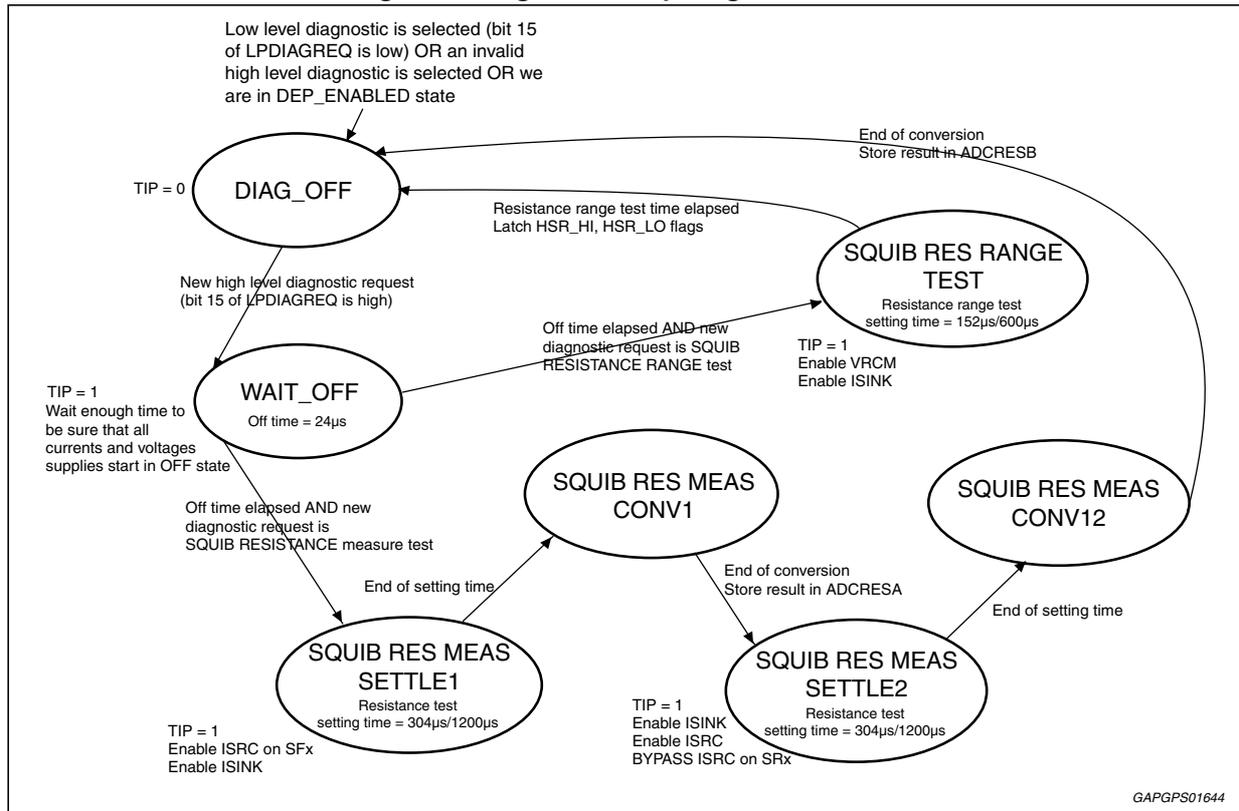


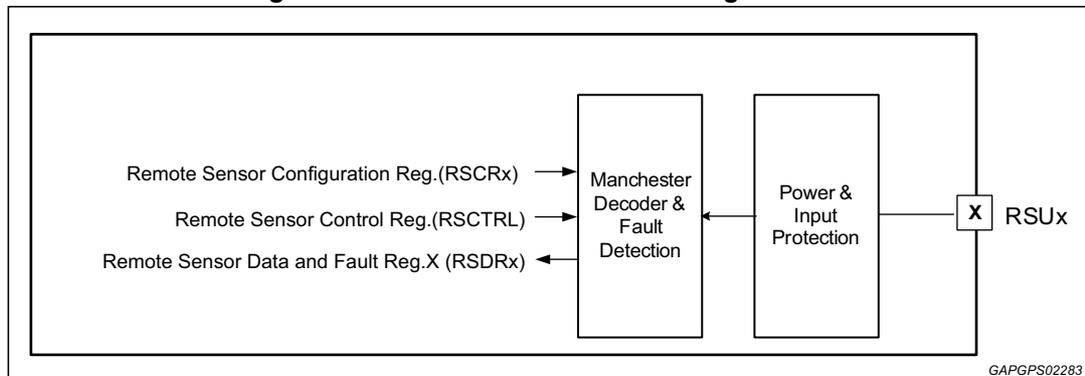
Figure 37. High level loop diagnostic flow2



## 9 Remote sensor interface

The L9679P contains 2 remote sensor interfaces, capable of supporting PSI-5 protocol (synchronous mode, increased voltage, extended range). A simplified block diagram of the interface is shown below. The interface supply is given on the SATBUCK pin (refer to [Figure 3: Power supply block diagram](#)). The circuitry consists of a power interface that mirrors current flowing in the external sensor and transmits this current information to the decoder, which produces a digital value for each remote sensor channel. The voltage at the RSUx pins can be limited by the power interface in case of SATBUCK supply overvoltage to protect the external sensors. Decoded data are then output through the Remote Sensor Data Registers (RSDRx). Received signals can be processed to the corresponding discrete logic output pin WS0-WS1. The power interface also contains error detection circuitry. When a fault is detected, the error code is stored in a global SPI data buffer in the Remote Sensor Data Registers (RSDRx).

**Figure 38. Remote sensor interface logic blocks**



Remote sensor configuration can be addressed via the Remote Sensor Configuration Registers (RSCRx). In particular, TSxDIS bit allows overriding the time slot control for PSI5 I/F and BLKTxSEL allows selection between 5 ms and 10ms for the blanking time applied to the current limitation fault detection each time a channel is activated.

The Remote Sensor Control Register (RSCTRL) allows for interface channels to be switched on and off and for Sync Pulse control via SPI.

The remote sensor interface reports both data information and fault information in the Remote Sensor Data Register (RSDRx). The device accommodates for a total of 6 data registers. Independent data registers are defined for each remote sensor interface.

If the device detects an error on the sensor interface, the MSB in RSDRx (FLTBIT) will be set to '1' and the following bits will be used to report the detected errors. Otherwise, the register will contain only data information. Detailed information on data and fault reporting are explained in the following sections.

When a fault condition is detected, the RSFLT bit of the global status word (GSW) is set to 1. Faults other than Short to Ground and Over-temperature will only clear after read, not by the disabling of channel.

Data are cleared upon reading the RSDRx register.

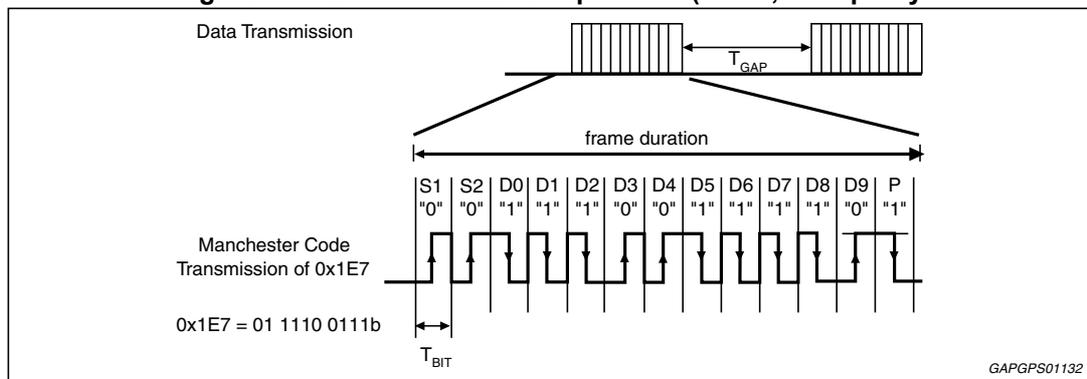
## 9.1 PSI5 mode

All channels are compliant to the PSI-5 v1.3 specification as described below:

- Two-wire current interface
- Manchester coded digital data transmission
- High data transmission speeds of 125 kbps and 189 kbps
- Variable data word length (8 & 10 bit only)
- 1-bit parity
- Synchronous operating mode with 3 time slots

An example of the data format for one possible PSI-5 protocol configuration is shown below. Data size and the error checking may vary, but the presence of 2 sync start bits (referenced below as sync bits) and 2  $T_{GAP}$  time is consistent regardless.

**Figure 39. PSI-5 remote sensor protocol (10-bit, 1-bit parity)**



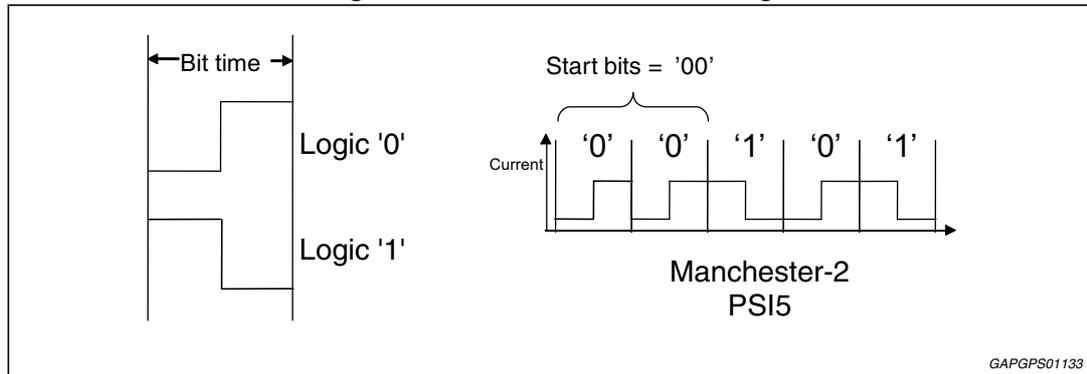
### 9.1.1 Functional description

The Remote Sensor Interface block provides a hardware connection between the microcontroller and up to twelve remote sensors (maximum three per channel). Each channel is independent on the others, and is not influenced by possible fault conditions occurring on other channels, such as short circuits to ground or to vehicle battery. Each channel is supplied by a current limited DC voltage derived from SATBUCK, and monitors the current sunk from its supply in order to extract encoded data. The remote sensor modulates the current draw to transmit Manchester-encoded data back to the receiver. The current level detection threshold for all channels is internally computed by the IC in order to adapt the signal level to the sensors quiescent current.

All channels can be enabled or disabled independently via SPI commands. The operational status of all channels can also be read via SPI command. All channels support individual selective sync-pulse control to allow communication back to the remote sensor via sync-pulse voltage modulation as described in the PSI5 v1.3 specification.

The message bits are encoded using a Manchester format, in which logic values are determined by a current transition in the middle of the bit time. When configured for PIS5 sensors each interface supports Manchester 2 encoding as shown in [Figure 40](#).

Figure 40. Manchester bit encoding

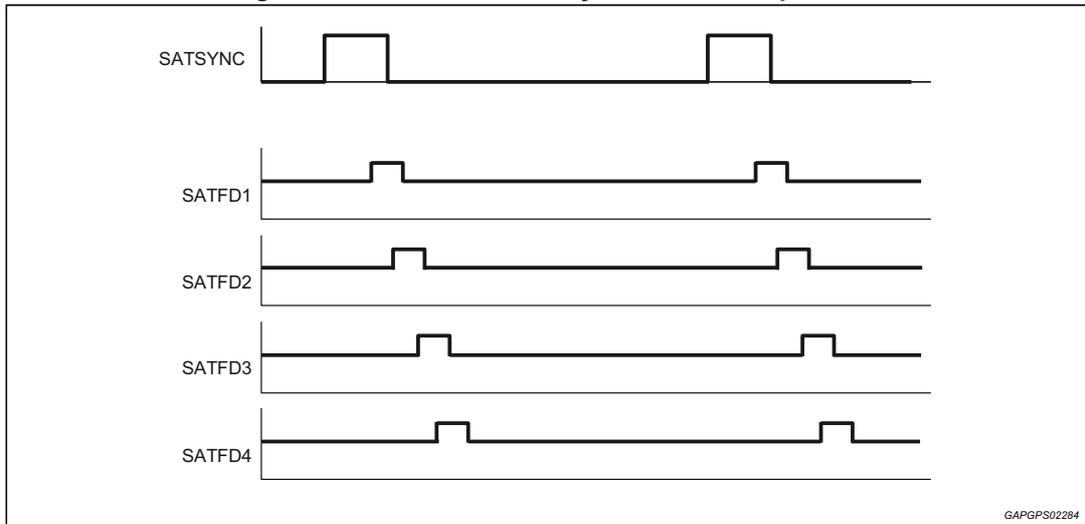


The sensor input filter time, deglitch filter, (delay until a threshold crossing is detected) can be configured in 15 steps. Filters can be selected individually for each channel, through the Remote Sensor Configuration Register, WSFILT bits

The received message data are stored in input data registers that are read out by the microcontroller via the SPI interface. For PSI5, three data registers per channel are used to store remote sensor messages received during timeslots 1, 2, and 3 respectively. Each register is updated after a certain delay ( $T_{WRITE\_EN\_DELAY}$ ) from the end of relative sensor message. All the bits inside the register itself are simultaneously updated upon reception of the remote sensor message to prevent partial frame data from being sampled via the SPI interface. After the data for a given channel is read via the SPI interface, subsequent requests for data from this channel will result in an error response.

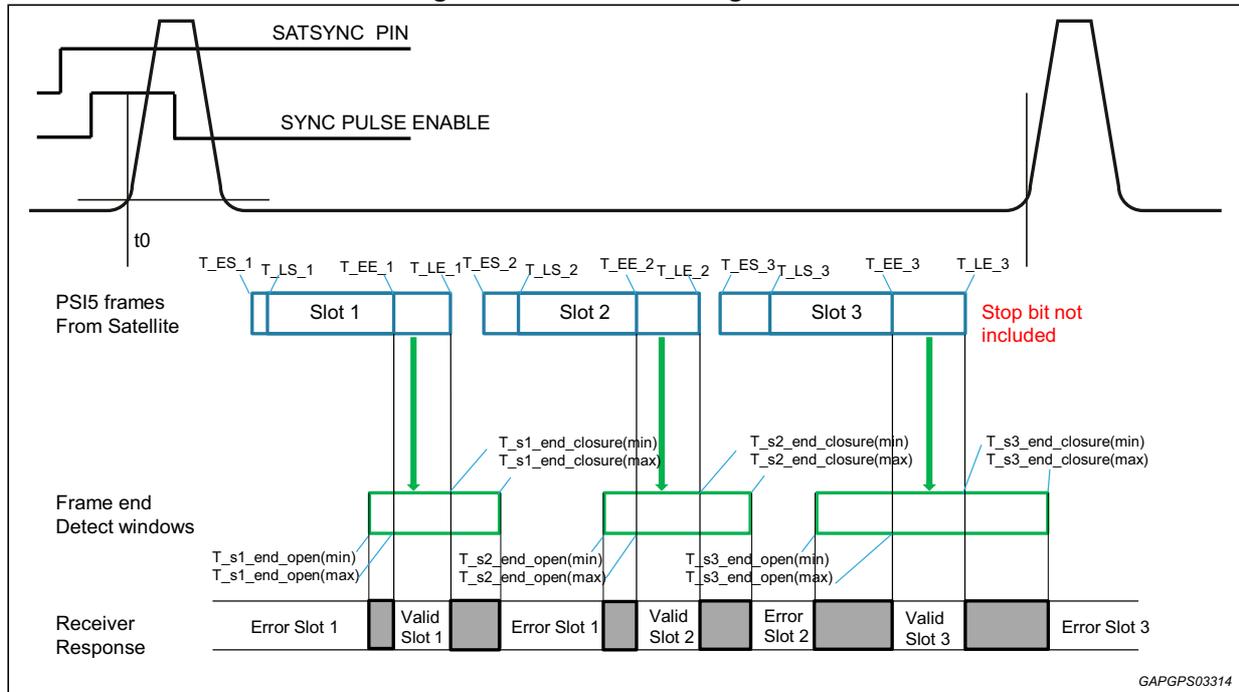
To allow for sampling synchronization of remote sensor data with the software in the microcontroller, the Remote sensor Interface block includes sync-pulse circuitry to signal initiation of sampling in the remote sensor. The sync-pulse is output to the remote sensors in the form of an increased voltage level on the RSUx pins when sampling is to be conducted. The higher voltage level required for the sync-pulse is sourced from the SYNCBOOST boost regulator. Pulse shaping is used to limit the slew rate of the pulses to reduce EMI. Feedback protection is provided to prevent fault conditions on one channel from affecting the others during sync-pulse generation. The microcontroller schedules the activation of the sync pulses to the four channels by providing a periodic signal to the SATSYNC pin. When a rising edge is detected on SATSYNC pin, the Remote sensor Interface block outputs sync pulses on channels RSU0-RSU1 in sequence to reduce the average current inrush to the remote sensors as shown in [Figure 41](#). The voltage source in the Remote Sensor Interface block can source and sink current and is used to discharge the bus capacitance at the end of the sync pulse. The pull down device used to sink current is current limited.

Figure 41. Remote sensor synchronization pulses



L9679P supports three time slots in a sync period with associated RSDRx registers. The messages received within one sync period are routed to the corresponding RSDRx register associated to each time slot. A time slot control is performed to check if the incoming messages fall within the valid time slots reported in Table 62 and sketched in Figure 42. If the end of the received message occurs after the end of the checked outside a valid time slot, a SLOT\_ERROR fault will be detected and stored in the related RSDRx register. Slot error assignment is described in Figure 42. For instance, if the end of second message falls before expected valid time window the error slot 1 is asserted and then also the data received with the first message is lost. If two messages end within the same slot, the second message will be assigned to that slot, regardless its validity. The time slot control can be disabled by setting the TSxDIS bit in the RSCRx register.

Figure 42. PSI5 slot timing control



The remote sensor interface is also able to detect faults occurring on the sensor interface. The Remote Sensor Data Register (RSDRx) will report multiple fault flags.

When the number of bits decoded is incorrect (either too many or too few), a bit error is indicated. When any bit error is detected (bit time, too many bits, too few bits), the decoder will revert to the minimum bit time of the selected range and the message is discarded.

Error bit INVALID is an OR-ed combination of the following errors:

- Start bit error outside of selected operating range
- Data length error or stop bit error
- Parity Error of received Remote sensor Message
- Bit time error (a data bit edge is not received inside the expected time window)

All fault bit related to channel error are loaded in the 3 time slot register and the fault has the priority, so the fault overwrite valid data.

### 9.1.2 Sensor data integrity: LCID and CRC

Each RSDRx data register contains a Logical Channel ID which is a 4/2-bit field for remote sensors used to link the received data to the corresponding logical channel number. Each RSDRx register contains also a CRC bit field computed on the data packet for data integrity check. To satisfy functional safety requirements LCID, DATA and CRC bit fields propagate through the same data path as a single item to the SPI output.

The polynomial calculation implemented for PSI5 data is described as in PSI5 specification  $g(x)=1+x+x^3$  with initialization value equal to '111'.

Below are the equations to calculate the CRC in combinatorial way.

$$\text{CRC}[2] = \text{CRCext}[0] + D[0] + D[1] + D[3] + D[6] + D[7] + D[8] + D[10] + D[13] + D[14] + D[15]$$

$$\text{CRC}[1] = \text{CRCext}[2] + D[0] + D[1] + D[2] + D[4] + D[7] + D[8] + D[9] + D[11] + D[14] + D[15] + D[16]$$

$$\text{CRC}[0] = \text{CRCext}[1] + \text{CRCext}[0] + D[0] + D[2] + D[5] + D[6] + D[7] + D[9] + D[12] + D[13] + D[14] + D[16]$$

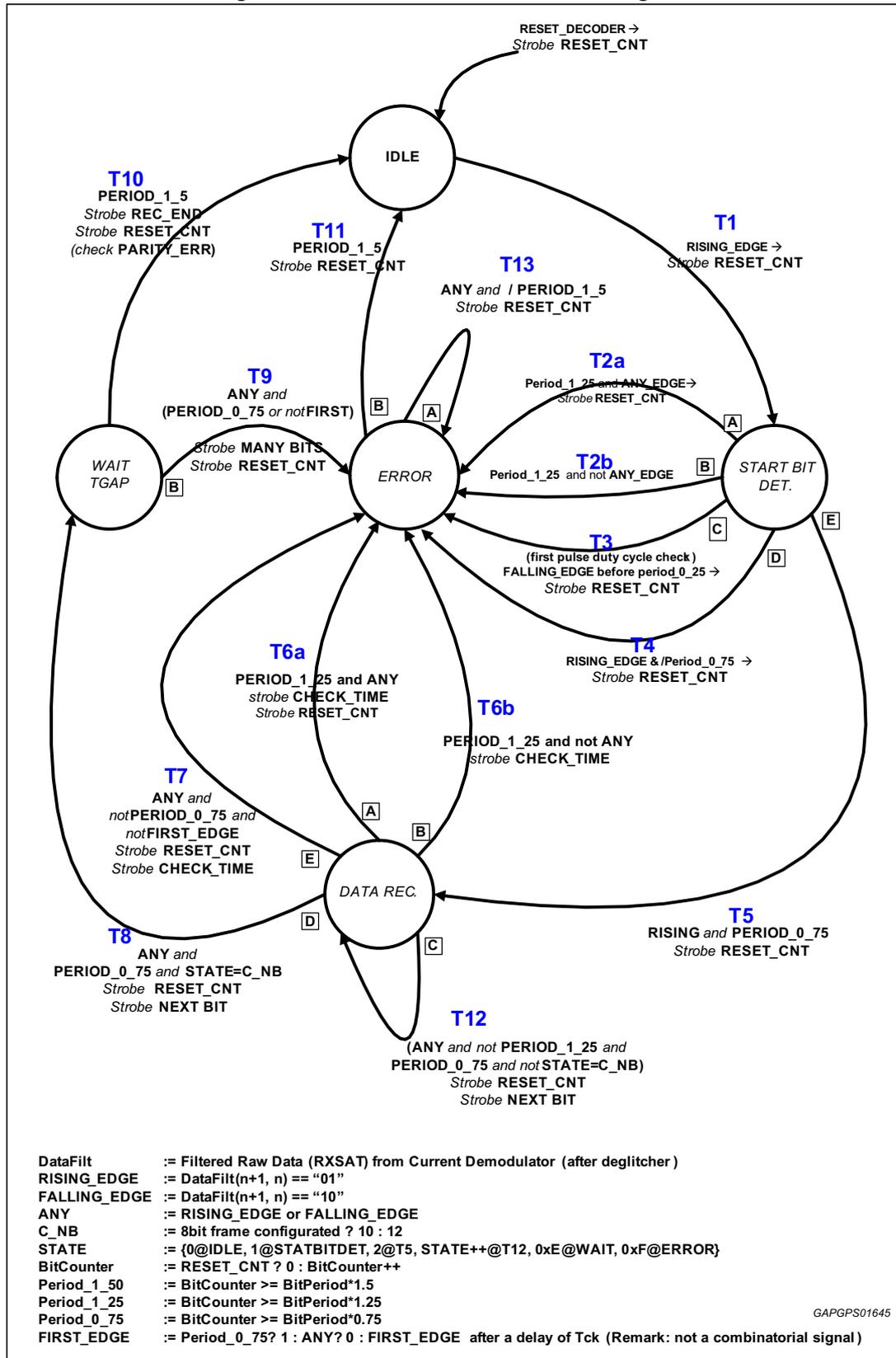
Where  $D[16:0] = \text{RSDR}[16:0]$  and  $\text{CRCext}[n]$  are the starting seed values (all '1').

### 9.1.3 Detailed description

#### Manchester decoding

The Manchester decoder will support remote sensor communication as per PSI specification rev 1.3 for the modes configurable via the STS bits in the RSCRx registers. The Manchester Decoder checks the duty-cycle and period of the start bits to determine their validity, depending on the configuration of the `PERIOD_MEAS_DISABLE` bit in the RSCRx registers. The expected time windows for the mid bit transitions of each subsequent bit within the received frame are determined by means of the internal oscillator time base. Glitches shorter than 25% of the minimum bit time duration are rejected.

Figure 43. Manchester decoder state diagram



A Manchester Decoder Error occurs if one or more of the following are true:

- Two valid start bits are detected, and at least one of the expected 13 mid-bit transitions are not detected
- Two valid start bits are detected, and more than 13 mid-bit transitions are detected
- When the number of bits decoded is incorrect (either too many or too few), a bit error is indicated. When any bit error is detected (bit time, too many bits, too few bits), the decoder will revert to the minimum bit time of the selected range and the message is discarded.

The Manchester decoder re-initializes at the start of each timeslot, such that remote sensor frames violating timeslot boundaries will result in the setting of a Manchester Error. All errors are readable through the Sensor Fault Status Register and the RSFLT bit in the Global Status Word Register.

When a valid message is correctly decoded, the 10/8 data bits are stored into the appropriate RSDRx register together with the related LCID. The RSDRx register contains the 10/8 bits data as they are received from the sensor (no data range check/mask is done at this stage). The 8-bit data word is right-justified inside the 10-bit data field in the RSDRx registers.

### **Current sensor w/ auto-adjust trip current**

The current sensor is responsible for translating the current drawn by the sensor into a digital state. Each remote sensor channel has a dedicated current sensor.

The current flowing through the RSU power stage is internally downscaled by a factor 100, sent to a 10 bits A/D converter and digitally processed to extract both the sensor quiescent and delta currents.

The delta current threshold for signal detection can either be fixed or auto-adjusted to the actual calculated sensor delta current, depending on the FIX\_THRESH bit setting in the RSCRx registers.

The current trip point is dynamically determined by adding the delta current threshold (fixed/auto-adjusted) to the quiescent current (auto-adjusted). The RSU current is compared against the current trip point to determine the current demodulator digital output. A logic '1' represents the sensor current above the current trip point. The current demodulator output is fed into the Manchester decoder and optionally to the WSx discrete output pins, depending on the configuration of the RSPTEN bit in the RSCRx registers.

Thanks to the quiescent and delta current tracking features the receiver is capable to automatically adapt to different nominal sensor currents and/or to be tolerant to sensor current drifts over lifetime.

Both the sensor quiescent and delta current tracking algorithms can be configured by setting appropriately the REDUCED\_RANGE, BLOCK\_CURR\_IN\_MSG and AVG/SSDIS bits in the RSCRx registers.

## 9.2 Test mode

In order to test the input structures of the connected microcontroller, the L9679P features a wheel speed test mode that allows test patterns to be applied on the four wheel speed outputs WS0-WS1. The test mode can be entered via SPI and the test patterns can also be controlled via SPI commands. Test patterns can be composed only of static high or low signals, which can be selected via SPI. For failsafe reasons only one channel at a time can be switched into test mode.

## 9.3 Remote sensor interface fault protection

### 9.3.1 Short to ground, current limit

Each output is short circuit protected by an independent current limit. Should the output current level reach or exceed the ILIMTH for a time period greater than TILIMTH or the remote sensor interface the output stage is disabled. An internal up-down counter will count in 25  $\mu$ s increment up to TILIMTH. The filter time is chosen in order to avoid false current limit detection for in-rush current that may happen at interface switch-on. When the output is turned off due to current limit, the appropriate fault code STG is set in the Remote Sensor Data Register (RSDR). The fault timer latch is cleared when the sensor channel is first disabled and then re-enabled through the Remote Sensor Control Register (RSCTRL). This fault condition does not interfere neither with the normal operation of the IC, nor with the operation of the other channels. When a sensor fault is detected, the RSFLT bit of the GSW is set indicating a fault occurred and can be decoded by addressing the RSDR register.

In order to fulfill the blanking time requirement at channel activation as per PSI-5 specification, a dedicated masking time is applied to the current limitation fault detection each time a channel is activated.

### 9.3.2 Short to battery

All outputs are independently protected against a short to battery condition. Short to battery protection disconnects the channel from its supply rail to guarantee that no adverse condition occurs within the IC. The short-to-battery detection circuit has input offset voltage (10mV, minimum) to prevent disconnecting of the output under an open circuit condition. A short to battery is detected when the output RSUx pin voltage increases above SATBUCK or SYNCBOOST (depending on operation) supply pin voltage for a T<sub>STBTH</sub> time. An internal up-counter will count in 1.5  $\mu$ s increment up to T<sub>STBTH</sub>. The counter will be cleared if the short condition is not present for at least 1.5  $\mu$ s. The channel in short to battery is not shut down by this condition. Other channels are not affected in case of short of one output pin. As in the case previously described, the STB fault code can be read from RSDR bits and any fault will set the RSFLT bit of the global status word register (GSW). The STB bit is cleared upon read or upon channel disabled via SPI RSCTRL register.

### 9.3.3 Cross link

The device provides also the capability of a cross link check between outputs, in order to reveal conditions where two output channels are in short. This functionality is allowed by enabling one output channel, while asking for voltage measurement on any of the other ones.

### 9.3.4 Leakage to battery, sensor open

The sensor interface offers also open sensor detection. The auto-adjusting counter for remote sensor current sensing will drop to 0 in case the current flowing through RSUx pin is lower than 2.5 mA typ. The OPENDET fault flag is asserted when the fault condition lasts for longer than TRSUOP\_FILT deglitch filter time. This fault flag can be read from RSDR bits and any fault will set the RSFLT bit of the global status word register (GSW). The channel in this condition is not shutdown. This fault bit is cleared upon read or upon channel disabled via SPI RSCTRL register.

### 9.3.5 Leakage to ground

The sensor interface offers as well the detection of a leakage to ground condition, which will possibly raise the sensor current higher than 42 mA/12 mA typ in PS15/WSS modes respectively. The CURRENT\_HI fault flag is asserted when the fault condition lasts for longer than T<sub>RSUCH\_FILT</sub> deglitch filter time. This fault flag can be read from RSDR bits and any fault will set the RSFLT bit of the global status word register (GSW). The channel in this condition is not shutdown. This fault bit is cleared upon read or upon channel disabled via SPI RSCTRL register.

### 9.3.6 Thermal shutdown

Each output is protected by an independent over-temperature detection circuit should the remote sensor interface thermal protection be triggered the output stage is disabled and a corresponding thermal fault is latched and reported through the RSTEMP flag in the Remote Sensor Data Register (RSDRx). The thermal fault flag is cleared when the sensor channel is first disabled and then re-enabled through the Remote Sensor Configuration Register (RSCRx).

# 10 Watchdog timers

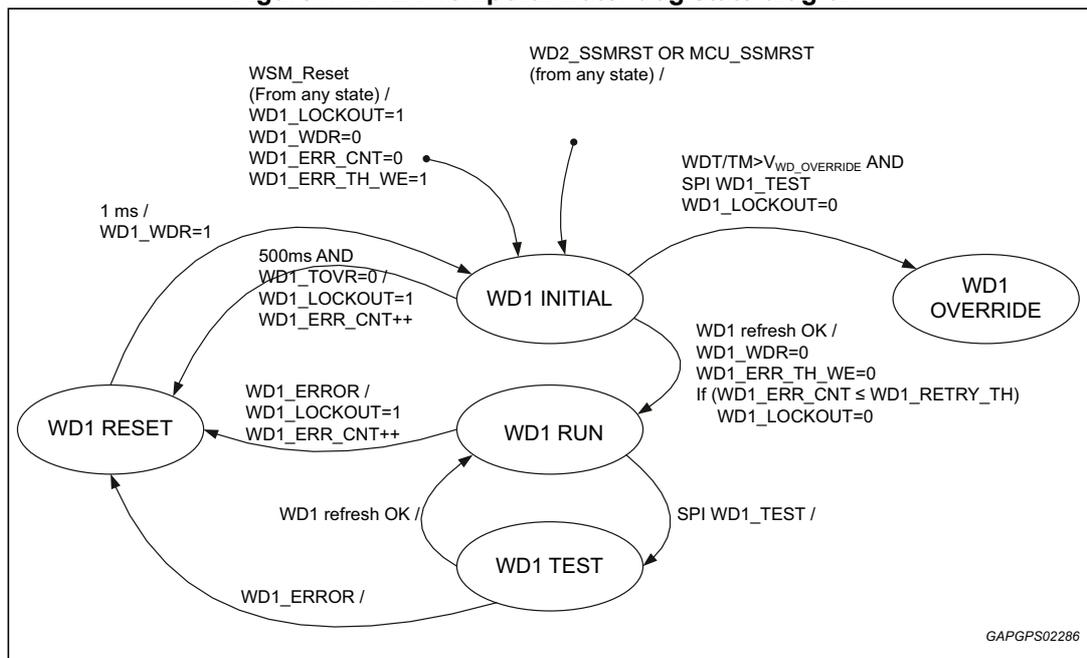
This device offers a 2-level watchdog control approach. The first control level is given by means of a temporal watchdog (WD1). The WD1 window times are SPI programmable and a couple of specific codes have to be written within this window in order to serve the WD1 control. The second control level is featured by an algorithmic seed/key watchdog (WD2). Unlike the temporal watchdog, the algorithmic watchdog service must be maintained before a timeout occurs, i.e. there is no restriction on refreshing the watchdog too early. Both WD1 and WD2 watchdog functionalities can be tested through the WD\_TEST SPI command.

## 10.1 Temporal watchdog (WD1)

The temporal watchdog ensures the system software is operating correctly by requiring periodic service from the microcontroller at a programmable rate. This service (watchdog refresh) must occur within a time window, and if serviced too early or too late will enter an error state reported via the FLTISR register (WD1\_WDR bit).

The overall WD1 functionality is described in the state diagram reported in *Figure 44*.

**Figure 44. WD1 Temporal watchdog state diagram**



Following the description of the WD1 states and signals (most of them reported in related SPI registers)

Table 13. Watchdog timer status description

| State/Signal   | Description   |
|----------------|---|
| WD1 INITIAL    | Default state entered from startup. While in this state, no watchdog service is required, and the IC may stay in this state indefinitely. For system safety, all arming signals are disabled during this state to prevent deployment.   |
| WD1 RUN        | Normal run time state where WD1 service is required.  |
| WD1 TEST       | A special state used to test the watchdog function. Normally, this state will only be checked once per power cycle by the software, but there is no inherent restriction in the watchdog logic preventing periodic testing. This state allows testing of the watchdog without setting WD1_LOCKOUT=1, which can only be cleared via WSM reset. Deployment is inhibited when the WD state machine is in this state. |
| WD1 RESET      | State entered when a WD1_ERROR occurs. This is a timed-duration state that is automatically exited after 1ms.   |
| WD1 OVERRIDE   | A special state used to disable watchdog functionality for development purposes. Other logic within the IC can use this state to emulate the WD1 RUN state without the need to service WD1.   |
| WSM_RESET      | Signal used to reset the WD1 state machine to the WD1 INITIAL state and all signals to their inactive values  |
| WD1_refresh OK | Signal that is asserted only if the watchdog is refreshed ('A' - 'B' or 'B' - 'A' seq.) within the WD1 time window  |
| WD1_ERROR      | Signal that is asserted if the watchdog refresh fails to occur during the WD1 time window.  |
| WD1_WDR        | Watchdog Reset – latched signal that is activated whenever a watchdog error is qualified. For WD1, this occurs when WD1 service is required, but not received. This signal is SPI-readable.   |
| WD1_TM         | Test Mode – a signal that indicates that WD1 is being tested. This signal is SPI-readable.  |
| WD1_LOCKOUT    | A latched signal activated if an unexpected WD1 error occurs. This signal is permanently latched when set (until WSM_RESET). When set, all arming signals are disabled, preventing deployment. This signal is SPI-readable.   |
| SPI_WD1_TEST   | SPI command used to enter WD1 TEST state from WD1 RUN state, or to enter WD1 OVERRIDE state from INITIAL state if WDT/TM pin voltage is greater than the threshold. This command has no effect in other states.   |

### 10.1.1 Watchdog timer configuration

The watchdog timer can be configured on two different frequency modes:

- Fast watchdog with maximum range of 2ms and a resolution of 8  $\mu$ s;
- Slow watchdog with maximum range of 16.3ms and a resolution of 64  $\mu$ s.

The watchdog window times are SPI programmable. The configuration of watchdog timer frequency and window times can be done by setting the Watchdog Timer Configuration Register (WDTCR) with the appropriate values. However, this configuration is accepted only when the device is in the Init operating state, as shown in [Figure 10](#). As soon as the device enters in Diag state, the watchdog control is enabled and the watchdog configuration is fixed and cannot be changed anymore.

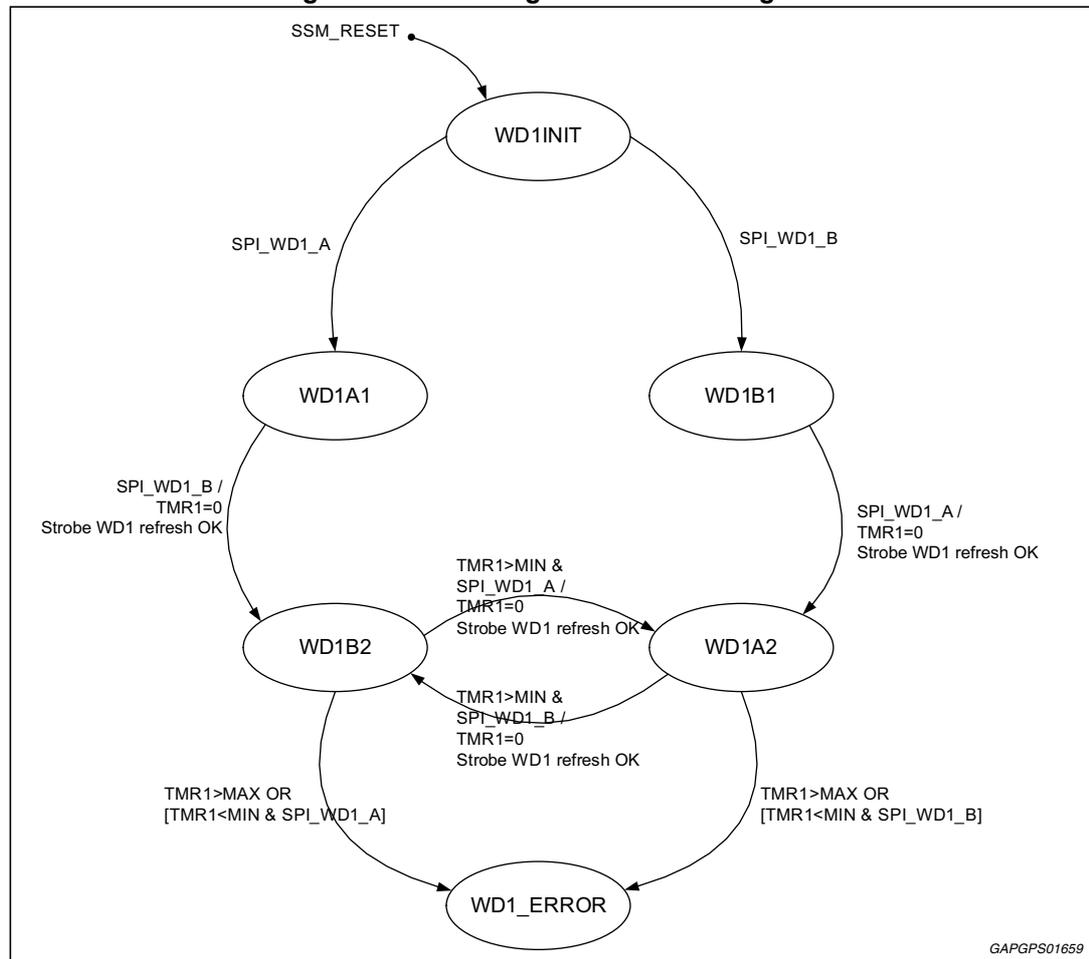
### 10.1.2 Watchdog timer operation

While in the WD1\_INITIAL state, watchdog service must begin or a SPI command with WD1\_TO\_DIS=1 must be received within the first 500 ms. If the WD1 Timeout Disable bit is set, the device can stay in the WD1\_INITIAL state indefinitely without watchdog service.

To refresh WD1, the logic must receive a Watchdog Timer Register (WD1T) SPI command containing the expected key value within the WD1 time window (WDTMIN+WDTDELTA). If it is received too early, too late the WD1\_ERROR signal will be asserted. The WD1\_ERROR will not be asserted in case a SPI command containing the Watchdog Timer Register (WD1T) with an incorrect key value is received at any time relative to the window. This allows the system software to repeatedly transmit the key value until it needs to change to the correct key value. Upon reception of the correct key within the window, the logic will reset the watchdog timer to create a new window.

The timer is cleared upon writing code 'A' and code 'B' (either in 'A' - 'B' or 'B' - 'A' sequences) to the WD1CTL [1:0] bits, in the WD1T register. The watchdog timer value can be read via the WD1T register.

Figure 45. Watchdog timer refresh diagram

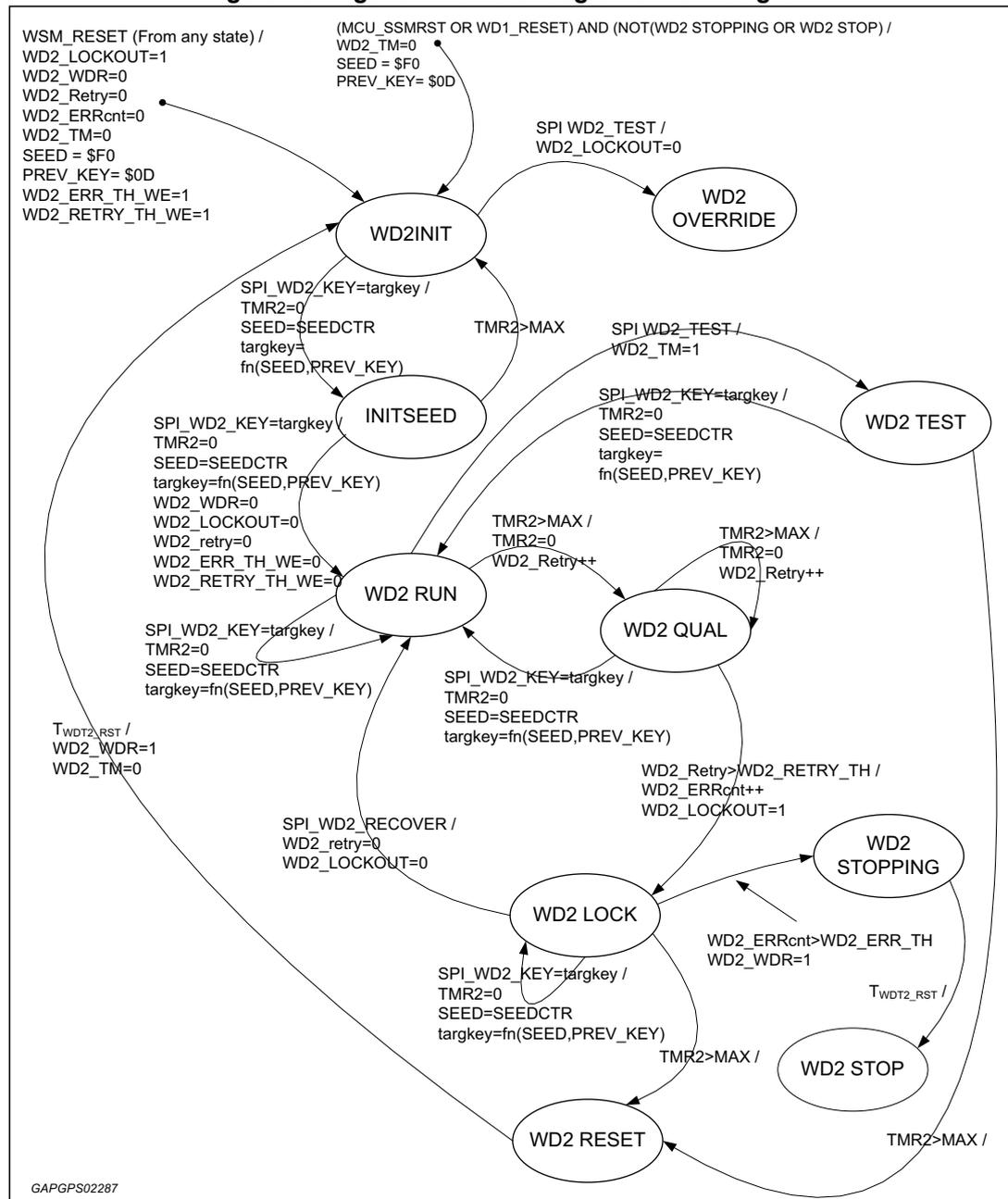


## 10.2 Algorithmic watchdog (WD2)

The algorithmic watchdog (WD2) is intended to protect higher software layers, and as such requires servicing at a much slower rate and allows for software jitter as compared with WD1. Additionally, WD2 is not implemented as a window watchdog, but is a maximum-time watchdog, where refresh is accepted at any time before the timer expires.

The overall WD2 functionality is described in the following state diagram:

**Figure 46. Algorithmic watchdog timer flow diagram**



Following the description of the WD2 states and signals (most of them available through SPI registers)

**Table 14. WD2 states and signals**

| State / Signal  | Description  |
|-----------------|--|
| WD2 INIT        | Default state entered from startup or after a SSM reset (if not in WD2 STOP state).  |
| WD2 OVERRIDE    | Special state used to disable WD2 watchdog functionality.  |
| WD2 INITSEED    | State entered when the correct default key is received in INIT state. Here the timer starts to count waiting for the real first key.   |
| WD2 RUN         | Normal run-time state where WD2 service is required.   |
| WD2 TEST        | A special state used to test the watchdog function. Normally, this state will only be checked once per power cycle by the software, but there is no inherent restriction in the watchdog logic preventing periodic testing. This state allows testing of the watchdog without affecting WD2 error (no reset is generated, WD2_LOCKOUT stay low). Only WD2_WDR latch could be set to 1, in this way µC is able to verify the functionality of the watchdog. |
| WD2 QUAL        | A state used to qualify a number of WD2_ERROR occurrences before action is taken. The intent is to use this state to permit a retry strategy to account for software jitter.   |
| WD2 LOCK        | A state entered after the allowed retries have been exhausted. This is where action is taken due to WD2 service failure.   |
| WD2 STOPPING    | This is a timed-duration state that is automatically exited after 1ms  |
| WD2 STOP        | A state used to prevent continual recovery of WD2 errors using the WD2_KEY key mechanism to restart watchdog service.  |
| WD2 RESET       | State entered when a WD2_ERROR occurs after having been qualified in the WD2_QUAL state (when all retries are exhausted), or when testing the WD2. This is a timed-duration state that is automatically exited after 1ms.  |
| WSM_RESET       | Watchdog State Machine reset – used to force a transition to the WD2 INIT state and reset all signals to their inactive states   |
| WD2_RETRY       | Counter that tracks the number of retry attempts. It is incremented each time the logic detects a WD2 error while qualifying the error.  |
| WD2_WDR         | Watchdog Reset – latched signal that is activated whenever a watchdog error is qualified. For WD2, this occurs when WD2 service not received after all retry attempts have previously failed. This signal is SPI-readable.   |
| WD2_TM          | Test Mode – a signal that indicates that WD2 is being tested. This signal is SPI-readable.   |
| WD2_LOCKOUT     | A latched signal that is activated on startup, or whenever a WD2 error is fully qualified (all retry attempts have failed). Recovery is still possible after this is set going into WD2 RUN state. This signal drives the WD2_LOCKOUT output pin. This signal is SPI-readable.   |
| SPI_WD2_TEST    | SPI command used to enter WD2_TEST state or to enter WD2_OVERRIDE state from INIT.   |
| TMR2            | Timer to count the maximum time limit to receive the correct key   |
| SPI_WD2_RECOVER | SPI command used to clear retry counter  |
| WD2_ERR_CNT     | Counter that tracks the number of WD2 error occurred   |

To refresh WD2, the logic must receive a WD2\_KEY command containing the expected key value before the WD2 timer expires. If it is received too late the refresh criteria have not been met. The WD2 error is asserted if the refresh does not occur before the end of the timeout. The WD2 error is not asserted if it receives continuously a WD2\_KEY command with the correct key. This allows the system software to repeatedly transmit the correct key value at any rate faster than the required timeout.

Upon reception of the correct key, the logic will generate a new seed value, then calculate a new key using the new seed and reset the watchdog timer to create a new timeout.

When in WD2 INITSEED state, the three steps above are executed anyway. The seed is latched from a free-running counter that starts when WSM is released. The WD2\_KEY command is used for transmission of the watchdog key, while WD2\_SEED command is used to read the new seed and the previous key.

The SEED is generated by latching the value from a free-running counter. The free-running seed counter runs at a rate of  $f_{WD2\_SEED}$  as specified in [Table 29](#). The key value and seed value are 8-bits in length. The key shall be calculated as follows:  $(KEY = SEED \oplus PrevKEY + \$01)$  where  $\oplus$  denotes a bit-wise XOR operation

### 10.3 Watchdog reset assertion timer

Upon either a WD1 or a WD2 watchdog reset, the watchdog logic will momentarily assert the RESET pin for time duration  $T_{WDT1\_RST} / T_{WDT2\_RST}$ . When the RESET pin has been asserted through the watchdog reset assertion timer, stored faults are maintained and can be read by the microcontroller via SPI following the RESET period.

### 10.4 Watchdog timer disable input (WDT/TM)

This input pin has a passive pull-down and is used to disable the watchdog timer. The state of this pin can be read by SPI through the WDT/TM\_S bit in the GSW register. When WDT/TM pin is asserted, the watchdog timer is disabled, the timer is reset to its starting value and no faults are generated.

The WDT/TM input pin must not be biased HIGH ( $WDT/TM > V_{WDTDIS\_TH}$ ) prior to POR in order to have a proper start-up.



The voltage and current for the selected channel are made available to the main ADC by selecting the proper channel and enabling the measurement process by dedicated DIAGCTRLx commands.

The device offers the capability to actively keep all the DCSx lines discharged by means of a weak pull down. The pull down is active by default on all channels and it is deactivated in either of the following cases:

1. when the voltage source is active on the relevant channel
2. when a voltage measurement is requested on the relevant channel
3. if SPI bit SWCTRL(DCS\_PD\_CURR) is set (global pull-down disable for all channels)

In case of Hall-effect sensors, a single current measurement is processed. The current load needed for regulating the pin is internally reflected to a reference resistance, whose voltage drop is then measured through the internal ADC converter.

When resistive or switch sensors are used, a more complex measurement is performed. In a first step the current information as above described is provided. Then, also the information on the voltage level achieved on the output pin is provided via ADC. By processing these two values, the micro-controller can understand the resistive value. The DCSx voltage is internally rescaled by a voltage divider into the ADC converter voltage range as shown in Figure 48. Additionally a positive voltage offset is internally applied to the scaled voltage in order to allow voltage measurement capability for DCSx down to -1V.

In order to get accurate resistive information even in case of an external ground voltage shift on the sensor of up to +/-1V, the voltage measurement step actually needs two DCSx voltage measurements. A first voltage measurement has to be done with selection of 6.25V on the output channel and a second one with the regulator switched off. The difference between the two measurements will cancel out the offsets (both external ground shift and internal offset).

The DCSx current and voltage can be retrieved from ADC readings according to the following formulas and related parameters specified in the Electrical Characteristics section.

$$I_{DCSx} = 100 \cdot \frac{I_{REF\_DCS}}{2^{ADC\_RES}} \cdot DIAGCTRLn(ADCRESn) @DIAGCTRL(ADCREQn = \$04$$

$$V_{DCSx} = \text{RATIO}_{VDCSx} \cdot \left( \frac{ADC_{REF\_hi}}{2^{ADC\_RES}} \cdot DIAGCTRLn(ADCRESn) - V_{OFF\_DCSx} \right) - V_{OFF\_DCSx} \cdot (\text{RATIO}_{VDCSx} - 1) @DIAGCTRLn(ADCREQn) = \$03$$

The DCSx sensor resistance can be calculated according to the following formula:

$$R_{\text{sensor}_x} = \frac{\Delta V_{DCSx}}{I_{DCSx}} = \frac{V_{DCSx}@(\text{SWCTRL}(\text{SWOEN})=1) - V_{DCSx}@(\text{SWCTRL}(\text{SWOEN})=0)}{I_{DCSx}}$$

@SWCTRL(CHID) = x

The device provides also the capability of a cross link check between outputs, in order to reveal conditions where two output channels are in short. This functionality is allowed by enabling one output channel, while asking for voltage measurement on any of the other ones.

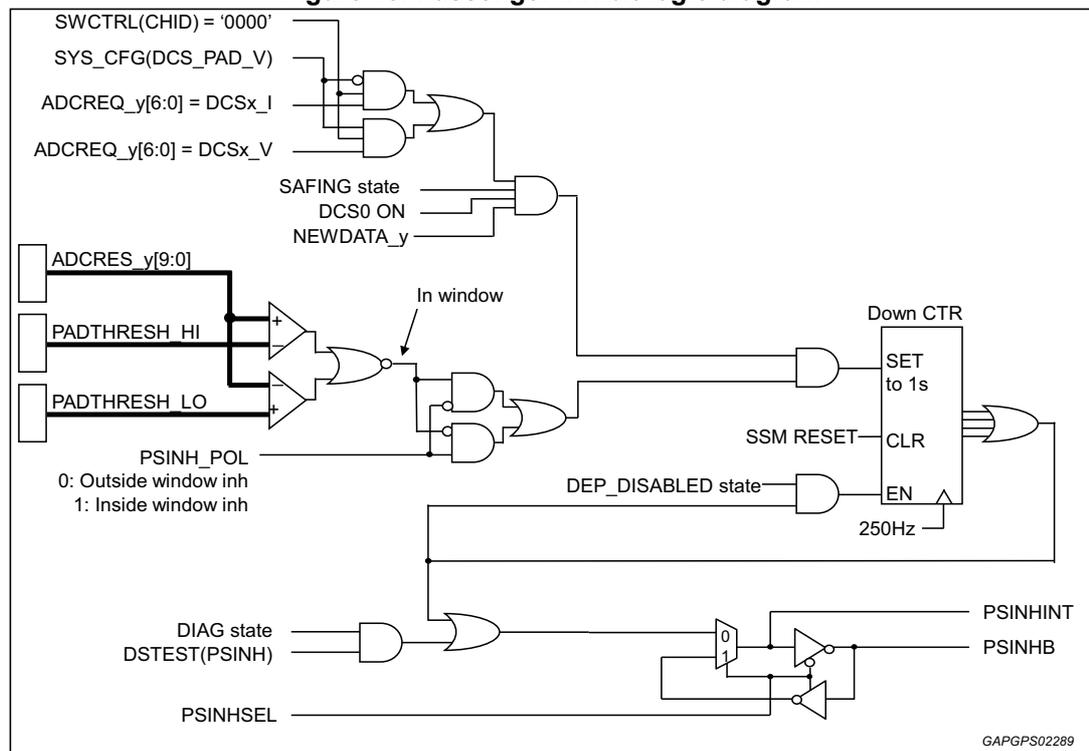
Each output is protected against

- Overload conditions by current limit
- Ground offset between the ECU and the loads of up to ±1 V.
- Loss of ECU battery
- Loss of ground
- Unpowered shorts to battery
- Shorts to ground

### 11.1 Passenger inhibit interface

L9679P provides a feature to deactivate passenger restraint devices based on a preprogrammed mask. It generates a signal (PSINHINT) based on microcontroller-initiated measurements performed on DC Sensor channel 0. The PSINHINT signal is bitwise AND-ed with the LOOP\_MATRIX\_PSINH mask register, allowing selective deactivation of squib loops independent of microcontroller control. This signal is also inverted and output on the PSINHB pin of the IC to activate externally controlled squib loops.

Figure 48. Passenger inhibit logic diagram



An upper and lower threshold is preprogrammed via SPI by writing the desired 10-bits values into the PADTHRESH\_HI and PADTHRESH\_LO registers during the Diag state. These thresholds define the measurement window where the passenger restraints are active. Any measurement outside this window will result in the assertion of the PSINHINT signal (as described below), thereby deactivating the squib loops identified in the PSINH mask. The PSINH mask is also preprogrammed during the Diag state.

Another control (DCS\_PAD\_V bit in SYS\_CFG register) is preprogrammed to select either a voltage measurement or a current measurement on DCS0 for this purpose.

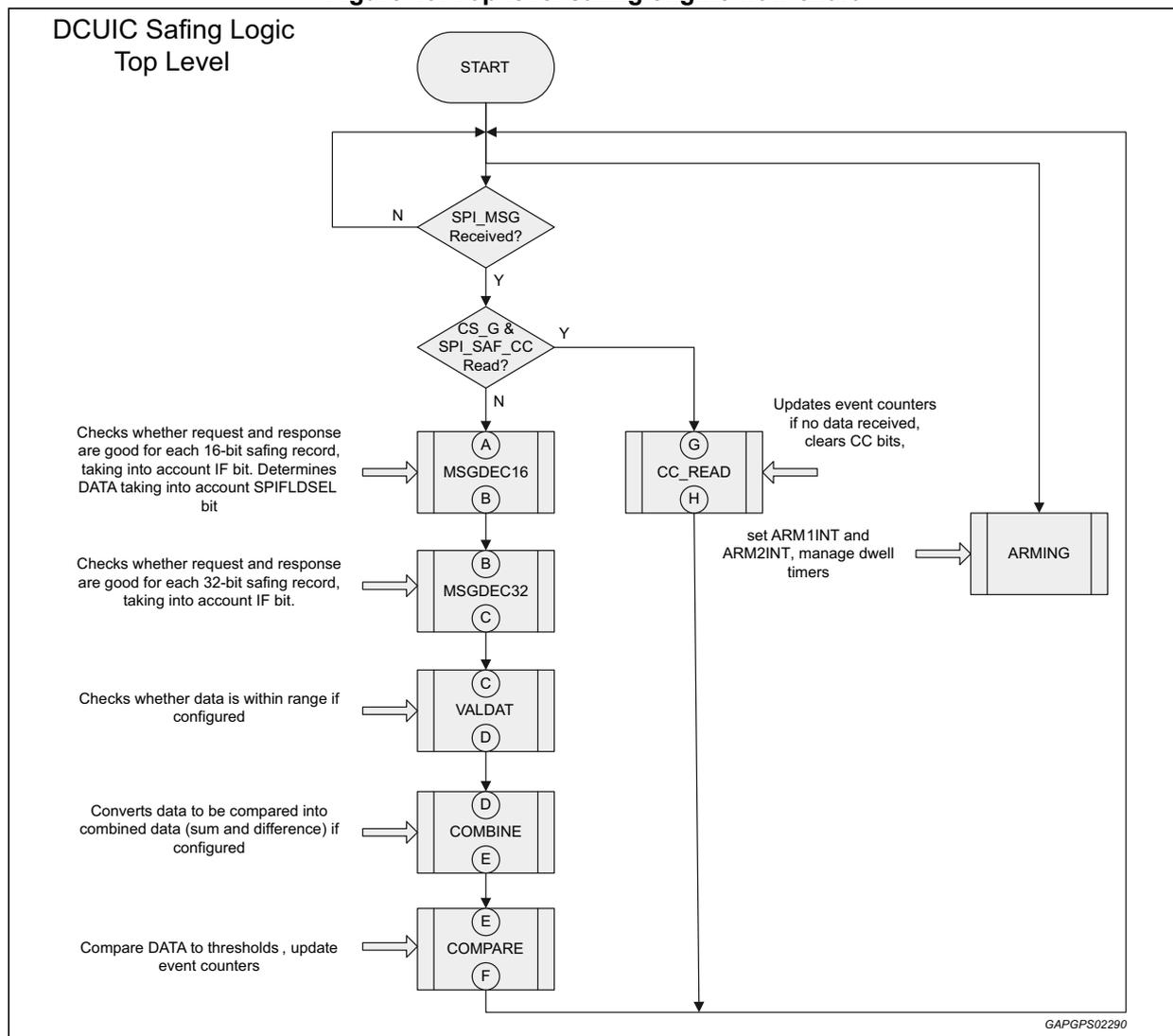
The automated control of the PSINHINT signal occurs when the microcontroller runs diagnostic testing of the DCS0 interface. A 1 second timer is included to ensure the diagnostic test is run periodically. When the timer expires (down-counts to 0), the PSINHINT signal is asserted. When the measurement of the DCS0 voltage or DCS current (as selected by the DCS\_PAD\_V bit) is taken, and the value falls within the preprogrammed window, the timer will be reloaded. If the measurement is outside the window, the timer will not be reloaded, and it will continue to count down until it expires, resulting in activation of PSINHINT. For testing purposes, the PSINHINT can be controlled directly via SPI while in DIAG state using the Diag State Test Selection (DSTEST) register.

# 12 Safing logic

## 12.1 Safing logic overview

The integrated safing logic uses data from on-board and remote locations by decoding the various SPI communications between the interfaces and the main microcontroller. The safing logic has several programmable features enabling its ability to decode SPI transmissions and can process data from up to 16 sensors. The operating mode involves simple symmetrical data threshold comparisons, with the use of symmetrical or asymmetrical counters. A high level diagram is shown in the figure below. Please note that this top-level diagram is simplified, and references more detailed flowcharts to show a) message decoding, b) valid data limits, c) effects of the 'combine' function, d) comparison to thresholds and arming, and e) the setting of the 'compare complete bit'. Two independent arming outputs, ARM1INT and ARM2INT, are also mapped internally to any of the integrated squib drivers.

Figure 49. Top level safing engine flow chart



## 12.2 SPI sensor data decoding

Sensor data is regularly communicated with the main microcontroller through multiple SPI messages. The L9679P monitors SPI traffic on MISO\_RS bus. Since not all communications between sensors and the microcontroller contain data, it is important for the decoder to properly sort the communications and extract only the targeted data. The solution involves defining specific masking functions, contained within independent safing records, programmed by the user. The following figures detail the SPI message decoding methodology and the ensuing comparisons of valid sensor data to the programmed thresholds.

Figure 50. Safing engine – 32-bit message decoding flow chart

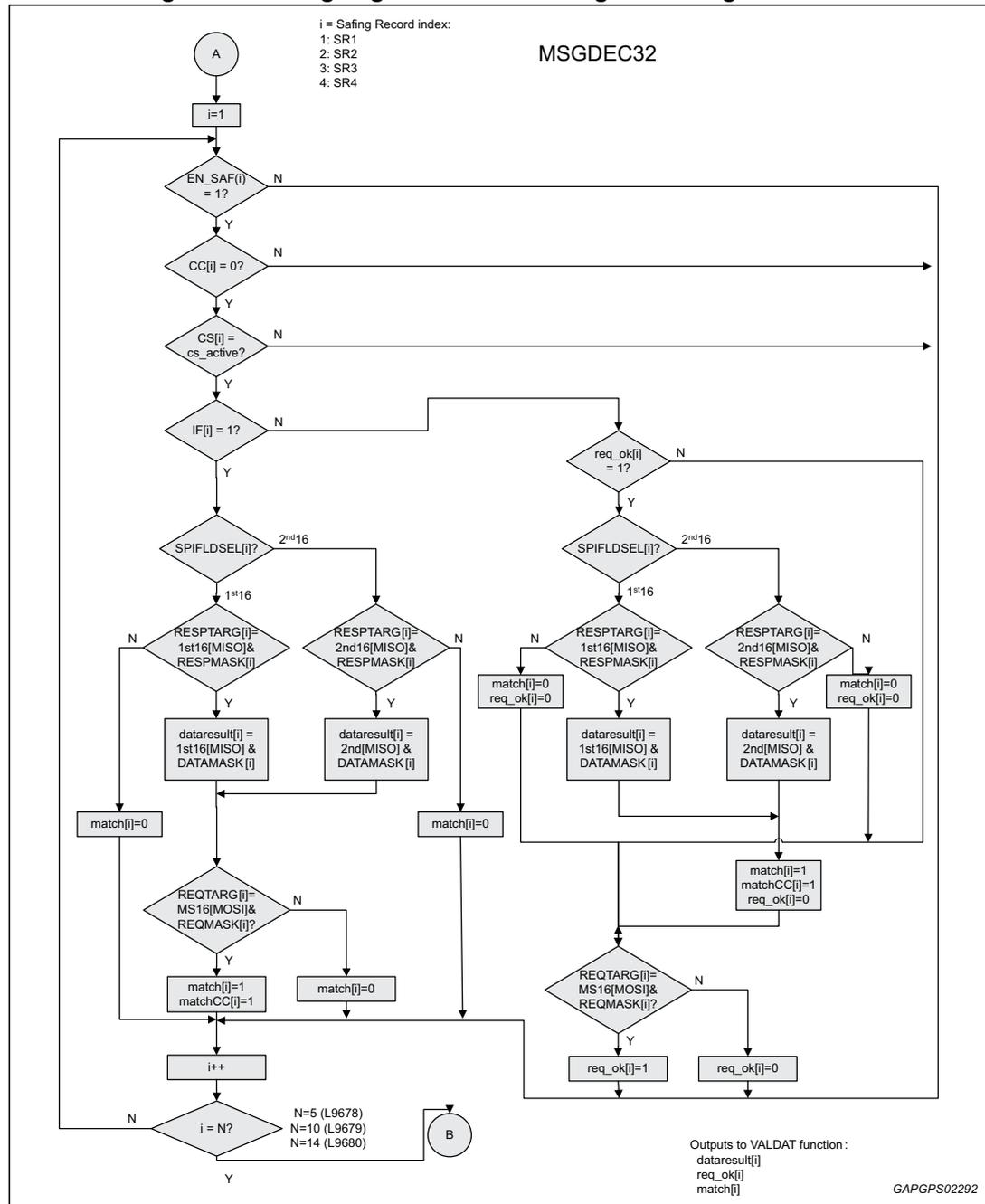


Figure 51. Safing engine – 16-bit Message decoding flow chart

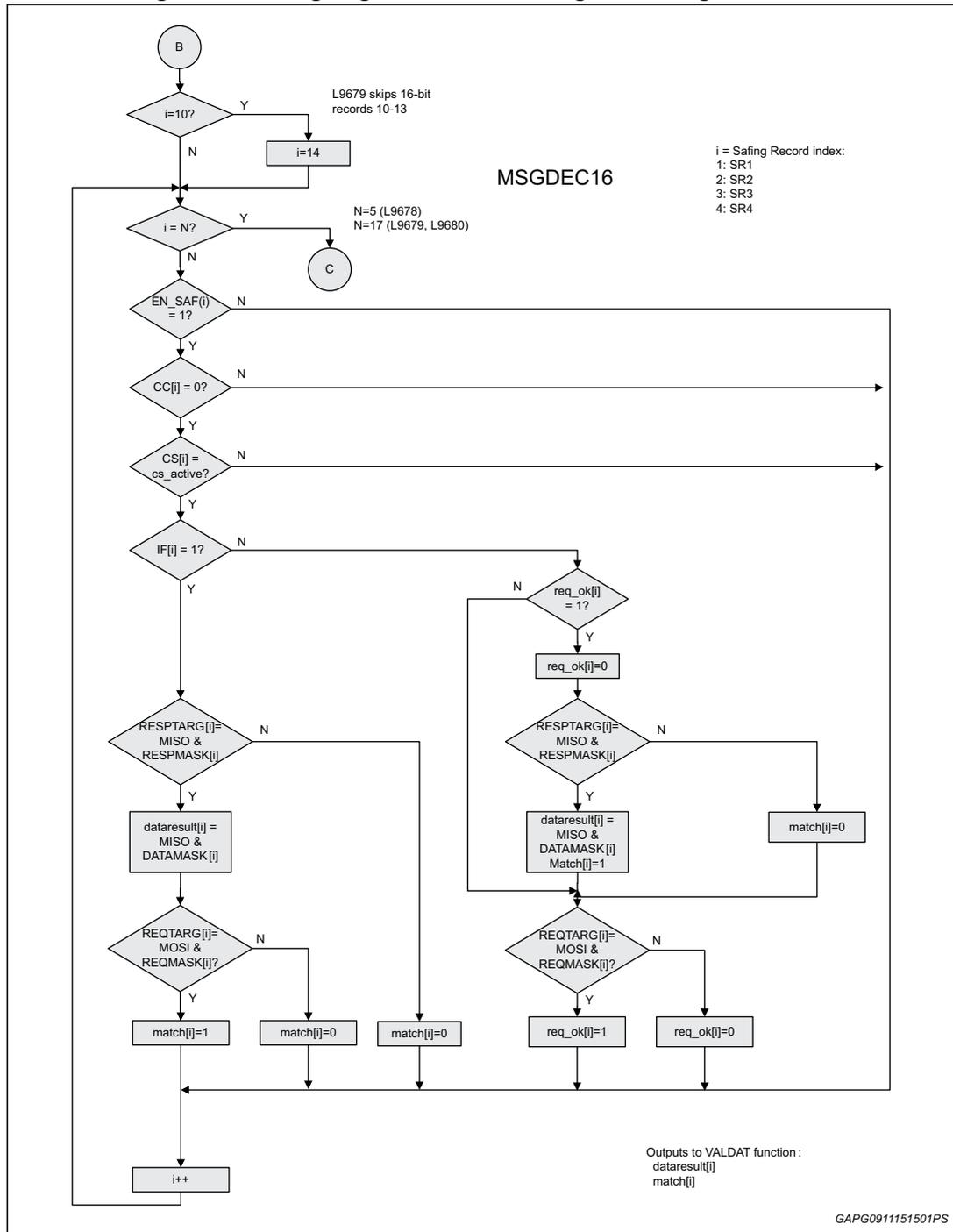


Figure 52. Safing engine - Validate data flow chart

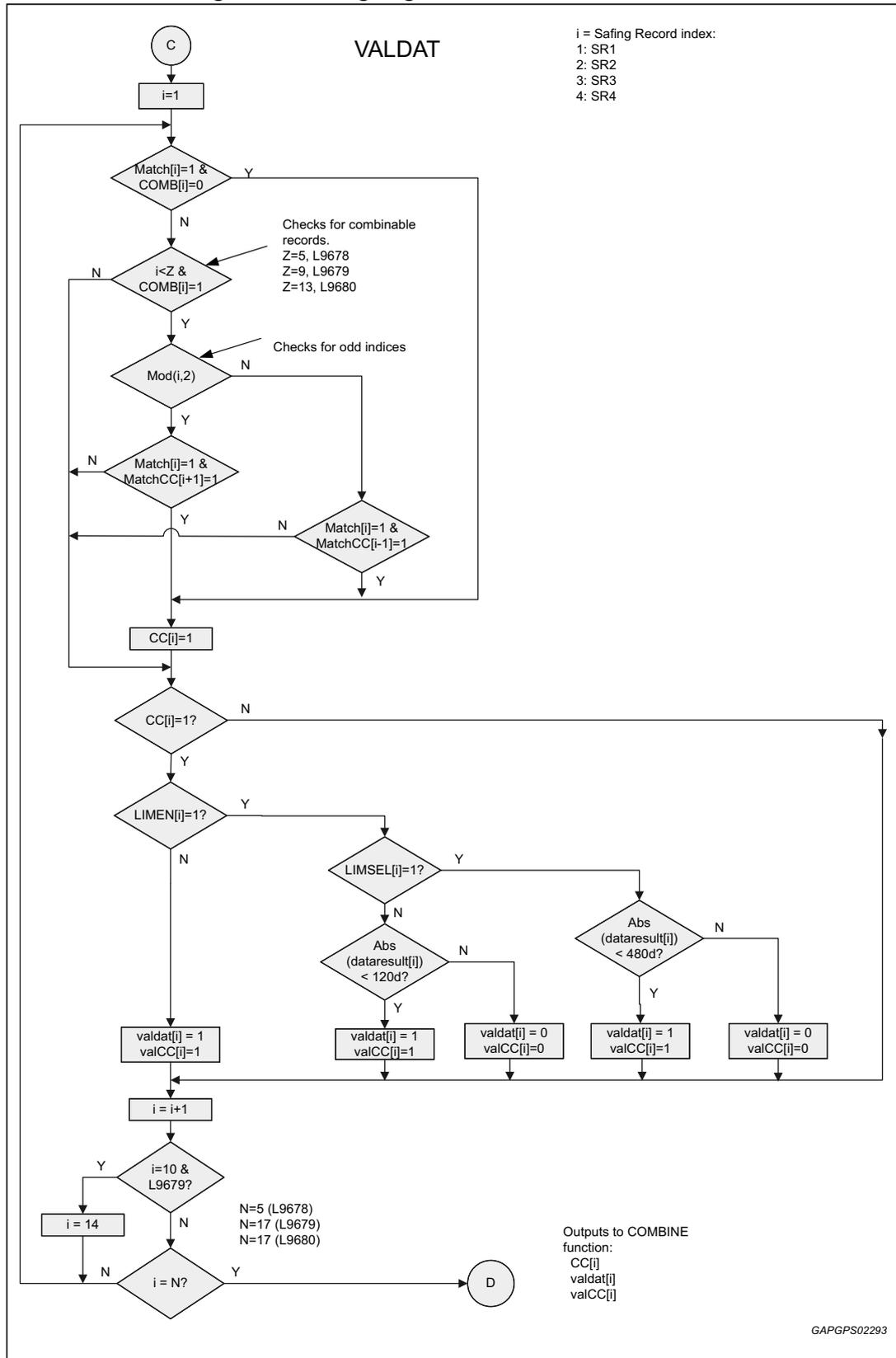


Figure 53. Safing engine - Combine function flow chart

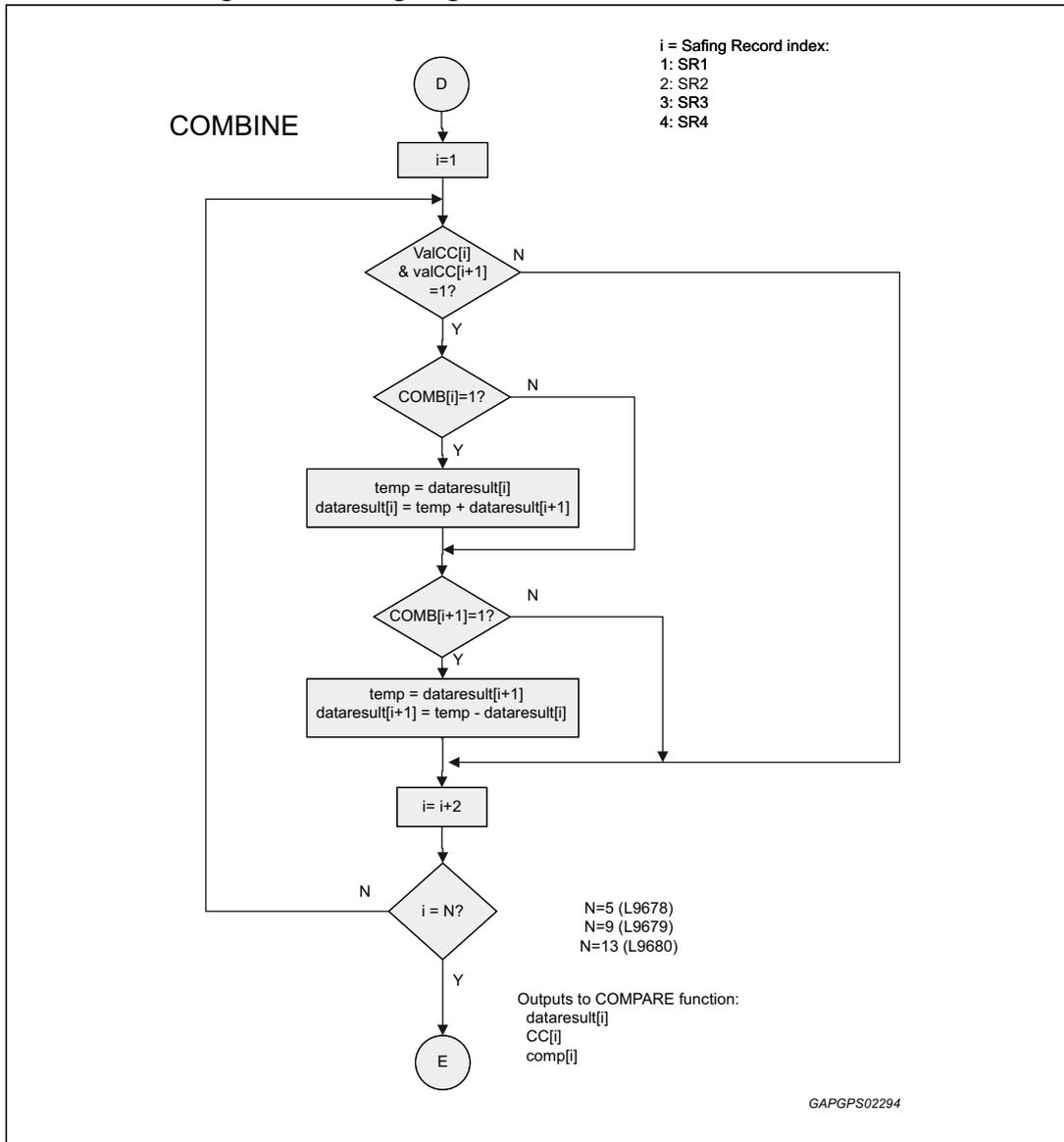


Figure 54. Safing engine threshold comparison

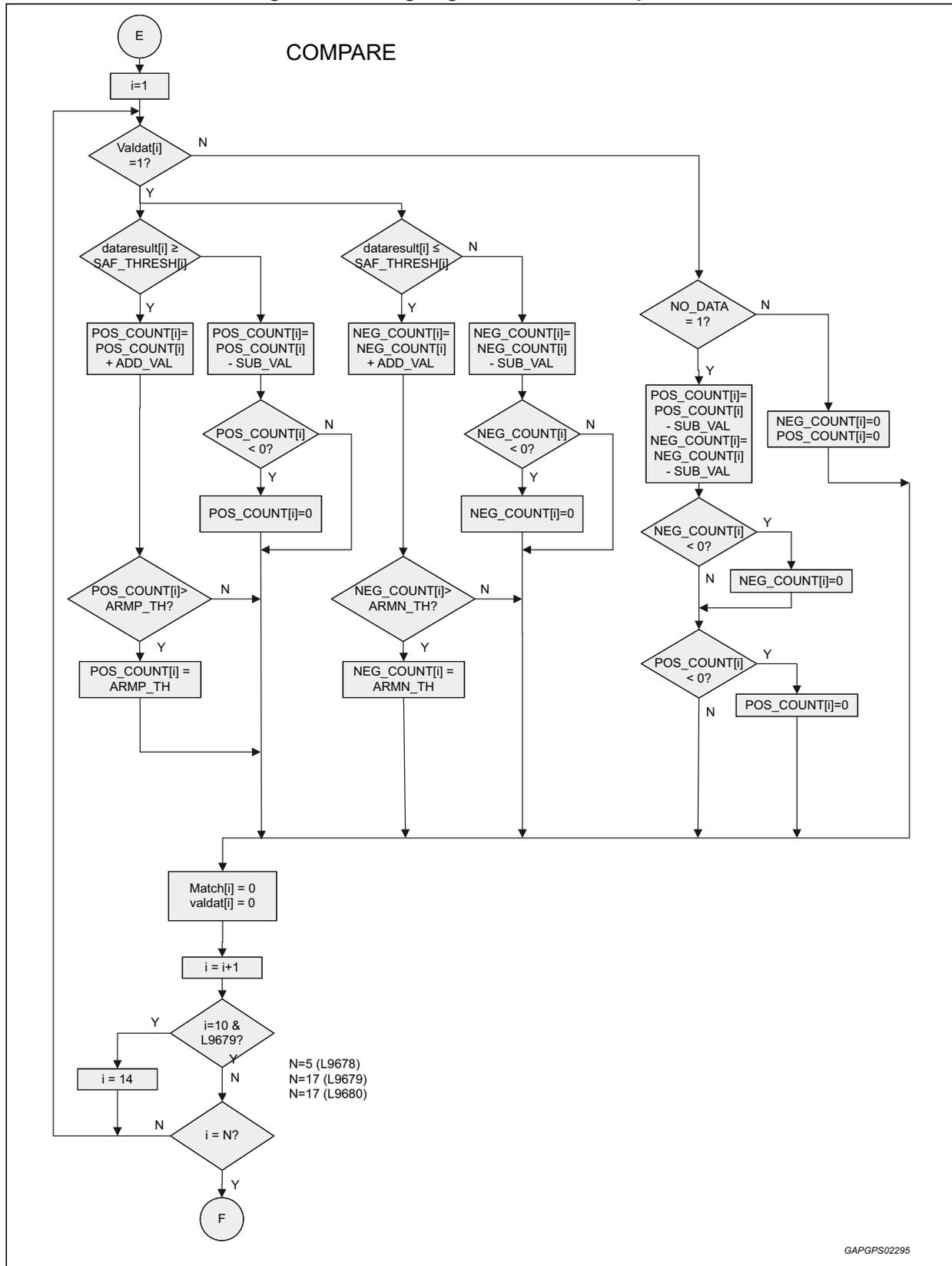
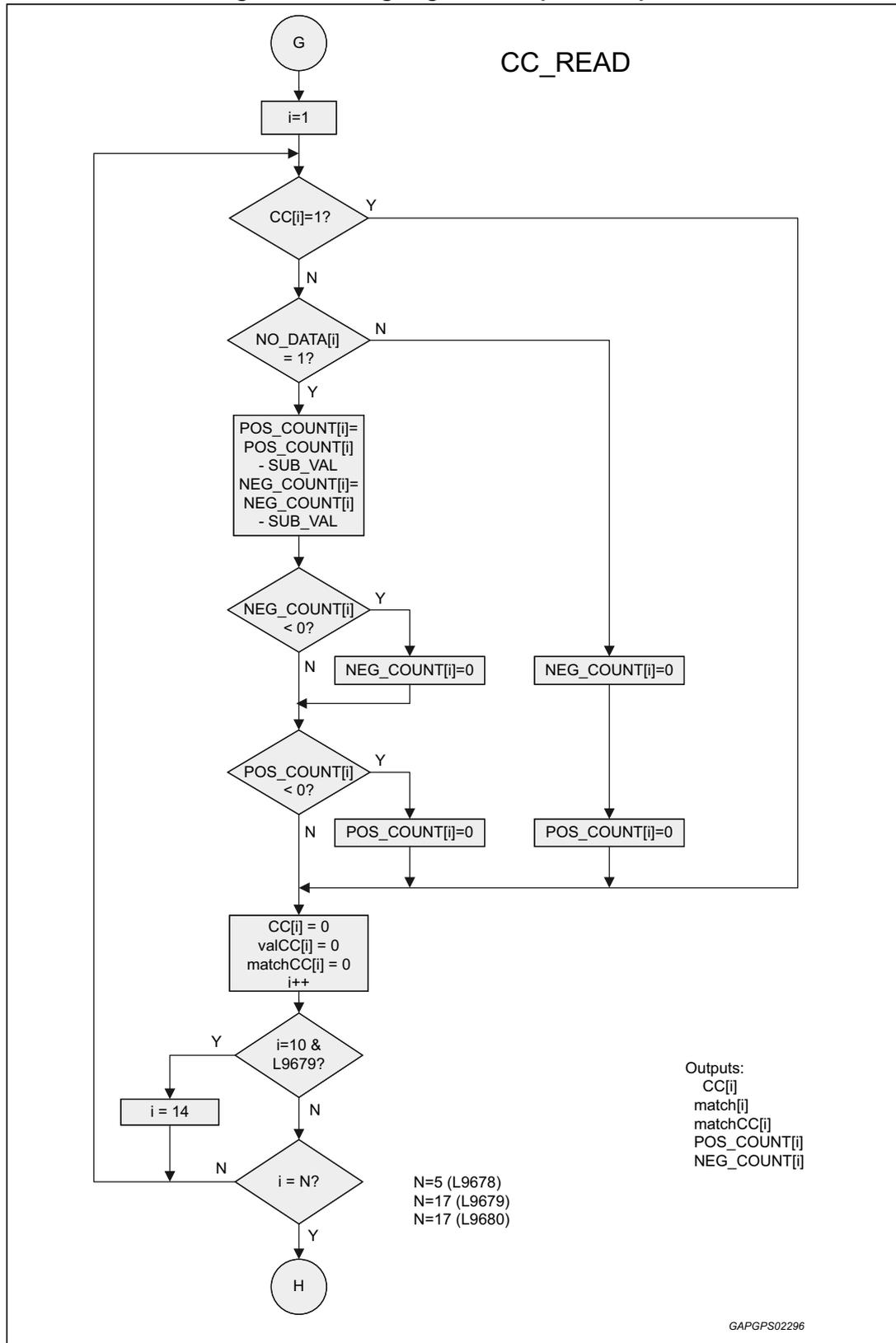


Figure 55. Safing engine - Compare complete



Each saftng record has SPI accessible registers defined in the SPI command tables and summarized below:

- Request Mask and Request Target - to understand what sensor the microcontroller is addressing
- Response Mask and Response Target - to identify the sensor response
- Data Mask - to extract relevant sensor data from the response.
  - Sensor data is extracted as a bit-wise AND result of the SAF\_DATA\_MASKx and monitored RS\_MISO data. The configuration of the set bits of the DATAMASK must be contiguous for both 16-bit and 32-bit records. The 32-bit records are comprised of Part1 as MSW and Part2 as LSW.
  - The extracted data is then right justified into a 16/32 bit register for 16/32 bit saftng records, respectively, prior to further processing steps which assume data is signed should be "using two's complement representation".
- Saftng Threshold - specific value that sets the comparator limit for successful arming
- Control:
  - IF, In Frame - to indicate serial data response is 'in frame'. There are two types of potential serial data responses, 'in frame' and 'out of frame'.
  - CS - to align saftng record with a specific SPI CS. The device contains 5 SPI CS inputs for the saftng function (CS\_RS, SAF\_CSx)
  - ARM - there are four internal arming signals, each active record is assigned or mapped to any arming signal. Several saftng records can be mapped to a single arming output. ARMx outputs can be enabled also simultaneously.
  - Dwell - Once an arming condition is detected, the saftng record remains armed for the specified dwell time.
  - Comb (Combined Data) - specific solution for dual axis high-g sensors specifically oriented off-axis.
  - LimEn (Limit Enable) - to enable PSI5 out-of-range control.
  - LimSel (Limit Select) - to select PSI5 out-of-range thresholds between 8-bit and 10-bit protocol.
  - SPIFLDSEL (SPI Field Select) - to determine which 16-bit field in long SPI messages (>31 bit) to use for response on MISO of SPI monitor. Don't care for messages less than 32 bits.

If input packet matches multiple saftng records, the saftng engine should process all of them and treat them independently.

Saftng record can only be evaluated on the first matching input packet. Any further data packet matches are ignored (i.e. once CC is set, record can't be processed until CC is cleared)

The En (Record Enable) bit for any record is programmable as on or off at any time and will enable/disable the record itself upon the following SATSYNC.

All CC bits are available in one register (SAF\_CC) for access in one single SPI read. After ARMING is achieved and CC is set, no further messages are considered until CC is cleared via read.

Saftng Engine must not process sensor data in any state but Saftng state (refer to [Figure 10](#)).

All saftng records are cleared on SSM RESET.

Comb (Combined Data) bit allows combining X and Y for off-axis oriented sensors. In this case, it is typical for such orientations to add or subtract the sensor response to translate the sensor signal to an on-axis response. Only couples of 16-bit long records have this feature (i.e. 1&2, 3&4, 5&6, 7&8, 9&10, 11&12).

Records are added and subtracted and results compare against two thresholds. Safing engine will process data as follows:

- Use record(n) and record(n+1), where n = 1, 3, 5, 7, 9, 11.
- The matching inputs used for math combinations are processed only after both are captured.
- The sum of the two matching inputs will be compared to the threshold of record(n).
- The difference of the two records will be compared to the threshold of record(n+1).
- If the Comb feature was enabled on only one of the two records in a couple, math would be performed only on it as shown in *Figure 54*

Example of Combine Function operation:

**Table 15. Example of combine function operation**

| Record #  | Combine Bit | Data | Resulting value | Record Threshold | ARMSELx Configuration | ARMINTx Result |
|-----------|-------------|------|-----------------|------------------|-----------------------|----------------|
| Record 1  | 0           | 12   | 12              | 48               | ARMP                  | 0              |
| Record 2  | 0           | 50   | 50              | 48               | ARMP                  | 1              |
| Record 3  | 0           | 50   | 12              | 48               | ARMP                  | 0              |
| Record 4  | 1           | 12   | 50 – 12 = 38    | 48               | ARMP                  | 0              |
| Record 5  | 1           | 12   | 12 + 50 = 62    | 48               | ARMP                  | 1              |
| Record 6  | 0           | 50   | 50              | 48               | ARMP                  | 1              |
| Record 7  | 1           | 50   | 12 + 50 = 62    | 48               | ARMP                  | 1              |
| Record 8  | 1           | 12   | 50 – 12 = 38    | 48               | ARMP                  | 0              |
| Record 9  | 1           | 12   | 50 + 12 = 62    | -24              | ARMN                  | 0              |
| Record 10 | 1           | 50   | 12 – 50 = -38   | -24              | ARMN                  | 1              |

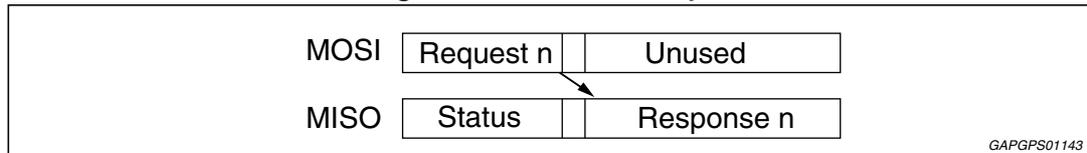
All items in the safing records, except En(Record Enable) bit, can be configured only in Diag state (refer to *Figure 10*). Additionally, the global bit to select internal or external safing engine is set in Init state.

### 12.3 In-frame and out-of-frame responses

Some sensors will communicate data within the current communication frame while others will send data on the next communication frame. Sometimes this is sensor specific and sometimes this is due to the amount of data to be transmitted. A simplified diagram shows the basic communication differences of in and out of frame responses.

In-frame example:

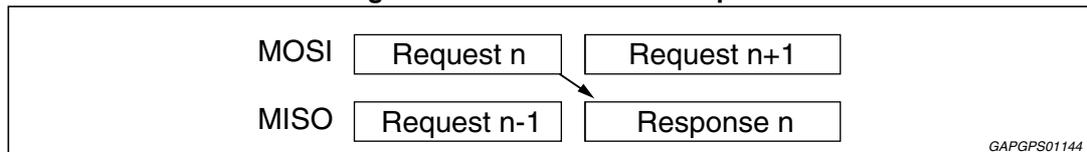
Figure 56. In-frame example



At least one bit needed to allow for synchronization between clock domains (SPI clock and system clock).

Out-of-frame example:

Figure 57. Out-of-frame example



Synchronization between clock domains relies upon inter-frame gap.

## 12.4 Safing state machine operation

State machine operation is disabled when the safing state machine reset signal is active as described in the power supply diagnostics and controls section of this document. The outputs of the state machine are ARMxREQ. As previously stated, there is a maximum of 16 safing records available to the state machine. Inputs to the safety state machine are programmed safing records and sensor data. The configuration of the state machine is common to all sensors.

### 12.4.1 Simple threshold comparison operation

In this mode, sensor data received through the sensor SPI interface and validated by the safing record is passed to the safing algorithm. The simple threshold comparison algorithm compares the received data to two thresholds, SAF\_TH (positive threshold) and (-SAF\_TH) (negative threshold). If the sensor data is greater than SAF\_TH or is less than (-SAF\_TH) then an event is flagged and the event counter is incremented based on the programmed value of ADD\_VAL. If sensor data does not trigger the SAF\_TH comparators, the counter is decremented by SUB\_VAL. SUB\_VAL is programmed by the user and can be same or different than ADD\_VAL. This feature allows for an asymmetrical counter function making the system either more or less sensitive to sensor data. Since sensor data can indicate a positive or negative event, the algorithm maintains separate event counters, POS\_COUNT and NEG\_COUNT. ADD\_VAL and SUB\_VAL programmed values are the same for both event counters.

On each sensor sample, the event counters, POS\_COUNT and NEG\_COUNT, are updated based on the SAF\_TH comparators. Likewise, each event counter is compared with a corresponding arming threshold. In this case, POS\_COUNT value is compared to ARMP\_TH and NEG\_COUNT to ARMN\_TH. ARMP\_TH and ARMN\_TH are programmable thresholds set by the user. The compared result will set ARMP and ARMN to either '1' or '0' depending on the comparison status. If ARMP\_TH or ARMN\_TH are set to 0, the arming will be activated immediately entering in safing state.

POS\_COUNT and NEG\_COUNT are not updated if microcontroller stops reading SAF\_CC bits (this must be avoided otherwise ARMING set and reset will not be possible).

By way of the assignment of the ADD\_VAL, SUB\_VAL, ARMP\_TH and ARMN\_TH settings, the safing engine can be configured to assert arming for either a simple accumulation of COUNTs in a non-consecutive manner, or it could be set to require some number of consecutive samples.

## 12.5 Safing engine output logic (ARMxINT)

SPI messages are monitored and mapped to specific safing records. Each safing record is configured with its own threshold, dwell time and the appropriate ARMxINT signal to activate if safing criteria are met.

Any enabled safing record can be programmed to an arming signal. All safing records arming status is logically 'OR'd' to its programmed arming signal. For example, if safing records 1, 2, 4 are programmed to ARMINT1 and the records are enabled, any of the records can set the ARMINT1 signal. Configuration of safing record mapping to ARMxINT signals is specified in the in the SAF\_CONTROL\_x register (refer to [Table 65](#)).

While in Diag state, L9679P allows diagnostics of the squib driver HS and LS FETs, ARM pins, VSF output and firing timers. The ARM and VSF output tests are mutually exclusive.

For safety purposes, the safing logic circuitry is physically separated from the circuitry that contains the deployment logic.

Figure 58. Safing engine arming flow diagram

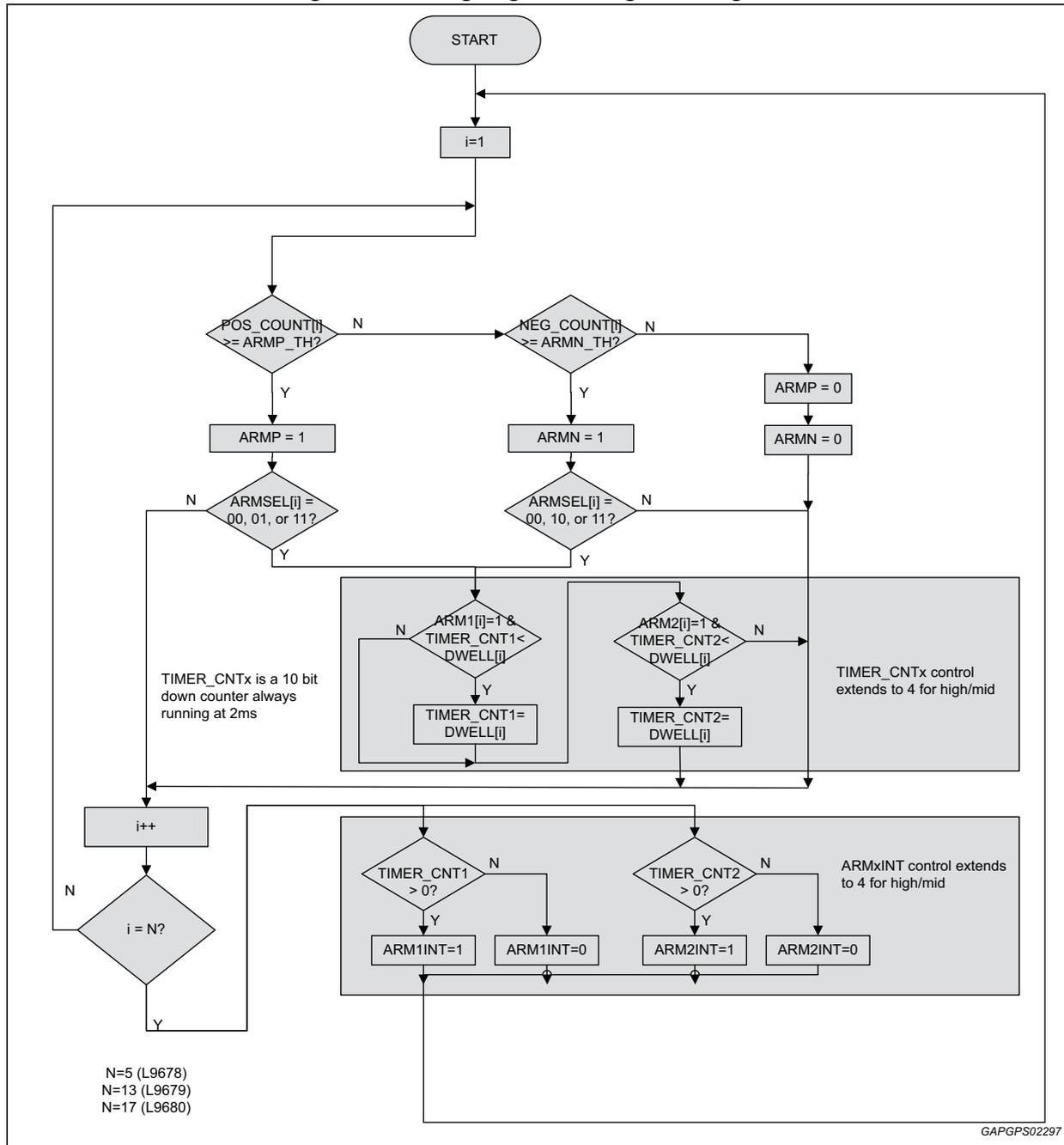
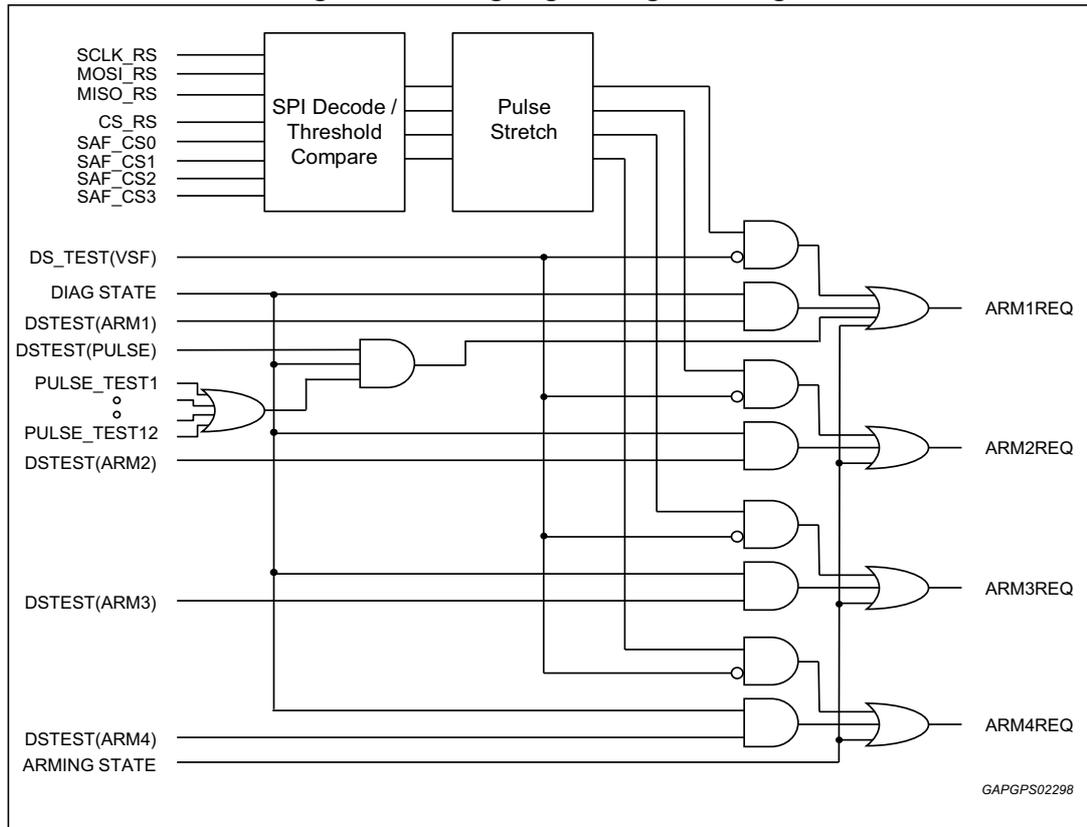


Figure 59. Safing engine diagnostic logic

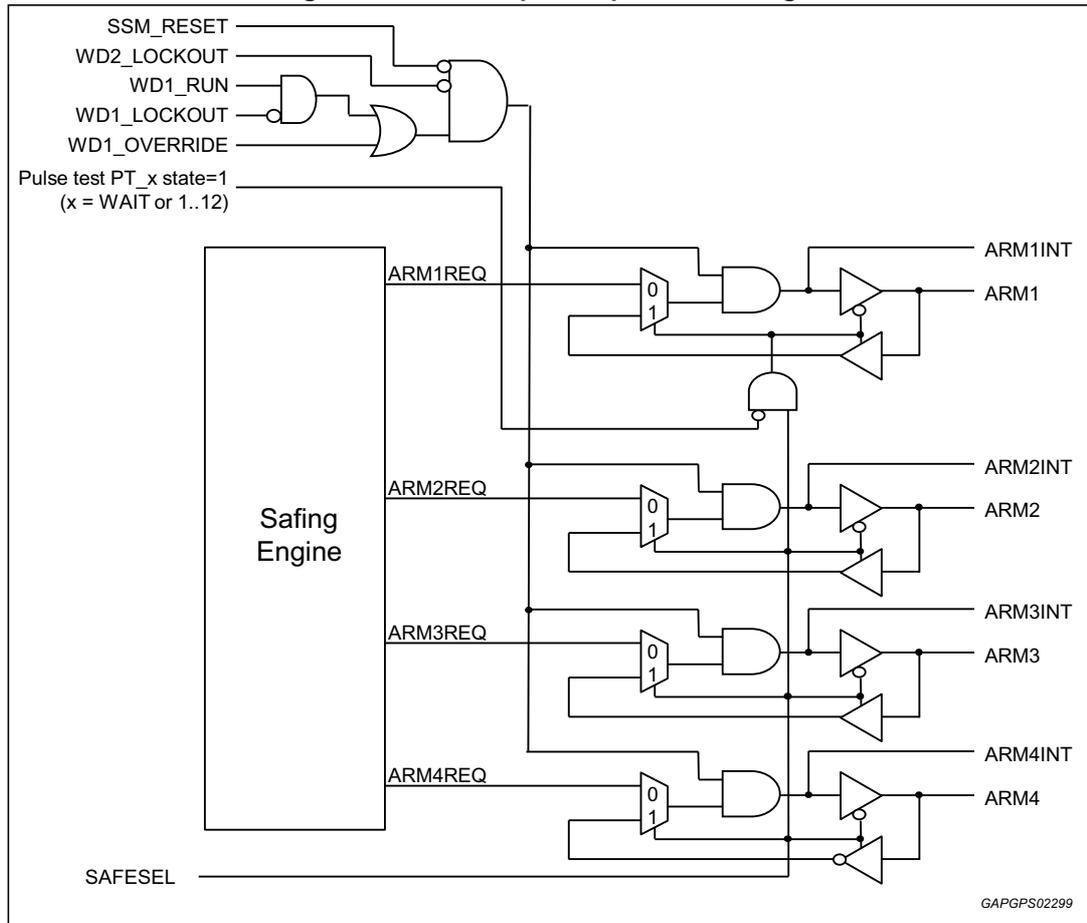


A configurable mask for each internal ARMxINT signal is available for all of the integrated deployment loops. The un-masked ARMxINT signal for each loop will enable the respective loop drivers.

Activation of VSF (regulation rail for High Side Safing FET) occurs upon ARMxINT. Actual High Side Safing FET activation still requires microcontroller signal.

L9679P is able to provide arming signals to external deployment loops by means of four discrete output ARMx pins.

Figure 60. ARMx input/output control logic



### 12.5.1 Arming pulse stretch

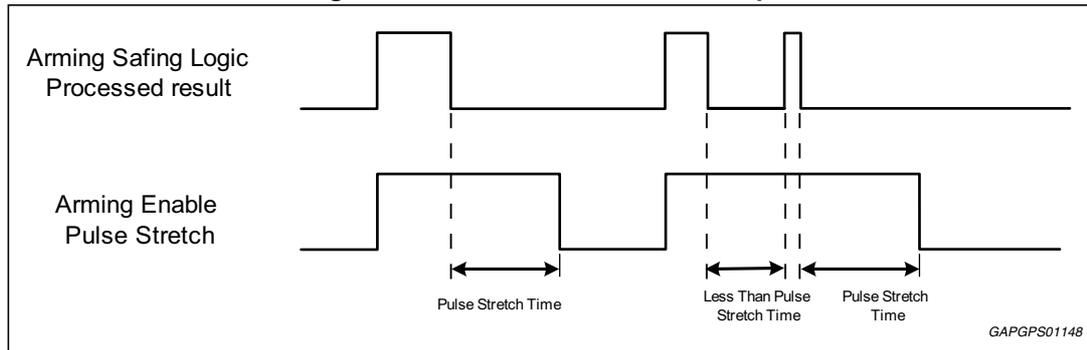
Upon a valid command processed by the safing logic, the Dwell bit to stretch the arming time assertion (dwell time) applies to each safing record and is used to help safe the deployment sequence to avoid undesired behaviour.

Once dwell time has started, it will continue, regardless of the En (Record Enable) bit. Dwell will be truncated in case of SSM reset. Dwell values in the safing records are transferred to the ARMx signals. A dedicated counter is designed for each ARMx output pin. If different dwell values are assigned to the same ARMx, the longer value is used. Dwell times can only be extended, not reduced. If the remaining dwell time is less than the new dwell extension setting, the new setting will be loaded into the dwell counter.

Dwell times are user programmable.

The behaviour of the pulse stretch timer is shown below.

Figure 61. Pulse stretch timer example



The Arming Enable Pulse Stretch Timer status is available in the AEPSTS register.

## 12.6 Additional communication line

The ACL pin is the Additional Communication Line input that provides a means of safely activating the arming outputs (ARMx and VSF) for disposal of restraints devices at the end of vehicle life.

The handshake sequence for activating the Arming outputs is illustrated in *Figure 62*. The strategy involves generation of a seed value from within the L9679P device using a free-running 8-bit counter running at  $f_{SCRAP\_SEED}$  rate, where it can be read by the microcontroller. The microcontroller uses it to generate an 8-bit key value. When the seed value is read (SPI SCRAP\_SEED command), L9679P also freezes the seed value and computes its own key, which is used for comparison to the key subsequently submitted by the microcontroller. The key value is submitted by the microcontroller using the SCRAP\_KEY command, and successful reception of this command with a key value matching the internally calculated key allows the successful completion of the first handshake. After that, in case a second handshake (seed-key) completes successfully and if a valid ACL is detected (as described below) the L9679P transitions from Scrap state to Arming state. To remain in Arming state the microcontroller must periodically refresh L9679P with the SCRAP\_KEY command containing the correct key value in the data field of the command, and L9679P must also receive the correct ACL signal. This must occur before the scrap timeout timer expires ( $T_{SCRAP\_TIMEOUT}$ ). The scrap key is derived from the seed value using a simple logical inversion on the even-numbered bits (0, 2, 4, 6). From a logical standpoint, this is equivalent to a bit-wise XOR of the seed value with 0x55.

While the SSM is in Arming state, the arming outputs are asserted (ARMx=1, VSF on). If the periodic scrap key is incorrect, or not received before the timeout expires, or the ACL is not correctly received, the SSM reverts back to the Scrap state, and the arming outputs are deactivated.

Figure 62. Scrap SEED-KEY state diagram

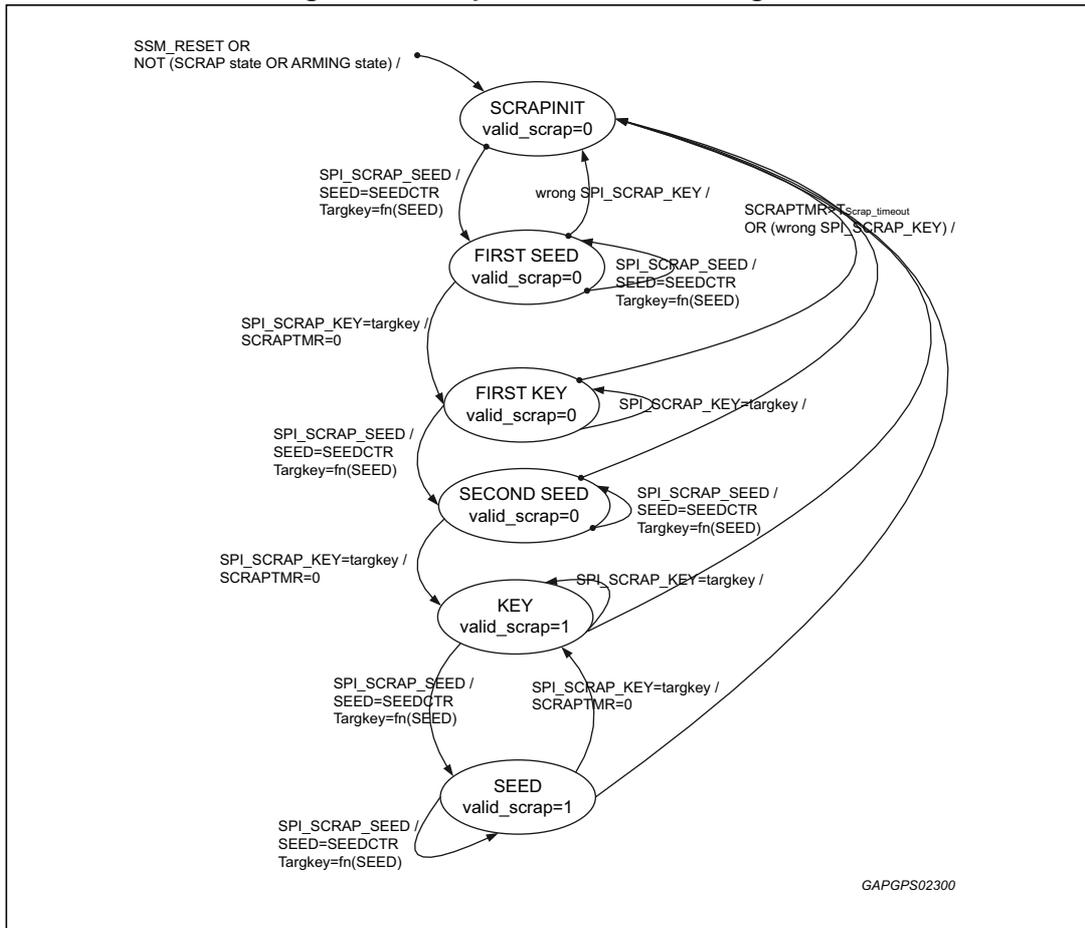
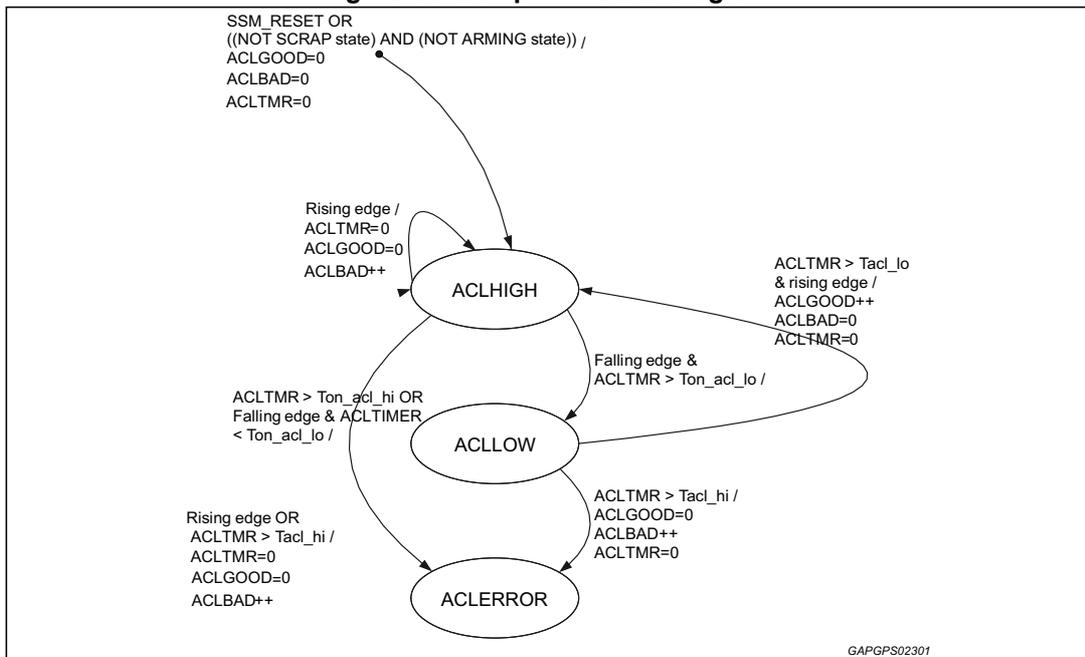


Figure 63. Scrap ACL state diagram

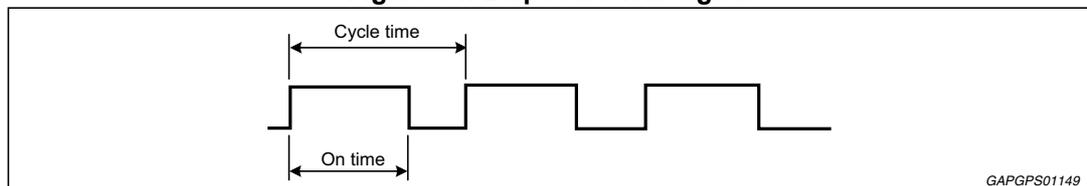


A specific waveform needs to be present on ACL input in order to instruct L9679P to arm all deployment loops. L9679P is designed to support the Additional Communication Line (ACL) aspect of the ISO-26021 standard, which requires an independent hardwired signal (ACL) to implement the scrapping feature. The disposal signal may come from either the vehicle's service connector, or the systems main microcontroller, depending on the end customer's requirements.

The arming function monitors the disposal PWM input (ACL pin) for a command to arm all loops for vehicle end-of-life airbag disposal. The disposal signal characteristic is shown in *Figure 64*. To remain in Arming state, at least three cycles of the ACL signal must be qualified (in addition to the periodic KEY value being received from the microcontroller). For the device to qualify the periodic ACL signal, the period and duty cycle are checked. Two consecutive cycles of invalid disposal signal are to be received to disqualify the ACL signal.

If the logic detects that the signal is incorrect or missing while in Scrap state, the device will stay in Scrap state; would it happen in Arming state, it will transition to Scrap state immediately.

**Figure 64. Disposal PWM signal**



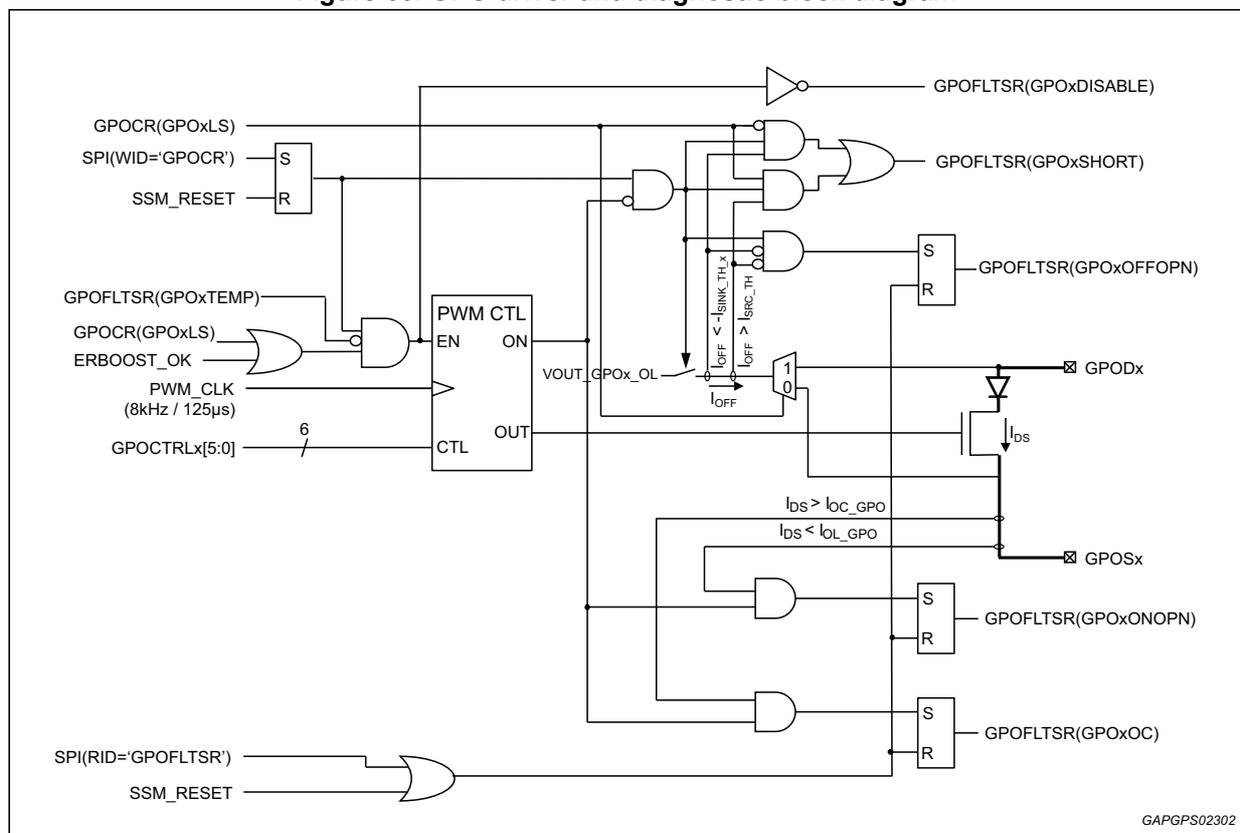
The disposal PWM signal cycle time and on time parameters can be found in the electrical parameters tables.

### 13 General purpose output (GPO) drivers

The L9679P contains three General Purpose Output (GPO) drivers configurable either as high-side or low-side modes. The drivers can be independently controlled in ON-OFF mode or in PWM mode setting the desired duty cycle value through the GPO Control Register (GPOCTRLx).

For low side driver configuration, the GPODx pin is the drain connection of an internal MOSFET and is the current sink for the output driver. The GPOSx pin is the source connection of the internal MOSFET and is externally connected to ground. For high side driver configuration, the GPODx pin will be connected to battery and GPOSx pin will be connected to load's high side.

**Figure 65. GPO driver and diagnostic block diagram**



The drivers are configured in one of the two modes through the GPO Configuration Register (GPOCR) register. This hardware configuration is only allowed during the Init and Diag states.

When configured as high-side, the drivers need ER Boost voltage to be above the  $V_{ERBST\_OK}$  threshold to be enabled.

The default state of all drivers is off. The drivers can be independently activated via SPI control bits on GPO Control Register (GPOCTRLx). In addition, a set point on the GPOCTRLx will control the output drivers in PWM with a 125Hz frequency. If PWM control is desired, user should set the needed set point in the GPOxPWM bits of the GPOCTRLx while activating the interface. When all bits are set to '0', the GPOx output will be disabled.

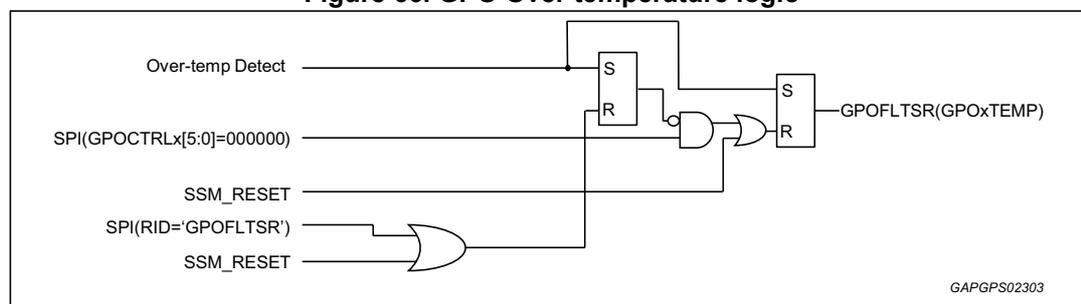
PWM control is based on a 125Hz frequency. 6 bits of GPOCTRLx are reserved to this mode, in order to control the drivers with 64 total levels from a 0% to a full 100% duty cycle.

When both GPO channels are used in PWM Mode at the same frequency they are synchronized to provide parallel configuration capability.

PWM control is implemented through a careful slew rate control to mitigate EMC emissions while operating the interface. The driver output structure is designed to stand -1V on its terminals and a +1V reverse voltage across source and drain.

The GPO driver is protected against short circuits and thermal overload conditions. The output driver contains diagnostics available in the GPO Fault Status Register (GPOFLTSR). All faults except for thermal overload will be latched until the GPOFLTSR register is read. Thermal overload faults will remain active after reading the GPOFLTSR register should the temperature remain above the thermal fault condition. For current limit faults, the output driver will operate in a linear mode (ILIM) until a thermal fault condition is detected.

Figure 66. GPO Over temperature logic



The device offers also an open load diagnostics while in ON state. The diagnostics is run comparing the current through the output stage with a reference threshold  $I_{OpenLoad}$ : should the output current be lower than the threshold, the open detection flag is asserted.

The device is also able to detect a fault condition during the OFF state by means of the Voltage Regulator Current Monitor (VRCM) block. During the OFF state the VRCM block tries to force a voltage  $V_{OUT\_GPOx\_OL}$  (2.5 V) on GPOD pin if LS mode is selected (with a current limitation of  $I_{LIM\_GPOD\_SRC/SINK}$ ) or on GPOS pin if the HS mode is selected (with a current limitation of  $I_{LIM\_GPOS\_SRC/SINK}$ ) and, at the same, it compares the current sourced or sunk in order to detect if a fault on GPO pins is present. The diagnostic in OFF state is able to detect the open load in both HS and LS modes, the short to ground fault in LS mode and the short to battery fault in HS mode:

Table 16. Short to ground fault in LS mode

|  | LS MODE   |            | Interpretation  |
|--|-----------|------------|-----------------|
|  | GPOxSHORT | GPOxOFFOPN |                 |
| $I_{OFF} > I_{SRC\_TH}$                      | 1         | 0          | Short to ground |
| $- I_{SINK\_TH\_LS} < I_{OFF} < I_{SRC\_TH}$ | 0         | 1          | Open            |
| $I_{OFF} < - I_{SINK\_TH\_LS}$               | 0         | 0          | Normal          |

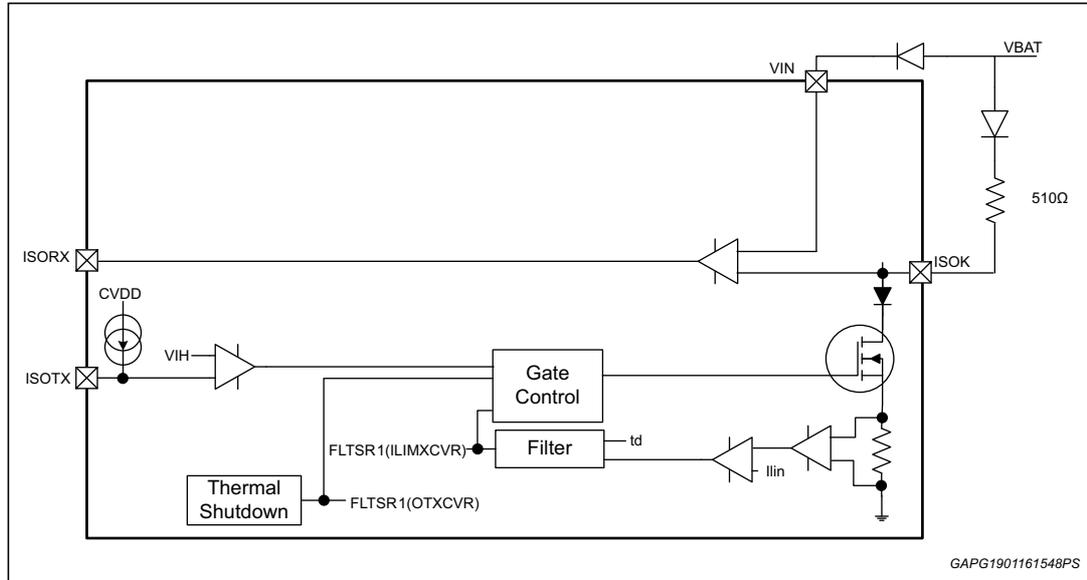
Table 17. Short to battery fault in HS mode

|  | HS MODE   |            | Interpretation   |
|--|-----------|------------|------------------|
|  | GPOxSHORT | GPOxOFFOPN |                  |
| $I_{OFF} > I_{SRC\_TH}$                      | 0         | 0          | Normal           |
| $- I_{SINK\_TH\_HS} < I_{OFF} < I_{SRC\_TH}$ | 0         | 1          | Open             |
| $I_{OFF} < - I_{SINK\_TH\_HS}$               | 1         | 0          | Short to battery |

# 14 ISO9141 Transceiver (K-Line)

A block diagram of the function is shown below. Data transmitted by the main microcontroller is sent via the ISOTX pin and data is received via the ISORX pin. The bus output is ISOK.

Figure 67. ISO9141 block diagram



When the ISOTX pin is asserted, logic high, the ISOK output will be disabled (pulled up by an external resistor). When the ISOTX pin is logic low, the ISOK output will be enabled (pulled down by the internal driver). This input pin contains an internal pull-up to command the output to the disabled state in the event of an open circuit condition.

The ISORX pin has a push-pull output stage referenced to VDDQ voltage. This output is asserted high when the voltage on the ISOK pin is above the ISOK input receiver threshold, VBATMON, as defined in the electrical tables, while it is low when the voltage on the ISOK pin is below the ISOK input receiver threshold with hysteresis.

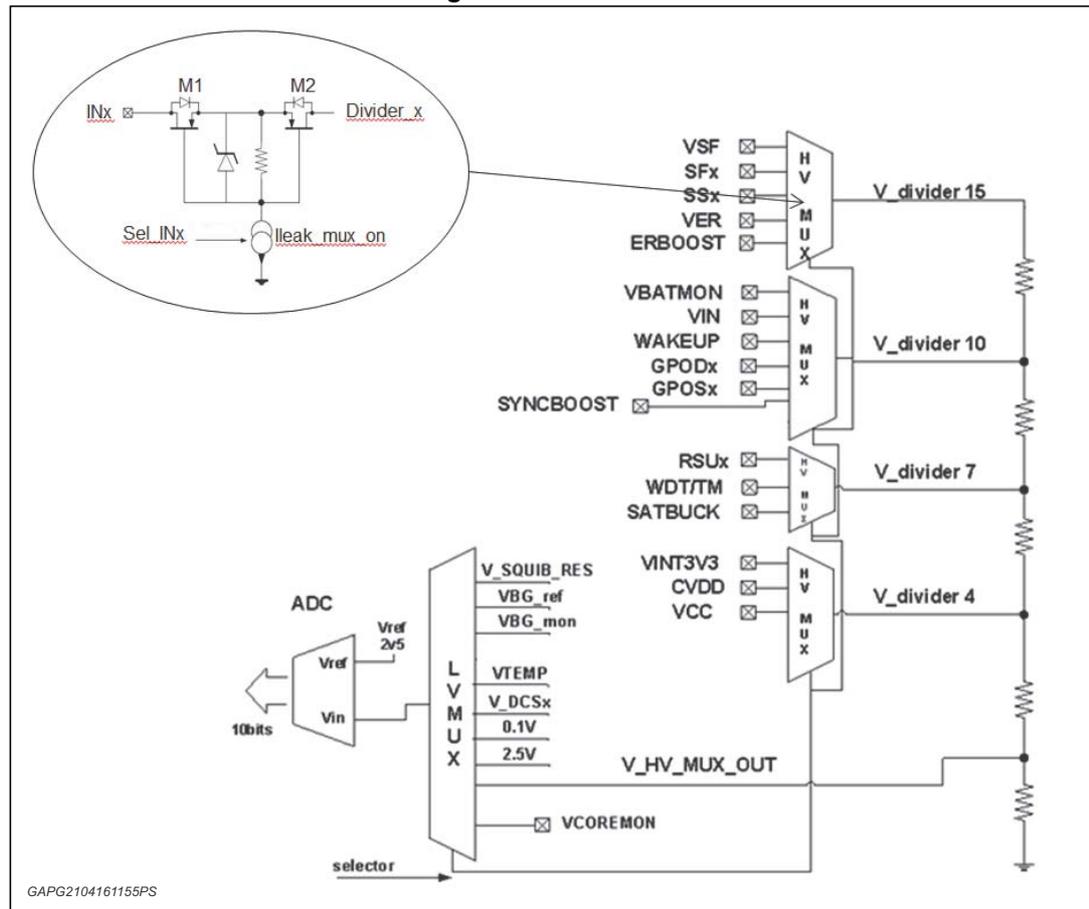
ISOK output is a low side driver compatible with ISO9141 physical layer.

The output stage is protected against short circuits and diagnostics provide feedback for current limit and thermal shutdown. While in current limit, the output stage will continue to function until thermal limit is reached. If the thermal limit occurs, the output stage will shut down until the temperature decreases below the limit threshold with hysteresis. The fault status is reported in the ISO9141 Fault Status Register (ISOFLTSR).

# 15 System voltage diagnostics

L9679P has an integrated dedicated circuitry to provide diagnostic feedback and processing of several inputs. These inputs are addressed with an internal analog multiplexer and made available through the SPI digital interface with the Diagnostic Data commands. In order to avoid saturation of high voltage internal signals, an internal voltage divider is used.

Figure 68. ADC MUX



The diagnostics circuitry is activated by four SPI Diagnostics Control commands (DIAGCTRLx); each of them can address all the available nodes to be monitored, except for what mentioned in [Table 18](#).

DIAGCTRLx SPI command bit fields are structured in the following way:

### DIAGCTRL\_A (ADDRESS HEX 3A)

|      | 19        | 18 | 17 | 16            | 15 | 14 | 13 | 12            | 11 | 10 | 9 | 8 | 7 | 6             | 5 | 4 | 3 | 2 | 1 | 0 |
|------|-----------|----|----|---------------|----|----|----|---------------|----|----|---|---|---|---------------|---|---|---|---|---|---|
| MOSI |           |    |    |               | x  | x  | x  | x             | x  | x  | x | x | x | ADCREQ_A[6:0] |   |   |   |   |   |   |
| MISO | NEWDATA_A | 0  | 0  | ADCREQ_A[6:0] |    |    |    | ADCRES_A[9:0] |    |    |   |   |   |               |   |   |   |   |   |   |

**DIAGCTRL\_B (ADDRESS HEX 3B)**

|      |           |    |    |                |    |    |    |    |    |                |   |   |   |                |   |   |   |   |   |   |
|------|-----------|----|----|----------------|----|----|----|----|----|----------------|---|---|---|----------------|---|---|---|---|---|---|
|      | 19        | 18 | 17 | 16             | 15 | 14 | 13 | 12 | 11 | 10             | 9 | 8 | 7 | 6              | 5 | 4 | 3 | 2 | 1 | 0 |
| MOSI |           |    |    |                | x  | x  | x  | x  | x  | x              | x | x | x | ADCREQ_B [6:0] |   |   |   |   |   |   |
| MISO | NEWDATA_B | 0  | 0  | ADCREQ_B [6:0] |    |    |    |    |    | ADCRES_B [9:0] |   |   |   |                |   |   |   |   |   |   |

**DIAGCTRL\_C (ADDRESS HEX 3C)**

|      |           |    |    |                |    |    |    |    |    |                |   |   |   |                |   |   |   |   |   |   |
|------|-----------|----|----|----------------|----|----|----|----|----|----------------|---|---|---|----------------|---|---|---|---|---|---|
|      | 19        | 18 | 17 | 16             | 15 | 14 | 13 | 12 | 11 | 10             | 9 | 8 | 7 | 6              | 5 | 4 | 3 | 2 | 1 | 0 |
| MOSI |           |    |    |                | x  | x  | x  | x  | x  | x              | x | x | x | ADCREQ_C [6:0] |   |   |   |   |   |   |
| MISO | NEWDATA_C | 0  | 0  | ADCREQ_C [6:0] |    |    |    |    |    | ADCRES_C [9:0] |   |   |   |                |   |   |   |   |   |   |

**DIAGCTRL\_D (ADDRESS HEX 3D)**

|      |           |    |    |                |    |    |    |    |    |                |   |   |   |                |   |   |   |   |   |   |
|------|-----------|----|----|----------------|----|----|----|----|----|----------------|---|---|---|----------------|---|---|---|---|---|---|
|      | 19        | 18 | 17 | 16             | 15 | 14 | 13 | 12 | 11 | 10             | 9 | 8 | 7 | 6              | 5 | 4 | 3 | 2 | 1 | 0 |
| MOSI |           |    |    |                | x  | x  | x  | x  | x  | x              | x | x | x | ADCREQ_D [6:0] |   |   |   |   |   |   |
| MISO | NEWDATA_D | 0  | 0  | ADCREQ_D [6:0] |    |    |    |    |    | ADCRES_D [9:0] |   |   |   |                |   |   |   |   |   |   |

ADCREQ[A-D] bit fields, used to address the different measurements offered, are listed in [Table 18](#) for reference.

L9679P diagnostics is structured to take four automatic conversions at a time. In order to get four measurements, four different SPI commands have to be sent (DIAGCTRL\_A, DIAGCTRL\_B, DIAGCTRL\_C and DIAGCTRL\_D), in no particular order.

In case the voltage to be measured is not immediately available, the desired inputs for conversion have to be programmed by SPI in advance, to allow them to attain a stable voltage value. This case applies to the squib resistance measurement and diagnostics (refer to [Loop diagnostics control and results registers](#)) and to the DC sensor measurement (refer to [Section 11](#)).

CONVRDY\_0 bit in GSW is equal to (NEWDATA\_A or NEWDATA\_B), while CONVRDY\_1 bit in GSW corresponds to (NEWDATA\_C or NEWDATA\_D).

Each NEWDATAx flag is asserted when conversion is finished and cleared when result is read out. However result is cleared only when new result for that register is available.

When a new request is received it is queued if other conversions are ongoing. The conversions are executed in the same order as their request arrived. The queue is 4 measures long so it's possible to send all 4 requests at the same time and then wait for the results. If a DIAGCTRLRx command is received twice, the second conversion request will overwrite the previous one.

Requests are sent to the L9679P IC via the ADC measurement Registers (ADCREQx) as shown in [Table 18](#). All diagnostics results are available on the ADCRESx registers, when addressed by the related ADCREQx register (e.g. data requested by ADCREQA would be written to ADCRESA).

Table 18. Diagnostics control register (DIAGCTRLx)

| ADC Request (ADCREQx) |   |   |   |   |   |   |      | Voltage Measurement Selection                           | ADC Results (ADCRESx)      |
|-----------------------|---|---|---|---|---|---|------|---|----------------------------|
| Bit[6:0]              |   |   |   |   |   |   | Hex  |   | Bit[9:0]                   |
| 0                     | 0 | 0 | 0 | 0 | 0 | 0 | \$00 | Unused  |                            |
| 0                     | 0 | 0 | 0 | 0 | 0 | 1 | \$01 | ADC ground reference                                    | V <sub>ADC_GROUND</sub>    |
| 0                     | 0 | 0 | 0 | 0 | 1 | 0 | \$02 | ADC Test Pattern 2                                      | V <sub>ADC_FULLSCALE</sub> |
| 0                     | 0 | 0 | 0 | 0 | 1 | 1 | \$03 | DC Sensor ch. selected, Voltage                         | DCSV_selected              |
| 0                     | 0 | 0 | 0 | 1 | 0 | 0 | \$04 | DC Sensor ch. selected, Current                         | DCSI_selected              |
| 0                     | 0 | 0 | 0 | 1 | 0 | 1 | \$05 | DC Sensor ch. selected, Resistance <sup>(1)</sup>       | DCSV and DCSI selected     |
| 0                     | 0 | 0 | 0 | 1 | 1 | 0 | \$06 | Squib measurement loop selected                         | Voutx                      |
| 0                     | 0 | 0 | 0 | 1 | 1 | 1 | \$07 | Internal reference Voltage                              | VBGR                       |
| 0                     | 0 | 0 | 1 | 0 | 0 | 0 | \$08 | Internal reference monitor Voltage                      | VBGM                       |
| 0                     | 0 | 0 | 1 | 0 | 0 | 1 | \$09 |   |                            |
| 0                     | 0 | 0 | 1 | 0 | 1 | 0 | \$0A | Temperature Measurement                                 | TEMP                       |
| 0                     | 0 | 0 | 1 | 0 | 1 | 1 | \$0B | DC Sensor ch 0, Voltage                                 | DCSV_0                     |
| 0                     | 0 | 0 | 1 | 1 | 0 | 0 | \$0C | DC Sensor ch 1, Voltage                                 | DCSV_1                     |
| 0                     | 0 | 0 | 1 | 1 | 0 | 1 | \$0D | DC Sensor ch 2, Voltage                                 | DCSV_2                     |
| 0                     | 0 | 0 | 1 | 1 | 1 | 0 | \$0E | DC Sensor ch 3, Voltage                                 | DCSV_3                     |
| 0                     | 0 | 0 | 1 | 1 | 1 | 1 | \$0F | DC Sensor ch 4, Voltage                                 | DCSV_4                     |
| 0                     | 0 | 1 | 0 | 0 | 0 | 0 | \$10 | DC Sensor ch 5, Voltage                                 | DCSV_5                     |
| 0                     | 0 | 1 | 0 | 0 | 0 | 1 | \$11 | DC Sensor ch 6, Voltage                                 | DCSV_6                     |
| 0                     | 0 | 1 | 0 | 0 | 1 | 0 | \$12 | DC Sensor ch 7, Voltage                                 | DCSV_7                     |
| 0                     | 0 | 1 | 0 | 0 | 1 | 1 | \$13 | DC Sensor ch 8, Voltage                                 | DCSV_8                     |
| 0                     | 0 | 1 | 0 | 1 | 0 | 0 | \$14 | V <sub>B</sub> voltage of ER ESR measure <sup>(2)</sup> | V <sub>B</sub>             |
| 0                     | 0 | 1 | 0 | 1 | 0 | 1 | \$15 | V <sub>A</sub> voltage of ER ESR measure <sup>(2)</sup> | V <sub>A</sub>             |
| 0                     | 0 | 1 | 0 | 1 | 1 | 0 | \$16 | V <sub>C</sub> voltage of ER ESR measure <sup>(2)</sup> | V <sub>C</sub>             |
| 0                     | 0 | 1 | 0 | 1 | 1 | 1 | \$17 | Unused  |                            |
| 0                     | 0 | 1 | 1 | 0 | 0 | 0 | \$18 | Unused  |                            |
| 0                     | 0 | 1 | 1 | 0 | 0 | 1 | \$19 | Unused  |                            |
| 0                     | 0 | 1 | 1 | 0 | 1 | 0 | \$1A | Unused  |                            |
| 0                     | 0 | 1 | 1 | 0 | 1 | 1 | \$1B | Unused  |                            |
| 0                     | 0 | 1 | 1 | 1 | 0 | 0 | \$1C | Unused  |                            |
| 0                     | 0 | 1 | 1 | 1 | 0 | 1 | \$1D | Unused  |                            |
| 0                     | 0 | 1 | 1 | 1 | 1 | 0 | \$1E | Unused  |                            |
| 0                     | 0 | 1 | 1 | 1 | 1 | 1 | \$1F | Unused  |                            |
| 0                     | 1 | 0 | 0 | 0 | 0 | 0 | \$20 | VBATMON pin voltage                                     | VBATMON                    |

Table 18. Diagnostics control register (DIAGCTRLx) (continued)

| ADC Request (ADCREQx) |   |   |   |   |   |   |      | Voltage Measurement Selection            | ADC Results (ADCRESx) |
|-----------------------|---|---|---|---|---|---|------|--|-----------------------|
| Bit[6:0]              |   |   |   |   |   |   | Hex  |  | Bit[9:0]              |
| 0                     | 1 | 0 | 0 | 0 | 0 | 1 | \$21 | VIN pin voltage                          | VIN                   |
| 0                     | 1 | 0 | 0 | 0 | 1 | 0 | \$22 | Internal analog supply voltage (VINT3V3) | VINT3V3               |
| 0                     | 1 | 0 | 0 | 0 | 1 | 1 | \$23 | Internal digital supply voltage (CVDD)   | CVDD                  |
| 0                     | 1 | 0 | 0 | 1 | 0 | 0 | \$24 | ERBOOST pin voltage                      | ERBOOST               |
| 0                     | 1 | 0 | 0 | 1 | 0 | 1 | \$25 | SYNCBOOST pin voltage                    | SYNCBOOST             |
| 0                     | 1 | 0 | 0 | 1 | 1 | 0 | \$26 | VER pin voltage                          | VER                   |
| 0                     | 1 | 0 | 0 | 1 | 1 | 1 | \$27 | SATBUCK voltage                          | SATBUCK               |
| 0                     | 1 | 0 | 1 | 0 | 0 | 0 | \$28 | VCC voltage                              | VCC                   |
| 0                     | 1 | 0 | 1 | 0 | 0 | 1 | \$29 | WAKEUP pin voltage                       | WAKEUP                |
| 0                     | 1 | 0 | 1 | 0 | 1 | 0 | \$2A | VSF pin voltage                          | VSF                   |
| 0                     | 1 | 0 | 1 | 0 | 1 | 1 | \$2B | WDTDIS pin voltage                       | WDTDIS                |
| 0                     | 1 | 0 | 1 | 1 | 0 | 0 | \$2C | GPOD0 pin voltage                        | GPOD0                 |
| 0                     | 1 | 0 | 1 | 1 | 0 | 1 | \$2D | GPOS0 pin voltage                        | GPOS0                 |
| 0                     | 1 | 0 | 1 | 1 | 1 | 0 | \$2E | GPOD1 pin voltage                        | GPOD1                 |
| 0                     | 1 | 0 | 1 | 1 | 1 | 1 | \$2F | GPOS1 pin voltage                        | GPOS1                 |
| 0                     | 1 | 1 | 0 | 0 | 0 | 0 | \$30 | GPOD2 pin voltage                        | GPOD2                 |
| 0                     | 1 | 1 | 0 | 0 | 0 | 1 | \$31 | GPOS2 pin voltage                        | GPOS2                 |
| 0                     | 1 | 1 | 0 | 0 | 1 | 0 | \$32 | RSU0 pin Voltage                         | RSU0                  |
| 0                     | 1 | 1 | 0 | 0 | 1 | 1 | \$33 | RSU1 pin Voltage                         | RSU1                  |
| 0                     | 1 | 1 | 0 | 1 | 0 | 0 | \$34 |  |                       |
| 0                     | 1 | 1 | 0 | 1 | 0 | 1 | \$35 |  |                       |
| 0                     | 1 | 1 | 0 | 1 | 1 | 0 | \$36 | SS0 pin voltage                          | SS0                   |
| 0                     | 1 | 1 | 0 | 1 | 1 | 1 | \$37 | SS1 pin voltage                          | SS1                   |
| 0                     | 1 | 1 | 1 | 0 | 0 | 0 | \$38 | SS2 pin voltage                          | SS2                   |
| 0                     | 1 | 1 | 1 | 0 | 0 | 1 | \$39 | SS3 pin voltage                          | SS3                   |
| 0                     | 1 | 1 | 1 | 0 | 1 | 0 | \$3A | SS4 pin voltage                          | SS4                   |
| 0                     | 1 | 1 | 1 | 0 | 1 | 1 | \$3B | SS5 pin voltage                          | SS5                   |
| 0                     | 1 | 1 | 1 | 1 | 0 | 0 | \$3C | SS6 pin voltage                          | SS6                   |
| 0                     | 1 | 1 | 1 | 1 | 0 | 1 | \$3D | SS7 pin voltage                          | SS7                   |
| 0                     | 1 | 1 | 1 | 1 | 1 | 0 | \$3E |  |                       |
| 0                     | 1 | 1 | 1 | 1 | 1 | 1 | \$3F |  |                       |
| 1                     | 0 | 0 | 0 | 0 | 0 | 0 | \$40 |  |                       |
| 1                     | 0 | 0 | 0 | 0 | 0 | 1 | \$41 |  |                       |

Table 18. Diagnostics control register (DIAGCTRLx) (continued)

| ADC Request (ADCREQx) |   |   |   |   |   |   |      | Voltage Measurement Selection | ADC Results (ADCRESx) |
|-----------------------|---|---|---|---|---|---|------|-------------------------------|-----------------------|
| Bit[6:0]              |   |   |   |   |   |   | Hex  |                               | Bit[9:0]              |
| 1                     | 0 | 0 | 0 | 0 | 1 | 0 | \$42 | Unused                        | -                     |
| 1                     | 0 | 0 | 0 | 0 | 1 | 1 | \$43 | Unused                        | -                     |
| 1                     | 0 | 0 | 0 | 1 | 0 | 0 | \$44 | Unused                        | -                     |
| 1                     | 0 | 0 | 0 | 1 | 0 | 1 | \$45 | Unused                        | -                     |
| 1                     | 0 | 0 | 0 | 1 | 1 | 0 | \$46 | SF0 pin voltage               | SF0                   |
| 1                     | 0 | 0 | 0 | 1 | 1 | 1 | \$47 | SF1 pin voltage               | SF1                   |
| 1                     | 0 | 0 | 1 | 0 | 0 | 0 | \$48 | SF2 pin voltage               | SF2                   |
| 1                     | 0 | 0 | 1 | 0 | 0 | 1 | \$49 | SF3 pin voltage               | SF3                   |
| 1                     | 0 | 0 | 1 | 0 | 1 | 0 | \$4A | SF4 pin voltage               | SF4                   |
| 1                     | 0 | 0 | 1 | 0 | 1 | 1 | \$4B | SF5 pin voltage               | SF5                   |
| 1                     | 0 | 0 | 1 | 1 | 0 | 0 | \$4C | SF6 pin voltage               | SF6                   |
| 1                     | 0 | 0 | 1 | 1 | 0 | 1 | \$4D | SF7 pin voltage               | SF7                   |
| 1                     | 0 | 0 | 1 | 1 | 1 | 0 | \$4E |                               |                       |
| 1                     | 0 | 0 | 1 | 1 | 1 | 1 | \$4F |                               |                       |
| 1                     | 0 | 1 | 0 | 0 | 0 | 0 | \$50 |                               |                       |
| 1                     | 0 | 1 | 0 | 0 | 0 | 1 | \$51 |                               |                       |

1. The DC sensor resistance measurement can only be addressed through DIAGCTRL\_A command. Results are available through DIAGCTRL\_A and DIAGCTRL\_B, where ADCRES\_A will contain DCSI and ADCRES\_B will contain DCSV.
2. Valid only for ADCREQ\_x field of MISO response when ESR measure results are available.

Proper scaling is necessary for various measurements. The divider ratios vary by measurement and are summarized by function in the table below.

Table 19. Diagnostics divider ratios

| Measurements | Divider Ratio |      |     |     |     |
|--------------|---------------|------|-----|-----|-----|
|              | 15:1          | 10:1 | 7:1 | 4:1 | 1:1 |
| VER          | X             |      |     |     |     |
| ERBOOST      | X             |      |     |     |     |
| VSF          | X             |      |     |     |     |
| SSxy         | X             |      |     |     |     |
| SFx          | X             |      |     |     |     |
| GPODx        |               | X    |     |     |     |
| GPOSx        |               | X    |     |     |     |
| SYNCBOOST    |               | X    |     |     |     |
| VIN          |               | X    |     |     |     |

Table 19. Diagnostics divider ratios (continued)

| Measurements      | Divider Ratio |      |     |     |     |
|-------------------|---------------|------|-----|-----|-----|
|                   | 15:1          | 10:1 | 7:1 | 4:1 | 1:1 |
| VBATMON           |               | X    |     |     |     |
| WAKEUP            |               | X    |     |     |     |
| SATBUCK           |               |      | X   |     |     |
| WDT/TM            |               |      | X   |     |     |
| RSUx              |               |      | X   |     |     |
| VCC               |               |      |     | X   |     |
| CVDD              |               |      |     | X   |     |
| VINT              |               |      |     | X   |     |
| Bandgap (BGR/BGM) |               |      |     |     | X   |

For measurements other than voltage (current, resistance, temperature etc.) the ranges are specified in the electrical parameters section of the relevant block.

## 15.1 Analog to digital algorithmic converter

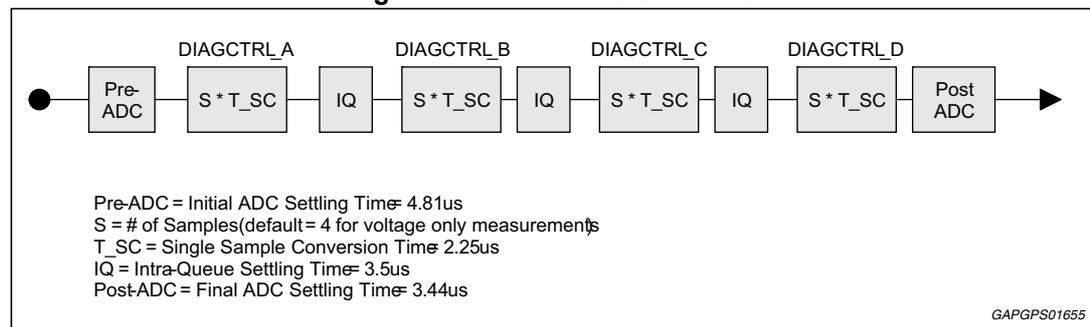
The device hosts an integrated 10 bit Analog to Digital converter, running at a clock frequency of 16 MHz. The ADC output is processed by a D to D converter with the following functions:

- Use of trimming bits to recover additional gain error due to resistor dividers mismatch;
- Digital low-pass filtering;
- Conversion from 12 to 10 bits.

10 bits data are filtered inside the digital section. The number of samples that are filtered vary depending on the chosen conversion. As per [Section 7.3.2](#), the number of used samples in converting DC sensor, squib or temperature measurements defaults to 8. The number of samples for all other measurements defaults to 4. The sample number can be configured by accessing the SYS\_CFG register. After low pass filter, the residual total error is  $\pm 4$  LSB. This error figure applies to the case of a ideal reference voltage: the spread of reference voltage causes a proportional error in the conversion output. The reference voltage of the ADC is set to 2.5 V.

The conversion time is comprised of several factors: the number of measurements loaded into the queue, the number of samples taken for any one measurement, and the various settling times. An example of conversion time calculation for a full ADC request queue is reported in [Figure 69](#). The timings reported in [Figure 69](#) are nominal ones, min/max values can be obtained by considering the internal oscillator frequency variation reported in the DC characteristics section.

**Figure 69. ADC conversion time**



## 16 Temperature sensor

The L9679P provides an internal analog temperature sensor. The sensor is aimed to have a reference for the average junction temperature on silicon surface. The sensor is placed far away from power dissipating stages and squib deployment drivers. The output of the temperature sensor is available via SPI through ADC conversion, as shown in [Table 18](#). The formula to calculate temperature from ADC reading is the following one:

$$T(^{\circ}\text{C}) = 180 - \left\{ \left( \frac{220}{1.652} \right) \cdot \left[ \left( \frac{\text{ADC}_{\text{REF}}}{2^{\text{ADC}_{\text{RES}}}} \cdot \text{DIAGCTRLn}(\text{ADCRESn}) \right) - 0.739 \right] \right\}$$

@ DIAGCTRLn(ADCREQn) = 0A<sub>hex</sub>

All parametric requirements for this block can be found in specification tables.

## 17 Electrical characteristics

Every parameter in this chapter is fulfilled down to  $V_{IN\_GOOD(max)}$ .

No device damage is granted to occur down to  $V_{IN\_BAD(min)}$ .

GNDA pin is used as ground reference for the voltage measurements performed within the device, unless otherwise stated.

All table or parameter declared 'Design Info' are not tested during production testing

### 17.1 Configuration and control

All electrical characteristics are valid for the following conditions unless otherwise noted.

$-40\text{ °C} \leq T_a \leq +95\text{ °C}$ .

**Table 20. Configuration and control DC specifications**

| No | Symbol         | Parameter                 | Conditions   | Min  | Typ  | Max  | Unit       |
|----|----------------|---------------------------|--|------|------|------|------------|
| 1  | $V_{NOV}$      | Normal Operating Voltage  | Design Info<br>Depending on power supply configuration                   | 6    | 13   | 18   | V          |
| 2  | $V_{JSV}$      | Jump Start Voltage        | Design Info<br>$40\text{ °C} \leq T_a \leq 50\text{ °C}$                 | 18   | -    | 26   | V          |
| 3  | $V_{LDV}$      | Load Dump Voltage         | Transient<br>Design Info   | 26.5 | -    | 40   | V          |
| 4  | WU_mon         | WAKEUP Monitor threshold  | GNDSUBx as ground reference<br>$V_{in} = 5.5\text{ V}$ and $35\text{ V}$ | -    | -    | 1.5  | V          |
| 5  | WU_off         | WAKEUP Off threshold      | GNDSUBx as ground reference<br>$V_{in} = 5.5\text{ V}$ and $35\text{ V}$ | 2    | 2.5  | 3    | V          |
| 6  | WU_on          | WAKEUP On threshold       | GNDSUBx as ground reference  | 4    | 4.5  | 5    | V          |
| 7  | WU_RPD         | WAKEUP Pull-down Resistor | GNDSUBx as ground reference  | 120  | 300  | 480  | k $\Omega$ |
| 8  | $V_{B\_GOOD0}$ | VBATMON Thresholds        | SYS_CTL(VBATMON_TH_SEL)=00<br>or 11                                      | 5.5  | 5.75 | 6    | V          |
| 9  | $V_{B\_BAD0}$  |                           | SYS_CTL(VBATMON_TH_SEL)=00<br>or 11                                      | 5    | 5.25 | 5.5  | V          |
| 10 | $V_{B\_GOOD1}$ |                           | SYS_CTL(VBATMON_TH_SEL)=01   | 6.45 | 6.7  | 6.95 | V          |
| 11 | $V_{B\_BAD1}$  |                           | SYS_CTL(VBATMON_TH_SEL)=01   | 5.95 | 6.2  | 6.45 | V          |
| 12 | $V_{B\_GOOD2}$ |                           | SYS_CTL(VBATMON_TH_SEL)=10   | 7.5  | 7.75 | 8    | V          |
| 13 | $V_{B\_BAD2}$  |                           | SYS_CTL(VBATMON_TH_SEL)=10   | 7    | 7.25 | 7.6  | V          |

Table 20. Configuration and control DC specifications (continued)

| No  | Symbol   | Parameter   | Conditions   | Min  | Typ  | Max               | Unit       |
|-----|--|---|--|------|------|-------------------|------------|
| 13b | $\Delta V_{BG00D2\_VB_{BAD}2}$                       | VBATMON delta thresholds                                      | $V_{BG00D2\_VB_{BAD}2}$                                  | 300  | -    | 600               | mV         |
| 14  | $I_{LKG\_VBATMON\_OFF}$                              | VBATMON input leakage   | Device OFF   | -5   | -    | 5                 | $\mu A$    |
| 15  | $I_{LKG\_VBATMON\_ON}$                               |   | Device ON<br>Design Info                                 | 20   | 24   | 30                | $\mu A$    |
| 16  | $R_{PD\_VBATMON}$                                    | VBATMON pull-down resistance                                  | Device ON<br>VBATMON < 10V<br>Design Info                | 125  | 250  | 375               | k $\Omega$ |
| 17  | $I_{LKG\_VBATMON\_TOT}$                              | VBATMON total input leakage                                   | $I_{LKG\_VBATMON\_ON} + R_{PD\_VBATMO}$<br>VBATMON = 18V | 35   | -    | 180               | $\mu A$    |
| 18  | $V_{IN\_GOOD0}$                                      | VIN Good and VIN Bad Thresholds                               | SYS_CTL(VIN_TH_SEL)=0                                    | 5    | 5.25 | 5.5               | V          |
| 19  | $V_{IN\_BAD0}$                                       |   | SYS_CTL(VIN_TH_SEL)=0                                    | 4.5  | 4.75 | 5                 | V          |
| 20  | $V_{IN\_GOOD1}$                                      |   | SYS_CTL(VIN_TH_SEL)=1                                    | 6.05 | 6.3  | 6.55              | V          |
| 21  | $V_{IN\_BAD1}$                                       |   | SYS_CTL(VIN_TH_SEL)=1                                    | 5.55 | 5.8  | 6.05              | V          |
| 22  | $V_{IN\_FASTSLOPE\_H}$                               | VIN Thresholds used to change Boost regulator transition time | -  | 9.3  | 9.8  | 10.3              | V          |
| 23  | $V_{IN\_FASTSLOPE\_L}$                               |   | -  | 9    | 9.5  | 10                | V          |
| 24  | $V_{IN\_FASTSLOPE\_HYS}$                             |   | -  | 0.2  | 0.3  | 0.4               | V          |
| 25  | $V_{IN\_SYNC\_DIS\_L}$                               | VIN SyncBoost Disable Thresholds                              | SYS_CTL(SYBST_V) = 0                                     | 12.2 | -    | 13.6              | V          |
| 26  | $V_{IN\_SYNC\_DIS\_H}$                               |   | SYS_CTL(SYBST_V) = 1                                     | 15   | -    | 16.2              | V          |
| 27  | $V_{IN\_SYNC\_DIS\_LYS}$<br>$V_{IN\_SYNC\_DIS\_HYS}$ |   | SYS_CTL(SYBST_V) = 0 / 1<br>Guaranteed by design         | 5    | -    | 300               | mV         |
| 28  | $I_{LKG\_VIN\_OFF}$                                  | VIN input current   | Device OFF<br>VIN = 40V                                  | -10  | -    | 10                | $\mu A$    |
| 29  | $I_{VIN\_ON}$  | VIN current consumption                                       | Device ON<br>VIN = 12V                                   | -    | -    | 40                | mA         |
| 30  | $C_{VIN}$  | External VIN capacitor  | Design Info  | 1    | -    | 13 <sup>(1)</sup> | $\mu F$    |

Table 20. Configuration and control DC specifications (continued)

| No | Symbol                 | Parameter                         | Conditions  | Min | Typ | Max | Unit        |
|----|------------------------|-----------------------------------|---|-----|-----|-----|-------------|
| 31 | $I_{LKG\_VER\_OFF}$    | VER Input Leakage                 | Device OFF<br>VER = 40V   | -5  | -   | 50  | $\mu A$     |
| 32 | $I_{LKG\_VER\_ON\_L}$  |                                   | Device ON<br>ERBOOST > VER<br>ER Charge OFF   | 50  | -   | 200 | $\mu A$     |
| 33 | $I_{LKG\_VER\_ON\_H}$  |                                   | Device ON<br>ERBOOST < VER<br>ER Charge OFF   | 100 | -   | 500 | $\mu A$     |
| 34 | $V_{WDTDIS\_TH}$       | WDT/TM threshold                  | Test go no go   | 10  | 12  | 14  | V           |
| 35 | $V_{WDTDIS\_HYST}$     | WDT/TM hysteresis                 | Design Info   | 0.2 | 0.4 | 0.5 | V           |
| 36 | $I_{PD\_WDTDIS}$       | WDT/TM Pull Down Resistance       | $V_{WDTDIS} \leq 5V$  | 20  | 45  | 70  | $\mu A$     |
| 37 | $V_{TH2\_H\_VCCSEL\_}$ | VCCSEL Input Voltage Thresholds 2 | -   | 5.9 | 6.4 | 6.9 | V           |
| 38 | $V_{TH2\_L\_VCCSEL}$   |                                   | -   | 5.6 | 6.1 | 6.6 | V           |
| 39 | $V_{HYS2\_VCCSEL}$     |                                   | -   | 0.2 | -   | -   | V           |
| 40 | $I_{PD\_VCCSEL}$       | VCCSEL Pull Down Current          | VCCSEL = SATBUCK  | 20  | 45  | 70  | $\mu A$     |
| 41 | $I_{TOTLKG\_BAT}$      | Battery Line Total Input Leakage  | Room Temp<br>WAKEUP = 0<br>All following pins at 13V:<br>VBATMON, VIN, ERBSTSW,<br>ERBOOST, SYNCBSTSW,<br>SYNCBOOST<br><br>Guaranteed by design | -   | -   | 35  | $\mu A$     |
| 42 | $T_J$                  | Junction Temperature              | Design Info   | -   | -   | 150 | $^{\circ}C$ |

1. Bigger capacitor can be used in case an external switch is used in parallel to the ER-Switch.

Table 21. Configuration and control AC specifications

| No | Symbol                                | Parameter  | Conditions                    | Min  | Typ  | Max  | Unit |
|----|---------------------------------------|--|-------------------------------|------|------|------|------|
| 1  | T <sub>FLT_VBATMONTH</sub>            | VBATMON thresholds<br>deglitch filter time                       | -                             | 26   | 30   | 34   | μs   |
| 2  | T <sub>FLT_VINGOOD_UP</sub>           | VIN Good thresholds<br>deglitch filter time<br>rising edge       | -                             | 3    | 3.5  | 4    | μs   |
| 3  | T <sub>FLT_VINGOOD_DO<br/>WN_L</sub>  | VIN Good thresholds<br>deglitch filter time<br>falling edge      | SYS_CFG(VINGOOD_FILT_SEL) = 0 | -    | 1    | -    | μs   |
| 4  | T <sub>FLT_VINGOOD_DO<br/>WN_H</sub>  | VIN Good thresholds<br>deglitch filter time<br>falling edge      | SYS_CFG(VINGOOD_FILT_SEL) = 1 | 3    | 3.5  | 4    | μs   |
| 6  | T <sub>FLT_VINBAD_DOWN</sub>          | VIN Bad thresholds<br>deglitch filter time<br>falling edge       | -                             | 3    | 3.5  | 4    | μs   |
| 7  | T <sub>FLT_VINBAD_UP</sub>            | VIN Bad thresholds<br>deglitch filter time<br>rising edge        | -                             | 26   | 30   | 34   | μs   |
| 8  | T <sub>VINGOOD_BLK</sub>              | VIN Good Thresholds<br>blanking time                             | -                             | 26   | 30   | 34   | μs   |
| 9  | T <sub>FLT_VINSYNCDIS_D<br/>OWN</sub> | VIN SyncBoost<br>Disable<br>deglitch filter time<br>falling edge | -                             | 3.3  | -    | 4.2  | μs   |
| 10 | T <sub>FLT_VINSYNCDIS<br/>_UP</sub>   | VIN SyncBoost<br>Disable<br>deglitch filter time<br>rising edge  | -                             | 9.5  | -    | 11   | μs   |
| 11 | T <sub>FLT_WAKEUP</sub>               | Wakeup deglitch filter<br>time                                   | -                             | 0.95 | 1.05 | 1.15 | ms   |
| 12 | T <sub>LATCH_WAKEUP</sub>             | Wakeup latch time  | -                             | 9.7  | 10.8 | 11.9 | ms   |
| 13 | T <sub>PWRUP</sub>                    | Power-up Delay Time<br>–<br>Wake-up to RESET<br>released         | -                             | -    | -    | 10   | ms   |

Table 22. Open ground detection DC specifications

| No | Symbol                           | Parameter                       | Conditions / Comments           | Min | Typ | Max | Unit |
|----|----------------------------------|---------------------------------|---------------------------------|-----|-----|-----|------|
| 1  | GND <sub>A</sub> <sub>OPEN</sub> | GND <sub>A</sub> open threshold | GNDSUB <sub>x</sub> =0          | 100 | 200 | 300 | mV   |
| 2  | GND <sub>D</sub> <sub>OPEN</sub> | GND <sub>D</sub> open threshold | GNDSUB <sub>x</sub> =0          | 100 | 200 | 300 | mV   |
| 3  | BSTGND <sub>OPEN</sub>           | BSTGND open threshold           | GNDSUB <sub>x</sub> =0          | 100 | 200 | 300 | mV   |
| 4  | I <sub>PU_BSTGND</sub>           | BSTGND pull-up current          | ER BOOST OFF and SYNC BOOST OFF | 130 | -   | 270 | μA   |
| 5  | SATGND <sub>OPEN</sub>           | SATGND open threshold           | GNDSUB <sub>x</sub> =0          | 100 | 200 | 300 | mV   |
| 6  | I <sub>PU_SATGND</sub>           | SATGND pull-up current          | SATBUCK OFF                     | 80  | 120 | 160 | μA   |
| 7  | VCCGND <sub>OPEN</sub>           | VCCGND open threshold           | GNDSUB <sub>x</sub> =0          | 100 | 200 | 300 | mV   |
| 8  | I <sub>PU_VCCGND</sub>           | VCCGND pull-up current          | VCC BUCK OFF                    | 80  | 120 | 160 | μA   |

Table 23. GND\_OPEN\_AC - Open ground detection DC specifications

| No | Symbol                      | Parameter   | Condition | Min | Typ | Max | Unit |
|----|-----------------------------|---|-----------|-----|-----|-----|------|
| 1  | T <sub>FLT_GNDREFOPEN</sub> | GND <sub>A</sub> and GND <sub>D</sub> Open Deglitch Filter Time | -         | 7   | 11  | 16  | μs   |
| 2  | T <sub>FLT_GNDREGOPEN</sub> | BSTGND, SATGND, VCCGND Open Deglitch Filter Time                | -         | 1.9 | 2.3 | 2.7 | μs   |

## 17.2 Internal analog reference

All electrical characteristics are valid for the following conditions unless otherwise noted:

$$-40\text{ °C} \leq T_a \leq +95\text{ °C}$$

$$V_{IN\_BAD0(min)} \leq V_{IN} \leq 35\text{ V}$$

Table 24. Internal analog reference

| N° | Symbol                     | Parameter                | Condition                | Min   | Typ | Max   | Unit |
|----|----------------------------|--------------------------|--------------------------|-------|-----|-------|------|
| 1  | V <sub>BG1</sub>           | Bandgap reference        | -                        | -1%   | 1.2 | +1%   | V    |
| 2  | V <sub>BG2</sub>           | Bandgap monitor          | -                        | -1%   | 1.2 | +1%   | V    |
| 3  | V <sub>ADC_GROUND</sub>    | ADC Ground reference     | ADC total error included | 90    | 104 | 120   | mV   |
| 4  | V <sub>ADC_FULLSCALE</sub> | ADC Full scale reference | -                        | -1.5% | 2.5 | +1.5% | V    |

### 17.3 Internal regulators

All electrical characteristics are valid for the following conditions unless otherwise noted.

$-40\text{ °C} \leq T_a \leq +95\text{ °C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$

**Table 25. Internal regulator DC specifications**

| No | Symbol             | Parameter               | Condition  | Min  | Typ | Max  | Unit |
|----|--------------------|-------------------------|--|------|-----|------|------|
| 1  | $V_{OUT\_VINT3V3}$ | VINT3V3 output voltage  | $V_{in} = 5.5\text{ V}, 12\text{ V}$ and $35\text{ V}$ | 3.14 | 3.3 | 3.46 | V    |
| 2  | $V_{OV\_VINT3V3}$  | VINT3V3 over voltage    | -  | 3.47 | -   | 3.7  | V    |
| 3  | $V_{UV\_VINT3V3}$  | VINT3V3 under voltage   | -  | 2.97 | -   | 3.13 | V    |
| 4  | $V_{OUT\_CVDD}$    | CVDD output voltage     | $V_{in} = 5.5\text{ V}, 12\text{ V}$ and $35\text{ V}$ | 3.14 | 3.3 | 3.46 | V    |
| 5  | $I_{OUT\_CVDD}$    | CVDD current capability | External load is not allowed                           | -    | -   | 50   | mA   |
| 6  | $I_{LIM\_CVDD}$    | CVDD current limit      | $V_{in} = 5.5\text{ V}, 12\text{ V}$ and $35\text{ V}$ | 80   | -   | -    | mA   |
| 7  | $V_{OV\_CVDD}$     | CVDD over voltage       | -  | 3.47 | -   | 3.7  | V    |
| 8  | $V_{UV\_CVDD}$     | CVDD under voltage      | -  | 2.7  | -   | 2.9  | V    |
| 9  | $C_{CVDD}$         | CVDD output capacitance | Design info  | 60   | 100 | 140  | nF   |

**Table 26. Internal regulators AC specifications**

| No | Symbol                    | Parameter   | Comment | Min | Typ | Max | Unit          |
|----|---------------------------|---|---------|-----|-----|-----|---------------|
| 1  | $T_{FLT\_VINT\_CVDD\_OV}$ | Internal regulator over voltage deglitch filter time  | -       | 7   | 11  | 16  | $\mu\text{s}$ |
| 2  | $T_{FLT\_VINT\_CVDD\_UV}$ | Internal regulator under voltage deglitch filter time | -       | 7   | 11  | 16  | $\mu\text{s}$ |

## 17.4 Watchdog

All electrical characteristics are valid for the following conditions unless otherwise noted:

$$-40\text{ }^{\circ}\text{C} \leq T_a \leq +95\text{ }^{\circ}\text{C}, V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$$

**Table 27. Temporal watchdog timer AC specifications (WD1)**

| No | Symbol                    | Parameter                    | Condition | Min | Typ | Max  | Unit |
|----|---------------------------|------------------------------|-----------|-----|-----|------|------|
| 1  | T <sub>WDT1_TIMEOUT</sub> | Temporal watchdog timeout    | -         | -   | -   | 2.00 | ms   |
|    |                           |                              |           | -   | -   | 16.3 | ms   |
| 2  | T <sub>WDT1_RST</sub>     | Temporal watchdog reset time | -         | 0.9 | 1.0 | 1.1  | ms   |

**Table 28. Algorithmic watchdog timer DC specifications (WD2)**

| No | Symbol                    | Parameter                 | Condition                   | Min     | Typ | Max | Unit |
|----|---------------------------|---------------------------|-----------------------------|---------|-----|-----|------|
| 1  | V <sub>OH_WD2LCKOUT</sub> | WD2LockOut output voltage | I <sub>LOAD</sub> = -0.5 mA | VCC-0.6 | -   | VCC | V    |
| 2  | V <sub>OL_WD2LCKOUT</sub> |                           | I <sub>LOAD</sub> = 2.0 mA  | 0       | -   | 0.4 | V    |

**Table 29. Algorithmic watchdog timer AC specifications (WD2)**

| No | Symbol                      | Parameter                       | Condition           | Min | Typ                   | Max | Unit |
|----|-----------------------------|---------------------------------|---------------------|-----|-----------------------|-----|------|
| 1  | T <sub>WDT2_TIMEOUT</sub>   | Algorithmic watchdog timeout    | -                   | 45  | 50                    | 55  | ms   |
| 2  | T <sub>WDT2_RST</sub>       | Algorithmic watchdog reset time | -                   | 0.9 | 1.0                   | 1.1 | ms   |
| 3  | T <sub>RISE_WD2LCKOUT</sub> | WD2LockOut rise time            | 50 pF load, 20%-80% | -   | -                     | 1.0 | μs   |
| 4  | T <sub>FALL_WD2LCKOUT</sub> | WD2LockOut fall time            | 50 pF load, 20%-80% | -   | -                     | 1.0 | μs   |
| 5  | f <sub>WD2_SEED</sub>       | WD2 Seed Counter Rate           | -                   | -   | $\frac{f_{osc}}{512}$ | -   | MHz  |

## 17.5 Oscillators

All electrical characteristics are valid for the following conditions unless otherwise noted:

$-40\text{ °C} \leq T_a \leq +95\text{ °C}$ ,  $V_{\text{INGOOD0}}(\text{max}) \leq V_{\text{IN}} \leq 35\text{ V}$ .

**Table 30. Oscillators specifications**

| N # | Symbol                     | Parameter  | Condition                                 | Min  | Typ                               | Max  | Unit |
|-----|----------------------------|--|---|--|-----------------------------------|--|------|
| 1   | $f_{\text{OSC}}$           | Main oscillator average frequency                  | -   | 15.2                                       | 16                                | 16.8                                       | MHz  |
| 2   | $f_{\text{MOD\_OSC}}$      | Main oscillator modulation frequency               | SPI_CLK_CNF(MAIN_SS_DIS=0)<br>Design Info | -  | $\frac{f_{\text{osc}}}{128}$      | -  | MHz  |
| 3   | $I_{\text{MOD\_OSC}}$      | Main oscillator modulation index                   | SPI_CLK_CNF(MAIN_SS_DIS=0)                | 2  | 4                                 | 6  | %    |
| 4   | $f_{\text{AUX}}$           | Aux oscillator average frequency                   | -   | 7.125                                      | 7.5                               | 7.875                                      | MHz  |
| 5   | $f_{\text{MOD\_AUX}}$      | Aux oscillator modulation frequency                | SPI_CLK_CNF(AUX_SS_DIS=0)<br>Design Info  | -  | $\frac{f_{\text{osc\_AUX}}}{128}$ | -  | MHz  |
| 6   | $I_{\text{MOD\_AUX}}$      | Aux oscillator modulation index                    | SPI_CLK_CNF(AUX_SS_DIS=0)                 | 2  | 4                                 | 6  | %    |
| 7   | $f_{\text{OSC\_LOW\_TH}}$  | Main oscillator low frequency detection threshold  | -   | $\frac{128}{68} \cdot f_{\text{AUX\_MIN}}$ | -                                 | $\frac{128}{68} \cdot f_{\text{AUX\_MAX}}$ | MHz  |
| 8   | $f_{\text{OSC\_HIGH\_TH}}$ | Main oscillator high frequency detection threshold | -   | $\frac{79}{32} \cdot f_{\text{AUX\_MIN}}$  | -                                 | $\frac{79}{32} \cdot f_{\text{AUX\_MAX}}$  | MHz  |

## 17.6 Reset

All electrical characteristics are valid for the following conditions unless otherwise noted:

$-40\text{ °C} \leq T_a \leq +95\text{ °C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$ ,  $V_{CCx(min)} \leq V_{CCx} \leq V_{CCx(max)}$ ,  
 $V_{CC} = 3.3\text{ V}$  or  $5\text{ V}$

**Table 31. Reset DC specifications**

| No | Symbol          | Parameter                  | Comment                     | Min          | Typ | Max      | Unit       |
|----|-----------------|----------------------------|-----------------------------|--------------|-----|----------|------------|
| 1  | $V_{OH\_RESET}$ | RESET output voltage       | $I_{LOAD} = -1.0\text{ mA}$ | $V_{CC}-0.4$ | -   | $V_{CC}$ | V          |
| 2  | $V_{OL\_RESET}$ |                            | $I_{LOAD} = 2.0\text{ mA}$  | 0            | -   | 0.4      | V          |
| 3  | $R_{PD\_RESET}$ | RESET pull down resistance | -                           | 65           | 100 | 135      | k $\Omega$ |

**Table 32. Reset AC specifications**

| No | Symbol            | Parameter       | Comment             | Min  | Typ | Max  | Unit          |
|----|-------------------|-----------------|---------------------|------|-----|------|---------------|
| 1  | $T_{RISE\_RESET}$ | Rise time       | 50 pF load, 20%-80% | -    | -   | 1.00 | $\mu\text{s}$ |
| 2  | $T_{FALL\_RESET}$ | Fall time       |                     | -    | -   | 1.00 | $\mu\text{s}$ |
| 3  | $T_{HOLD\_RESET}$ | Reset hold time | -                   | 0.45 | 0.5 | 0.55 | ms            |

## 17.7 SPI interface

All electrical characteristics are valid for both Global and Remote Sensor SPI and for the following conditions unless otherwise noted:

$-40\text{ °C} \leq T_a \leq +95\text{ °C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$ ,  $V_{CCx(min)} \leq V_{CCx} \leq V_{CCx(max)}$ ,  
 $V_{CC} = 3.3\text{ V}$  or  $5\text{ V}$

**Table 33. Global and remote sensor SPI DC specifications**

| No | Symbol                                  | Parameter                       | Comment             | Min | Typ | Max | Unit          |
|----|---|---------------------------------|---------------------|-----|-----|-----|---------------|
| 1  | $V_{IH\_CS\_G}$<br>$V_{IH\_CS\_RS}$     | CS_x High level Input Voltage   | -                   | 2   | -   | -   | V             |
| 2  | $V_{IL\_CS\_G}$<br>$V_{IL\_CS\_RS}$     | CS_x Low level Input Voltage    | -                   | -   | -   | 0.8 | V             |
| 3  | $I_{PU\_CS\_G}$<br>$I_{PU\_CS\_RS}$     | CS_x Pull Up Current            | $CS\_x = 0\text{V}$ | -70 | -45 | -20 | $\mu\text{A}$ |
| 4  | $V_{IH\_MOSI\_G}$<br>$V_{IH\_MOSI\_RS}$ | MOSI_x High level Input Voltage | -                   | 2   | -   | -   | V             |
| 5  | $V_{IL\_MOSI\_G}$<br>$V_{IL\_MOSI\_RS}$ | MOSI_x Low level Input Voltage  | -                   | -   | -   | 0.8 | V             |
| 6  | $I_{PD\_MOSI\_G}$<br>$I_{PD\_MOSI\_RS}$ | MOSI_x Pull Down Current        | $MOSI\_x = V_{CC}$  | 20  | 45  | 70  | $\mu\text{A}$ |
| 8  | $V_{IH\_SCLK\_G}$<br>$V_{IH\_SCLK\_RS}$ | SCLK_x High level Input Voltage | -                   | 2   | -   | -   | V             |

**Table 33. Global and remote sensor SPI DC specifications (continued)**

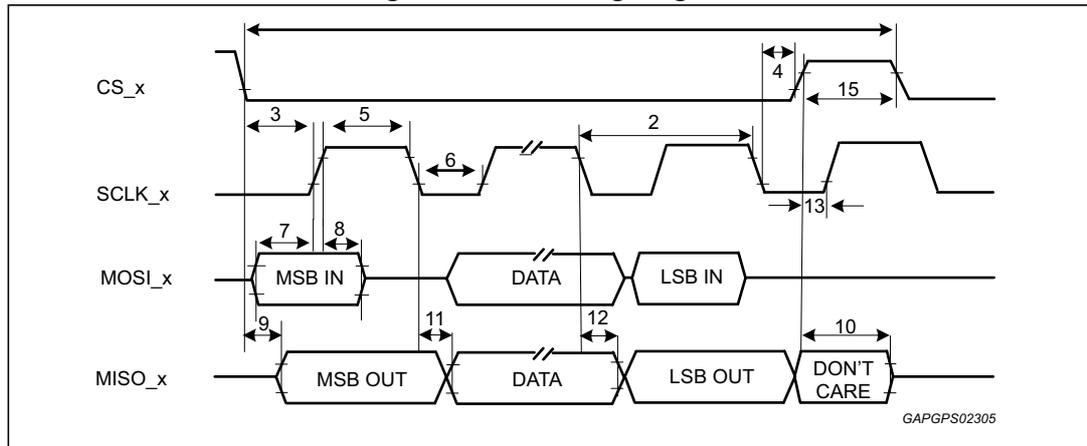
| No | Symbol  | Parameter                        | Comment                     | Min         | Typ | Max | Unit |
|----|---|----------------------------------|-----------------------------|-------------|-----|-----|------|
| 9  | V <sub>IL_SCLK_G</sub><br>V <sub>IL_SCLK_RS</sub>   | SCLK_x Low level Input Voltage   | -                           | -           | -   | 0.8 | V    |
| 10 | I <sub>PD_SCLK_G</sub><br>I <sub>PD_SCLK_RS</sub>   | SCLK_x Pull Down Current         | SCLK_x = VCC                | 20          | 45  | 70  | µA   |
| 12 | V <sub>OH_MISO_G</sub><br>V <sub>OH_MISO_RS</sub>   | MISO_x High level Output Voltage | I <sub>LOAD</sub> = -800 µA | VCC<br>-0.5 | -   | VCC | V    |
| 13 | V <sub>OL_MISO_G</sub><br>V <sub>OL_MISO_RS</sub>   | MISO_x Low level Output Voltage  | I <sub>LOAD</sub> = 2.0 mA  | -           | -   | 0.4 | V    |
| 14 | I <sub>LKG_MISO_G</sub><br>I <sub>LKG_MISO_RS</sub> | MISO_x Output Leakage            | Tri-state leakage           | -10         | -   | 10  | µA   |
| 15 | V <sub>IH_MISO_RS</sub>                             | MISO_RS High level Input Voltage | -                           | 2           | -   | -   | V    |
| 16 | V <sub>IL_MISO_RS</sub>                             | MISO_RS Low level Input Voltage  | -                           | -           | -   | 0.8 | V    |

**Table 34. SPI AC specifications**

| No | Symbol                     | Parameter                        | Comments / Conditions   | Min   | Typ | Max  | Unit |
|----|----------------------------|----------------------------------|-------------------------|-------|-----|------|------|
| 1  | F <sub>SCLK</sub>          | SPI transfer frequency           | -                       | -     | 8   | 8.08 | MHz  |
| 2  | T <sub>SCLK</sub>          | SCLK_x period                    | -                       | 123.8 | -   | -    | ns   |
| 3  | T <sub>LEAD</sub>          | Enable lead time                 | -                       | 250   | -   | -    | ns   |
| 4  | T <sub>LAG</sub>           | Enable lag time                  | -                       | 50    | -   | -    | ns   |
| 5  | T <sub>HIGH_SCLK</sub>     | SCLK_x high time                 | -                       | 40    | -   | -    | ns   |
| 6  | T <sub>LOW_SCLK</sub>      | SCLK_x low time                  | -                       | 40    | -   | -    | ns   |
| 7  | T <sub>SETUP_MOSI</sub>    | MOSI_x input setup time          | -                       | 20    | -   | -    | ns   |
| 8  | T <sub>HOLD_MOSI</sub>     | MOSI_x input hold time           | -                       | 20    | -   | -    | ns   |
| 9  | T <sub>ACC_MISO</sub>      | MISO_x access time               | 80 pF load              | -     | -   | 60   | ns   |
| 10 | T <sub>DIS_MISO</sub>      | MISO_x disable time              |                         | -     | -   | 100  | ns   |
| 11 | T <sub>VALID_MISO</sub>    | MISO_x output valid time         |                         | -     | -   | 30   | ns   |
| 12 | T <sub>HOLD_MISO</sub>     | MISO_x Output Hold Time          | 80 pF load; Design Info | 0     | -   | -    | ns   |
| 13 | T <sub>NODATA</sub>        | SCLK_x hold time                 | -                       | 20    | -   | -    | ns   |
| 14 | T <sub>FLT_CS</sub>        | CS_x noise glitch rejection time | -                       | 50    | -   | 300  | ns   |
| 15 | T <sub>NODATA</sub>        | SPI interframe time              | -                       | 400   | -   | -    | ns   |
| 16 | T <sub>SETUP_MISO_RS</sub> | MISO_RS Input Setup Time         | -                       | 20    | -   | -    | ns   |
| 17 | T <sub>HOLD_MISO_RS</sub>  | MISO_RS Input Hold Time          | -                       | 20    | -   | -    | ns   |

Note: All timing is shown with respect to 10% and 90% of the actual delivered VCC voltage.

Figure 70. SPI timing diagram



### 17.8 ERBoost regulator

All electrical characteristics are valid for the following conditions unless otherwise noted:  
 $-40\text{ }^{\circ}\text{C} \leq T_a \leq +95\text{ }^{\circ}\text{C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$ .

Table 35. ERBoost regulator DC specifications

| No | Symbol                     | Parameter               | Conditions   | Min   | Typ  | Max  | Unit |
|----|----------------------------|-------------------------|--|-------|------|------|------|
| 1  | V <sub>O_ERBST</sub>       | Boost output voltage    | Across all line and I <sub>O_BST</sub> load (steady state)<br>SYS_CTL(ER_BST_V)=0  | 22.6  | 23.8 | 25   | V    |
| 2  |                            |                         | Across all line and I <sub>O_BST</sub> load (steady state)<br>1SYS_CTL(ER_BST_V)=1 | 31.65 | 33   | 35   | V    |
| 3  | I <sub>O_ERBST</sub>       | Boost output current    | -  | 0.1   | -    | 70   | mA   |
| 4  | dV <sub>SR_ac</sub>        | Line transient response | All line, load; dt=100us;<br>BST33V = 0/1<br>Design Info                           | -8%   | -    | 8%   | %    |
| 5  | dV <sub>LR_ac</sub>        | Load transient response | All line, load; dt=100us;<br>BST33V = 0/1<br>Design Info                           | -8%   | -    | 8%   | %    |
| 6  | R <sub>DSON_ERBST</sub>    | Power switch resistance | -  | -     | -    | 1    | Ω    |
| 7  | I <sub>OC_ERBST</sub>      | Over current detection  | -  | 650   | -    | 1350 | mA   |
| 8  | I <sub>OC_ERBST_ERON</sub> |                         | ER Switch activated AND<br>SW_REGS_CONF(LOW_ERBST_ILIM_ERON) = 1                   | 125   | -    | 600  | mA   |

Table 35. ERBoost regulator DC specifications (continued)

| No | Symbol                     | Parameter   | Conditions  | Min   | Typ | Max | Unit        |
|----|----------------------------|---|---|-------|-----|-----|-------------|
| 9  | $I_{LKG\_ERBST\_OFF}$      | ERBOOST input current   | ERBOOST=40V<br>Power-off or Sleep Mode  | -5    | -   | +5  | $\mu A$     |
| 10 | $I_{LKG\_ERBST\_ON}$       |   | Active or Passive Mode<br>ERBoost reg. enabled<br>ERBSTSW > ERBoost > VER<br>ER Charge OFF<br>VSF regulator OFF<br>Any GPO channel not enabled<br><br>Guarantee by design | 60    | -   | 200 | $\mu A$     |
| 11 | $I_{LKG\_ERBST\_ON\_WGPO}$ |   | Active or Passive Mode<br>ERBoost reg. enabled<br>ERBSTSW > ERBoost > VER<br>ER Charge OFF<br>VSF regulator OFF<br>All GPO channel activated                              | 1.5   | -   | 2.4 | mA          |
| 12 | $V_{ERBST\_OK}$            | ERBOOST voltage threshold   | BST33V = 0  | 18    | 20  | 22  | V           |
| 13 |                            |   | BST33V = 1  | 26    | 28  | 30  | V           |
| 14 | $V_{ERBST\_OV}$            | ERBOOST Over Voltage threshold  | SYS_CTL(ER_BST_V) = 0   | 22.6  | -   | 25  | V           |
| 15 |                            |   | SYS_CTL(ER_BST_V) = 1   | 31.65 | -   | 35  | V           |
| 16 | $V_{ERBST\_DIS\_TH}$       | Voltage difference between VIN and ERBOOST to deactivate the ER Boost regulator | VIN – ERBOOST<br>Vin = 5.5 V, 12 V and 35 V   | 1.6   | 2.2 | 2.5 | V           |
| 17 | $V_{ERBST\_CLAMP\_EN\_TH}$ | Voltage difference between ERBSTSW and ERBOOST to activate the ER Boost CLAMP   | $V_{ERBSTSW} - V_{ERBOOST}$   | 2.7   | 3.3 | 3.7 | V           |
| 18 | $T_{JSD\_ERBST}$           | Thermal shutdown  | -   | 150   | 175 | 190 | $^{\circ}C$ |
| 19 | $T_{HYS\_TSDERBST}$        |   | -   | 5     | 10  | 15  | $^{\circ}C$ |

Table 36. ERBoost regulator AC specifications

| No | Symbol   | Parameter                                      | Conditions  | Min | Typ   | Max  | Unit          |
|----|--|--|---|-----|-------|------|---------------|
| 1  | $F_{SW\_ERBST}$  | ERBOOST switching frequency                    | -   | 1.8 | 1.882 | 2.0  | MHz           |
| 2  | $T_{RISE\_ERBSTSW\_SLOW}$<br>$T_{FALL\_ERBSTSW\_SLOW}$ | ERBSTSW transition time                        | 10% to 90% voltage on ERBSTSW<br>$V_{IN} \geq V_{IN\_FASTSLOPE\_H} = 10.3\text{ V}$<br>$I_{load} = 60\text{ mA}$<br>$SYS\_CTL(ER\_BST\_V) = 1$<br>Guaranteed by Design                                | 15  | -     | 35   | ns            |
| 3  | $T_{RISE\_ERBSTSW\_FAST}$<br>$T_{FALL\_ERBSTSW\_FAST}$ |  | 10% to 90% voltage on ERBSTSW<br>$V_{IN} = V_{IN\_FASTSLOPE\_L} = 9\text{ V}$   | 5   | -     | 15   | ns            |
| 4  | $T_{ON\_ERBST}$  | ERBOOST charge-up time                         | $C_{ERBOOST} = 2.2\ \mu\text{F}$<br>$V_{in} = 12\text{V}$ , $I_{O\_ERBST} = 5\text{mA}$<br>$SYS\_CTL(ER\_BST\_V) = 1$<br>Measured from CS_G edge to $V_{O\_ERBST}(\text{min})$                        | 50  | -     | 500  | $\mu\text{s}$ |
| 5  | $T_{SOFTST\_IOC\_ERBST}$                               | ERBOOST over current threshold soft start time | Not tested  | -5% | 1024  | +5%  | $\mu\text{s}$ |
| 6  | $T_{FLT\_VIN\_ERBST\_COMP}$                            | Deglitch filter on VIN_ERBoost comparator      | -   | 27  | 30    | 33   | $\mu\text{s}$ |
| 7  | $T_{FLT\_TSD\_ERBST}$                                  | Thermal shutdown filter time                   | -   | -   | -     | 10   | $\mu\text{s}$ |
| 8  | $T_{SOFTST\_ERBST}$                                    | ERBOOST Soft-start Time                        | Design Info.<br>Time from activation of ERBOOST when overcurrent is 40% of $I_{OC\_ERBST}$ ( $I_{OC\_ERBST\_ERON}$ ) to instant when overcurrent is 100% of $I_{OC\_ERBST}$ ( $I_{OC\_ERBST\_ERON}$ ) | -   | -     | 1075 | $\mu\text{s}$ |

Table 37. ERBOOST Converter external components design info

| No | Symbol              | Component   | Conditions                               | Min | Typ | Max | Unit          |
|----|---------------------|---|--|-----|-----|-----|---------------|
| 1  | $L_{ERBST}$         | Inductance  | -  | 8   | 10  | 12  | $\mu\text{H}$ |
| 2  | $ESL_{ERBST}$       | Inductance resistance                                 | -  | -   | -   | 0.1 | $\Omega$      |
| 3  | $C_{BLK\_ERBST}$    | Output bulk capacitance to ensure regulator stability | Min cap value including derating factors | 1   | 2.2 | -   | $\mu\text{F}$ |
| 4  | $ESR_{CBLK\_ERBST}$ | Bulk capacitor ESR                                    | -  | -   | -   | 50  | m $\Omega$    |

**Table 37. ERBOOST Converter external components design info (continued)**

| No | Symbol                    | Component                      | Conditions             | Min | Typ | Max  | Unit |
|----|---------------------------|--------------------------------|------------------------|-----|-----|------|------|
| 5  | V <sub>FSTR_ERBST</sub>   | Steering diode forward voltage | I <sub>F</sub> =100 mA | -   | -   | 0.85 | V    |
| 6  | I <sub>LKGSTR_ERBST</sub> | Steering diode reverse leakage | T <sub>a</sub> = 95 °C | -   | -   | 3    | mA   |

## 17.9 ER CAP current generators and diagnostic

All electrical characteristics are valid for the following conditions unless otherwise noted:

-40 °C ≤ T<sub>a</sub> ≤ +95 °C, VIN<sub>GOOD0</sub> ≤ VIN ≤ 35 V, 8 V ≤ ERBOOST.

**Table 38. ER CAP current generators and diagnostic DC specifications**

| No | Symbol                                | Parameter   | Conditions   | Min  | Typ | Max  | Unit |
|----|---------------------------------------|---|--|------|-----|------|------|
| 1  | I <sub>ER_CHARGE</sub>                | ER charge current                                 | ERBOOST ≥ 8<br>VERBOOST - VER ≥ 2V<br>ERBOOST = 24 V and<br>35 V                       | 60   | 65  | 70   | mA   |
| 2  | I <sub>ER_DISCHARGE_LOW</sub>         | ER discharge low level current                    | VER ≥ 6V   | 60   | 65  | 70   | mA   |
| 3  | I <sub>ER_DISCHARGE_HIGH</sub>        | ER discharge high level current                   | VER ≥ 8V   | 589  | 640 | 691  | mA   |
| 4  | R <sub>DSON_ERCHARGE</sub>            | ER charge power resistance                        | (V <sub>ERBOOST</sub> - V <sub>VER</sub> )/I <sub>VER</sub><br>I <sub>VER</sub> = 10mA | -    | -   | 20   | Ω    |
| 5  | VER <sub>RANGE</sub>                  | VER voltage measurement range                     | -  | 20   | -   | 35   | V    |
| 6  | VER <sub>ACC</sub>                    | VER voltage measurement accuracy                  | VER <sub>RANGE</sub>   | -8   | -   | +8   | %    |
| 7  | ERCAP <sub>RANGE</sub>                | Energy reserve capacitor measurement range        | Design Info  | -    | -   | 10   | mF   |
| 8  | ERCAP <sub>ACC</sub>                  | Energy reserve capacitor measurement accuracy     | ΔVERMIN = 2 V  | -7   | -   | +7   | %    |
| 9  | ERCAP <sub>ESR</sub> <sub>RANGE</sub> | Energy reserve capacitor ESR measurement range    | -  | 200  | -   | 600  | mΩ   |
| 10 | ERCAP <sub>ESR</sub> <sub>ACC</sub>   | Energy reserve capacitor ESR measurement accuracy | All errors included except the offset one (OFF <sub>ER_ESR</sub> )                     | -20  | -   | +20  | %    |
| 11 | G <sub>ER_ESR</sub>                   | Energy Reserve Capacitor ESR Measurement Gain     | -  | -13% | 3   | +13% | V/V  |
| 12 | OFF <sub>ER_ESR</sub>                 | Energy Reserve Capacitor ESR Measurement Offset   | Design Info  | 70   | -   | 160  | mΩ   |

**Table 38. ER CAP current generators and diagnostic DC specifications (continued)**

| No | Symbol                 | Parameter   | Conditions    | Min | Typ | Max | Unit |
|----|------------------------|---|---------------|-----|-----|-----|------|
| 13 | $T_{JSD\_ERBST}$       | ER charge thermal shutdown  | -             | 150 | 175 | 190 | °C   |
| 14 | $T_{HYS\_TSDERBST}$    |   | -             | 5   | 10  | 15  | °C   |
| 15 | $V_{VER\_VBATMON\_TH}$ | Voltage difference between VER and VBATMON to activate the ER Discharge in passive mode | VER - VBATMON | 1.6 | 2.2 | 2.5 | V    |

**Table 39. ER CAP current generators and diagnostic AC specifications**

| No | Symbol                   | Parameter                               | Conditions   | Min | Typ | Max | Unit          |
|----|--------------------------|---|--|-----|-----|-----|---------------|
| 1  | $T_{ON\_ERCAP}$          | Energy reserve capacitor charge-up time | $C_{VER} \leq 10\text{mF}$ nominal, BST33V = 0, Design Info      | -   | -   | 4   | s             |
| 2  | $T_{ESR\_DIAG}$          | ER CAP ESR diagnostic duration          | Total duration time from SPI command to ADC results availability | -5% | 225 | +5% | $\mu\text{s}$ |
| 3  | $T_{FLT\_TSD\_ERCHARGE}$ | Thermal shutdown filter time            | -  | -   | -   | 10  | $\mu\text{s}$ |

## 17.10 ER switch

All electrical characteristics are valid for the following conditions unless otherwise noted:

$-40\text{ °C} \leq T_a \leq +95\text{ °C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$ .

**Table 40. ER Switch DC specifications**

| No | Symbol               | Parameter                        | Conditions  | Min | Typ | Max | Unit     |
|----|----------------------|----------------------------------|---|-----|-----|-----|----------|
| 1  | $R_{DSON\_ERSW}$     | Power switch resistance          | $V_{in} = 5.5\text{ V}$ and $35\text{ V}$   | 0.5 | -   | 3   | $\Omega$ |
| 2  | $I_{LIM\_ERSW}$      | ER switch current limit          | $V_{ER} = 17\text{ V}$ @ $V_{in} = 12\text{ V}$ and $V_{ER} = 35\text{ V}$ @ $V_{IN} = 31\text{ V}$                             | 600 | 810 | 980 | mA       |
| 3  | $V_{ER\_SW\_OV\_TH}$ | ER switch Over Voltage threshold | Test go / no go<br>ER switch turned off when $V_{in} > V_{ER} + V_{ER\_SW\_OV\_TH}$<br>$V_{in} = 12\text{ V}$ and $35\text{ V}$ | 10  | -   | 200 | mV       |
| 4  | $T_{JSD\_ERSW}$      | Thermal shutdown                 | -   | 150 | 175 | 190 | °C       |
| 5  | $T_{HYS\_TSDERSW}$   |                                  | -   | 5   | 10  | 15  | °C       |

**Table 41. ER Switch AC specifications**

| No | Symbol                    | Parameter   | Conditions               | Min | Max | Unit |
|----|---------------------------|---|--------------------------|-----|-----|------|
| 1  | T <sub>ON_ERSW</sub>      | ER turn-on time (time to reach either R <sub>DSON_ERSW</sub> or I <sub>LIM_ERSW</sub> ) | C <sub>VIN</sub> = 10 µF | -   | 5   | µs   |
| 2  | T <sub>FLT_TSD_ERSW</sub> | Thermal shutdown filter time  | -                        | -   | 10  | µs   |
| 3  | T <sub>BLK_ERSW</sub>     | ER switch activation blanking time after thermal shutdown                               | -                        | -   | 1   | ms   |

### 17.11 COVRACT

All electrical characteristics are valid for the following conditions unless otherwise noted:

-40 °C ≤ Ta ≤ +95 °C, VIN<sub>GOOD0</sub> ≤ VIN ≤ 35 V; VIN<sub>GOOD(max)</sub> ≤ VIN ≤ 35 V; VCCx(min) ≤ VCCx ≤ VCCx(max); VCC = 3.3 V or 5 V

**Table 42. COVRACT DC specifications**

| No | Symbol                   | Parameter                          | Conditions                    | Min       | Typ | Max | Unit |
|----|--------------------------|------------------------------------|-------------------------------|-----------|-----|-----|------|
| 1  | V <sub>OH_COVRACT</sub>  | COVRACT output voltage             | I <sub>LOAD</sub> = -0.5 mA   | VCC - 0.6 | -   | VCC | V    |
| 2  | V <sub>OL_COVRACT</sub>  |                                    | I <sub>LOAD</sub> = 2.0 mA    | 0         | -   | 0.4 | V    |
| 3  | I <sub>REV_COVRACT</sub> | Reverse current short high voltage | COVRACT = 40 V<br>VCC = 3.3 V | -         | -   | 1   | mA   |

**Table 43. COVRACT AC specifications**

| No | Symbol                    | Parameter | Conditions          | Min | Typ | Max  | Unit |
|----|---------------------------|-----------|---------------------|-----|-----|------|------|
| 1  | T <sub>RISE_COVRACT</sub> | Rise time | 50 pF load, 20%-80% | -   | -   | 1.00 | µs   |
| 2  | T <sub>FALL_COVRACT</sub> | Fall time | 50 pF load, 20%-80% | -   | -   | 1.00 | µs   |

### 17.12 SYNCBOOST converter

All electrical characteristics are valid for the following conditions unless otherwise noted:

-40 °C ≤ Ta ≤ +95 °C, VIN<sub>GOOD0</sub> ≤ VIN ≤ VIN<sub>SYNC\_DIS\_x(min)</sub>

**Table 44. SYNCBOOST converter DC specifications**

| No | Symbol                 | Parameter                | Conditions  | Min   | Typ   | Max | Unit |
|----|------------------------|--------------------------|---|-------|-------|-----|------|
| 1  | V <sub>O_SYNCBST</sub> | SYNCBOOST output voltage | Across all line and load, steady state<br>SYS_CTL(SYBST) = 0  | 11.40 | 12    | -   | V    |
| 2  |                        |                          | Across all line and load (steady state)<br>SYS_CTL(SYBST) = 1 | 14.00 | 14.75 | -   | V    |

Table 44. SYNCBOOST converter DC specifications (continued)

| No | Symbol                              | Parameter   | Conditions   | Min | Typ | Max  | Unit |
|----|-------------------------------------|---|--|-----|-----|------|------|
| 3  | I <sub>O_SYNCBST_VL_IH</sub>        | SYNCBOOST output current  | SYS_CTL(SYBST_V) = 0<br>SYS_CFG(LOW_POWER_MODE) = 0                  | 20  | -   | 360  | mA   |
| 4  | I <sub>O_SYNCBST_VL_IL</sub>        |   | SYS_CTL(SYBST_V) = 0<br>SYS_CFG(LOW_POWER_MODE) = 1                  | 20  | -   | 240  | mA   |
| 5  | I <sub>O_SYNCBST_VH_IH</sub>        |   | SYS_CTL(SYBST_V) = 1<br>SYS_CFG(LOW_POWER_MODE) = 0                  | 20  | -   | 290  | mA   |
| 6  | I <sub>O_SYNCBST_VH_IL</sub>        | SYNCBOOST output current  | SYS_CTL(SYBST_V) = 0<br>SYS_CFG(LOW_POWER_MODE) = 1                  | 20  | -   | 190  | mA   |
| 7  | dV <sub>SR_ac</sub>                 | Line transient response   | All line, load; dt = 100 μs;<br>SYS_CTL(SYBST) = 0/1<br>Design Info  | -8% | -   | 8%   | %    |
| 8  | dV <sub>LR_ac</sub>                 |   |  | -8% | -   | 8%   | %    |
| 9  | R <sub>DSON_SYNCBST</sub>           | Power switch resistance   | -  | -   | -   | 0.5  | Ω    |
| 10 | I <sub>OC_SYNCBST_HIGH</sub>        | Over current detection of integrated MOS  | SYS_CFG(LOW_POWER_MODE) = 0  | 1.6 | -   | 3.2  | A    |
| 11 | I <sub>OC_SYNCBST_LOW</sub>         |   | SYS_CFG(LOW_POWER_MODE) = 1  | 1.5 | -   | 2.6  | A    |
| 12 | I <sub>LKG_SYNCBOOST</sub>          | SYNCBOOST leakage   | SYNCBOOST=40V Device off   | -   | -   | 10   | μA   |
| 13 | I <sub>LKG_SYNCBSTSW</sub>          | SYNCBSTSW leakage   | SYNCBSTSW=40V Device off   | -   | -   | 20   | μA   |
| 14 | V <sub>SYNCBST_OK</sub>             | SYNCBOOST voltage threshold   | -  | 9   | 10  | 11   | V    |
| 15 | V <sub>SYNCBST_OV</sub>             | SYNCBOOST Over Voltage threshold  | -  | 22  | 23  | 24   | V    |
| 16 | V <sub>SYNCBST_DIS_TH</sub>         | Voltage difference between VIN and SYNCBOOST to deactivate the SYNC Boost regulator | VIN – SYNCBOOST  | 1.6 | 2.2 | 2.5  | V    |
| 17 | V <sub>SYNCBST_CLAMP_EN_TH</sub>    | Voltage difference between SYNCBSTSW and SYNCBOOST to activate the SYNC Boost CLAMP | V <sub>SYNCBSTSW</sub> – V <sub>SYNCBOOST</sub>                      | 2.7 | 3.3 | 3.7  | V    |
| 18 | V <sub>VIN_SYNCBST_RESTART_TH</sub> | Voltage threshold to restart Syncboost regulator during ER State                    | SYS_CTL(RESTART_SYBST_SEL) = 0<br>Voltage threshold on VIN pin       | 9   | -   | 10.3 | V    |
| 19 | V <sub>SYNCBST_RESTART_TH</sub>     |   | SYS_CTL(RESTART_SYBST_SEL) = 1<br>Voltage threshold on SYNCBOOST pin | 19  | 20  | 21   | V    |

**Table 44. SYNCBOOST converter DC specifications (continued)**

| No | Symbol                      | Parameter                   | Conditions | Min | Typ | Max | Unit |
|----|-----------------------------|-----------------------------|------------|-----|-----|-----|------|
| 20 | T <sub>JSDERSYNCBST</sub>   | Thermal shutdown            | -          | 150 | 175 | 190 | C    |
| 21 | T <sub>HYS_TSDSYNCBST</sub> | Thermal shutdown hysteresis | -          | 5   | 10  | 15  | °C   |

**Table 45. SYNCBOOST converter AC specifications**

| No | Symbol   | Parameter  | Conditions   | Min | Typ   | Max  | Unit |
|----|--|--|--|-----|-------|------|------|
| 1  | F <sub>SW_SYNCBST</sub>  | SYNCBST switching frequency                                | -  | 1.8 | 1.882 | 2.0  | MHz  |
| 2  | T <sub>RISE_SYNCBSTSW_SLOW</sub><br>T <sub>FALL_SYNCBSTSW_SLOW</sub> | SYNCBSTSW transition time                                  | 10% to 90% voltage on SYNCBSTSW<br>VIN = VIN <sub>FASTSLOPE_H</sub><br>Design Info   | 15  | -     | 30   | ns   |
| 3  | T <sub>RISE_SYNCBSTSW_FAST</sub><br>T <sub>FALL_SYNCBSTSW_FAST</sub> |  | 10% to 90% voltage on SYNCBSTSW<br>VIN = VIN <sub>FASTSLOPE_L</sub><br>Design Info   | 5   | -     | 20   | ns   |
| 4  | T <sub>SOFTST_SYNCBST</sub>  | SYNCBST Soft-start Time                                    | Design Info.<br>Time from activation of SYNCBOOST when overcurrent is 40 % of I <sub>OC_SYNCBST_HIGH</sub> (I <sub>OC_SYNCBST_LOW</sub> ) to instant when overcurrent is 100% of I <sub>OC_SYNCBST_HIGH</sub> (I <sub>OC_SYNCBST_LOW</sub> ) | -   | -     | 1075 | µs   |
| 5  | T <sub>SOFTST_OC_SYNCBST</sub>                                       | ERBOOST <sup>Over Current</sup> threshold soft start time  | Not tested   | -5% | 1024  | +5%  | µs   |
| 6  | T <sub>FLT_TSD_SYNCBST</sub>   | Thermal shutdown filter time                               | -  | -   | -     | 10   | µs   |
| 7  | T <sub>BLK_SYNCB</sub>   | Sync boost activation blanking time after thermal shutdown | -  | -   | 1     | -    | ms   |

**Table 46. SYNCBOOST converter external components design info**

| No | Symbol                      | Component               | Conditions         | Min  | Typ | Max | Unit |
|----|-----------------------------|-------------------------|--------------------|------|-----|-----|------|
| 1  | L <sub>SYNCBST</sub>        | Inductance              | Min 4.7 µH nominal | 3.76 | -   | -   | µH   |
| 2  | ESL <sub>SYNCBST</sub>      | Inductance resistance   | -                  | -    | -   | 0.1 | Ω    |
| 3  | C <sub>BLK_SYNCBST</sub>    | Output bulk capacitance | Min 2.2 µF nominal | 1.76 | -   | -   | µF   |
| 4  | ESR <sub>CBLK_SYNCBST</sub> | Bulk capacitor ESR      | -                  | -    | -   | 50  | mΩ   |

Table 46. SYNCBOOST converter external components design info (continued)

| No | Symbol       | Component                      | Conditions                        | Min | Typ | Max | Unit |
|----|--------------|--------------------------------|-----------------------------------|-----|-----|-----|------|
| 5  | $V_{FSTR}$   | Steering diode forward voltage | $I_F = 1 \text{ A}$               | -   | -   | 0.5 | V    |
| 6  | $I_{LKGSTR}$ | Steering diode reverse leakage | $T_a = 95 \text{ }^\circ\text{C}$ | -   | -   | 3   | mA   |

### 17.13 SATBUCK converter

All electrical characteristics are valid for the following conditions unless otherwise noted:

$-40 \text{ }^\circ\text{C} \leq T_a \leq +95 \text{ }^\circ\text{C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{V}$ ,  $V_{SYNCSBST\_OK} \leq \text{SYNCBOOST}$

Table 47. SATBUCK converter DC specifications

| No | Symbol                     | Parameter                                | Conditions   | Min  | Typ | Max  | Unit     |
|----|----------------------------|--|--|------|-----|------|----------|
| 1  | $V_{O\_SATBUCK}$           | SATBUCK output voltage                   | Across all line and load, steady state SAT_V = 0                     | 6.92 | 7.2 | 7.48 | V        |
| 2  |                            |  | Across all line and load, steady state SAT_V = 1                     | 8.64 | 9   | 9.36 | V        |
| 3  | $I_{O\_SATBUCK\_VH\_IH}$   | SATBUCK output current                   | SAT_V = 0<br>LOW_POWER_MODE = 0                                      | 20   | -   | 450  | mA       |
| 4  | $I_{O\_SATBUCK\_VH\_IL}$   |  | SAT_V = 0<br>LOW_POWER_MODE = 1                                      | 20   | -   | 300  | mA       |
| 5  | $I_{O\_SATBUCK\_VL\_IH}$   |  | SAT_V = 1<br>LOW_POWER_MODE = 0                                      | 20   | -   | 390  | mA       |
| 6  | $I_{O\_SATBUCK\_VL\_IL}$   |  | SAT_V = 1<br>LOW_POWER_MODE = 1                                      | 20   | -   | 240  | mA       |
| 7  | $dV_{SR\_ac}$              | Line transient response                  | All line, load; dt=100 $\mu\text{s}$ ;<br>SAT_V = 0/1<br>Design Info | -4%  | -   | 4%   | %        |
| 8  | $dV_{LR\_ac}$              | Load transient response                  | All line, load; dt=100 $\mu\text{s}$ ;<br>SAT_V = 0/1<br>Design Info | -4%  | -   | 4%   | %        |
| 9  | $R_{DSON\_SATBUCK\_HS}$    | High side power switch resistance        | SyncBoost = 12 V and 35 V  | -    | -   | 1.4  | $\Omega$ |
| 10 | $R_{DSON\_SATBUCK\_LS}$    | Low side power switch resistance         | SyncBoost = 12 V and 35 V  | -    | -   | 1    | $\Omega$ |
| 11 | $I_{OC\_HS\_SATBUCK\_HI}$  | High side over current detection         | LOW_POWER_MODE = 0   | 0.83 | 1.1 | 1.37 | A        |
| 12 | $I_{OC\_HS\_SATBUCK\_LO}$  |  | LOW_POWER_MODE = 1   | 0.53 | 0.7 | 0.9  | A        |
| 13 | $I_{OCP\_LS\_SATBUCK\_LO}$ | Low side positive over current detection | $V_{SATBUCKSW} \geq 0$<br>$V_{SYNCSBST} < V_{SYNCSBST\_RESTART\_TH}$ | 1    | -   | 100  | mA       |
| 14 | $I_{OCP\_LS\_SATBUCK\_HI}$ |  | $V_{SATBUCKSW} \geq 0$<br>FAST SLOPE                                 | 100  | 240 | 350  | mA       |

**Table 47. SATBUCK converter DC specifications**

| No | Symbol                        | Parameter                                | Conditions                                      | Min  | Typ  | Max  | Unit |
|----|-------------------------------|--|---|------|------|------|------|
| 15 | I <sub>OCN_LS_SATBCK_HI</sub> | Low side negative over current detection | V <sub>SATBCKSW</sub> = 0<br>LOW_POWER_MODE = 0 | 0.94 | 1.25 | 1.56 | A    |
| 16 | I <sub>OCN_LS_SATBCK_LO</sub> |  | V <sub>SATBCKSW</sub> = 0<br>LOW_POWER_MODE = 1 | 0.64 | 0.85 | 1.06 | A    |
| 17 | V <sub>SATBCK_OK_LOW</sub>    | SATBUCK voltage threshold                | SYS_CTL(SAT_V) = 0                              | 6.2  | 6.5  | 6.8  | V    |
| 18 | V <sub>SATBCK_OK_HIGH</sub>   |  | SYS_CTL(SAT_V) = 1                              | 7.7  | 8.1  | 8.5  | V    |

**Table 48. SATBUCK converter AC specifications**

| No | Symbol   | Parameter                   | Conditions  | Min  | Typ   | Max | Units |
|----|--|-----------------------------|---|------|-------|-----|-------|
| 1  | F <sub>SW_SATBCK</sub>   | SATBUCK switching frequency | -   | 1.8  | 1.882 | 2.0 | MHz   |
| 2  | T <sub>RISE_SATBCKSW_SLOW</sub><br>T <sub>FALL_SATBCKSW_SLOW</sub> | SATBCKSW transition time    | 10% to 90% voltage on SATBCKSW<br>V <sub>SYNCBST</sub> < V <sub>SYNCBST_RESTART_TH</sub><br>Design Info | 10   | -     | 25  | ns    |
|    | T <sub>RISE_SATBCKSW_FAST</sub><br>T <sub>FALL_SATBCKSW_FAST</sub> |                             | 10% to 90% voltage on SATBCKSW<br>V <sub>SYNCBST</sub> > V <sub>SYNCBST_RESTART_TH</sub><br>Design Info | 5    | -     | 15  |       |
| 4  | T <sub>SOFTST_SATBCK</sub>   | SATBUCK soft start time     | From 10% to 90%   | 0.50 | -     | 2   | ms    |

**Table 49. SATBUCK converter external components design info**

| No | Symbol                     | Component               | Conditions         | Min  | Typ | Max  | Unit |
|----|----------------------------|-------------------------|--------------------|------|-----|------|------|
| 1  | L <sub>SATBCK</sub>        | Inductance              | Min 4.7 μH nominal | 3.76 | -   | -    | μH   |
| 2  | ESR <sub>LSATBCK</sub>     | Inductance Resistance   | -                  | -    | -   | 0.25 | Ω    |
| 3  | C <sub>BLK_SATBCK</sub>    | Output Bulk Capacitance | Min 4.7 μH nominal | 3    | -   | 30   | μF   |
| 4  | ESR <sub>CBLK_SATBCK</sub> | Bulk Capacitor ESR      | -                  | -    | -   | 50   | mΩ   |

## 17.14 VCC regulator

All electrical characteristics are valid for the following conditions unless otherwise noted:

$-40\text{ }^{\circ}\text{C} \leq T_a \leq +95\text{ }^{\circ}\text{C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$ ,  $V_{SATBCK\_OK} \leq SATBCK$

**Table 50. VCC converter DC specifications**

| No | Symbol                        | Parameter                                | Conditions   | Min  | Typ  | Max  | Units |
|----|-------------------------------|--|--|------|------|------|-------|
| 1  | V <sub>O_VCC</sub>            | VCCBUCK Output Voltage                   | Across all line and load, steady state<br>VCCSEL < V <sub>TH1_L_VCCSEL</sub>   | 3.20 | 3.3  | 3.40 | V     |
| 2  |                               |  | Across all line and load, steady state<br>VCCSEL = > V <sub>TH1_H_VCCSEL</sub> | 4.85 | 5    | 5.15 | V     |
| 3  | I <sub>O_VCC3V_HI</sub>       | VCCBUCK output current                   | VCCSEL < V <sub>TH1_L_VCCSEL</sub><br>LOW_POWER_MODE = 0                       | 20   | -    | 420  | mA    |
| 4  | I <sub>O_VCC3V_LO</sub>       |  | VCCSEL < V <sub>TH1_L_VCCSEL</sub><br>LOW_POWER_MODE = 1                       | 20   | -    | 230  | mA    |
| 5  | I <sub>O_VCC5V_HI</sub>       |  | VCCSEL > V <sub>TH1_H_VCCSEL</sub><br>LOW_POWER_MODE = 0                       | 20   | -    | 270  | mA    |
| 6  | dV <sub>SR_ac</sub>           | Line transient response                  | All line, load; dt=100 μs;<br>Design Info                                      | -4%  | -    | 4%   | %     |
| 7  | dV <sub>LR_ac</sub>           | Load transient response                  | All line, load; dt=100 μs;<br>Design Info                                      | -4%  | -    | 4%   | %     |
| 8  | R <sub>DS(on)_VCCBCK_HS</sub> | High side power switch resistance        | SATBUCK = 6.92 V and 9.36 V  | -    | 1.4  | 0.6  | Ω     |
| 9  | R <sub>DS(on)_VCCBCK_LS</sub> | Low side power switch resistance         | SATBUCK = 6.92 V and 9.36 V  | -    | 1.4  | 0.6  | Ω     |
| 10 | I <sub>OC_HS_VCCBCK_HI</sub>  | High side over current detection         | SYS_CFG(LOW_POWER_MODE) = 0  | 0.59 | 0.75 | 0.9  | A     |
| 11 | I <sub>OC_HS_VCCBCK_LO</sub>  |  | SYS_CFG(LOW_POWER_MODE) = 1  | 0.4  | 0.56 | 0.7  | A     |
| 12 | I <sub>OCP_LS_VCCBCK</sub>    | Low side positive over current detection | V <sub>VCCBCKSW</sub> > 0<br>SYS_CFG(LOW_POWER_MODE) = 0 / 1                   | 1    | -    | 100  | mA    |
| 13 | I <sub>OCN_LS_VCCBCK_HI</sub> | Low side negative over current detection | V <sub>VCCBCKSW</sub> = 0<br>LOW_POWER_MODE = 0                                | 0.67 | 0.9  | 1.13 | A     |
| 14 | I <sub>OCN_LS_VCCBCK_LO</sub> |  | V <sub>VCCBCKSW</sub> = 0<br>LOW_POWER_MODE = 1                                | 0.49 | 0.65 | 0.82 | A     |
| 15 | I <sub>OF_VCC</sub>           | Open feedback current on VCC             | -  | 100  | 150  | 200  | μA    |
| 16 | V <sub>CCOV3V</sub>           | VCC over voltage detection               | VCCSEL < V <sub>TH2_L_VCCSEL</sub>   | 3.43 | -    | 3.6  | V     |
| 17 | V <sub>CCOV5V</sub>           |  | VCCSEL > V <sub>TH2_H_VCCSEL</sub>   | 5.25 | -    | 5.50 | V     |

**Table 50. VCC converter DC specifications (continued)**

| No | Symbol              | Parameter                        | Conditions                         | Min | Typ | Max  | Units |
|----|---------------------|----------------------------------|------------------------------------|-----|-----|------|-------|
| 18 | VCC <sub>UV3V</sub> | VCC under voltage detection high | VCCSEL < V <sub>TH2_L_VCCSEL</sub> | 3.0 | -   | 3.17 | V     |
| 19 | VCC <sub>UV5V</sub> |                                  | VCCSEL > V <sub>TH2_H_VCCSEL</sub> | 4.5 | -   | 4.75 | V     |
| 20 | VCC <sub>UVL</sub>  | VCC under voltage detection low  | -                                  | 1.8 | 2   | 2.2  | V     |

**Table 51. VCC converter AC specifications**

| No | Symbol   | Parameter   | Conditions                                    | Min | Typ   | Max | Units |
|----|--|---|---|-----|-------|-----|-------|
| 1  | F <sub>SW_VCCBCK</sub>                                   | VCCBUCK switching frequency   | -   | 1.8 | 1.882 | 2.0 | MHz   |
| 2  | T <sub>RISE_VCCBCKSW</sub><br>T <sub>FALL_VCCBCKSW</sub> | VCCBCKSW transition time  | 10% to 90% voltage on VCCBCKSW<br>Design Info | 8   | -     | 20  | ns    |
| 3  | T <sub>SOFTST_VCCBCK</sub>                               | VCCBUCK soft start time   | From 10% to 90%                               | 0.5 | -     | 2   | ms    |
| 4  | T <sub>FLT_VCCOV</sub>                                   | VCC over voltage detection deglitch filter time                         | -   | 27  | 30    | 33  | µs    |
| 5  | T <sub>FLT_VCCOV_RAMPUP</sub>                            | VCC Over voltage detection deglitch filter time during VCC_RAMPUP state | VCC reg in VCC_RAMPUP state                   | 1.5 | 2     | 2.5 | µs    |
| 6  | T <sub>FLT_VCCUV</sub>                                   | VCC under voltage detection deglitch filter time                        | -   | 27  | 30    | 33  | µs    |
| 7  | T <sub>FLT_VCCUVL</sub>                                  | VCC under voltage low detection deglitch filter time                    | -   | 1.5 | 2     | 2.5 | µs    |

**Table 52. VCC converter external components design info**

| No | Symbol                     | Component               | Conditions         | Min  | Typ | Max  | Unit |
|----|----------------------------|-------------------------|--------------------|------|-----|------|------|
| 1  | L <sub>VCCBCK</sub>        | Inductance              | Min 4.7 µH nominal | 3.76 | -   | -    | µH   |
| 2  | ESR <sub>LVCCBCK</sub>     | Inductance resistance   | -                  | -    | -   | 0.25 | Ω    |
| 3  | C <sub>BLK_VCCBCK</sub>    | Output bulk capacitance | Min 4.7 µF nominal | 3    | -   | 30   | µF   |
| 4  | ESR <sub>CBLK_VCCBCK</sub> | Bulk capacitor ESR      | -                  | -    | -   | 50   | mΩ   |

## 17.15 VSF regulator

All electrical characteristics are valid for the following conditions unless otherwise noted:

$-40\text{ °C} \leq T_a \leq +95\text{ °C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35V$ ,  $V_{SF} + 2V \leq ERBOOST$

**Table 53. VSF regulator DC specifications**

| No | Symbol                   | Parameter                   | Conditions  | Min | Typ | Max | Unit |
|----|--------------------------|-----------------------------|---|-----|-----|-----|------|
| 1  | VSF                      | Output voltage              | All line, load, IO_VSF up to 6mA<br>SYS_CGF(VSF_V)= 0           | 18  | 20  | 22  | V    |
| 2  |                          |                             | Only in case<br>SYS_CTL(ER_BST_V)=1<br>SYS_CGF(VSF_V) = 1       | 23  | 25  | 27  | V    |
| 3  | I <sub>LIM_VSF</sub>     | Output load current limit   | VSF = 0   | 7   | 10  | 13  | mA   |
| 4  | V <sub>DO_VSF</sub>      | Drop-out voltage            | V(ERBOOST-VSF)  | -   | -   | 2   | V    |
| 5  | C <sub>VSF</sub>         | Output capacitance          | Design Info   | 2.9 | -   | 14  | nF   |
| 6  | I <sub>LKG_VSF_OFF</sub> | VSF input leakage           | Device OFF  | -5  | -   | 5   | μA   |
| 7  | R <sub>PD_VSF</sub>      | VSF pull-down resistance    | Device ON<br>VSF regulator OFF; VSF = 25V                       | 60  | 125 | 220 | kΩ   |
| 8  | I <sub>PD_VSF</sub>      | VSF pull-down current       | Device ON<br>VSF regulator ON; Design Info                      | 34  | 40  | 46  | μA   |
| 9  | I <sub>PD_VSF_TOT</sub>  | VSF total pull-down current | Device ON<br>VSF regulator ON<br>VSF = 25V<br>SYS_CGF(VSF_V)= 1 | 147 | 230 | 462 | μA   |

**Table 54. VSF regulator AC specifications**

| No | Symbol              | Parameter        | Conditions  | Min | Typ | Max | Unit |
|----|---------------------|------------------|---|-----|-----|-----|------|
| 1  | T <sub>ON_VSF</sub> | VSF turn on time | C <sub>VSF</sub> = 14 nF<br>Measured from VSF_EN=1 to<br>VSF inside regulation limits | -   | -   | 100 | μs   |

## 17.16 Deployment drivers

All electrical characteristics are valid for the following conditions unless otherwise noted:

$-40\text{ }^{\circ}\text{C} \leq T_a \leq +95\text{ }^{\circ}\text{C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{V}$ ,  $6\text{V} \leq SS_{xy} \leq 35\text{V}$ ,  $SS_{xy} - SF_x \leq 25\text{V}$ .

**Table 55. Deployment drivers – DC specifications**

| No | Symbol                   | Parameter  | Comments / Conditions  | Min                      | Typ  | Max  | Unit     |
|----|--------------------------|--|--|--------------------------|------|------|----------|
| 1  | $I_{DEPL\_LO}$           | Deployment Current                                     | R = 2 ohms<br>Considering 9mA as not detected leakage with a 1kOhm equivalent resistance from SFx to GND                               | 1.33                     | 1.4  | 1.6  | A        |
| 2  | $I_{DEPL\_HI}$           |  | R = 2 ohms, $9\text{V} \leq SS_{xy}$<br>Considering 13.5mA as not detected leakage with a 1kOhm equivalent resistance from SFx to GND, | 1.94                     | 1.99 | 2.3  | A        |
| 3  | $I_{TH\_DEPL}$           | Deployment Current Counter Threshold                   | -  | $I_{DEPL}^* \times 90\%$ | -    | -    | A        |
| 4  | $I_{OC\_SR}$             | Low side Over Current Detection                        | -  | 2.2                      | 3.1  | 4.0  | A        |
| 5  | $I_{LIM\_SR}$            | Low side Current Limitation                            | -  | 2.2                      | 3.1  | 4.0  | A        |
| 6  | $\Delta I_{LIM\_OC\_SR}$ | Difference between Current Limitation and OC Threshold | $I_{LIM\_SR} - I_{OC\_SR}$   | 0.1                      | -    | -    | mA       |
| 7  | $R_{DSON\_HSLs}$         | Combined High side MOS + Low side MOS On Resistances   | $T_a = 95^{\circ}\text{C}$   | -                        | -    | 2    | $\Omega$ |
| 8  | $I_{REV\_SF}$            | Reverse Current on SFx                                 | Without device malfunction <sup>(1)</sup><br>Not to be tested in series production   | -                        | -    | -100 | mA       |

Table 55. Deployment drivers – DC specifications (continued)

| No | Symbol                        | Parameter            | Comments / Conditions  | Min | Typ  | Max  | Unit |
|----|-------------------------------|----------------------|--|-----|------|------|------|
| 9  | I <sub>LKG_SS_OFF</sub>       | SSxy leakage current | Device OFF<br>SSxy ≤ 35 V<br>SFx=SFy=0   | -10 | -    | 10   | μA   |
| 10 | I <sub>LKG_SS_ON_1CH</sub>    |                      | Device ON<br>SSxy ≤ 35 V<br>SFx = 0<br>SSxy Leakage current of each channel<br>Not Tested  | 70  | 100  | 130  | μA   |
| 11 | I <sub>LKG_SS_ON</sub>        |                      | Device ON<br>SSxy ≤ 35 V<br>SFx = SFy = 0<br>Total SSxy leakage current with both x and y channels NOT armed (= 2 * 100μA)           | 140 | 200  | 260  | μA   |
| 12 | I <sub>LKG_SS_CH_ARMED</sub>  |                      | Device ON<br>SSxy ≤ 35 V<br>SFx = 0<br>Total SSxy leakage current with only one channel armed (=520 + 100 μA)                        | 450 | 620  | 850  | μA   |
| 13 | I <sub>LKG_SS_2CH_ARMED</sub> |                      | Device ON<br>SSxy ≤ 35 V<br>SFx = SFy = 0<br>Total SSxy leakage current with both x and y channels armed (= 2* 520 μA)<br>Not Tested | 884 | 1040 | 1196 | μA   |
| 14 | I <sub>LKG_SF_ON_0V</sub>     | SF Leakage Current   | Device ON,<br>SYNCBOOST = SSxy = 35V,<br>SFx = 0V  | -5  | -    | 5    | μA   |
| 15 | I <sub>LKG_SF_ON_35V</sub>    |                      | Device ON,<br>SYNCBOOST = SSxy = 35V,<br>SFx = 35V   | -5  | -    | 50   | μA   |
| 16 | I <sub>LKG_SF_OFF_0V</sub>    |                      | Device OFF<br>SYNCBOOST = open,<br>SSxy = open but all SSxy pins connected,<br>SFx = 0V  | -5  | -    | 5    | μA   |
| 17 | I <sub>LKG_SF_OFF_35V</sub>   |                      | Device OFF<br>SYNCBOOST = open,<br>SSxy = open but all SSxy pins connected,<br>SFx = 35V   | -5  | -    | 50   | μA   |

Table 55. Deployment drivers – DC specifications (continued)

| No | Symbol             | Parameter               | Comments / Conditions   | Min  | Typ | Max  | Unit              |
|----|--------------------|-------------------------|---|------|-----|------|-------------------|
| 18 | $I_{LKG\_SR\_ON}$  | SR Leakage Current      | Device ON,<br>SYNCSBOOST = SSxy = 35V,<br>SRx = 0V-35   | -    | -   | 50   | $\mu$ A           |
| 19 | $I_{LKG\_SR\_OFF}$ |                         | DEVICE OFF,<br>SYNCSBOOST = open,<br>SSxy = open but all SSxy pins<br>connected,<br>SRx pull down current OFF<br>SRx=0V-20V | -    | -   | 50   | $\mu$ A           |
| 20 |                    |                         | DEVICE OFF,<br>SYNCSBOOST = open,<br>SSxy = open but all SSxy pins<br>connected,<br>SRx pull down current OFF<br>SRx=35V    | -    | -   | 30   | $\mu$ A           |
| 21 | $V_{SR\_CLAMP}$    | SR voltage clamp        | -   | 35   | -   | 40   | V                 |
| 22 | $L_{DEPL}$         | Load Inductance         | Maximum load inductance<br>Design Info <sup>(2)</sup>   | 0    | -   | 56   | $\mu$ H           |
| 23 | $C_{SFx}$          | Load Capacitance        | Maximum capacitance to GND<br>Design Info   | 13   | -   | 455  | nF                |
| 24 | $C_{SRx}$          |                         |   | 13   | -   | 455  | nF                |
| 25 | $C_{SSxy}$         | SSxy Capacitance        | Maximum capacitance to GND<br>connected directly to SSxy pin<br>Design Information  | -    | -   | 10   | nF                |
| 26 | $R_{SFLx}$         | Load Impedance          | Design Info   | -    | -   | 6.5  | $\Omega$          |
| 27 |                    | Wire Length             | Squib Loops containing a clock<br>spring shall be limited to a<br>maximum length of 3m                                      | 1    | -   | 10   | m                 |
| 28 | $R_{Wirex}$        | Wire Resistance         | Design Info   | 16.8 | -   | 63.4 | m $\Omega$ /<br>m |
| 29 | $L_{Wirex}$        | Wire Inductance         | Design Info   | 0.6  | -   | 1.8  | $\mu$ H/<br>m     |
| 30 | $R_{CSx}$          | Clock Spring Resistance | Maximum number of clock<br>springs is 3 for any IC<br>Design Info   | 0    | -   | 0.7  | $\Omega$          |

**Table 55. Deployment drivers – DC specifications (continued)**

| No | Symbol                | Parameter               | Comments / Conditions | Min   | Typ | Max   | Unit          |
|----|-----------------------|-------------------------|-----------------------|-------|-----|-------|---------------|
| 31 | $L_{CSx}$             | Clock Spring Inductance | Design Info           | 0     | -   | 42.9  | $\mu\text{H}$ |
| 32 | $k_{L\_CS1 - L\_CS2}$ | Clock Spring Coupling   | Design Info           | 0.739 | -   | 0.903 | -             |
| 33 | $L_{EMI}$             | Squib EMI protection    | Design Info           | 0     | -   | 7.7   | $\mu\text{H}$ |

1. In case of an unsupplied device and shorted deployment pins (e.g. to battery voltage), the dynamic reverse current through the high side power stage depends on  $C_{SSxy}$ .

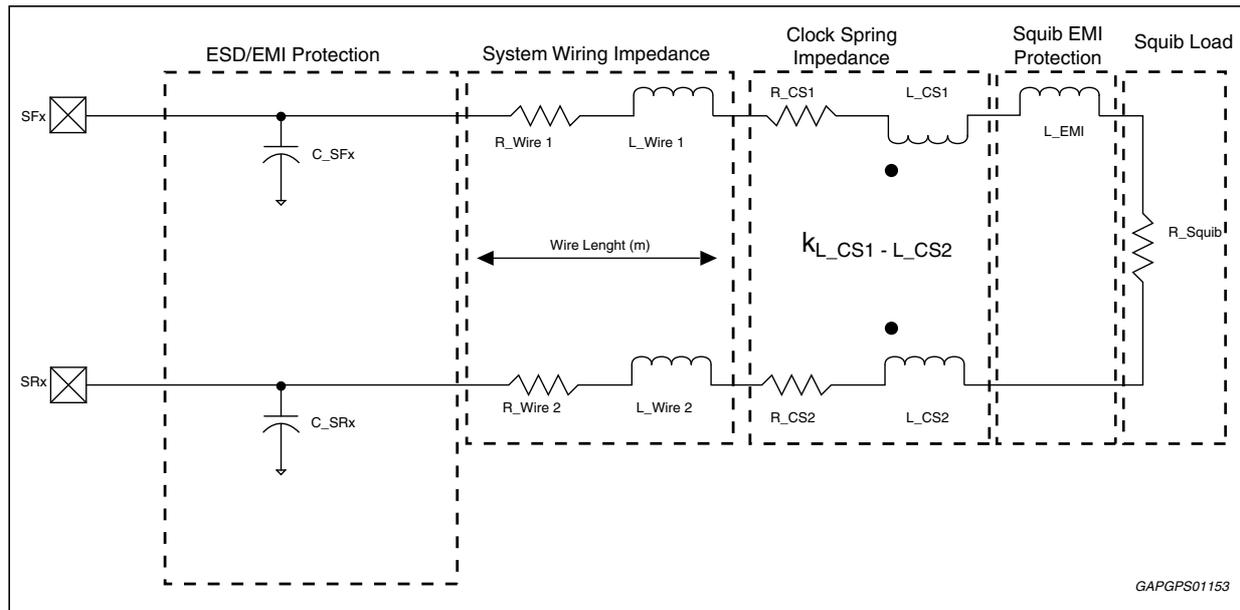
2.  $L_{DEPL}$  could be calculated in the following way:

Non-Clock Spring Loops:  $L_{DEPL}(\text{max}) = L_{\text{Wire}}(10\text{m} \cdot 2) + L_{EMI} = (3.6\mu\text{H}/\text{m} \cdot 10\text{m}) + 7.7\mu\text{H} = 43.7\mu\text{H}$

Clock Spring Loops:  $L_{\text{Wire}}(3\text{m} \cdot 2) + 2 \cdot L_{CSx} + L_{EMI} - (2 \cdot k_{L\_CS1 - L\_CS2} \cdot \text{SQRT}(L_{CS1} \cdot L_{CS2})) = (3.6\mu\text{H}/\text{m} \cdot 3\text{m}) + 2 \cdot 42.9\mu\text{H} + 7.7\mu\text{H} - (2 \cdot 0.739 \cdot 42.9\mu\text{H}) = 40.9\mu\text{H}$

Clock Spring Loops with short to ground:  $L_{DEPL}(\text{max}) = L_{\text{Wire}}(3\text{m}) + L_{CSx} + L_{EMI} = (1.8\mu\text{H}/\text{m} \cdot 3\text{m}) + 42.9\mu\text{H} + 7.7\mu\text{H} = 56\mu\text{H}$ .

**Figure 71. Deployment drivers diagram**



GAPGPS01153

Table 56. Deployment drivers – AC specifications

| No | Symbol                    | Parameter  | Conditions  | Min | Typ                    | Max | Unit |
|----|---------------------------|--|---|-----|------------------------|-----|------|
| 1  | T <sub>DEPL</sub>         | Deployment time  | DCR <sub>x</sub> (Dep_Current) = I <sub>DEPL_LO</sub> ≥ 1.209A rising to 1.209A falling;<br>T <sub>DEPL</sub> = DCR <sub>x</sub> (Deploy_Time)* T <sub>DEP_TIME_RES</sub> - T <sub>DEL_IDEP</sub> | -   | -                      | -   | ms   |
| 2  |                           |  |   | -   | -                      | -   |      |
| 3  |                           |  |   | -   | -                      | -   |      |
| 4  | T <sub>DEP_TIME_RES</sub> | DCR <sub>x</sub> Deploy_Time resolution  | -   | -   | $\frac{1024}{f_{osc}}$ | -   | µs   |
| 5  | T <sub>DEP_CC_RES</sub>   | Deployment current counter resolution  | -   | -   | $\frac{256}{f_{osc}}$  | -   | µs   |
| 6  | T <sub>RISE_IDEPL</sub>   | Rise time 10% - 90% of I <sub>DEPL</sub>   | SSxy = 25 V,<br>R <sub>SQ</sub> = 2.2 ohm,<br>C = 22 nF L = 44 µH   | -   | -                      | 32  | µs   |
| 7  | T <sub>DEL_IDEP</sub>     | Delay time SPI_CS to 90% I <sub>DEPL</sub>   |   | -   | -                      | 65  | µs   |
| 8  | T <sub>FALL_IDEPL</sub>   | Fall time 90% - 10% I <sub>DEPL</sub>  |   | -   | -                      | 32  | µs   |
| 9  | T <sub>DEL_SD_LS</sub>    | Low side shutdown delay time (with respect to high-side deactivation)  | -   | 50  | -                      | -   | µs   |
| 10 | T <sub>FLT_ILIM_LS</sub>  | Low side overcurrent to low side deactivation deglitch time in short to battery condition                    | -   | 80  | 100                    | 120 | µs   |
| 11 | T <sub>FLT_OS_LS</sub>    | Low side overcurrent to high side deactivation deglitch time in case of intermittent open to squib condition | -   | -   | -                      | 20  | µs   |
| 12 | T <sub>OFF_OS_HS</sub>    | High side OFF time in case of intermittent open to squib condition   | -   | 4   | -                      | 12  | µs   |

## 17.17 Deployment driver diagnostic

### 17.17.1 Squib resistance measurement

All electrical characteristics are valid for the following conditions unless otherwise noted:

$-40\text{ °C} \leq T_a \leq +95\text{ °C}$ ,  $V_{IN\_GOOD0(max)} \leq V_{IN} \leq 35\text{ V}$ ,  $6\text{ V} \leq SS_{xy} \leq 35\text{ V}$ ,  $7\text{ V} \leq SYNCBOOST \leq 35\text{ V}$ .

**Table 57. Deployment drivers diagnostics - Squib resistance measurement**

| No | Symbol   | Parameter   | Conditions  | Min  | Typ  | Max  | Unit  |
|----|--|---|---|------|------|------|-------|
| 1  | R <sub>SQ_RANGE_1</sub>                          | Squib resistance range 1                                      | LPDIAGREQ(ISRC_CURR_SEL) = 0  | 0    | -    | 10.0 | Ω     |
| 2  | R <sub>SQ_RANGE_2</sub>                          | Squib resistance range 2                                      | LPDIAGREQ(ISRC_CURR_SEL) = 1  | 0    | -    | 50.0 | Ω     |
| 3  | G <sub>RSQ</sub>                                 | Squib resistance measurement<br>Differential amplifier gain   | $V_{OUT\_RSQ} = G_{RSQ} \times [(V_{SF} - V_{SR})] + V_{off\_RSQ}$                            | -2%  | 5.2  | +2%  | V/V   |
| 4  | V <sub>off_RSQ</sub>                             | Squib resistance measurement<br>Differential amplifier offset | $V_{OUT\_RSQ} = G_{RSQ} \times [(V_{SF} - V_{SR})] + V_{off\_RSQ}$                            | 200  | -    | 400  | mV    |
| 5  | I <sub>SRC_HI_SF</sub><br>I <sub>SRC_HI_SR</sub> | Squib resistance measurement<br>High current source           | LPDIAGREQ(ISRC_CURR_SEL) = 0<br>LPDIAGREQ(ISRC) = "01" or "10"<br>SyncBoost = 11.5 V and 35 V | -5%  | 40   | +5%  | mA    |
| 6  | I <sub>SRC_LO_SF</sub><br>I <sub>SRC_LO_SR</sub> | Squib resistance measurement<br>Low current source            | LPDIAGREQ(ISRC_CURR_SEL) = 1<br>LPDIAGREQ(ISRC) = "01" or "10"<br>SyncBoost = 11.5 V and 35 V | -10% | 8    | +10% | mA    |
| 7  | I <sub>SRC_DELTA</sub>                           | Squib Resistance Measurement<br>Delta Current Source          | I <sub>SRC_HI_x</sub> - I <sub>SRC_LO_x</sub>   | -5%  | 32   | +5%  | mA    |
| 8  | SR <sub>ISRC</sub>                               | Squib resistance measurement<br>current source slew-rate      | -   | 3    | 7.5  | 12   | mA/μs |
| 9  | V <sub>SRx_RM</sub>                              | SRx voltage during<br>resistance measurement                  | LPDIAGREQ(ISRC)="01" or "10"<br>LPDIAGREQ(ISINK)=1  | 0.4  | 0.7  | 1.2  | V     |
| 10 | I <sub>SINK_HI_SR</sub>                          | SRx current sink limit high                                   | LPDIAGREQ(ISRC_CURR_SEL) = 0<br>LPDIAGREQ(ISINK) = 1  | 50   | 75   | 100  | mA    |
| 11 | I <sub>SINK_LO_SR</sub>                          | SRx current sink limit low                                    | LPDIAGREQ(ISRC_CURR_SEL) = 1<br>LPDIAGREQ(ISINK) = 1  | 10   | 17.5 | 25   | mA    |
| 12 | I <sub>PD_SR_L</sub>                             | SRx current pull down   | SYS_CTL(PD&VRM_SEL) = 0   | 0.7  | 1    | 1.3  | mA    |
| 13 | I <sub>PD_SR_H</sub>                             |   | SYS_CTL(PD&VRM_SEL) = 1   | 4.5  | 6    | 7.5  | mA    |
| 14 | R <sub>LKG_SF</sub>                              | SFx leakage resistance  | Design info   | 1    | -    | -    | kΩ    |

Table 57. Deployment drivers diagnostics - Squib resistance measurement (continued)

| No | Symbol              | Parameter                             | Conditions  | Min | Typ | Max | Unit |
|----|---------------------|---------------------------------------|---|-----|-----|-----|------|
| 15 | V <sub>LKG_SF</sub> | SFx leakage voltage source            | Design info   | -1  | -   | 18  | V    |
| 16 | R <sub>SQ_ACC</sub> | Squib resistance measurement accuracy | After software calculation<br>All errors included<br>R <sub>SQ</sub> between 1.0 Ω and 10.0 Ω<br>With High Current Source (40 mA) | -8% | -   | +8  | %    |
| 17 | -                   | EMI input low-pass filter             | Design Info   | 50  | -   | 100 | kHz  |

### 17.17.2 Squib leakage test (VRCM)

All electrical characteristics are valid for the following conditions unless otherwise noted:

$$-40\text{ °C} \leq T_a \leq +95\text{ °C}, V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$$

Table 58. Squib Leakage Test (VRCM)

| No | Symbol                    | Parameter   | Conditions   | Min                      | Typ  | Max    | Unit |
|----|---------------------------|---|--|--------------------------|------|--------|------|
| 1  | V <sub>OUT_VRCM</sub>     | Output Voltage on SF or SR pins during Leakage test | I <sub>OUT</sub> = 0 mA  | -10%                     | 2.5  | +10%   | V    |
| 2  |                           |   | I <sub>OUT</sub> = 6.6 mA  | 1.9                      | -    | 2.5    | V    |
| 3  | R <sub>LKG_GSG_TH</sub>   | Detection threshold, leakage to GND                 | Leakage detected if R <sub>LKG_GSG</sub> ≤ 1 kΩ and not detected if R <sub>LKG_GSG</sub> ≥ 10 kΩ<br>Design Info                          | 1                        | -    | 10     | kΩ   |
| 4a | I <sub>LKG_GSQ_TH_L</sub> |   | Equivalent to resistance range<br>SYS_CTL(PD&VRCM_SEL) = 0<br>-25 °C ≤ T <sub>j</sub> ≤ +150 °C<br>guaranteed by design/characterization | -15.5%                   | 450  | +15.5% | μA   |
| 4b |                           |   | Equivalent to resistance range<br>SYS_CTL(PD&VRCM_SEL) = 0<br>-40 °C ≤ T <sub>j</sub> ≤ +150 °C  | -17%                     | 450  | +15.5% | μA   |
| 5  |                           |   | I <sub>LKG_GSQ_TH_H</sub>  | SYS_CTL(PD&VRCM_SEL) = 1 | -15% | 2      | 15%  |
| 6  | T <sub>FLT_LKG</sub>      |   | Leakage to GND deglitch filter time  | -                        | 17   | 20     | 23   |
| 7  | R <sub>LKG_BSQ_TH</sub>   | Detection threshold, leakage to battery             | Leakage detected if R <sub>LKG_GSG</sub> ≤ 1 kΩ and not detected if R <sub>LKG_GSG</sub> ≥ 10 kΩ<br>Design Info                          | 1                        | -    | 10     | kΩ   |
| 8a | I <sub>LKG_BSQ_TH</sub>   |   | Equivalent to resistance range<br>-25 °C ≤ T <sub>j</sub> ≤ +150 °C<br>guaranteed by design/characterization                             | -12%                     | 1.8  | +15%   | mA   |
| 8b |                           |   | -40 °C ≤ T <sub>j</sub> ≤ +150 °C  | -17%                     | 1.8  | +15%   | mA   |

Table 58. Squib Leakage Test (VRCM)

| No  | Symbol                      | Parameter  | Conditions  | Min  | Typ | Max  | Unit       |
|-----|-----------------------------|--|---|------|-----|------|------------|
| 9   | $T_{FLT\_LKG}$              | Leakage to BAT deglitch filter time  | -   | 17   | 20  | 23   | $\mu s$    |
| 10  | $I_{LIM\_VRCM\_SRC}$        | VRCM current limitation  | -   | -20  | -   | -10  | mA         |
| 11  | $I_{LIM\_VRCM\_SINK}$       |  | -   | 10   | -   | 20   | mA         |
| 12  | $V_{SHIFT}$                 | External ground or battery shift   | Design Info   | -1   | -   | +1   | V          |
| 13  | $R_{SQ\_LOW\_TH}$           | Detection threshold for "resistance too low"   | Design Info   | 200  | -   | 500  | $\Omega$   |
| 14a | $I_{RSQ\_LOW\_TH}$          |  | Equivalent to resistance range<br>-25 °C $\leq T_j \leq$ +150 °C<br>guaranteed by design/characterization | -12% | 6   | +12% | mA         |
| 14b |                             |  | -40 °C $\leq T_j \leq$ +150 °C  | -17% | 6   | +12% | mA         |
| 15  | $T_{FLT\_RLOW}$             | "Resistance too low" deglitch filter time  | -   | 12   | 15  | 18   | $\mu s$    |
| 16  | $R_{SQ\_HIGH}$              | Detection Threshold for "resistance too high"  | Design Info   | 2    | -   | 5    | k $\Omega$ |
| 17a | $I_{RSQ\_HIGH}$             |  | Equivalent to resistance range<br>-25 °C $\leq T_j \leq$ +150 °C<br>guaranteed by design/characterization | -17% | 700 | +17% | $\mu A$    |
| 17b |                             |  | -40 °C $\leq T_j \leq$ +150 °C  | -17% | 700 | +22% | $\mu A$    |
| 18  | $T_{FLT\_RHIGH}$            | "Resistance too high" deglitch filter time   | -   | 12   | 15  | 18   | $\mu s$    |
| 19  | $T_{delay\_STG\_selection}$ | Time needed to change the VRCM STG thresholds (450 $\mu A$ -to-2 mA or 2 mA-to-450 $\mu A$ ) | guaranteed by design  | -    | -   | 2    | $\mu s$    |

**17.17.3 High/low side FET test**

All electrical characteristics are valid for the following conditions unless otherwise noted:

-40 °C ≤ Ta ≤ +95 °C, VIN\_GOOD0(max) ≤ VIN ≤ 35 V, 6 V ≤ SSxy ≤ 35 V, 7 V ≤ SYNCBOOST ≤ 35 V.

**Table 59. High/low side FET test**

| No | Symbol                          | Parameter  | Conditions                                     | Min    | Typ | Max    | Unit |
|----|---------------------------------|--|--|--------|-----|--------|------|
| 1  | I <sub>HS_FET_TH</sub>          | Detection threshold high side FET test   | -  | -12%   | 1.8 | +12%   | mA   |
| 2  | I <sub>LS_FET_TH</sub>          | Detection threshold low side FET test  | SYS_CTL(PD&VRCM_SEL) = 0                       | -15.5% | 450 | +15.5% | µA   |
| 3  | I <sub>LS_FET_TH_HIGH</sub>     |  | SYS_CTL(PD&VRCM_SEL) = 1                       | -15%   | 2   | +15%   | mA   |
| 4  | E <sub>FET_TEST</sub>           | Energy transferred to squib during HS/LS FET tests   | Design Info                                    | -      | -   | 170    | µJ   |
| 5  | T <sub>DRIVER_DIS</sub>         | Driver Disable time  | Guarantee by design                            | -      | -   | 1.5    | µs   |
| 6  | T <sub>TOT_FETTEST_ACTIVE</sub> | Total FET test activation time in case of no fault condition   | Guarantee by design                            | -      | -   | 4      | µs   |
| 7  | T <sub>FETTIMEOUT</sub>         | HS/LS FET test timeout   | -  | 190    | 200 | 210    | µs   |
| 8  | T <sub>FLT_LKGB_FT</sub>        | Deglitch filter time during FET test on I <sub>HS_FET_TH</sub> / I <sub>LS_FET_TH</sub> current thresholds | -  | 0.8    | 1   | 1.2    | µs   |
| 9  | I <sub>LIM_HS_FET</sub>         | HS FET current in HS driver diagnostics  | Not tested because of item # 1 in errata sheet | 40     | 50  | 60     | mA   |
| 10 | SG <sub>XYOPEN</sub>            | Squib open ground detection  | GNDSUBx as ground reference                    | 300    | 450 | 600    | mV   |
| 11 | T <sub>FLT_SGOPEN</sub>         | Squib open ground detection filter time  | -  | 46     | 50  | 54     | µs   |

**17.17.4 Deployment timer test**

All electrical characteristics are valid for the following conditions unless otherwise noted:

-40 °C ≤ Ta ≤ +95 °C, VIN\_GOOD0 ≤ VIN ≤ 35 V.

**Table 60. Deployment timer test - AC specifications**

| No | Symbol                    | Parameter                               | Conditions               | Min | Typ   | Max | Unit |
|----|---------------------------|---|--------------------------|-----|---|-----|------|
| 1  | t <sub>PULSE_PERIOD</sub> | Deployment timer pulse test period time | SYSDIAGREQ(DSTEST)=PULSE | 7   | 8   | 9   | ms   |
| 2  | I <sub>PULSE_HIGH</sub>   | Deployment timer pulse test high time   |                          | -   | DCR_x(Deploy_Time)* T <sub>DEP_TIME_RES</sub> | -   | µs   |

## 17.18 Remote sensor interface

All electrical characteristics are valid for the following conditions unless otherwise noted:  
 $40\text{ °C} \leq T_a \leq +95\text{ °C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$ ,  $V_{SATBUCK(min)} \leq V_{SATBUCK}$ ,  
 $V_{SYNCBOOST(min)} \leq V_{SYNCBOOST}$

### 17.18.1 PSI-5 interface

Table 61. PSI-5 satellite transceiver - DC specifications

| No  | Symbol                     | Parameter   | Conditions  | Min                    | Typ   | Max                    | Unit          |
|-----|----------------------------|---|---|------------------------|-------|------------------------|---------------|
| 1   | $I_{RSU}$                  | Interface quiescent current   | -   | -35                    | -     | -4                     | mA            |
| 2   | $V_{RSU\_MAX}$             | Max. output voltage excluding sync. pulse                             | (internal regulation, $V_{SATBUCK} = V_{SYNCBOOST}$ )   | -                      | -     | 11                     | V             |
| 3   | $V_{RSU\_SYNC\_MAX}$       | Max. output voltage including sync. pulse                             | (internal regulation, $V_{SYNCBOOST} = V_{IN}$ )<br>Syncboost = 12 V, 14.75 V, 18 V and 35 V  | -                      | -     | 16.5                   | V             |
| 4   | $R_{RSU}$                  | RSU output resistance   | From $I_{RSU} = -4\text{ mA}$ to $-65\text{ mA}$  | 3                      | -     | 9.5                    | $\Omega$      |
| 5   | $I_{STB\_TH}$              | Static reverse current into SATBUCK or SYNCBOOST pin ( $V_{SUPPLY}$ ) | $V_{RSUx} > V_{SUPPLY} + V_{RSU\_STB}$  | 0.0                    | -     | 10                     | mA            |
| 6   | $V_{RSU\_STB}$             | Output short to battery threshold                                     | -   | 10.0                   | -     | 100                    | mV            |
| 7   | $I_{OCTH\_PSI5}$           | Over current detection threshold                                      | Interface disabled after $T_{FLT\_OCTH\_PSI5}$  | -130                   | -     | -66                    | mA            |
| 8   | $I_{LIM\_PSI5}$            | Output current limit  | $I_{RSUx}$  | -130                   | -     | -80                    | mA            |
| 9   | $\Delta I_{LIM\_OC\_PSI5}$ | Difference between current limitation and OC threshold                | $ABS(I_{LIM\_RSU}) - ABS(I_{OCTH\_RSU})$  | 1                      | -     | -                      | mA            |
| 10  | $I_{BO}$                   | Base current  | Default value   | -15%                   | -15   | +15%                   | mA            |
| 11  | $I_{THGND}$                | Leakage to ground fault current detection                             | To ground; detected by $I_B$  | -50.4                  | -42   | -35                    | mA            |
| 12a | $I_{THOPEN}$               | Output open load detection threshold                                  | $V_{RSUx} = \text{open or leakage to battery}$<br>$-25\text{ °C} \leq T_j \leq +150\text{ °C}$<br>guaranteed by design/characterization | -3.5                   | -     | -0.5                   | mA            |
| 12b |                            |   | $-40\text{ °C} \leq T_j \leq +150\text{ °C}$  | -3.9                   | -     | -0.2                   | mA            |
| 13  | $I_{OL}$                   | Output open load detection threshold                                  | $V_{RSUx} = \text{open}$  | $I_{LKGB}(\text{min})$ | -     | $I_{LKGB}(\text{max})$ | mA            |
| 14  | $DAC_{RES}$                | DAC resolution  | -   | -                      | 10    | -                      | Bit           |
| 15  | $I_{LSB}$                  | LSB current   | Design Info   | -                      | 93.75 | -                      | $\mu\text{A}$ |

**Table 61. PSI-5 satellite transceiver - DC specifications (continued)**

| No | Symbol              | Parameter  | Conditions  | Min  | Typ | Max  | Unit     |
|----|---------------------|--|---|------|-----|------|----------|
| 16 | $V_{t2}$            | Sync pulse amplitude                                       | $I_{RSU} = 4 - 35 \text{ mA}$<br>Referred to $V_{RSUx}$ voltage before sync pulse<br>Syncboost = 12 V, 14.75 V, 18 V and 35 V | 3.8  | -   | -    | V        |
| 17 | $V_{SYNCDROP}$      | Sync drop-out voltage                                      | $V_{SYNCBOOST} - V_{RSUx}$  | 1    | -   | -    | V        |
| 18 | $I_{LIM\_SYNC\_LS}$ | Sync pulse current limit (LS driver)                       | -   | 50   | -   | 80   | mA       |
| 19 | $I_{LIM\_SYNC}$     | Static current limitation for each transceiver output RSUx | During sync pulse generator $V_{RSUx}=GND$  | -240 | -   | -120 | mA       |
| 20 | $C_1$               | Capacitor on RSUx Regulator                                | 22 nF nominal<br>Design Info  | 13   | -   | -    | nF       |
| 21 | $R_{E2}$            | RSU damping resistance                                     | Design info   | -    | 2.5 | -    | $\Omega$ |
| 22 | $C_2$               | ECU pin capacitance  | 5 nF nominal<br>Design Information, not tested  | 4    | -   | 6    | nF       |
| 23 | -                   | Total number of sensors connected to bus                   | Design info   | 1    | -   | 3    | -        |

**Table 62. PSI-5 satellite transceiver - AC specifications**

| No | Symbol                | Parameter                                   | Conditions   | Min | Typ | Max  | Unit          |
|----|-----------------------|---|--|-----|-----|------|---------------|
| 1  | $T_{Bit\_125k}$       | Bit time (125kbps mode)                     | At the sensor connector  | 7.6 | 8   | 8.4  | $\mu\text{s}$ |
| 2  | $T_{Bit\_189k}$       | Bit time (189kbps mode)                     | At the sensor connector  | 5   | 5.3 | 5.6  | $\mu\text{s}$ |
| 3  | $T_{FLT\_OCTH\_PSI5}$ | Over Current Detection deglitch filter time | Normal operation   | 500 | -   | 600  | $\mu\text{s}$ |
| 4  | $T_{BLK\_OCTH\_PSI5}$ | Over Current Detection Blanking Time        | At interface power on (BLKTxSEL = 0)                                   | 4.6 | -   | 5.4  | ms            |
| 5  |                       |   | At interface power on (BLKTxSEL = 1)                                   | 9.4 | -   | 10.8 | ms            |
| 6  | $T_{STBTH}$           | Reverse Battery Blocking Enable Time        | -  | 12  | -   | 16   | $\mu\text{s}$ |
| 7  | $t_0$                 | Reference time                              | @0.5 V on top of $V(RSUx)$<br>Syncboost = 12 V, 14.75 V, 18 V and 35 V | -   | 0   | -    | -             |
| 8  | $t_1$                 | Start delay time                            | From $t_0$ to SATSYNC<br>Syncboost = 12 V, 14.75 V, 18 V and 35 V      | -3  | -   | -    | $\mu\text{s}$ |

Table 62. PSI-5 satellite transceiver - AC specifications (continued)

| No | Symbol                               | Parameter                                 | Conditions   | Min   | Typ | Max   | Unit             |
|----|--------------------------------------|---|--|-------|-----|-------|------------------|
| 9  | $t_2$                                | Sync signal sustain start                 | @ VRSU+3.8 V relative to $t_0$<br>Syncboost = 12 V, 14.75 V, 18 V and 35 V | -     | -   | 7     | $\mu\text{s}$    |
| 10 | $SR_{\text{RISE\_RSU}}$              | Sync slope rising slew rate               |  | 0.43  | -   | 1.5   | V/ $\mu\text{s}$ |
| 11 | $SR_{\text{FALL\_RSU}}$              | Sync slope falling slew rate              |  | -1.5  | -   | -     | V/ $\mu\text{s}$ |
| 12 | $t_3$                                | Sync signal sustain time                  | Design Info  | 16    | -   | -     | $\mu\text{s}$    |
| 13 | $t_4$                                | Discharge time limit                      | Design Info  | -     | -   | 35    | $\mu\text{s}$    |
| 14 | $T_{\text{BLANK}}$                   | Decoder blanking time (decoding disabled) | Design Info  | -     | -   | 42    | $\mu\text{s}$    |
| 15 | $T_{\text{SYNC}}$                    | Time between two sync pulses              | Design Info  | 400   | 500 | -     | $\mu\text{s}$    |
| 16 | $T_{\text{FLT\_PSI5\_HF}}$           | PSI5 Deglitch filter time                 | F = 189 kbaud<br>Configurable by SPI (4bits)                               | 1     | -   | 2     | $\mu\text{s}$    |
| 17 | $T_{\text{FLT\_PSI5\_LF}}$           | PSI5 Deglitch filter time                 | F = 125 kbaud<br>Configurable by SPI (4bits)                               | 1.5   | -   | 2.5   | $\mu\text{s}$    |
| 18 | $T_{\text{ES\_1}}, T_{\text{LS\_1}}$ | Message start time, Slot 1                | Related to $t_0$ , Sensor Side, P8P-500-3L                                 | 44    | -   | 58.6  | $\mu\text{s}$    |
| 19 |                                      |   | Related to $t_0$ , Sensor Side, P8P-500-3H                                 | 44    | -   | 58.6  | $\mu\text{s}$    |
| 20 |                                      |   | Related to $t_0$ , Sensor Side, P8P-500-4H                                 | 44    | -   | 58.6  | $\mu\text{s}$    |
| 21 |                                      |   | Related to $t_0$ , Sensor Side, P10P-500-3L                                | 44    | -   | 58.6  | $\mu\text{s}$    |
| 22 |                                      |   | Related to $t_0$ , Sensor Side, P10P-500-3H                                | 44    | -   | 58.6  | $\mu\text{s}$    |
| 23 |                                      |   | Related to $t_0$ , Sensor Side, P10P-500-4H                                | 44    | -   | 58.6  | $\mu\text{s}$    |
| 24 | $T_{\text{ES\_2}}, T_{\text{LS\_2}}$ | Message start time, Slot 2                | Related to $t_0$ , Sensor Side, P8P-500-3L                                 | 181.3 | -   | 210.4 | $\mu\text{s}$    |
| 25 |                                      |   | Related to $t_0$ , Sensor Side, P8P-500-3H                                 | 181.3 | -   | 210.4 | $\mu\text{s}$    |
| 26 |                                      |   | Related to $t_0$ , Sensor Side, P8P-500-4H                                 | 139.5 | -   | 164.2 | $\mu\text{s}$    |
| 27 |                                      |   | Related to $t_0$ , Sensor Side, P10P-500-3L                                | 181.3 | -   | 210.4 | $\mu\text{s}$    |
| 28 |                                      |   | Related to $t_0$ , Sensor Side, P10P-500-3H                                | 181.3 | -   | 210.4 | $\mu\text{s}$    |
| 29 |                                      |   | Related to $t_0$ , Sensor Side, P10P-500-4H                                | 139.5 | -   | 164.2 | $\mu\text{s}$    |

**Table 62. PSI-5 satellite transceiver - AC specifications (continued)**

| No | Symbol                                | Parameter                             | Conditions   | Min   | Typ | Max   | Unit |
|----|---------------------------------------|---------------------------------------|--|-------|-----|-------|------|
| 30 | T <sub>ES_3</sub> , T <sub>LS_3</sub> | Message start time, Slot 3            | Related to t <sub>0</sub> , Sensor Side, P8P-500-3L  | 328.9 | -   | 373.5 | µs   |
| 31 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-3H  | 328.9 | -   | 373.5 | µs   |
| 32 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-4H  | 245.5 | -   | 281.3 | µs   |
| 33 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3L | 328.9 | -   | 373.5 | µs   |
| 34 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3H | 328.9 | -   | 373.5 | µs   |
| 35 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-4H | 245.5 | -   | 281.3 | µs   |
| 36 | T <sub>s1_end_open</sub>              | Slot 1 End valid window, opening time | Related to t <sub>0</sub> , Sensor Side, P8P-500-3L  | 107.2 | -   | 127.6 | µs   |
| 37 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-3H  | 82    | -   | 99.4  | µs   |
| 38 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-4H  | 82    | -   | 99.4  | µs   |
| 39 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3L | 121   | -   | 142.8 | µs   |
| 40 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3H | 91    | -   | 109.4 | µs   |
| 41 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-4H | 91    | -   | 109.4 | µs   |
| 42 | T <sub>s1_end_closure</sub>           | Slot 1 End valid window, closure time | Related to t <sub>0</sub> , Sensor Side, P8P-500-3L  | 151   | -   | 174.6 | µs   |
| 43 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-3H  | 119.8 | -   | 139.9 | µs   |
| 44 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-4H  | 119.8 | -   | 139.9 | µs   |
| 45 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3L | 167.8 | -   | 193   | µs   |
| 46 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3H | 131   | -   | 152.5 | µs   |
| 47 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-4H | 131   | -   | 152.5 | µs   |
| 48 | T <sub>s2_end_open</sub>              | Slot 2 End valid window, opening time | Related to t <sub>0</sub> , Sensor Side, P8P-500-3L  | 231.6 | -   | 264.9 | µs   |
| 49 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-3H  | 206   | -   | 236.7 | µs   |
| 50 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-4H  | 168   | -   | 194.9 | µs   |
| 51 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3L | 245.4 | -   | 280.1 | µs   |
| 52 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3H | 215.5 | -   | 246.7 | µs   |
| 53 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-4H | 177.5 | -   | 205   | µs   |
| 54 | T <sub>s2_end_closure</sub>           | Slot 2 End valid window, closure time | Related to t <sub>0</sub> , Sensor Side, P8P-500-3L  | 302.8 | -   | 342.1 | µs   |
| 55 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-3H  | 271.6 | -   | 308   | µs   |
| 56 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-4H  | 225.4 | -   | 256.5 | µs   |
| 57 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3L | 319.6 | -   | 360.5 | µs   |
| 58 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3H | 282.7 | -   | 320   | µs   |
| 59 |                                       |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-4H | 236.5 | -   | 260   | µs   |

Table 62. PSI-5 satellite transceiver - AC specifications (continued)

| No | Symbol                         | Parameter                             | Conditions  | Min   | Typ                   | Max   | Unit |
|----|--------------------------------|---------------------------------------|---|-------|-----------------------|-------|------|
| 60 | T <sub>s3_end_open</sub>       | Slot 3 End valid window, opening time | Related to t <sub>0</sub> , Sensor Side, P8P-500-3L   | 365.1 | -                     | 412.5 | μs   |
| 61 |                                |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-3H   | 339.4 | -                     | 384.3 | μs   |
| 62 |                                |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-4H   | 263.9 | -                     | 300.9 | μs   |
| 63 |                                |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3L  | 378.9 | -                     | 427.7 | μs   |
| 64 |                                |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3H  | 348.5 | -                     | 394.3 | μs   |
| 65 |                                |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-4H  | 273   | -                     | 311   | μs   |
| 66 | T <sub>s3_end_closure</sub>    | Slot 3 End valid window, closure time | Related to t <sub>0</sub> , Sensor Side, P8P-500-3L   | 465.9 | -                     | 522.7 | μs   |
| 67 |                                |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-3H   | 434.7 | -                     | 488   | μs   |
| 68 |                                |                                       | Related to t <sub>0</sub> , Sensor Side, P8P-500-4H   | 342.5 | -                     | 386.1 | μs   |
| 69 |                                |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3L  | 482.7 | -                     | 541.1 | μs   |
| 70 |                                |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-3H  | 445.9 | -                     | 500   | μs   |
| 71 |                                |                                       | Related to t <sub>0</sub> , Sensor Side, P10P-500-4H  | 353.7 | -                     | 398.2 | μs   |
| 72 | T <sub>SYNC_DLY_SHORT</sub>    | Sync Pulse Start Delay                | SYS_CFG(RSU_SYNC_PULSE_SHIFT_CONF)=0 Related to Start of Sync Pulse on ch. N-1  | -     | $\frac{160}{f_{osc}}$ | -     | μs   |
| 73 | T <sub>SYNC_DLY_LONG</sub>     |                                       | SYS_CFG(RSU_SYNC_PULSE_SHIFT_CONF)=1 Related to Start of Sync Pulse on ch. N-1  | -     | $\frac{288}{f_{osc}}$ | -     | μs   |
| 74 | T <sub>FLT_OPEN_RSU</sub>      | Open Detection Deglitch Filter Time   | -   | 10    | -                     | 15    | μs   |
| 75 | T <sub>FLT_LKG_RSU</sub>       | Leakage Deglitch Filter Time          | -   | 10    | -                     | 15    | μs   |
| 76 | T <sub>WRITE_EN_DELAY_LF</sub> | Data register write delay             | Design Info<br>F = 125 kbaud<br>Calculated from transition of last sensor bit to when data is available in SPI register | -     | -                     | 19    | μs   |
| 77 | T <sub>WRITE_EN_DELAY_HF</sub> |                                       | Design Info<br>F = 189 kbaud<br>Calculated from transition of last sensor bit to when data is available in SPI register | -     | -                     | 14    | μs   |

### 17.19 DC sensor interface

All electrical characteristics are valid for the following conditions unless otherwise noted:  
 $40\text{ }^{\circ}\text{C} \leq T_a \leq +95\text{ }^{\circ}\text{C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$ ,  $8.5\text{ V} \leq \text{SYNCBOOST} \leq 35\text{ V}$ .

**Table 63. DC Sensor interface specifications**

| No | Symbol            | Parameter                                  | Conditions   | Min  | Typ               | Max  | Unit     |
|----|-------------------|--|--|------|-------------------|------|----------|
| 1  | $V_{OUT\_DCSREG}$ | DCS output voltage regulation mode         | DCS regulator enabled<br>SyncBoost = 11.5 V and 35 V   | -10% | 6.25              | +10% | V        |
| 2  | $I_{LIM\_DCSREG}$ | DCS current limitation regulation mode     | DCS regulator enabled<br>SyncBoost = 11.5 V and 35 V   | 24   | 27                | 30   | mA       |
| 3  | $V_{DCS\_RANGE1}$ | DCS voltage measurement range1             | First voltage measurement ( $V_{DCS\_MEAS1}$ ) to compensate external ground shift and internal offset | -1   | -                 | 1.4  | V        |
| 4  | $V_{DCS\_ACC1}$   | DCS voltage measurement accuracy 1         | $V_{DCS} = V_{DCS\_RANGE1}$<br>Included ADC error  | -15  | -                 | 15   | %        |
| 5  | $V_{DCS\_RANGE2}$ | DCS voltage measurement range 2            | -  | 1.5  | -                 | 10   | V        |
| 6  | $V_{DCS\_ACC2}$   | DCS voltage measurement accuracy 2         | $V_{DCS} = V_{DCS\_RANGE2}$<br>Included ADC error  | -8   | -                 | +8   | %        |
| 7  | $I_{DCS\_RANGE1}$ | DCS Current measurement range 1            | -  | 1    | -                 | 2    | mA       |
| 8  | $I_{DCS\_ACC1}$   | DCS current measurement accuracy 1         | $I_{DCS} = I_{DCS\_RANGE1}$<br>Included ADC error  | -30  | -                 | +30  | %        |
| 9  | $I_{DCS\_RANGE2}$ | DCS current measurement range 2            | -  | 2    | -                 | 22   | mA       |
| 10 | $I_{DCS\_ACC2}$   | DCS current measurement accuracy 2         | $I_{DCS} = I_{DCS\_RANGE2}$<br>Included ADC error  | -12  | -                 | +12  | %        |
| 11 | $I_{DCS\_RANGE3}$ | DCS current measurement range 3            | Regulator in current limitation  | -    | $I_{LIM\_DCSREG}$ | -    | mA       |
| 12 | $I_{DCS\_ACC3}$   | DCS Current measurement accuracy 3         | $V_{DCS} = 0V$<br>Included ADC error   | -12  | -                 | +12  | %        |
| 13 | $R_{DCS\_RANGE}$  | DCS resistance measurement range           | Design info  | 65   | -                 | 3000 | $\Omega$ |
| 14 | $R_{DCS\_ACC}$    | Accuracy of digital resistance measurement | Performing voltage measurements 1 and 2<br>After software calculation<br>all errors included           | -15  | -                 | 15   | %        |

Table 63. DC Sensor interface specifications

| No  | Symbol             | Parameter  | Conditions  | Min  | Typ   | Max  | Unit             |
|-----|--------------------|--|---|------|-------|------|------------------|
| 15a | $I_{PD\_DCS\_OFF}$ | DCSx current pull down                                 | $V_{DCS} \geq 1.5\text{ V}$<br>All DCS channels OFF<br>Not tested   | 70   | 100   | 130  | $\mu\text{A}$    |
| 15b | $I_{PD\_DCS}$      |  | $V_{DCS} \geq 1.5\text{ V}$<br>Pull-down current on all DCS channels but the one activated  | 160  | 200   | 250  | $\mu\text{A}$    |
| 16  | $R_{PD\_DCS}$      | DCSx resistance pull down                              | Device active,<br>DCSx current pull down disabled   | 90   | 150   | 210  | $\text{k}\Omega$ |
| 17a | $I_{PD\_DCS\_TOT}$ | DCSx total current pull down                           | $I_{PD\_DCS\_TOT} = I_{PD\_DCS\_OFF} + R_{PD\_DCS}$<br>$V_{DCS} = 6.5\text{ V}$<br>All DCS channels OFF<br>Not tested                           | 80   | 140   | 220  | $\mu\text{A}$    |
| 17b | $I_{PD\_DCS}$      |  | $I_{PD\_DCS\_TOT} = I_{PD\_DCS} + R_{PD\_DCS}$<br>$V_{DCS} = 6.5\text{ V}$<br>Total Pull-down current on all DCS channel but the one activated. | 180  | 240   | 320  | $\mu\text{A}$    |
| 18  | $C_{DCS}$          | Output capacitance                                     | Design Info   | 10   | -     | -    | nF               |
| 19  | $I_{REF\_DCS}$     | Internal Current Reference for DCS Current Measurement | -   | -5%  | 300   | +5%  | $\mu\text{A}$    |
| 20  | Ratio_VDCS         | Divider ratio for DCSx voltage measurement             | -   | -3%  | 7.125 | +3%  | V/V              |
| 21  | $V_{OFF\_DCS}$     | DCSx internal offset during voltage measurement        | -   | 0.35 | 0.375 | 0.39 | V                |

## 17.20 Safing engine

All electrical characteristics are valid for the following conditions unless otherwise noted:

$40\text{ }^{\circ}\text{C} \leq T_a \leq +95\text{ }^{\circ}\text{C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$ ,  $V_{CCx(min)} \leq V_{CCx} \leq V_{CCx(max)}$ ,  
 $V_{CC} = 3.3\text{ V}$  or  $5\text{ V}$ .

Table 64. Arming Interface – DC specifications

| No | Symbol           | Parameter                    | Conditions  | Min           | Typ  | Max  | Unit             |
|----|------------------|------------------------------|---|---------------|------|------|------------------|
| 1  | $V_{TH\_H\_ACL}$ | ACL input voltage thresholds | -   | 2.33          | -    | 2.5  | V                |
| 2  | $V_{TH\_L\_ACL}$ |                              |   | 1.58          | -    | 1.71 | V                |
| 3  | $V_{HYS\_ACL}$   | ACL hysteresis               | -   | 0.6           | 0.75 | 0.9  | V                |
| 4  | $R_{PD\_ACL}$    | ACL pull down resistance     | $V_{ACL} = 3.3\text{V}$                                 | 150           | 210  | 270  | $\text{k}\Omega$ |
| 5  | $V_{OH\_ARM}$    | ARMx output high voltage     | $I_{LOAD} = -0.5\text{ mA}$<br>internal safing selected | $V_{CC}-0.60$ | -    | VCC  | V                |

**Table 64. Arming Interface – DC specifications (continued)**

| No | Symbol                        | Parameter                        | Conditions  | Min      | Typ | Max | Unit |
|----|-------------------------------|----------------------------------|---|----------|-----|-----|------|
| 6  | V <sub>OL_ARM</sub>           | ARMx output low voltage          | I <sub>LOAD</sub> = 2.0 mA<br>internal safing selected  | 0        | -   | 0.4 | V    |
| 7  | R <sub>PD_ARM</sub>           | ARMx pull down resistance        | -   | 65       | 100 | 135 | kΩ   |
| 8  | V <sub>IH_ARM</sub>           | ARMx high level input voltage    | -   | 2        | -   | -   | V    |
| 9  | V <sub>IL_ARM</sub>           | ARMx low level input voltage     | -   | -        | -   | 0.8 | V    |
| 10 | R <sub>PD_ARMx, x=1,2,3</sub> | ARM1,2,3 pull down resistor      | External safing selected                                | 60       | 100 | 140 | kΩ   |
| 11 | V <sub>IH_FENL</sub>          | FENL high level Input Voltage    | -   | 2        | -   | -   | V    |
| 12 | V <sub>IL_FENL</sub>          | FENL low level Input Voltage     | -   | -        | -   | 0.8 | V    |
| 13 | I <sub>PU_ARM4</sub>          | ARM4 pull up current             | ARM4 = 0V<br>external safing selected                   | -100     | -75 | -50 | μA   |
| 14 | V <sub>OH_PSINHB</sub>        | PSINHB output high voltage       | I <sub>LOAD</sub> = -0.5 mA<br>Internal safing selected | VCC-0.60 | -   | VCC | V    |
| 15 | V <sub>OL_PSINHB</sub>        | PSINHB output low voltage        | I <sub>LOAD</sub> = 2.0 mA<br>Internal safing selected  | 0        | -   | 0.4 | V    |
| 16 | R <sub>PD_PSINHB</sub>        | PSINHB pull down resistance      | -   | 65       | 100 | 135 | kΩ   |
| 17 | V <sub>IH_PSINHB</sub>        | PSINHB high level input voltage  | -   | 2        | -   | -   | V    |
| 18 | V <sub>IL_PSINHB</sub>        | PSINHB low level input voltage   | -   | -        | -   | 0.8 | V    |
| 19 | V <sub>IH_SAF_CSx</sub>       | SAF_CSx high level input voltage | -   | 2        | -   | -   | V    |
| 20 | V <sub>IL_SAF_CSx</sub>       | SAF_CSx low level input voltage  | -   | -        | -   | 0.8 |      |
| 21 | I <sub>PU_SAF_CSx</sub>       | SAF_CSx pull up current          | SAF_CSx = 0 V to<br>V <sub>IH_SAF_CSx(min)</sub>        | -70      | -45 | -20 | μA   |

**Table 65. Arming interface – AC specifications**

| No | Symbol                 | Parameter                  | Conditions | Min | Typ | Max | Unit |
|----|------------------------|----------------------------|------------|-----|-----|-----|------|
| 1  | T <sub>ARM</sub>       | Sensor sampling period     | -          | 475 | 500 | 525 | μs   |
| 2  | T <sub>ACL_HI</sub>    | ACL period time thresholds | -          | 213 | -   | 237 | ms   |
| 3  | T <sub>ACL_LO</sub>    |                            | -          | 168 | -   | 187 | ms   |
| 4  | T <sub>ON_ACL_HI</sub> | ACL on-time thresholds     | -          | 154 | -   | 171 | ms   |
| 5  | T <sub>ON_ACL_LO</sub> |                            | -          | 114 | -   | 126 | ms   |

Table 65. Arming interface – AC specifications (continued)

| No | Symbol                     | Parameter  | Conditions   | Min  | Typ                  | Max  | Unit   |
|----|----------------------------|--|--|------|----------------------|------|--------|
| 6  | T <sub>VALID_ACL</sub>     | Scrap validation<br>T <sub>ACL</sub> and T <sub>ON_ACL</sub> valid | -  | 3    | -                    | -    | cycles |
| 7  | T <sub>INVALID_ACL</sub>   | Scrap invalid<br>T <sub>ACL</sub> invalid                          | -  | 2    | -                    | -    | cycles |
| 8  | T <sub>SCRAP_TIMEOUT</sub> | Scrap timeout timer  | -  | 520  | 550                  | 580  | μs     |
| 9  | f <sub>SCRAP_SEED</sub>    | Scrap seed counter<br>frequency                                    | -  | -    | $\frac{f_{osc}}{16}$ | -    | MHz    |
| 10 | T <sub>PULSE_STRECH</sub>  | Arming enable pulse stretch<br>time                                | -  | -    | -                    | 0    | ms     |
| 11 |                            |  | -  | 30   | 32                   | 34   | ms     |
| 12 |                            |  | -  | 242  | -                    | 270  | ms     |
| 13 |                            |  | -  | 1934 | -                    | 2162 | ms     |
| 14 | T <sub>RISE_ARM</sub>      | ARMx rise time   | 50 pF load, 20% to 80%<br>internal safing selected | -    | -                    | 1.00 | μs     |
| 15 | T <sub>FALL_ARM</sub>      | ARMx fall time   |  | -    | -                    | 1.00 | μs     |
| 16 | T <sub>RISE_PSINHB</sub>   | PSINHB rise time   |  | -    | -                    | 1.00 | μs     |
| 17 | T <sub>FALL_PSINHB</sub>   | PSINHB fall time   |  | -    | -                    | 1.00 | μs     |

## 17.21 General purpose output drivers

All electrical characteristics are valid for the following conditions unless otherwise noted:

$40\text{ °C} \leq T_a \leq +95\text{ °C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{V}$ ,  $V_{GPODx} + 5\text{V} \leq V_{ERBOOST}$ .

**Table 66. GPO interface DC specifications**

| No | Symbol                | Parameter  | Conditions  | Min  | Typ | Max  | Unit          |
|----|-----------------------|--|---|------|-----|------|---------------|
| 1  | $V_{SAT\_GPO\_L}$     | Output saturation voltage  | $V_{GPOD} - V_{GPOS}$<br>$I_{LOAD} = 50\text{ mA}$ , ERBOOST = 35 V | -    | -   | 0.5  | V             |
| 2  | $V_{SAT\_GPO\_H}$     | Output saturation voltage  | $V_{GPOD} - V_{GPOS}$<br>$I_{LOAD} = 70\text{ mA}$                  | -    | -   | 0.7  | V             |
| 3  | $I_{LIM\_GPO}$        | Driver current limit   | $V_{GPOD} - V_{GPOS} = 1.5\text{ V}$<br>ERBOOST = 35 V              | 73   | 110 | 160  | mA            |
| 4  | $I_{OC\_GPO}$         | Over current detection   | ERBOOST = 35 V  | 73   | 110 | 160  | mA            |
| 5  | $V_{OUT\_GPOD\_OL}$   | GPO diag OFF output voltage on GPOD in low side mode in open load condition  | GPOxLS = 1<br>$I_{OUT} = 0\text{ mA}$                               | -10% | 2.5 | +10% | V             |
| 6  | $V_{OUT\_GPOS\_OL}$   | GPO diag OFF output voltage on GPOS in high side mode in open load condition | GPOxLS = 0<br>$I_{OUT} = 0\text{ mA}$                               | -10% | 2.5 | +10% | V             |
| 7  | $I_{SRC\_TH}$         | GPO diag OFF state short to ground detection threshold                       | GPOxLS = 0 / 1  | 15   | 27  | 40   | $\mu\text{A}$ |
| 8  | $I_{SINK\_TH\_LS}$    | GPO Diag OFF state short to battery detection threshold low side mode        | GPOxLS = 1<br>GPOS = 0  | 15   | 27  | 46   | $\mu\text{A}$ |
| 9  | $I_{SINK\_TH\_HS}$    | GPO Diag OFF state short to battery detection threshold high side mode       | GPOxLS = 0  | 170  | 220 | 270  | $\mu\text{A}$ |
| 10 | $I_{LIM\_GPOD\_SRC}$  | GPO Diag OFF state low side mode current limitation on GPOD                  | GPOxLS = 1,<br>GPO Driver OFF,<br>GPOD = 0 V, GPOS = 0 V            | -90  | -70 | -50  | $\mu\text{A}$ |
| 11 | $I_{LIM\_GPOD\_SINK}$ |  | GPOxLS = 1,<br>GPO Driver OFF,<br>GPOD = 18 V, GPOS = 0 V           | 50   | 70  | 90   | $\mu\text{A}$ |
| 12 | $I_{LIM\_GPOS\_SRC}$  | GPO Diag OFF state high side mode current limitation on GPOS                 | GPOxLS = 0,<br>GPO Driver OFF,<br>GPOD = 18 V, GPOS = 0 V           | -90  | -70 | -50  | $\mu\text{A}$ |
| 13 | $I_{LIM\_GPOS\_SINK}$ |  | GPOxLS = 0,<br>GPO driver OFF,<br>GPOD = 18 V, GPOS = 18 V          | 320  | 400 | 480  | $\mu\text{A}$ |
| 14 | $I_{OL\_GPO}$         | Open load current threshold  | GPO driver ON   | 0.5  | 1   | 3    | mA            |

Table 66. GPO interface DC specifications (continued)

| No | Symbol               | Parameter                   | Conditions   | Min | Typ | Max | Unit         |
|----|----------------------|-----------------------------|--|-----|-----|-----|--------------|
| 15 | $I_{DIAG\_GPO}$      | Diagnostic current on load  | Voltage measurement in progress through Analog MUX<br>Increased leakage for a short specified time (32 $\mu$ s)          | -   | -   | 130 | $\mu$ A      |
| 16 | $I_{LKG\_GPOD\_OFF}$ | GPOD output leakage current | $V_{GPOD} = 18$ V<br>$V_{GPOS} = 0$ V, ERBOOST = 35 V<br>Power-off or Sleep Mode   | -5  | -   | +5  | $\mu$ A      |
| 17 | $I_{LKG\_GPOD\_ON}$  |                             | $V_{GPOD} = 18$ V<br>$V_{GPOS} = 0$ V, ERBOOST = 35 V<br>GPO Driver OFF<br>Active or Passive Mode with GPO un-configured | -5  | -   | +5  | $\mu$ A      |
| 18 | $I_{LKG\_GPOS\_OFF}$ | GPOS output leakage current | $V_{GPOD} = 18$ V<br>$V_{GPOS} = 0$ V, ERBOOST = 35 V<br>Power-off or Sleep Mode   | -5  | -   | +5  | $\mu$ A      |
| 19 | $I_{LKG\_GPOS\_ON}$  |                             | $V_{GPOD} = 18$ V<br>$V_{GPOS} = 0$ V, ERBOOST = 35 V<br>GPO Driver OFF<br>Active or Passive Mode with GPO un-configured | -5  | -   | +5  | $\mu$ A      |
| 20 | $I_{REV\_GPO}$       | Reverse current             | $V_{GPOS} = V_{GPOD} + 1$ V<br>GPO Driver OFF  | -   | -   | 1   | mA           |
| 21 | $T_{JSD\_GPO}$       | Thermal shutdown            | -  | 150 | 175 | 190 | $^{\circ}$ C |
| 22 | $T_{HYS\_TSD\_GPO}$  |                             | -  | 5   | 10  | 15  | $^{\circ}$ C |
| 23 | $C_{GPO}$            | Load capacitor              | Design Info  | 6   | -   | -   | nF           |

Table 67. GPO driver interface – AC specifications

| No | Symbol         | Parameter  | Conditions  | Min | Typ  | Max | Unit       |
|----|----------------|--|---|-----|------|-----|------------|
| 1  | $SR_{GPOx}$    | GPOx output voltage slew rate                                | 30% - 70%;<br>$R_{LOAD} = 273$ $\Omega$ , $C_{LOAD} = 100$ nF | 0.1 | 0.25 | 0.4 | V/ $\mu$ s |
| 2  | $T_{FLT\_OC}$  | Over current detection filter time                           | GPO Driver ON   | 10  | 12   | 14  | $\mu$ s    |
| 3  | $T_{FLT\_UC}$  | Open load detection filter time                              | GPO Driver ON   | 8   | 10   | 12  | $\mu$ s    |
| 4  | $T_{FLT\_STB}$ | Short to battery detection in OFF state deglitch filter time | GPO Driver OFF  | 8   | 10   | 15  | $\mu$ s    |
| 5  | $T_{FLT\_STG}$ | Short to GND detection in OFF state deglitch filter time     | GPO Driver OFF  | 8   | 10   | 15  | $\mu$ s    |

Table 67. GPO driver interface – AC specifications (continued)

| No | Symbol                     | Parameter                              | Conditions                     | Min | Typ | Max | Unit |
|----|----------------------------|--|--------------------------------|-----|-----|-----|------|
| 6  | T <sub>MASK_STUP_ON</sub>  | Diagnostic mask delay after switch ON  | C <sub>GPOX</sub> = 100 nF typ | 136 | -   | 200 | μs   |
| 7  | T <sub>MASK_STUP_OFF</sub> | Diagnostic mask delay after switch OFF | C <sub>GPOX</sub> = 100 nF typ | 520 | -   | 584 | μs   |
| 8  | T <sub>FLT_TSD</sub>       | Thermal shutdown filter time           | -                              | -   | -   | 10  | μs   |
| 9  | F <sub>PWM</sub>           | GPO PWM frequency                      | Design Info                    | -   | 125 |     | Hz   |
| 10 | DC <sub>PWM</sub>          | GPO PWM duty cycle                     | Increment step = 1.6%          | 0   | -   | 100 | %    |

## 17.22 ISO9141 Interface (K-LINE)

All electrical characteristics are valid for the following conditions unless otherwise noted:

40 °C ≤ Ta ≤ +95 °C, VIN<sub>GOOD0</sub> ≤ VIN ≤ 35 V.

Table 68. ISO9141 interface DC specifications

| N° | Symbol                    | Parameter  | Conditions                                   | Min           | Typ           | Max           | Unit |
|----|---------------------------|--|--|---------------|---------------|---------------|------|
| 1  | V <sub>IH_ISOTX</sub>     | ISOTX high level input voltage                         | -  | 2             | -             | -             | V    |
| 2  | V <sub>IL_ISOTX</sub>     | ISOTX low level input voltage                          | -  | -             | -             | 0.8           | V    |
| 3  | V <sub>HYS_ISOTX</sub>    | ISOTX hysteresis input voltage                         | -  | 150           | -             | 500           | mV   |
| 4  | I <sub>PU_ISOTX</sub>     | ISOTX pull up current                                  | ISOTX = 0                                    | -70           | -45           | -20           | μA   |
| 5  | C <sub>IN_ISOTX</sub>     | ISOTX input capacitance                                | Design Info                                  | -             | -             | 5             | pF   |
| 6  | V <sub>TH_DOM_ISOK</sub>  | ISOK Input Receiver Threshold                          | ISOTX = 0V                                   | VIN *<br>0.4  | VIN *<br>0.45 | VIN *<br>0.5  | V    |
| 7  | V <sub>TH_REC_ISOK</sub>  |  | ISOTX = VDDQ                                 | VIN *<br>0.5  | VIN *<br>0.55 | VIN *<br>0.6  | V    |
| 8  | V <sub>HYS_ISOK</sub>     |  | -  | VIN *<br>0.07 | VIN *<br>0.1  | VIN *<br>0.13 | V    |
| 9  | V <sub>O_DOM_ISOK</sub>   | ISOK Output Voltage                                    | ISOTX = 0V,<br>I <sub>ISOK</sub> = 40mA      | -             | -             | 1.2           | V    |
| 10 | I <sub>OC_ISOK</sub>      | ISOK Over Current Detection                            | -  | 50            | -             | 100           | mA   |
| 11 | I <sub>LIM_ISOK</sub>     | ISOK Current Limitation                                | -  | 50            | -             | 100           | mA   |
| 12 | ΔI <sub>LIM_OC_ISOK</sub> | Difference between Current Limitation and OC Threshold | I <sub>LIM_ISOK</sub> - I <sub>OC_ISOK</sub> | 0.1           | -             | -             | mA   |

Table 68. ISO9141 interface DC specifications (continued)

| N° | Symbol                    | Parameter                    | Conditions   | Min           | Typ | Max  | Unit |
|----|---------------------------|------------------------------|--|---------------|-----|------|------|
| 13 | I <sub>SINK_ISOK</sub>    | ISOK sink current capability | Design Info  | 40            | -   | -    | mA   |
| 14 | I <sub>LKG_ISOK</sub>     | ISOK input leakage current   | V <sub>IN</sub> < 18V, Driver Off (device is supplied) | -10           | -   | 10   | μA   |
| 15 | V <sub>OH_ARM</sub>       | ISORX output high voltage    | I <sub>LOAD</sub> = -0.5 mA                            | VDDQ<br>-0.60 | -   | VDDQ | V    |
| 16 | V <sub>OL_ARM</sub>       | ISORX output low voltage     | I <sub>LOAD</sub> = 2 mA                               | 0             | -   | 0.4  | V    |
| 17 | C <sub>IN</sub>           | ISOK input capacitance       | -  | -             | -   | 10   | pF   |
| 18 | T <sub>JSD_ISOK</sub>     | Thermal shutdown             | -  | 150           | 175 | 190  | °C   |
| 19 | T <sub>HYS_TSD_ISOK</sub> |                              | -  | 5             | 10  | 15   | °C   |

Table 69. ISO9141 interface transceiver AC specifications

| N° | Symbol                  | Parameter                         | Conditions  | Min | Typ  | Max | Unit |
|----|-------------------------|-----------------------------------|---|-----|------|-----|------|
| 1  | T <sub>FLT_TSD</sub>    | Thermal shutdown filter time      | -   | -   | -    | 10  | μs   |
| 2  | T <sub>BLK_ISOK</sub>   | Current limit fault blanking time | -   | 8   | -    | 12  | μs   |
| 3  | T <sub>RISE_ISORX</sub> | ISORX rise time                   | 80pF load, 20%-80%  | -   | -    | 0.5 | μs   |
| 4  | T <sub>FALL_ISORX</sub> | ISORX fall time                   | 80pF load, 20%-80%  | -   | -    | 0.5 | μs   |
| 5  | -                       | Baud rate                         | Design Info   | -   | 62.5 | -   | kBd  |
| 6  | T <sub>PD_ILTX</sub>    | Propagation delay transmitter     | ISOTX High to Low to ISOK = 70%<br>* V <sub>O_REC_ISOK</sub><br>R <sub>ISOK</sub> = 510 Ω, C <sub>ISOK</sub> = 470 pF | -   | -    | 1   | μs   |
| 7  | T <sub>PD_IHTX</sub>    |                                   | ISOTX Low to High to ISOK = 30%<br>* V <sub>O_DOM_ISOK</sub><br>R <sub>ISOK</sub> = 510 Ω, C <sub>ISOK</sub> = 470 pF | -   | -    | 1.5 | μs   |
| 8  | T <sub>PD_ILRX</sub>    | Propagation delay receiver        | ISOK = V <sub>TH_DOM_ISOK</sub> to ISORX<br>High to Low<br>R <sub>ISOK</sub> = 510 Ω, C <sub>ISOK</sub> = 470 pF      | -   | -    | 1.5 | μs   |
| 9  | T <sub>PD_IHRX</sub>    |                                   | ISOK = V <sub>TH_REC_ISOK</sub> to ISORX<br>Low to High<br>R <sub>ISOK</sub> = 510 Ω, C <sub>ISOK</sub> = 470 pF      | -   | -    | 1.5 | μs   |
| 10 | T <sub>RISE_ISOK</sub>  | ISOK rise time                    | 30% to 70%<br>R <sub>ISOK</sub> = 510 Ω, C <sub>ISOK</sub> = 470 pF   | -   | -    | 1.5 | μs   |

Table 69. ISO9141 interface transceiver AC specifications (continued)

| N° | Symbol           | Parameter                        | Conditions  | Min | Typ | Max | Unit    |
|----|------------------|----------------------------------|---|-----|-----|-----|---------|
| 11 | $T_{FALL\_ISOK}$ | ISOK fall time                   | 70% to 30%<br>RISOK = 510 $\Omega$ , CISOK = 470 pF                 | -   | -   | 1.5 | $\mu$ s |
| 12 | $T_{PDW\_RX}$    | Receiver pulse width symmetry    | $T_{PD\_ILRX} - T_{PD\_IHRX}$                                       | -   | -   | 1   | $\mu$ s |
| 13 | $T_{PDW\_TX}$    | Transmitter pulse width symmetry | $(T_{PD\_ILTX} + T_{FALL\_ISOK}) - (T_{PD\_IHTX} + T_{RISE\_ISOK})$ | -   | -   | 1   | $\mu$ s |

## 17.23 Analog to digital converter

All electrical characteristics are valid for the following conditions unless otherwise noted:

$40\text{ }^{\circ}\text{C} \leq T_a \leq +95\text{ }^{\circ}\text{C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$ .

Table 70. Analog to digital converter

| No | Symbol           | Parameter  | Conditions  | Min   | Typ  | Max   | Unit    |
|----|------------------|--|---|-------|------|-------|---------|
| 1  | $V_{ADC\_RANGE}$ | ADC input voltage range  | -   | 0.1   | -    | 2.5   | V       |
| 2  | $V_{ADC\_REF}$   | ADC reference voltage  | -   | -1.5% | 2.5  | +1.5% | V       |
| 3  | ADC_RES          | ADC resolution <sup>(1)</sup>  | Design Info   | -     | 10   | -     | bit     |
| 4  | DNL              | Differential non linearity error (DNL)                                 | Separation between adjacent levels, measured bit to bit of actual and an ideal output step. No missing codes      | -1    | -    | +1    | LSB     |
| 5  | INL              | Integral non linearity error (INL)                                     | Maximum difference between the actual analog value at the transition between 2 adjacent steps and its ideal value | -3    | -    | +3    | LSB     |
| 6  | EQUANT           | Quantization error   | Design Info   | -0.5  | -    | 0.5   | LSB     |
| 7  | TotErr           | Total error  | Includes INL, DNL, ADC Reference voltage tolerance and quantization error   | -15   | -    | +15   | LSB     |
| 8  | TotErr_0v1       | ADC total error for 0.1 V input voltage                                | -   | -5    | -    | +5    | LSB     |
| 9  | TotErr_2v4       | ADC total error for 2.4 V input voltage                                | -   | -15   | -    | +15   | LSB     |
| 10 | $R_{LSB\_1}$     | Reproducibility: conversion result variation for constant input signal | 1x sampling measurements. Guaranteed by design  | -6    | -    | 6     | LSB     |
| 11 | $R_{LSB\_4}$     |  | 4x sampling measurements. Guaranteed by design  | -3    | -    | 3     | LSB     |
| 12 | $R_{LSB\_8}$     |  | 8x sampling measurements. Guaranteed by design  | -2.5  | -    | 2.5   | LSB     |
| 13 | Pre-ADC          | Pre-ADC settling time  | -   | -     | 4.81 | -     | $\mu$ s |

Table 70. Analog to digital converter (continued)

| No | Symbol   | Parameter                                 | Conditions  | Min | Typ   | Max | Unit |
|----|----------|---|---|-----|-------|-----|------|
| 14 | T_TSC    | Single conversion time                    | -   | -   | 2.25  | -   | µs   |
| 15 | IQ       | Intra-queue settling time                 | -   | -   | 3.5   | -   | µs   |
| 16 | Post-ADC | Post-ADC settling time                    | -   | -   | 3.44  | -   | µs   |
| 17 | -        | ADC conversion time - voltage             | 4x sampling for each of the 4 conversions in the queue<br>Design Info   | -   | 54.75 | -   | µs   |
| 18 | -        | ADC conversion time – current and voltage | 8x sampling for DCS, temperature and squib loop resistance measurements + 4x sampling for remaining 2 conversions in the queue<br>Design Info | -   | 51.25 | -   | µs   |

1.  $LSB = (2.5V / 1024) = 2.44mV$

## 17.24 Voltage diagnostics (Analog MUX)

All electrical characteristics are valid for the following conditions unless otherwise noted:

$40\text{ °C} \leq T_a \leq +95\text{ °C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35V$ .

Table 71. Voltage diagnostics (Analog MUX)

| No | Symbol        | Parameter   | Conditions   | Min | Typ | Max | Units |
|----|---------------|---|--|-----|-----|-----|-------|
| 1  | Ratio_1       | Divider ratios  | $V_{IN\_RANGE\_1} = 0.1\text{ V to }2.5\text{ V}$  | -   | 1   | -   | V/V   |
| 2  | Ratio_4       |   | $V_{INPUT\_RANGE\_4} = 1\text{ V to }10\text{ V}$  | -3% | 4   | +3% | V/V   |
| 3  | Ratio_7       |   | $V_{INPUT\_RANGE\_7} = 1.5V\text{ to }17.5V$       | -3% | 7   | +3% | V/V   |
| 4  | Ratio_10      |   | $V_{INPUT\_RANGE\_10} = 2\text{ V to }25\text{ V}$ | -3% | 10  | +3% | V/V   |
| 5  | Ratio_15      |   | $V_{INPUT\_RANGE\_15} = 3\text{ V to }35\text{ V}$ | -3% | 15  | +3% | V/V   |
| 6  | Offset        | Divider Offset  | High impedance                                     | -10 | -   | 10  | mV    |
| 7  | R_RATIO_4     | Multiplexer input resistance                          | Multiplexer input to GNDA                          | 80  | -   | -   | kΩ    |
| 8  | R_RATIO_7     |   | Multiplexer input to GNDA                          | 120 | -   | -   | kΩ    |
| 9  | R_RATIO_10    |   | Multiplexer input to GNDA                          | 160 | -   | -   | kΩ    |
| 10 | R_RATIO_15    |   | Multiplexer input to GNDA                          | 200 | -   | -   | kΩ    |
| 11 | I_LEAK_MUX_ON | Additional multiplexer on-state input leakage current | For all divider ratio expect ratio_1               | -   | -   | 60  | µA    |
| 12 | V_MEAS_ACC    | Voltage measurement Accuracy                          | (± 15 LSB) plus divider error (± 3%)               |     |     |     |       |

## 17.25 Temperature sensor

All electrical characteristics are valid for the following conditions unless otherwise noted:

$40\text{ °C} \leq T_a \leq +95\text{ °C}$ ,  $V_{IN\_GOOD0} \leq V_{IN} \leq 35\text{ V}$ .

**Table 72. Temperature sensor specifications**

| No | Symbol                 | Parameter                       | Conditions | Min | Typ | Max | Unit |
|----|------------------------|---------------------------------|------------|-----|-----|-----|------|
| 1  | T <sub>MON_RANGE</sub> | Monitoring temperature range    | -          | -40 | -   | 150 | °C   |
| 2  | T <sub>MON_ACC</sub>   | Monitoring temperature accuracy | -          | -15 | -   | 15  | °C   |

## 18 Quality information

### 18.1 OTP memory

The device contains a 128-bits One-Time Programmable memory. This OTP memory is used for the following purposes:

1. 86 bits data + 3 bits CRC for critical parameters trimming: bandgaps, oscillators, reference currents, firing currents, DC sensor and RSU interface parameters.
2. 18 bits data for other blocks trimming: ADC, ER Cap Measurement
3. 20 bits data for die and wafer traceability
4. 1 bit for debug purpose

User read/write access to the OTP memory via SPI is only possible during production testing and require activation of a special test mode.

During mission mode, the trimming bits are automatically read from OTP and transferred to the related circuits at each POR cycle. During this operation, actual CRC of the protected trimming data is calculated and checked against the expected CRC stored in the OTP. In case of CRC check failure the OTPCRC\_ERR flag is set in the FLTISR register.

# 19 Errata sheet

**Table 73. Errata sheet**

| # | Component Revision | Category / Function   | Issue Description  |
|---|--------------------|-----------------------|--|
| 1 | L9679BB            | Deployment Diagnostic | The high side driver diagnostic, described in section <a href="#">on page 167</a> , doesn't work. As consequence, the I <sub>LIM_HS_FET</sub> parameter is not tested in production.   |
| 2 | L9679BB            | Safing engine         | <p>The safing records associated with CS_RS validate and process data with matching request/response masks even if these are not coming from CS_RS frames but from frames sniffed on SAF_CSx.</p> <p>This may lead to issues when expansion chip is used and CS_RS frames sent on expansion are sniffed by SAF_CSx at SBC side; the SBC fails to check its own CS_RS and therefore all RSUs safing records CC with matching request/response masks of expansion RSUs safing records will be updated upon the processing of the expansion RSU SPI data.</p> <p>Workaround: use two different values for WID SPI bit when addressing CS_RS at SBC (ie WID=1) and expansion (WID=0) side.</p> |

## 20 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK<sup>®</sup> is an ST trademark.

### 20.1 TQFP100 (14x14x1.4 mm exp. pad down) package information

Figure 72. TQFP100 (14x14x1.4 mm exp. pad down) package outline

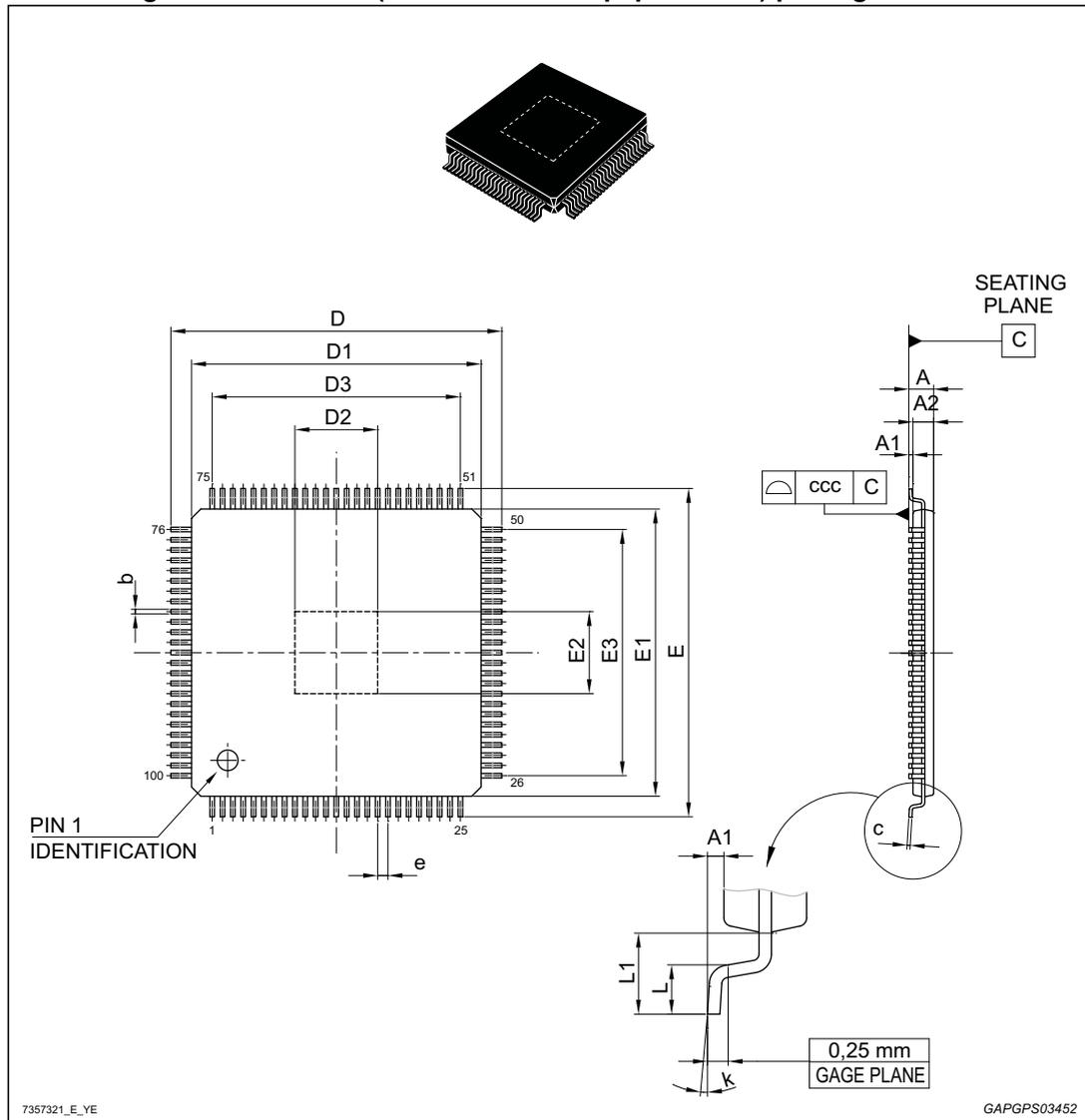


Table 74. TQFP100 (14x14x1.4 mm exp. pad down) package mechanical data

| Ref               | Dimensions  |       |       |                       |        |        |
|-------------------|-------------|-------|-------|-----------------------|--------|--------|
|                   | Millimeters |       |       | Inches <sup>(1)</sup> |        |        |
|                   | Min.        | Typ.  | Max.  | Min.                  | Typ.   | Max.   |
| A                 | -           | -     | 1.20  | -                     | -      | 0.0472 |
| A1                | 0.05        | -     | 0.15  | 0.0020                | -      | 0.0059 |
| A2                | 0.95        | 1.00  | 1.05  | 0.0374                | 0.0394 | 0.0413 |
| b                 | 0.17        | 0.22  | 0.27  | 0.0067                | 0.0087 | 0.0106 |
| c                 | 0.09        | -     | 0.20  | 0.0035                | -      | 0.0079 |
| D                 | 15.80       | 16.00 | 16.20 | 0.6220                | 0.6299 | 0.6378 |
| D1                | 13.80       | 14.00 | 14.20 | 0.5433                | 0.5512 | 0.5591 |
| D2 <sup>(2)</sup> | 5.40        | -     | 8.50  | 0.2126                | -      | 0.3346 |
| D3                | -           | 12.00 | -     | -                     | 0.4724 | -      |
| E                 | 15.80       | 16.00 | 16.20 | 0.622                 | 0.6299 | 0.6378 |
| E1                | 13.80       | 14.00 | 14.20 | 0.5433                | 0.5512 | 0.5591 |
| E2 <sup>(2)</sup> | 5.40        | -     | 8.50  | 0.2126                | -      | 0.3346 |
| E3                | -           | 12.00 | -     | -                     | 0.4724 | -      |
| e                 | -           | 0.50  | -     | -                     | 0.0197 | -      |
| L                 | 0.45        | 0.60  | 0.75  | 0.0177                | 0.0236 | 0.0295 |
| L1                | -           | 1.00  | -     | -                     | 0.0394 | -      |
| k                 | -           | 3.50  | 7.00  | -                     | 0.1378 | 0.2756 |
| ccc               | -           | -     | 0.08  | -                     | -      | 0.0031 |

1. Values in inches are converted from mm and rounded to 4 decimal digits.
2. The size of exposed pad is variable depending of lead frame design pad size. End user should verify "D2" and "E2" dimensions for each device application.

## 21 Revision history

**Table 75. Document revision history**

| Date        | Revision | Changes  |
|-------------|----------|--|
| 03-May-2016 | 1        | Initial release.   |
| 08-Oct-2018 | 2        | <ul style="list-style-type: none"> <li>– Updated <a href="#">Figure 2: Device function block diagram on page 23</a>;</li> <li>– Modified description of the bullet <a href="#">SSM_RESET on page 50</a>;</li> <li>– Corrected in <a href="#">Section 7.3.28</a> register “RES_MEAS_CHSEL[3:0]” for “0100” from “unused” to “ER cap ESR measure”;</li> <li>– Fixed condition of parameter <math>\Delta</math>LIM_OC_PSI5;</li> <li>– Updated <a href="#">Section 17.21: General purpose output drivers</a> and <a href="#">Table 66: GPO interface DC specifications</a>;</li> <li>– Changed min value of VOH_RESET parameter;</li> <li>– Fixed description in <a href="#">Section 8.1.2: Deploy command expiration timer</a>;</li> <li>– Added ISRC_DELTA parameter;</li> <li>– Fixed description in <a href="#">Section 6.12: Reset control</a> added min and max values of oscillator Frequency Detection Threshold parameters;</li> <li>– Fixed description for ERSWITCH_LIM_SEL bit in SYS_CTL spi register;</li> <li>– Fixed min value of IPD_VSF_TOT parameter;</li> <li>– Improved ESR ER CAP diagnostic description in <a href="#">Section 6.5.2: ER CAP ESR measurement</a>;</li> <li>– Added delta VBgood2 – VBbad2 parameter;</li> <li>– Removed VMEAS_ACC parameter;</li> <li>– Added VSR_CLAMP parameter;</li> <li>– Updated <a href="#">Figure 10: IC operating state diagram</a>;</li> <li>– Changed description in <a href="#">Section 9.1.1: Functional description</a> to specify better when data registers are updated; added in parameters section TWRITE_EN_DELAY_LF and TWRITE_EN_DELAY_HF;</li> <li>– Replaced 6 bits with 2 bits for deploy expiration timer configuration in <a href="#">Section 8.1.2: Deploy command expiration timer</a>;</li> <li>– Updated “CSx[2:0] 100 in <a href="#">Section 7.3.55: Safing control x registers (SAF_CONTROL_x)</a>;</li> <li>– Added parameters to specify soft start of erboost and syncboost in <a href="#">Table 36: ERBoost regulator AC specifications</a> and <a href="#">Table 45: SYNCBOOST converter AC specifications</a>;</li> <li>– Added block diagram of ADC Mux in <a href="#">Section 15: System voltage diagnostics</a>;</li> <li>– Added total Voltage Measurement Accuracy in <a href="#">Table 71: Voltage diagnostics (Analog MUX)</a>;</li> <li>– Fixed description in <a href="#">Section 5.2: Deployment drivers</a>;</li> <li>– Improved the power supply sequences;</li> <li>– Changed AMR of SR pin from 40 V to 35 V;</li> <li>– Added some additional test conditions in electrical tables;</li> <li>– Improved description of PSI5 time slot control.</li> <li>– <a href="#">Table 73: Errata sheet on page 268</a>.</li> </ul> |

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